

High-Performance ROM-less Microcontrollers with External Memory Bus

High Performance RISC CPU:

- · C compiler optimized architecture instruction set
- Linear program memory addressing up to 2 Mbytes
- · Linear data memory addressing to 4 Kbytes

	External Prog	gram Memory					
	On-	On-Chip					
Device	Maximum Addressing (bytes)	Addressing Single Word					
PIC18C601	256K	128K	1.5K				
PIC18C801	2M	1M	1.5K				

- Up to 160 ns instruction cycle:
 - DC 25 MHz clock input
 - 4 MHz 6 MHz clock input with PLL active
- 16-bit wide instructions, 8-bit wide data path
- · Priority levels for interrupts
- 8 x 8 Single Cycle Hardware Multiplier

Peripheral Features:

- High current sink/source 25 mA/25 mA
- Up to 47 I/O pins with individual direction control
- · Three external interrupt pins
- Timer0 module: 8-bit/16-bit timer/counter with 8-bit programmable prescaler
- Timer1 module: 16-bit timer/counter (time-base for CCP)
- Timer2 module: 8-bit timer/counter with 8-bit period register
- Timer3 module: 16-bit timer/counter
- Secondary oscillator clock option Timer1/Timer3
- Two Capture/Compare/PWM (CCP) modules CCP pins can be configured as:
 - Capture input: 16-bit, max. resolution 10 ns
 - Compare is 16-bit, max. resolution 160 ns (Tcy)
 - PWM output: PWM resolution is 1- to 10-bit Max. PWM freq. @:

8-bit resolution = 99 kHz 10-bit resolution = 24.4 kHz

- Master Synchronous Serial Port (MSSP) with two modes of operation:
 - 3-wire SPI™ (Supports all 4 SPI modes)
 - I²C™ Master and Slave mode
- Addressable USART module: Supports Interrupt on Address bit

Advanced Analog Features:

- 10-bit Analog-to-Digital Converter module (A/D) with:
 - Fast sampling rate
 - Conversion available during SLEEP
 - DNL = ± 1 LSb, INL = ± 1 LSb
 - Up to 12 channels available
- Programmable Low Voltage Detection (LVD) module
 - Supports interrupt on Low Voltage Detection

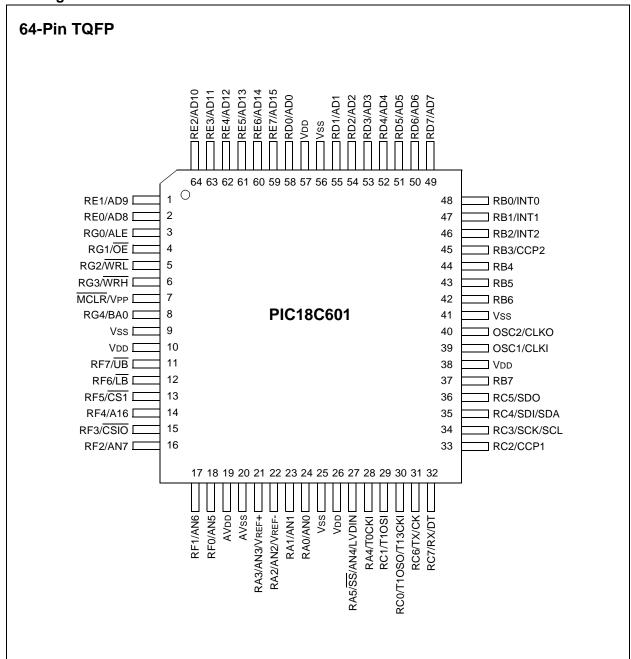
Special Microcontroller Features:

- Power-on Reset (POR), Power-up Timer (PWRT), and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator
- On-chip Boot RAM for boot loader application
- 8-bit or 16-bit external memory interface modes
- Up to two software programmable chip select signals (CS1 and CS2)
- One programmable chip I/O select signal (CSIO) for memory mapped I/O expansion
- Power saving SLEEP mode
- · Different oscillator options, including:
 - 4X Phase Lock Loop (of primary oscillator)
 - Secondary Oscillator (32 kHz) clock input

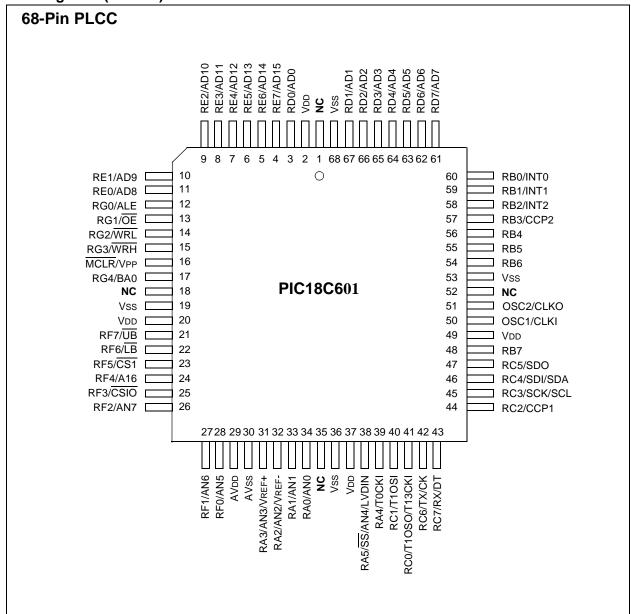
CMOS Technology:

- · Low power, high speed CMOS technology
- · Fully static design
- Wide operating voltage range (2.0V to 5.5V)
- Industrial and Extended temperature ranges
- · Low power consumption

Pin Diagrams



Pin Diagrams (Cont.'d)



Pin Diagrams (Cont.'d) 80-Pin TQFP RE4/AD12 RE2/AD10 RE3/AD11 RE5/AD13 RE6/AD14 RE7/AD15 RD0/AD0 RD3/AD3 RD5/AD5 RD6/AD6 RH0/A16 RD2/AD2 ☐RH1/A17 RD1/AD1 RD4/AD4 RD7/AD7 RJ0/D7 VDD Vss 80 79 78 77 76 75 74 73 72 71 70 69 68 67 66 65 64 63 62 61 RH2/A18 [10 RJ5/D5 2 59 RH3/A19 □ RJ4/D4 □ RB0/INT0 58 3 RE1/AD9 RE0/AD8 D 4 57 RB1/INT1 56 RB2/INT2 RG0/ALE [5 RG1/OE 55 RB3/CCP2 6 RG2/WRL 7 54 □ RB4 □ RB5 RG3/WRH I 8 53 MCLR/VPP 9 52 RB6 RG4/BA0 [10 51 Vss Vss L 11 50 OSC2/CLKO PIC18C801 49 OSC1/CLKI VDD 12 RF7/UB 48 □ Vdd 13 RB7 RF6/LB L 47 14 RF5/CS1 15 46 ☐ RC5/SDO RF4/CS2 L 45 RC4/SDI/SDA 16 RC3/SCK/SCL RF3/CSIO 17 44 □ RC2/CCP1 RF2/AN7 18 43 42 □ RJ3/D3 19 RH4/AN8 [RJ2/D2 RH5/AN9 [20 41 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 V_{DD} RH7/AN11 □ RA5/SS/AN4/LVDIN RA4/T0CKI RF1/AN6 RF0/AN5 RA1/AN1 ERA0/AN0 E AVDD AVss Vss RJ0/D0 [RC0/T10S0/T13CKI RC6/TX/CK RH6/AN10 RC7/RX/DT RA3/AN3/VREF+ RA2/AN2/VREF-

Pin Diagrams (Cont.'d)

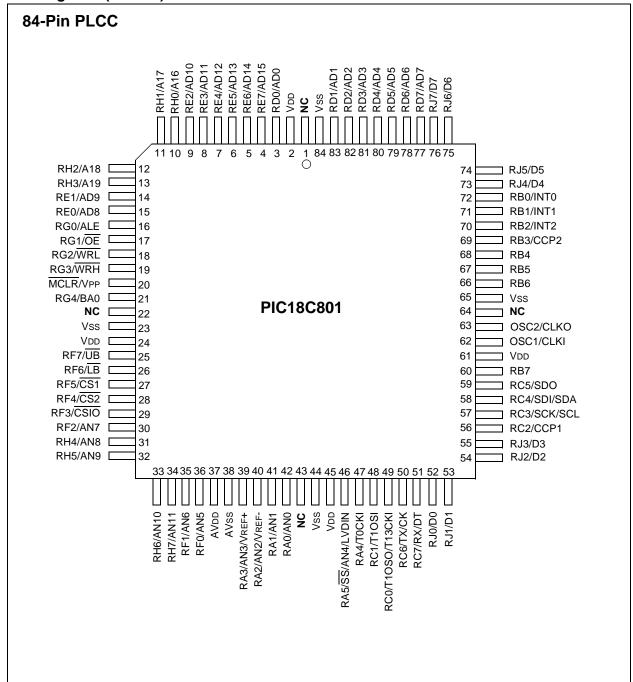


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NOTES:

1.0 DEVICE OVERVIEW

This document contains device specific information for the following two devices:

- 1. PIC18C601
- 2. PIC18C801

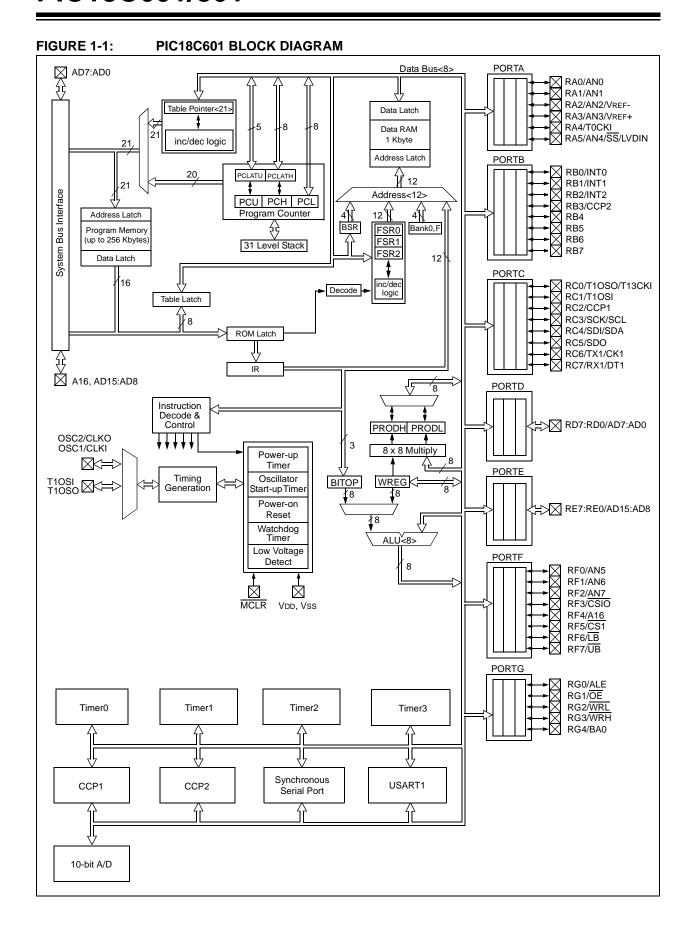
The PIC18C601 is available in 64-pin TQFP and 68-pin PLCC packages. The PIC18C801 is available in 80-pin TQFP and 84-pin PLCC packages.

An overview of features is shown in Table 1-1.

Device block diagrams are provided in Figure 1-1 for the 64/68-pin configuration, and Figure 1-2 for the 80/84-pin configuration. The pinouts for both packages are listed in Table 1-2.

TABLE 1-1: DEVICE FEATURES

Fea	tures	PIC18C601	PIC18C801		
Operating Frequency		DC - 25 MHz	DC - 25 MHz		
External	Bytes	256K	2M		
Program Memory	Max. # of Single Word Instructions	128K	1M		
Data Memory (Bytes)		1536	1536		
Interrupt Sources		15	15		
I/O Ports		Ports A - G	Ports A - H, J		
Timers		4	4		
Capture/Compare/PWM	modules	2	2		
Serial Communications		MSSP, Addressable USART	MSSP, Addressable USART		
10-bit Analog-to-Digital	Module	8 input channels	12 input channels		
RESETS (and Delays)		POR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)	POR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)		
Programmable Low Volt	age Detect	Yes	Yes		
8-bit External Memory In	nterface	Yes	Yes		
8-bit De-multiplexed Ext Memory Interface	ernal	No	Yes		
16-bit External Memory	Interfaces	Yes	Yes		
On-chip Chip Select Sig	nals	CS1	CS1, CS2		
On-chip I/O Chip Select	Signal	Yes	Yes		
Instruction Set		75 Instructions	75 Instructions		
Packages		64-pin TQFP 68-pin PLCC	80-pin TQFP 84-pin PLCC		



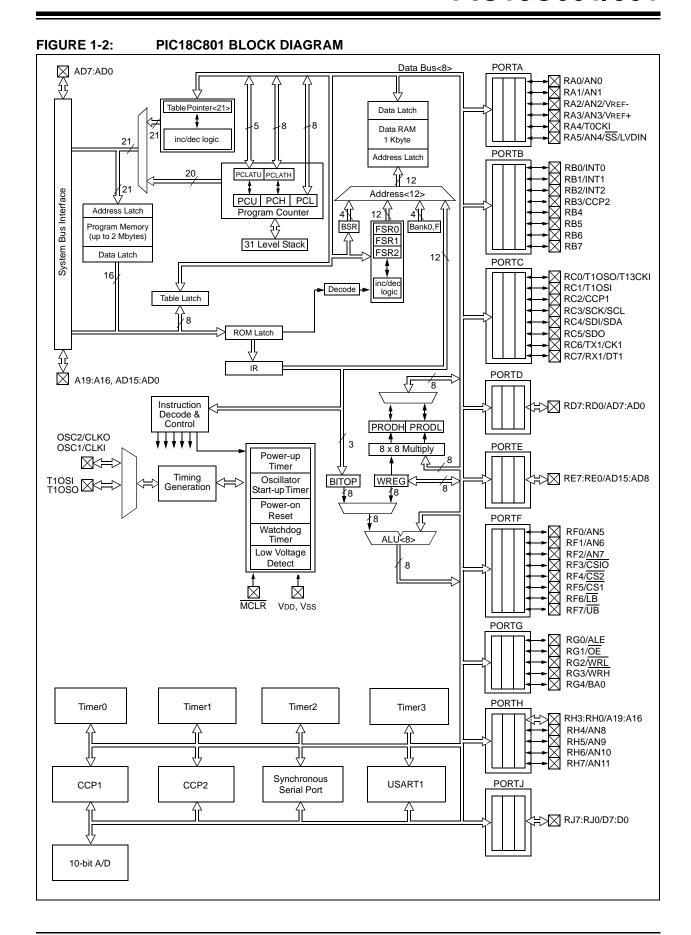


TABLE 1-2: PINOUT I/O DESCRIPTIONS

		Pin N	umber				
Pin Name	PIC18	BC601	PIC1	8C801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,,	Description
MCLR/VPP MCLR VPP	7	16	9	20	I P	ST	Master clear (RESET) input. This pin is an active low RESET to the device.
NC VPP	_	1, 18, 35, 52	_	1, 22, 43, 64	<u> </u>	_	Programming voltage input. These pins should be left unconnected.
OSC1/CLKI OSC1	39	50	49	62	I	CMOS/ST	Oscillator crystal input or external clock source input. ST buffer when in RC mode. Otherwise CMOS.
CLKI					I	CMOS	External clock source input. Always associated with pin function OSC1 (see OSC1/CLKI, OSC2/CLKO pins).
OSC2/CLKO OSC2	40	51	50	63	0	_	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO					0	_	In RC mode, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

I = Input

P = Power

CMOS = CMOS compatible input or output

Analog = Analog input

O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

		Pin N	umber				
Pin Name	PIC18	8C601	PIC18	BC801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,	Description
							PORTA is a bi-directional I/O port.
RA0/AN0	24	34	30	42			
RA0					I/O	TTL	Digital I/O.
AN0					- 1	Analog	Analog input 0.
RA1/AN1	23	33	29	41			
RA1					I/O	TTL	Digital I/O.
AN1					- 1	Analog	Analog input 1.
RA2/AN2/VREF-	22	32	28	40			
RA2					I/O	TTL	Digital I/O.
AN2					I	Analog	Analog input 2.
VREF-					I	Analog	A/D reference voltage (Low) input.
RA3/AN3/VREF+	21	31	27	39			
RA3					I/O	TTL	Digital I/O.
AN3					I	Analog	Analog input 3.
VREF+					1	Analog	A/D reference voltage (High) input.
RA4/T0CKI	28	39	34	47			
RA4					I/O	ST/OD	Digital I/O – Open drain when
							configured as output.
T0CKI					1	ST	Timer0 external clock input.
RA5/AN4/SS/LVDIN	27	38	33	46			
RA5					I/O	TTL	Digital I/O.
AN4					I	Analog	Analog input 4.
SS					I	ST	SPI slave select input.
LVDIN					- 1	Analog	Low voltage detect input.

Legend: TTL = TTL compatible input

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I = Input

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Analog = Analog input O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number		Pin				
Pin Name	PIC1	PIC18C601		PIC18C801		Buffer Type	
	TQFP	PLCC	TQFP	PLCC	Туре	.,,,,,	Description
							PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0 RB0 INT0	48	60	58	72	I/O I	TTL ST	Digital I/O. External interrupt 0.
RB1/INT1 RB1 INT1	47	59	57	71	I/O I	TTL ST	Digital I/O. External interrupt 1.
RB2/INT2 RB2 INT2	46	58	56	70	I/O I	TTL ST	Digital I/O. External interrupt 2.
RB3/CCP2 RB3 CCP2	45	57	55	69	I/O I/O	TTL ST	Digital I/O. Capture2 input, Compare2 output, PWM2 output.
RB4	44	56	54	68	I/O	TTL	Digital I/O, Interrupt-on-change pin.
RB5	43	55	53	67	I/O	TTL	Digital I/O, Interrupt-on-change pin.
RB6	42	54	52	66	I/O I	TTL ST	Digital I/O, Interrupt-on-change pin. ICSP programming clock.
RB7	37	48	47	60	I/O I/O	TTL ST	Digital I/O, Interrupt-on-change pin. ICSP programming data.

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Analog = Analog input

O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC1	8C601	PIC18	BC801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,	Description
							PORTC is a bi-directional I/O port.
RC0/T1OSO/T13CKI	30	41	36	49			
RC0					I/O	ST	Digital I/O.
T1OSO					0	_	Timer1 oscillator output.
T13CKI					I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI	29	40	35	48			
RC1					I/O	ST	Digital I/O.
T1OSI					I	CMOS	Timer1 oscillator input.
RC2/CCP1	33	44	43	56			
RC2					I/O	ST	Digital I/O.
CCP1					I/O	ST	Capture1 input/Compare1
							output/PWM1 output.
RC3/SCK/SCL	34	45	44	57		o .	D: 11 11/0
RC3					1/0	ST	Digital I/O.
SCK					I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL					1/0	ST	Synchronous serial clock
JOL					1/0	01	input/output for I ² C mode.
RC4/SDI/SDA	35	46	45	58			mparauparier i o maasi
RC4	00	70	45	30	I/O	ST	Digital I/O.
SDI					ı, o	ST	SPI data in.
SDA					I/O	ST	I ² C data I/O.
RC5/SDO	36	47	46	59			1 o data 1/o.
RC5	30	47	40	59	I/O	ST	Digital I/O.
SDO					0	-	SPI data out.
RC6/TX/CK	31	42	37	50			or radia odi.
RC6	31	72	31	30	I/O	ST	Digital I/O.
TX					0	_	USART asynchronous transmit.
CK					I/O	ST	USART synchronous clock.
RC7/RX/DT	32	43	38	51			,
RC7	J			.	I/O	ST	Digital I/O.
RX					I	ST	USART asynchronous receive.
DT					I/O	ST	USART synchronous data.

Legend: TTL = TTL compatible input

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Analog = Analog input O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC1	8C601	PIC1	8C801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,,	Description
							PORTD is a bi-directional I/O port. These pins have TTL input buffers when external memory is enabled.
RD0/AD0 RD0 AD0	58	3	72	3	I/O I/O	ST TTL	Digital I/O. External memory address/data 0.
RD1/AD1 RD1 AD1	55	67	69	83	I/O I/O	ST TTL	Digital I/O. External memory address/data 1.
RD2/AD2 RD2 AD2	54	66	68	82	I/O I/O	ST TTL	Digital I/O. External memory address/data 2.
RD3/AD3 RD3 AD3	53	65	67	81	I/O I/O	ST TTL	Digital I/O. External memory address/data 3.
RD4/AD4 RD4 AD4	52	64	66	80	I/O I/O	ST TTL	Digital I/O. External memory address/data 4.
RD5/AD5 RD5 AD5	51	63	65	79	I/O I/O	ST TTL	Digital I/O. External memory address/data 5.
RD6/AD6 RD6 AD6	50	62	64	78	I/O I/O	ST TTL	Digital I/O. External memory address/data 6.
RD7/AD7 RD7 AD7	49	61	63	77	I/O I/O	ST TTL	Digital I/O. External memory address/data 7.

Legend: TTL = TTL compatible input

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Analog = Analog input

O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC18	BC601	PIC18	BC801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,,	Description
							PORTE is a bi-directional I/O port.
RE0/AD8	2	11	4	15			
RE0					I/O	ST	Digital I/O.
AD8					I/O	TTL	External memory address/data 8.
RE1/AD9	1	10	3	14			
RE1					I/O	ST	Digital I/O.
AD9					I/O	TTL	External memory address/data 9.
RE2/AD10	64	9	78	9			
RE2					I/O	ST	Digital I/O.
AD10					I/O	TTL	External memory address/data 10.
RE3/AD11	63	8	77	8			
RE3					I/O	ST	Digital I/O.
AD11					I/O	TTL	External memory address/data 11.
RE4/AD12	62	7	76	7			
RE4					I/O	ST	Digital I/O.
AD12					I/O	TTL	External memory address/data 12.
RE5/AD13	61	6	75	6			
RE5					I/O	ST	Digital I/O.
AD13					I/O	TTL	External memory address/data 13.
RE6/AD14	60	5	74	5			
RE6					I/O	ST	Digital I/O.
AD14					I/O	TTL	External memory address/data 14.
RE7/AD15	59	4	73	4			
RE7					I/O	ST	Digital I/O.
AD15					I/O	ST	External memory address/data 15.

Legend: TTL = TTL compatible input

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Analog = Analog input

O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC18	3C601	PIC18	8C801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	1960	1,700	Description
							PORTF is a bi-directional I/O port.
RF0/AN5	18	28	24	36		0.7	D: :: 11/0
RF0 AN5					I/O I	ST Analog	Digital I/O. Analog input 5.
RF1/AN6	17	27	23	35	'	7 trialog	, water o.
RF1					I/O	ST	Digital I/O.
AN6					I	Analog	Analog input 6.
RF2/AN7 RF2	16	26	18	30	I/O	ST	Dinital I/O
AN7					1/O 	Analog	Digital I/O. Analog input 7.
RF3/CSIO	15	25	17	29		7	, and og any at the
RF3					I/O	ST	Digital I/O.
CSIO					I/O	ST	System bus chip select I/O.
RF4/ <u>A16</u> RF4/ <u>CS2</u>	14	24	— 16	 28			
RF4/C52	_	_	16	20	I/O	ST	Digital I/O.
A16					I/O	TTL	External memory address 16.
CS2					0	TTL	Chip select 2.
RF5/CS1	13	23	15	27	1/0	ОТ	Di-it-11/O
RF5 CS1					I/O O	ST TTL	Digital I/O. Chip select 1.
RF6/LB	12	22	14	26			5p 55.65
RF6					I/O	ST	Digital I/O.
LB					0	TTL	Low byte select signal for external memory interface.
RF7/UB	11	21	13	25			
RF7					I/O	ST	Digital I/O.
ŪB					0	TTL	High byte select signal for external memory interface.

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TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC18	BC601	PIC18	BC801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	.,,,,	.,,,,	Description
							PORTG is a bi-directional I/O port.
RG0/ALE	3	12	5	16			
RG0					I/O	ST	Digital I/O.
ALE					0	TTL	Address Latch Enable.
RG1/OE	4	13	6	17			
<u>RG</u> 1					I/O	ST	Digital I/O.
ŌĒ					0	TTL	Output Enable.
RG2/WRL	5	14	7	18			
RG2					I/O	ST	Digital I/O.
WRL					0	TTL	Write Low control.
RG3/WRH	6	15	8	19			
RG3					I/O	ST	Digital I/O.
WRH					0	TTL	Write High control.
RG4/BA0	8	17	10	21			
RG4					I/O	ST	Digital I/O.
BA0					0	TTL	System bus byte address 0.
							PORTH is a bi-directional I/O port.
RH0/A16	_	_	79	10			
RH0					I/O	ST	Digital I/O.
A16					0	TTL	External memory address 16.
RH1/A17	_	_	80	11			
RH1					I/O	ST	Digital I/O.
A17					0	_	External memory address 17.
RH2/A18	_	_	1	12			
RH2					I/O	ST	Digital I/O.
A18					0	_	External memory address 18.
RH3/A19	_	_	2	13			
RH3					1/0	ST	Digital I/O.
A19					0	_	External memory address 19.
RH4/AN8	_	_	19	31		0.7	D: 11 10
RH4					I/O	ST	Digital I/O.
AN8					I	Analog	Analog input 8.
RH5/AN9	_	_	20	32	1/0	C 	District I/O
RH5 AN9					I/O I	ST Analog	Digital I/O.
_			0.4	00	'	Analog	Analog input 9.
RH6/AN10	_	_	21	33	1/0	ST	Digital I/O
RH6 AN10					I/O I	_	Digital I/O.
			20	0.4	'	Analog	Analog input 10.
RH7/AN11 RH7	_	_	22	34	I/O	ST	Digital I/O
AN11					1/O 	Analog	Digital I/O. Analog input 11.
AINTI						Alialog	Λιταίος πιραί ττ.

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O = Output

TABLE 1-2: PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number						
Pin Name	PIC1	8C601	PIC1	8C801	Pin Type	Buffer Type	
	TQFP	PLCC	TQFP	PLCC	Турс	туре	Description
							PORTJ is a bi-directional I/O port.
RJ0/D0	_	_	39	52			
RJ0					I/O	ST	Digital I/O.
D0					I/O	TTL	System bus data bit 0.
RJ1/D1	_	_	40	53		0.7	5: 11/0
RJ1 D1					I/O I/O	ST TTL	Digital I/O.
RJ2/D2			41	54	1/0	IIL	System bus data bit 1.
RJ2/D2 RJ2	_		41	54	I/O	ST	Digital I/O.
D2					1/0	TTL	System bus data bit 2.
RJ3/D3	_	_	42	55			
RJ3					I/O	ST	Digital I/O.
D3					I/O	TTL	System bus data bit 3.
RJ4/D4	_	_	59	73			
RJ4					I/O	ST	Digital I/O.
D4					I/O	TTL	System bus data bit 4.
RJ5/D5	_	_	60	74			
RJ5 D5					I/O I/O	ST TTL	Digital I/O.
RJ6/D6			61	75	1/0	IIL	System bus data bit 5.
RJ6/D6	_		01	75	I/O	ST	Digital I/O.
D6					1/0	TTL	System bus data bit 6.
RJ7/D7	_	_	62	76			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
RJ7					I/O	ST	Digital I/O.
D7					I/O	TTL	System bus data bit 7.
Vss	9, 25,	19, 36,	11,31,	23, 44,	Р	_	Ground reference for logic and I/O pins.
	41, 56	53, 68	51, 70	65, 84			
VDD	10,26,	2, 20,	12,32,	2, 24,	Р	_	Positive supply for logic and I/O pins.
	38, 57	37, 49	48, 71	45, 61			
Avss	20	30	26	38	P	_	Ground reference for analog modules.
AVDD	19	29	25	37	Р		Positive supply for analog modules.

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

I = Input

P = Power

CMOS = CMOS compatible input or output

Analog = Analog input

O = Output

2.0 OSCILLATOR CONFIGURATIONS

2.1 Oscillator Types

PIC18C601/801 can be operated in one of four oscillator modes, programmable by configuration bits FOSC1:FOSC0 in CONFIG1H register:

- 1. LP Low Power Crystal
- 2. HS High Speed Crystal/Resonator
- 3. RC External Resistor/Capacitor
- 4. EC External Clock

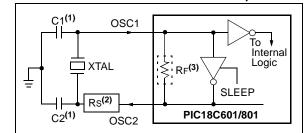
2.2 Crystal Oscillator/Ceramic Resonators

In LP or HS oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 2-1 shows the pin connections. An external clock source may also be connected to the OSC1 pin, as shown in Figure 2-3 and Figure 2-4.

PIC18C601/801 oscillator design requires the use of a parallel cut crystal.

Note: Use of a series cut crystal may give a frequency out of the crystal manufacturer's specifications.

FIGURE 2-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS OR LP OSC CONFIGURATION)



- **Note 1:** See Table 2-1 and Table 2-2 for recommended values of C1 and C2.
 - **2:** A series resistor (Rs) may be required for AT strip cut crystals.
 - 3: RF varies with the crystal chosen.

TABLE 2-1: CERAMIC RESONATORS

Ranges Tested:								
Mode	Mode Freq. OSC1							
HS	8.0 MHz 16.0 MHz 20.0 MHz 25.0 MHz	10 - 68 pF 10 - 22 pF TBD	10 €8 pF 10 €22 pF √BD TBD					
HS+PLL	4.0 MHz	MBD	TBD					
	values are to tes on this pa	r design guida ge.	nce only.					
	777 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	ators Used:						
40 MHz	ADMIZ Murata Erie CSA4.00MG ± 0.5%							
8 0 MHz Murata Erie CSA8.00MT ± 0.5%								
16.0 MHz Murata Erie CSA16.00MX ± 0.5%								
All reso	All resonators used did not have built-in capacitors.							

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Cap. Range C1	Cap. Range C2
LP	32.0 kHz	33 pF	33 pF
	200 kHz	15 pF	15¢F
HS	4.0 MHz	15 pF	(15 pF)
	8.0 MHz	15-33 pF	15-33 pF
	20.0 MHz	15-33-pt	15-33 pF
	25.0 MHz	1/ <u>/</u> /BD	TBD
HS+PLL	4.0 MH2	√15 pF	15 pF
These	values are fo	or design guida	ince only.
See not	és on this pa	ge.	
	Crys	tals Used	
320 kHz	Epson C-00	1R32.768K-A	± 20 PPM
200 kHz	STD XTL	200.000kHz	± 20 PPM
1.0 MHz	ECS EC	± 50 PPM	
4.0 MHz	ECS EC	± 50 PPM	
8.0 MHz	EPSON CA-	± 30 PPM	
20.0 MHz	EPSON CA-	301 20.000M-C	± 30 PPM

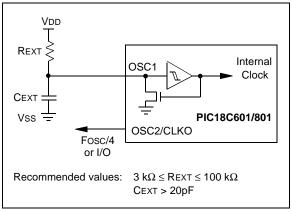
- **Note 1:** Recommended values of C1 and C2 are identical to the ranges tested (Table 2-1).
 - **2:** Higher capacitance increases the stability of the oscillator, but also increases the start-up time.
 - **3:** Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **4:** Rs may be required in HS mode to avoid overdriving crystals with low drive level specification.

2.3 RC Oscillator

For timing insensitive applications, the "RC" oscillator mode offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 2-2 shows how the RC combination is connected.

In the RC oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic.

FIGURE 2-2: RC OSCILLATOR MODE

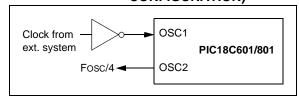


2.4 External Clock Input

The EC oscillator mode requires an external clock source to be connected to the OSC1 pin. The feedback device between OSC1 and OSC2 is turned off in these modes to save current. There is no oscillator start-up time required after a Power-on Reset or after a recovery from SLEEP mode.

In the EC oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-3 shows the pin connections for the EC oscillator mode.

FIGURE 2-3: EXTERNAL CLOCK INPUT OPERATION (EC OSC CONFIGURATION)



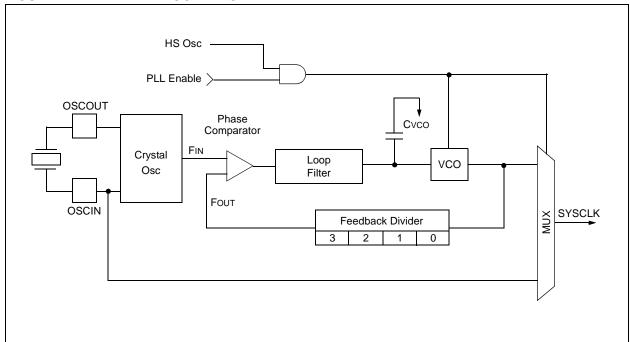
2.5 HS4 (PLL)

A Phase Lock Loop (PLL) circuit is provided as a software programmable option for users that want to multiply the frequency of the incoming crystal oscillator signal by 4. For an input clock frequency of 6 MHz, the internal clock frequency will be multiplied to 24 MHz. This is useful for customers who are concerned with EMI due to high frequency crystals.

The PLL is enabled by configuring HS oscillator mode and setting the PLLEN bit in the OSCON register. If HS oscillator mode is not selected, or PLLEN bit in OSCCON register is clear, the PLL is not enabled and the system clock will come directly from OSC1. HS oscillator mode is the default for PIC18C601/801. In all other modes, the PLLEN bit and the SCS1 bit are forced to '0'.

A PLL lock timer is used to ensure that the PLL has locked before device execution starts. The PLL lock timer has a time-out, referred to as TPLL.

FIGURE 2-4: PLL BLOCK DIAGRAM



2.6 Oscillator Switching Feature

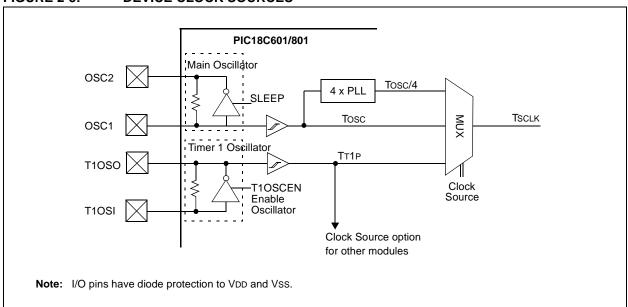
PIC18C601/801 devices include a feature that allows the system clock source to be switched from the main oscillator to an alternate low frequency clock source. For PIC18C601/801 devices, this alternate clock source is the Timer1 oscillator. If a low frequency crystal (32 kHz, for example) has been attached to the Timer1 oscillator pins and the Timer1 oscillator has been enabled, the device can switch to a low power execution mode. Figure 2-5 shows a block diagram of the system clock sources.

2.6.1 SYSTEM CLOCK SWITCH BIT

The system clock source switching is performed under software control. The system clock switch bit, SCS0 (OSCCON register), controls the clock switching. When the SCS0 bit is '0', the system clock source comes from the main oscillator, selected by the FOSC2:FOSC0 configuration bits in CONFIG1H register. When the SCS0 bit is set, the system clock source will come from the Timer1 oscillator. The SCS0 bit is cleared on all forms of RESET.

The Timer1 oscillator must be enabled to switch the system clock source. The Timer1 oscillator is enabled by setting the T1OSCEN bit in the Timer1 control register (T1CON). If the Timer1 oscillator is not enabled, any write to the SCS0 bit will be ignored (SCS0 bit forced cleared) and the main oscillator will continue to be the system clock source.

FIGURE 2-5: DEVICE CLOCK SOURCES



Note:

REGISTER 2-1: OSCCON REGISTER

	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
Ī	_	_	_	_	LOCK	PLLEN	SCS1	SCS0
_	bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3 LOCK: Phase Lock Loop Lock Status bit

1 = Phase Lock Loop output is stable as system clock

0 = Phase Lock Loop output is not stable and cannot be used as system clock

bit 2 PLLEN: Phase Lock Loop Enable bit

1 = Enable Phase Lock Loop output as system clock

0 = Disable Phase Lock Loop

bit 1 SCS1: System Clock Switch bit 1

When PLLEN and LOCK bit are set:

1 = Use PLL output

0 = Use primary oscillator/clock input pin When PLLEN bit or LOCK bit is cleared:

Bit is forced clear

bit 0 SCS0: System Clock Switch bit 0

When T1OSCEN bit is set:

1 = Switch to Timer1 oscillator/clock pin

0 = Use primary oscillator/clock input pin

When T1OSCEN is cleared:

Bit is forced clear

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

2.6.2 OSCILLATOR TRANSITIONS

PIC18C601/801 devices contain circuitry to prevent "glitches" when switching between oscillator sources. Essentially, the circuitry waits for eight rising edges of the clock source that the processor is switching to. This ensures that the new clock source is stable and that its pulse width will not be less than the shortest pulse width of the two clock sources.

A timing diagram indicating the transition from the main oscillator to the Timer1 oscillator is shown in Figure 2-6. The Timer1 oscillator is assumed to be running all the time. After the SCS0 bit is set, the processor is frozen at the next occurring Q1 cycle. After eight synchronization cycles are counted from the Timer1 oscillator, operation resumes. No additional delays are required after the synchronization cycles.

The sequence of events that takes place when switching from the Timer1 oscillator to the main oscillator will depend on the mode of the main oscillator. In addition to eight clock cycles of the main oscillator, additional delays may take place.

If the main oscillator is configured for an external crystal (HS, LP), the transition will take place after an oscillator start-up time (Tost) has occurred. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for HS and LP modes is shown in Figure 2-7.

FIGURE 2-6: TIMING DIAGRAM FOR TRANSITION FROM OSC1 TO TIMER1 OSCILLATOR

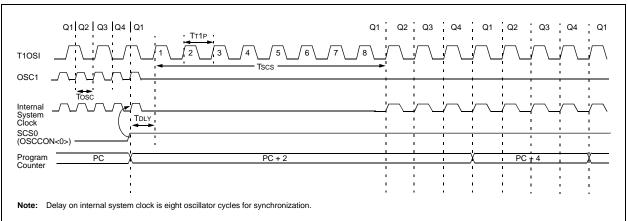
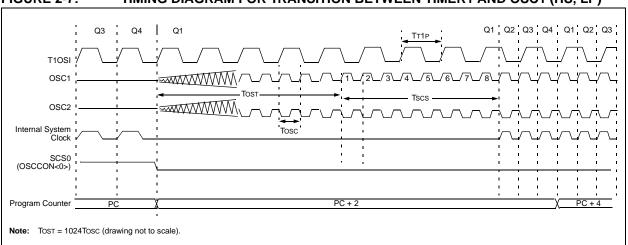


FIGURE 2-7: TIMING DIAGRAM FOR TRANSITION BETWEEN TIMER1 AND OSC1 (HS, LP)



If the main oscillator is configured for HS4 (PLL) mode with SCS1 bit set to '1', an oscillator start-up time (Tost), plus an additional PLL time-out (TPLL) will occur. The PLL time-out is typically 2 ms and allows the PLL to lock to the main oscillator frequency. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for HS4 mode is shown in Figure 2-8.

If the main oscillator is configured for HS4 (PLL) mode, with SCS1 bit set to '0', only oscillator start-up time (Tost) will occur. Since SCS1 bit is set to '0', PLL out-

put is not used, so the system oscillator will come from OSC1 directly and additional delay of TPLL is not required. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for HS4 mode is shown in Figure 2-9.

If the main oscillator is configured in the RC or EC modes, there is no oscillator start-up time-out. Operation will resume after eight cycles of the main oscillator have been counted. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for RC and EC modes is shown in Figure 2-10.

FIGURE 2-8: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (HS4 WITH SCS1 = 1)

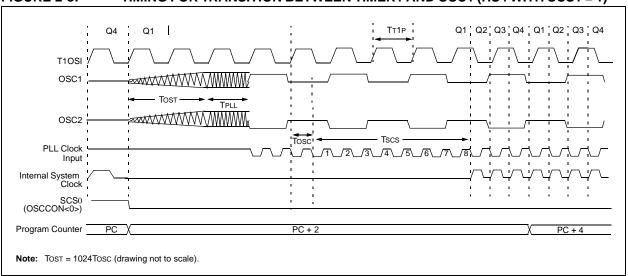
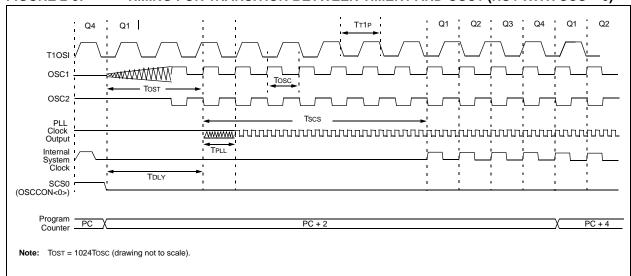


FIGURE 2-9: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (HS4 WITH SCS = 0)



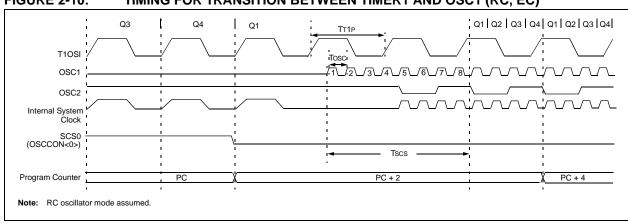


FIGURE 2-10: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (RC, EC)

2.6.3 SCS0, SCS1 PRIORITY

If both SCS0 and SCS1 are set to '1' simultaneously, the SCS0 bit has priority over the SCS1 bit. This means that the low power option will take precedence over the PLL option. If both bits are cleared simultaneously, the system clock will come from OSC1, after a ToST timeout. If only the SCS0 bit is cleared, the system clock will come from the PLL output, following ToST and TPLL time.

TABLE 2-3: SCS0, SCS1 PRIORITY

SCS1	SCS0	Clock Source
0	0	Ext Oscillator OSC1
0	1	Timer1 Oscillator
1	0	HS + PLL
1	1	Timer1 Oscillator

2.7 Effects of SLEEP Mode on the On-Chip Oscillator

When the device executes a SLEEP instruction, the on-chip clocks and oscillator are turned off and the device is held at the beginning of an instruction cycle (Q1 state). With the oscillator off, the OSC1 and OSC2 signals will stop oscillating. Since all the transistor switching currents have been removed, SLEEP mode achieves the lowest current consumption of the device (only leakage currents). Enabling any on-chip feature that will operate during SLEEP, will increase the cur-

rent consumed during SLEEP. The user can wake from SLEEP through external RESET, Watchdog Timer Reset, or through an interrupt.

2.8 Power-up Delays

Power-up delays are controlled by two timers, so that no external RESET circuitry is required for most applications. The delays ensure that the device is kept in RESET until the device power supply and clock are stable. For additional information on RESET operation, see Section 3.0 RESET.

The first timer is the Power-up Timer (PWRT), which optionally provides a fixed delay of TPWRT (parameter #33) on power-up only. The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable.

PIC18C601/801 devices provide a configuration bit, PWRTEN in CONFIG2L register, to enable or disable the Power-up Timer. By default, the Power-up Timer is enabled.

With the PLL enabled (HS4 oscillator mode), the time-out sequence following a Power-on Reset is different from other oscillator modes. The time-out sequence is as follows: the PWRT time-out is invoked after a POR time delay has expired, then, the Oscillator Start-up Timer (OST) is invoked. However, this is still not a sufficient amount of time to allow the PLL to lock at high frequencies. The PWRT timer is used to provide an additional time-out, called TPLL (parameter #7), to allow the PLL ample time to lock to the incoming clock frequency.

TABLE 2-4: OSC1 AND OSC2 PIN STATES IN SLEEP MODE

OSC Mode	OSC1 Pin	OSC2 Pin
RC	Floating, external resistor should pull high	At logic low
EC	Floating	At logic low
LP and HS	Feedback inverter disabled, at quiescent voltage level	Feedback inverter disabled, at quiescent voltage level

Note: See Table 3-1 in Section 3.0 RESET, for time-outs due to SLEEP and MCLR Reset.

3.0 RESET

PIC18C601/801 devices differentiate between various kinds of RESET:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during SLEEP
- d) Watchdog Timer (WDT) Reset during normal operation
- e) RESET Instruction
- f) Stack Full Reset
- g) Stack Underflow Reset

Most registers are unaffected by a RESET. Their status is unknown on POR and unchanged by all other RESETS. The other registers are forced to a "RESET" state on Power-on Reset, MCLR, WDT Reset, MCLR Reset during SLEEP, and by the RESET instruction.

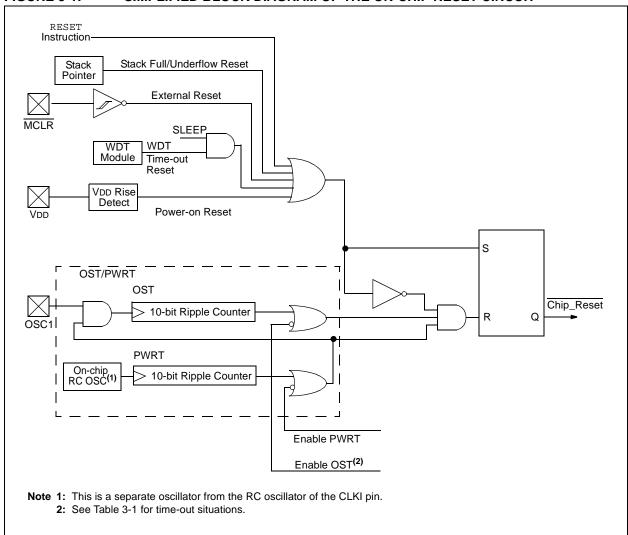
Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register, $\overline{\text{RI}}$, $\overline{\text{TO}}$, $\overline{\text{PD}}$ and $\overline{\text{POR}}$, are set or cleared differently in different RESET situations, as indicated in Table 3-2. These bits are used in software to determine the nature of the RESET. See Table 3-3 for a full description of the RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 3-1.

PIC18C601/801 has a $\overline{\text{MCLR}}$ noise filter in the $\overline{\text{MCLR}}$ Reset path. The filter will detect and ignore small pulses.

A WDT Reset does not drive MCLR pin low.

FIGURE 3-1: SIMPLIFIED BLOCK DIAGRAM OF THE ON-CHIP RESET CIRCUIT

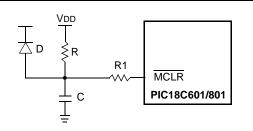


3.1 Power-on Reset (POR)

A Power-on Reset pulse is generated on-chip when a VDD rise is detected. To take advantage of the POR circuitry, connect the MCLR pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 3-2.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met. Power-on Reset may be used to meet the voltage start-up condition.

FIGURE 3-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if the VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: $R < 40 \ k\Omega$ is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.
 - 3: R1 = 100Ω to 1 k Ω will limit any current flowing into \overline{MCLR} from external capacitor C, in the event of \overline{MCLR} /VPP pin breakdown due to Electrostatic Discharge (ESD), or Electrical Overstress (EOS).

3.2 Power-up Timer (PWRT)

The Power-up Timer provides a fixed nominal time-out (parameter #33), only on power-up from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. The PWRT time delay allows VDD to rise to an acceptable level. PIC18C601/801 devices are available with PWRT enabled or disabled.

The power-up time delay will vary from chip to chip, due to VDD, temperature and process variation. See DC parameter #33 for details.

3.3 Oscillator Start-up Timer (OST)

The Oscillator Start-up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over (parameter #32). This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for LP, HS and HS4 modes and only on Power-on Reset or wake-up from SLEEP.

3.4 PLL Lock Time-out

With the PLL enabled, the time-out sequence following a Power-on Reset is different from other oscillator modes. A portion of the Power-up Timer is used to provide a fixed time-out that is sufficient for the PLL to lock to the main oscillator frequency. This PLL lock time-out (TPLL) is typically 1 ms and follows the oscillator start-up time-out (OST).

3.5 Time-out Sequence

On power-up, the time-out sequence is as follows: First, PWRT time-out is invoked after the POR time delay has expired; then, OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 3-3, Figure 3-4, Figure 3-5, Figure 3-6 and Figure 3-7 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the time-outs will expire. Bringing MCLR high will begin execution immediately (Figure 3-5). This is useful for testing purposes or to synchronize more than one PIC18C601/801 device operating in parallel.

Table 3-2 shows the RESET conditions for some Special Function Registers, while Table 3-3 shows the RESET conditions for all registers.

TABLE 3-1: TIME-OUT IN VARIOUS SITUATIONS

Oscillator	Powe	Wake-up from		
Configuration	PWRTEN = 0	PWRTEN = 1	SLEEP or Oscillator Switch ⁽¹⁾	
HS with PLL enabled ⁽¹⁾	72 ms + 1024Tosc	1024Tosc	1024Tosc + 1 ms	
HS, LP	72 ms + 1024Tosc	1024Tosc	1024Tosc	
EC	72 ms	_	_	
External RC	72 ms	_	_	

Note 1: 1 ms is the nominal time required for the 4X PLL to lock. Maximum time is 2 ms.

2: 72 ms is the nominal Power-up Timer delay.

REGISTER 3-1: RCON REGISTER BITS AND POSITIONS

R/W-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	U-0
IPEN	r	_	RI	TO	PD	POR	r
bit 7							bit 0

TABLE 3-2: STATUS BITS, THEIR SIGNIFICANCE, AND THE INITIALIZATION CONDITION FOR RCON REGISTER

Condition	Program Counter	RCON Register	RI	то	PD	POR	STKFUL	STKUNF
Power-on Reset	00000h	0r-1 110r	1	1	1	0	u	u
MCLR Reset during normal operation	00000h	0r-u uuur	u	u	u	u	u	u
Software Reset during normal operation	00000h	0r-0 uuur	0	u	u	u	u	u
Stack Full Reset during normal operation	00000h	0r-u uu1r	u	u	u	1	u	1
Stack Underflow Reset during normal operation	00000h	0r-u uu1r	u	u	u	1	1	u
MCLR Reset during SLEEP	00000h	0r-u 10ur	u	1	0	u	u	u
WDT Reset	00000h	0r-u 01ur	u	0	1	u	u	u
WDT Wake-up	PC + 2	ur-u 00ur	u	0	0	u	u	u
Interrupt wake-up from SLEEP	PC + 2 ⁽¹⁾	ur-u 00ur	u	0	0	u	u	u

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', r = reserved, maintain '0'

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bits are set, the PC is loaded with the interrupt vector (000008h or 000018h).

FIGURE 3-3: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)

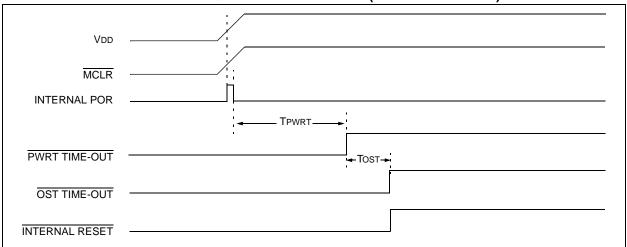


FIGURE 3-4: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 1

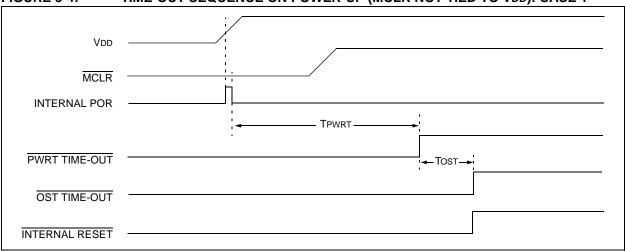
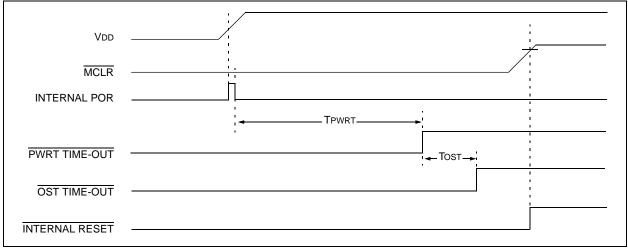


FIGURE 3-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2





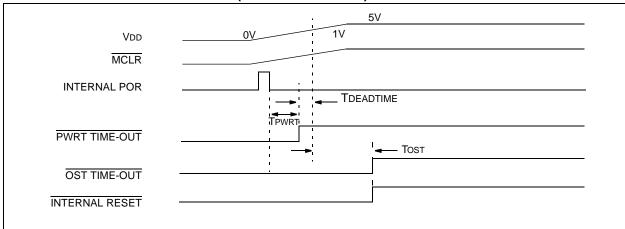


FIGURE 3-7: TIME-OUT SEQUENCE ON POR W/ PLL ENABLED (MCLR TIED TO VDD)

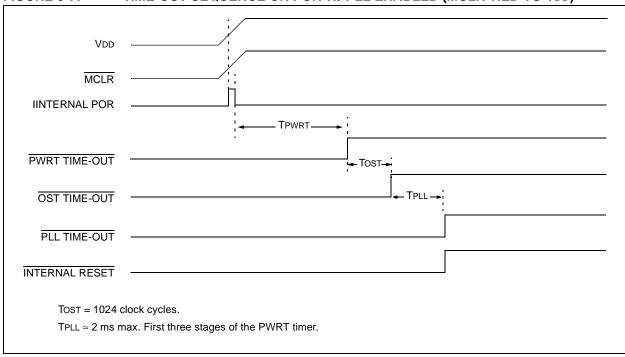


TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Appli Dev		Power-on Reset	MCLR Reset WDT Reset Reset Instruction Stack Over/Underflow Reset	Wake-up via WDT or Interrupt
TOSU	601	801	0 0000	0 0000	u uuuu (3)
TOSH	601	801	0000 0000	0000 0000	uuuu uuuu ⁽³⁾
TOSL	601	801	0000 0000	0000 0000	uuuu uuuu ⁽³⁾
STKPTR	601	801	00-0 0000	00-0 0000	uu-u uuuu ⁽³⁾
PCLATU	601	801	0 0000	0 0000	u uuuu
PCLATH	601	801	0000 0000	0000 0000	uuuu uuuu
PCL	601	801	0000 0000	0000 0000	PC + 2 ⁽²⁾
TBLPTRU	601	801	00 0000	00 0000	uu uuuu
TBLPTRH	601	801	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	601	801	0000 0000	0000 0000	uuuu uuuu
TABLAT	601	801	0000 0000	0000 0000	uuuu uuuu
PRODH	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
INTCON	601	801	0000 000x	0000 000u	uuuu uuuu ⁽¹⁾
INTCON2	601	801	1111 -1-1	1111 -1-1	uuuu -u-u ⁽¹⁾
INTCON3	601	801	11-0 0-00	11-0 0-00	uu-u u-uu ⁽¹⁾
INDF0	601	801	(Note 5)	(Note 5)	(Note 5)
POSTINC0	601	801	(Note 5)	(Note 5)	(Note 5)
POSTDEC0	601	801	(Note 5)	(Note 5)	(Note 5)
PREINC0	601	801	(Note 5)	(Note 5)	(Note 5)
PLUSW0	601	801	(Note 5)	(Note 5)	(Note 5)
FSR0H	601	801	0000	0000	uuuu
FSR0L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF1	601	801	(Note 5)	(Note 5)	(Note 5)
POSTINC1	601	801	(Note 5)	(Note 5)	(Note 5)
POSTDEC1	601	801	(Note 5)	(Note 5)	(Note 5)
PREINC1	601	801	(Note 5)	(Note 5)	(Note 5)
PLUSW1	601	801	(Note 5)	(Note 5)	(Note 5)
FSR1H	601	801	0000	0000	uuuu
FSR1L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
BSR	601	801	0000	0000	uuuu
INDF2	601	801	(Note 5)	(Note 5)	(Note 5)

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition, r = reserved, maintain '0'

- Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (00008h or 00018h).
 - **3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH, and TOSL are updated with the current value of the PC. The SKPTR is modified to point to the next location in the hardware stack.
 - 4: See Table 3-2 for RESET value for specific condition.
 - **5:** This is not a physical register. It is an indirect pointer that addresses another register. The contents returned is the value contained in the addressed register.

TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset	MCLR Reset WDT Reset Reset Instruction Stack Over/Underflow Reset	Wake-up via WDT or Interrupt
POSTINC2	601	801	(Note 5)	(Note 5)	(Note 5)
POSTDEC2	601	801	(Note 5)	(Note 5)	(Note 5)
PREINC2	601	801	(Note 5)	(Note 5)	(Note 5)
PLUSW2	601	801	(Note 5)	(Note 5)	(Note 5)
FSR2H	601	801	0000	0000	uuuu
FSR2L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
STATUS	601	801	x xxxx	u uuuu	u uuuu
TMR0H	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
T0CON	601	801	1111 1111	1111 1111	uuuu uuuu
OSCCON	601	801	00 0-00	uu u-u0	uu u-uu
LVDCON	601	801	00 0101	00 0101	uu uuuu
WDTCON	601	801	1111	uuuu	uuuu
RCON ⁽⁴⁾	601	801	0r-1 11qr	0r-1 qqur	ur-u qqur
TMR1H	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	601	801	0-00 0000	u-uu uuuu	u-uu uuuu
TMR2	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PR2	601	801	1111 1111	1111 1111	1111 1111
T2CON	601	801	-000 0000	-000 0000	-uuu uuuu
SSPBUF	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPADD	601	801	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	601	801	0000 0000	0000 0000	uuuu uuuu
SSPCON1	601	801	0000 0000	0000 0000	uuuu uuuu
SSPCON2	601	801	0000 0000	0000 0000	uuuu uuuu
ADRESH	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADRESL	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	601	801	00 0000	00 0000	uu uuuu
ADCON1	601	801	-000 0000	-000 0000	-uuu uuuu
ADCON2	601	801	0000	0000	uuuu
CCPR1H	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	601	801	00 0000	00 0000	uu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition, r = reserved, maintain '0'

- Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (00008h or 00018h).
 - **3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH, and TOSL are updated with the current value of the PC. The SKPTR is modified to point to the next location in the hardware stack.
 - 4: See Table 3-2 for RESET value for specific condition.
 - **5:** This is not a physical register. It is an indirect pointer that addresses another register. The contents returned is the value contained in the addressed register.

TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset	MCLR Reset WDT Reset Reset Instruction Stack Over/Underflow Reset	Wake-up via WDT or Interrupt
CCPR2H	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	601	801	00 0000	00 0000	uu uuuu
TMR3H	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	601	801	0000 0000	uuuu uuuu	uuuu uuuu
SPBRG	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
RCREG	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXREG	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA	601	801	0000 -01x	0000 -01u	uuuu -uuu
RCSTA	601	801	0000 000x	0000 000u	uuuu uuuu
IPR2	601	801	-1 1111	-1 1111	-u uuuu
PIR2	601	801	-1 0000	-1 0000	-u uuuu ⁽¹⁾
PIE2	601	801	-1 0000	-1 0000	-u uuuu
IPR1	601	801	1111 1111	1111 1111	uuuu uuuu
	601	801	-111 1111	-111 1111	-uuu uuuu
PIR1	601	801	0000 0000	0000 0000	uuuu uuuu (1)
	601	801	-000 0000	-000 0000	-uuu uuuu (1)
PIE1	601	801	0000 0000	0000 0000	uuuu uuuu
	601	801	-000 0000	-000 0000	-uuu uuuu
MEMCON	601	801	000000	000000	uuuuuu
TRISJ	601	801	1111 1111	1111 1111	uuuu uuuu
TRISH	601	801	1111 1111	1111 1111	uuuu uuuu
TRISG	601	801	1 1111	1 1111	u uuuu
TRISF	601	801	1111 1111	1111 1111	uuuu uuuu
TRISE	601	801	1111 1111	1111 1111	uuuu uuuu
TRISD	601	801	1111 1111	1111 1111	uuuu uuuu
TRISC	601	801	1111 1111	1111 1111	uuuu uuuu
TRISB	601	801	1111 1111	1111 1111	uuuu uuuu
TRISA	601	801	11 1111	11 1111	uu uuuu
LATG	601	801	x xxxx	u uuuu	u uuuu
LATF	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATE	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition, r = reserved, maintain '0'

- Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (00008h or 00018h).
 - **3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH, and TOSL are updated with the current value of the PC. The SKPTR is modified to point to the next location in the hardware stack.
 - **4:** See Table 3-2 for RESET value for specific condition.
 - **5:** This is not a physical register. It is an indirect pointer that addresses another register. The contents returned is the value contained in the addressed register.

TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset	MCLR Reset WDT Reset Reset Instruction Stack Over/Underflow Reset	Wake-up via WDT or Interrupt
LATD	601 801		xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	601 801		xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA	601	801	xx xxxx	uu uuuu	uu uuuu
PORTJ	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTH	601	801	0000 xxxx	0000 uuuu	uuuu uuuu
PORTG	601	801	x xxxx	u uuuu	u uuuu
PORTF	601	801	xxxx x000	uuuu u000	uuuu uuuu
PORTE	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTD	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	601	801	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	601	801	0x 0000	0u 0000	uu uuuu
CSEL2	601	801	1111 1111	uuuu uuuu	uuuu uuuu
CSELIO	601	801	1111 1111	uuuu uuuu	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition, r = reserved, maintain '0'

- Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (00008h or 00018h).
 - **3:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH, and TOSL are updated with the current value of the PC. The SKPTR is modified to point to the next location in the hardware stack.
 - 4: See Table 3-2 for RESET value for specific condition.
 - **5:** This is not a physical register. It is an indirect pointer that addresses another register. The contents returned is the value contained in the addressed register.

NOTES:

4.0 MEMORY ORGANIZATION

There are two memory blocks in PIC18C601/801 devices. These memory blocks are:

- · Program Memory
- · Data Memory

Each block has its own bus so that concurrent access can occur.

4.1 Program Memory Organization

PIC18C601/801 devices have a 21-bit program counter that is capable of addressing up to 2 Mbyte of external program memory space. The PIC18C601 has an external program memory address space of 256 Kbytes. Any program fetch or TBLRD from a program location greater than 256K will return all NOPs. The PIC18C801 has an external program memory address space of 2Mbytes. Refer to Section 5.0 ("External Memory Interface") for additional details.

The RESET vector address is mapped to 000000h and the interrupt vector addresses are at 000008h and 000018h. PIC18C601/801 devices have a 31-level stack to store the program counter values during subroutine calls and interrupts. Figure 4-1 shows the program memory map and stack for PIC18C601. Figure 4-2 shows the program memory map and stack for the PIC18C801.

4.1.1 "BOOT RAM" PROGRAM MEMORY

PIC18C601/801 devices have a provision for configuring the last 512 bytes of general purpose user RAM as program memory, called "Boot RAM". This is achieved by configuring the PGRM bit in the MEMCON register to '1'. (Refer to Section 5.0, "External Memory Interface" for more information.) When the PGRM bit is '1', the RAM located in data memory locations 400h through 5FFh (bank 4 through 5) is mapped to program memory locations 1FFE00h to 1FFFFFh.

When configured as program memory, the Boot RAM is to be used as a temporary "boot loader" for programming purposes. It can only be used for program execution. A read from locations 400h to 5FFh in data memory returns all '0's. Any attempt to write this RAM as data memory when PGRM = 1, does not modify any of these locations. TBLWT instructions to these locations will cause writes to occur on the external memory bus. The boot RAM program memory cannot be modified using TBLWT instruction. TBLRD instructions from boot RAM will read memory located on the external memory bus, not from the on-board RAM. Constants that are stored in boot RAM are retrieved using the RETLW instruction.

The default RESET state (power-up) for the PGRM bit is '0', which configures 1.5K of data RAM and all program memory as external. The PGRM bit can be set and cleared in the software.

When execution takes place from "Boot RAM", the external system bus and all of its control signals will be deactivated. If execution takes place from outside of "Boot RAM", the external system bus and all of its control signals are activated again.

Figure 4-3 and Figure 4-4 show the program memory map and stack for PIC18C601 and PIC18C801, when the PGRM bit is set.

FIGURE 4-1: PROGRAM MEMORY MAP
AND STACK FOR

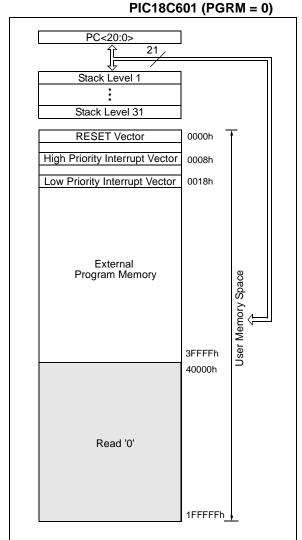
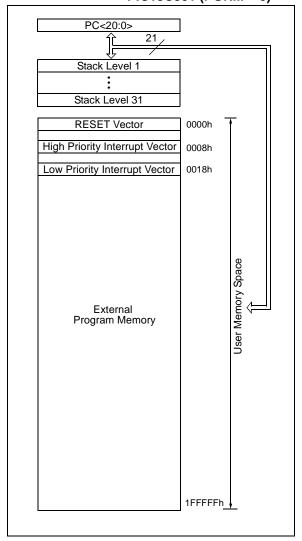
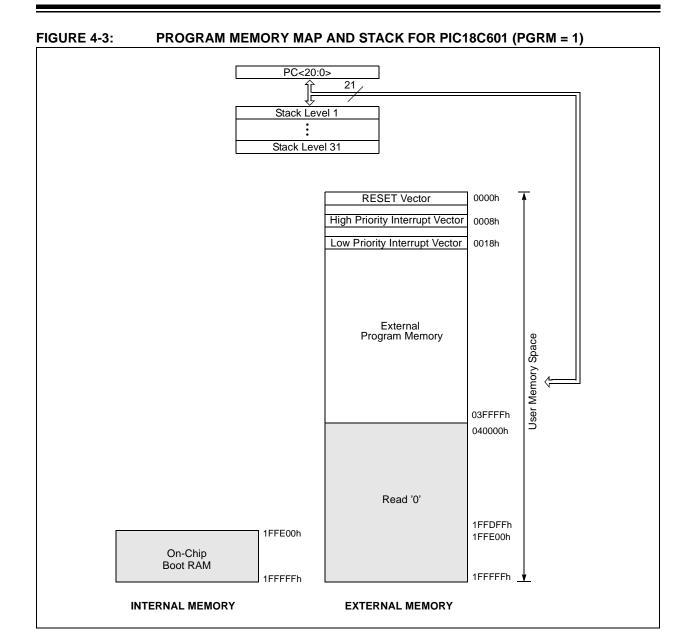
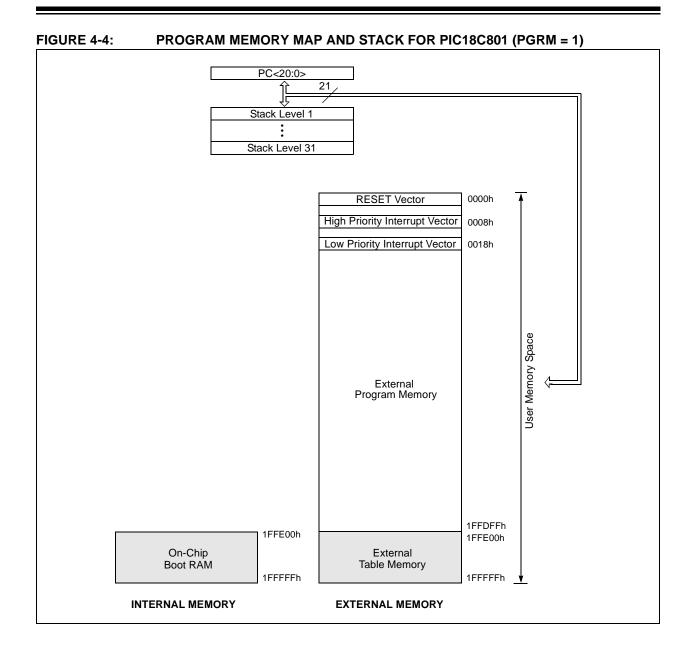


FIGURE 4-2: PROGRAM MEMORY MAP AND STACK FOR PIC18C801 (PGRM = 0)







4.1.2 BOOT LOADER

When configured as Program Memory, Boot RAM can be used as a temporary "Boot Loader" for programming purposes. If an external memory device is used as program memory, any updates performed by the user program will have to be performed in the "Boot RAM", because the user program cannot program and fetch from external memory, simultaneously.

A typical boot loader execution and external memory programming sequence would be as follows:

- The boot loader program is transferred from the external program memory to the last 2 banks of data RAM by TBLRD and MOVWF instructions.
- Once the "boot loader" program is loaded into internal memory and verified, open combination lock and set PGRM bit to configure the data RAM into program RAM.
- Jump to beginning of Boot code in Boot RAM.
 Program execution begins in Boot RAM to begin programming the external memory. System bus changes to an inactive state.
- Boot loader program performs the necessary external TBLWT and TBLWRD instructions to perform programming functions.
- When the boot loader program is finished programming external memory, jump to known valid external program memory location and clear PGRM bit in MEMCON register to set Boot RAM as data memory, or reset the part.

4.2 Return Address Stack

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC (Program Counter) is pushed onto the stack when a PUSH, CALL or RCALL instruction is executed, or an interrupt is acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. PCLATU and PCLATH are not affected by any of the return instructions.

The stack operates as a 31-word by 21-bit stack memory and a five-bit stack pointer, with the stack pointer initialized to 00000b after all RESETS. There is no RAM associated with stack pointer 00000b. This is only a RESET value. During a CALL type instruction, causing a push onto the stack, the stack pointer is first incremented and the RAM location pointed to by the stack pointer is written with the contents of the PC. During a RETURN type instruction, causing a pop from the stack, the contents of the RAM location indicated by the STKPTR is transferred to the PC and then the stack pointer is decremented.

The stack space is not part of either program or data space. The stack pointer is readable and writable, and the data on the top of the stack is readable and writable through SFR registers. Status bits STKOVF and STKUNF in STKPTR register, indicate whether stack over/underflow has occurred or not.

4.2.1 TOP-OF-STACK ACCESS

The top of the stack is readable and writable. Three register locations, TOSU, TOSH and TOSL, allow access to the contents of the stack location indicated by the STKPTR register. This allows users to implement a software stack, if necessary. After a CALL, RCALL or interrupt, the software can read the pushed value by reading the TOSU, TOSH and TOSL registers. These values can be placed on a user defined software stack. At return time, the software can replace the TOSU, TOSH and TOSL and do a return.

The user should disable the global interrupt enable bits during this time to prevent inadvertent stack operations.

4.2.2 RETURN STACK POINTER (STKPTR)

The STKPTR register contains the stack pointer value, the STKFUL (stack full) status bit, and the STKUNF (stack underflow) status bits. Register 4-1 shows the STKPTR register. The value of the stack pointer can be 0 through 31. The stack pointer increments when values are pushed onto the stack and decrements when values are popped off the stack. At RESET, the stack pointer value will be 0. The user may read and write the stack pointer value. This feature can be used by a Real Time Operating System for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit can only be cleared in software or by a POR. Any subsequent push operation that causes stack overflow will be ignored.

The action that takes place when the stack becomes full, depends on the state of STVREN (stack overflow RESET enable) configuration bit in CONFIG4L register. Refer to Section 4.2.4 for more information. If STVREN is set (default), stack over/underflow will set the STKFUL bit, and reset the device. The STKFUL bit will remain set and the stack pointer will be set to 0.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the stack pointer will increment to 31. All subsequent push attempts will be ignored and STKPTR remains at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and sets the STKUNF bit, while the stack pointer remains at 0. The STKUNF bit will remain set until cleared in software, or a POR occurs.

Note: Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the RESET vector, where the stack conditions can be verified and appropriate actions can be taken.

REGISTER 4-1: STKPTR - STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL	STKUNF	_	SP4	SP3	SP2	SP1	SP0
bit 7							bit 0

bit 7 STKFUL: Stack Full Flag bit

1 = Stack became full or overflowed

0 = Stack has not become full or overflowed

bit 6 STKUNF: Stack Underflow Flag bit

1 = Stack underflow occurred

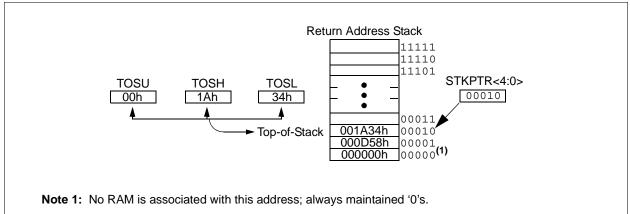
0 = Stack underflow did not occur

bit 5 Unimplemented: Read as '0'

bit 4-0 SP4:SP0: Stack Pointer Location bits

Note: Bit 7 and bit 6 can only be cleared in user software, or by a POR.

FIGURE 4-5: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



4.2.3 PUSH AND POP INSTRUCTIONS

Since the Top-of-Stack (TOS) is readable and writable, the ability to push values onto the stack and pop values off the stack, without disturbing normal program execution, is a desirable option. To push the current PC value onto the stack, a PUSH instruction can be executed. This will increment the stack pointer and load the current PC value onto the stack. TOSU, TOSH and TOSL can then be modified to place a return address on the stack.

The POP instruction discards the current TOS by decrementing the stack pointer. The previous value pushed onto the stack then becomes the TOS value.

4.2.4 STACK FULL/UNDERFLOW RESETS

These RESETS are enabled/disabled by programming the STVREN configuration bit in CONFIG4L register.

When the STVREN bit is disabled, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a RESET. When the STVREN bit is enabled, a full or underflow will set the appropriate STKFUL or STKUNF bit and then cause a RESET. The STKFUL or STKUNF bits are only cleared by the user software or a POR.

4.3 Fast Register Stack

A "fast return" option is available for interrupts and calls. A fast register stack is provided for the STATUS, WREG and BSR registers, and is only one layer in depth. The stack is not readable or writable and is loaded with the current value of the corresponding register when the processor vectors for an interrupt. The values in the fast register stack are then loaded back into the working registers, if the fast return instruction is used to return from the interrupt.

A low or high priority interrupt source will push values into the stack registers. If both low and high priority interrupts are enabled, the stack registers cannot be used reliably for low priority interrupts. If a high priority interrupt occurs while servicing a low priority interrupt, the stack register values stored by the low priority interrupt will be overwritten.

If high priority interrupts are not disabled during low priority interrupts, users must save the key registers in software during a low priority interrupt.

If no interrupts are used, the fast register stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the fast register stack for a subroutine call, a fast call instruction must be executed.

Example 4-1 shows a source code example that uses the fast register stack.

EXAMPLE 4-1: FAST REGISTER STACK CODE EXAMPLE

```
CALL SUB1, FAST ;STATUS, WREG, BSR
;SAVED IN FAST REGISTER
;STACK

SUB1

RETURN FAST ;RESTORE VALUES SAVED
;IN FAST REGISTER STACK
```

4.4 PCL, PCLATH and PCLATU

The program counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21-bits wide. The low byte is called the PCL register. This register is readable and writable. The high byte is called the PCH register. This register contains the PC<15:8> bits and is not directly readable or writable. Updates to the PCH register may be performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits and is not directly readable or writable. Updates to the PCU register may be performed through the PCLATU register.

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the LSb of the PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

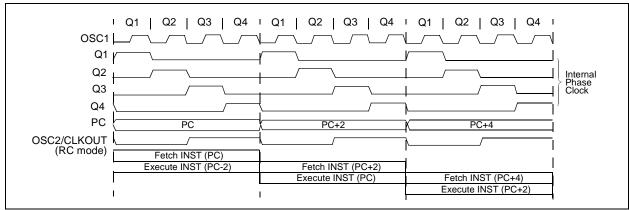
The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

The contents of PCLATH and PCLATU will be transferred to the program counter by an operation that writes PCL. Similarly, the upper two bytes of the program counter will be transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (See Section 4.8.1).

4.5 Clocking Scheme/Instruction Cycle

The clock input (from OSC1 or PLL output) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 4-6.





4.6 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined, such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO), two cycles are required to complete the instruction (Example 4-2).

A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register" (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

4.7 Instructions in Program Memory

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = '0'). Figure 4-1 shows an example of how instruction words are stored in the program memory. To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSB will always read '0' (see Section 4.4).

The CALL and GOTO instructions have an absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1>, which accesses the desired byte address in program memory. Instruction #2 in Figure 4-1 shows how the instruction "GOTO 0x06" is encoded in the program memory. Program branch instructions that encode a relative address offset operate in the same manner. The offset value stored in a branch instruction represents the number of single word instructions by which the PC will be offset. Section 20.0 provides further details of the instruction set.

EXAMPLE 4-2: INSTRUCTION PIPELINE FLOW

				_			
		Tcy0	Tcy1	Tcy2	Tcy3	Tcy4	Tcy5
		ICYU	ICYI	ICYZ	ICYS	1014	1015
1. MOVLW 55	h	Fetch 1	Execute 1				
2. MOVWF PO	RTB		Fetch 2	Execute 2		_	
3. BRA SUB_	1			Fetch 3	Execute 3		
4. BSF PO	RTA, BIT3	(Forced NOP)			Fetch 4	Flush	
5. Instruct	ion @ addr	ess SUB_1				Fetch SUB_1	Execute SUB_1

All instructions are single cycle, except for any program branches. These take two cycles, since the fetch instruction is "flushed" from the pipeline, while the new instruction is being fetched and then executed.

TABLE 4-1: INSTRUCTIONS IN PROGRAM MEMORY

Instruction	Opcode	Memory	Address
_	_	_	000007h
MOVLW 055h	0E55h	55h	000008h
		0Eh	000009h
GOTO 000006h	EF03h, F000h	03h	00000Ah
		EFh	00000Bh
		00h	00000Ch
		F0h	00000Dh
MOVFF 123h, 456h	C123h, F456h	23h	00000Eh
		C1h	00000Fh
		56h	000010h
		F4h	000011h
_	_	_	000012h

4.7.1 TWO-WORD INSTRUCTIONS

PIC18C601/801 devices have four two-word instructions: MOVFF, CALL, GOTO and LFSR. The second word of these instructions has the four MSB's set to 1's and is a special kind of NOP instruction. The lower 12 bits of the second word contain data to be used by the instruction. If the first word of the instruction is executed, the data in the second word is accessed. If the second word of the instruction is executed by itself (first word was skipped), it will execute as a NOP. This action is necessary when the two-word instruction is preceded by a conditional instruction that changes the PC and skips one instruction. A program example that demonstrates this concept is shown in Example 4-3. Refer to Section 19.0 for further details of the instruction set.

4.8 Lookup Tables

Lookup tables are implemented two ways:

- Computed GOTO
- · Table Reads

4.8.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL).

A lookup table can be formed with an ADDWF PCL instruction and a group of RETLW 0xnn instructions. WREG is loaded with an offset into the table, before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW 0xnn instructions that returns the value 0xnn to the calling function.

The offset value (value in WREG) specifies the number of bytes that the program counter should advance.

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

Warning: The LSb of the PCL is fixed to a value of '0'. Hence, computed GOTO to an odd address is not possible.

4.8.2 TABLE READS/TABLE WRITES

A better method of storing data in program memory allows 2 bytes of data to be stored in each instruction location.

Lookup table data may be stored as 2 bytes per program word by using table reads and writes. The table pointer (TBLPTR) specifies the byte address and the table latch (TABLAT) contains the data that is read from, or written to, program memory. Data is transferred to/from program memory one byte at a time.

A description of the Table Read/Table Write operation is shown in Section 6.0.

Note: If execution is taking place from Boot RAM Program Memory, RETLW instructions must be used to read lookup values from the Boot RAM itself.

EXAMPLE 4-3: Two-Word Instructions

		CA	SE 1:								
Object Code	Object Code Source Code										
0110 0110 0000 0000	TSTFSZ	REG1	; is RAM location 0?								
1100 0001 0010 0011	MOVFF	REG1, REG2	; No, execute 2-word instruction								
1111 0100 0101 0110			; 2nd operand holds address of REG2								
0010 0100 0000 0000	ADDWF	REG3	; continue code								
		CA	SE 2:								
Object Code			Source Code								
0110 0110 0000 0000	TSTFSZ	REG1	; is RAM location 0?								
1100 0001 0010 0011	MOVFF	REG1, REG2	; Yes								
1111 0100 0101 0110			; 2nd operand executed as NOP								
0010 0100 0000 0000	ADDWF	REG3	; continue code								

4.9 Data Memory Organization

The data memory is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. Figure 4-8 shows the data memory organization for PIC18C601/801 devices.

The data memory map is divided into banks that contain 256 bytes each. The lower four bits of the Bank Select Register (BSR<3:0>) select which bank will be accessed. The upper 4 bits for the BSR are not implemented.

The data memory contains Special Function Registers (SFR) and General Purpose Registers (GPR). The SFR's are used for control and status of the controller and peripheral functions, while GPR's are used for data storage and scratch pad operations in the user's application. The SFR's start at the last location of Bank 15 (0FFFh) and grow downwards. GPR's start at the first location of Bank 0 and grow upwards. Any read of an unimplemented location will read as '0's.

GPR banks 4 and 5 serve as a Program Memory called "Boot RAM", when PGRM bit in MEMCON is set. When PGRM bit is set, any read from "Boot RAM" returns '0's, while any write to it is ignored.

The entire data memory may be accessed directly or indirectly. Direct addressing may require the use of the BSR register. Indirect addressing requires the use of a File Select Register (FSR). Each FSR holds a 12-bit address value that can be used to access any location in the Data Memory map without banking.

The instruction set and architecture allow operations across all banks. This may be accomplished by indirect addressing, or by the use of the MOVFF instruction. The MOVFF instruction is a two-word/two-cycle instruction that moves a value from one register to another.

To ensure that commonly used registers (SFRs and select GPRs) can be accessed in a single cycle, regardless of the current BSR values, an Access Bank is implemented. A segment of Bank 0 and a segment of Bank 15 comprise the Access bank. Section 4.10 provides a detailed description of the Access bank.

4.9.1 GENERAL PURPOSE REGISTER FILE

The register file can be accessed either directly or indirectly. Indirect addressing operates through the File Select Registers (FSR). The operation of indirect addressing is shown in Section 4.12.

PIC18C601/801 devices have banked memory in the GPR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other RESETS.

Data RAM is available for use as GPR registers by all instructions. Bank 15 (0F80h to 0FFFh) contains SFR's. All other banks of data memory contain GPR registers starting with bank 0.

4.9.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and Peripheral Modules for controlling the desired operation of the device. These registers are implemented as static RAM. A list of these registers is given in Table 4-2.

The SFR's can be classified into two sets: those associated with the "core" function and those related to the peripheral functions. Those registers related to the "core" are described in this section, while those related to the operation of the peripheral features are described in the section of that peripheral feature.

The SFRs are typically distributed among the peripherals whose functions they control.

The unused SFR locations are unimplemented and read as '0's. See Table 4-2 for addresses for the SFRs.

4.9.3 SECURED ACCESS REGISTERS

PIC18C601/801 devices contain software programming options for safety critical peripherals. Because these safety critical peripherals can be programmed in software, registers used to control these peripherals are given limited access by the user code. This way, errant code will not accidentally change settings in peripherals that could cause catastrophic results.

The registers that are considered safety critical are the Watchdog Timer register (WDTCON), the External Memory Control register (MEMCON), the Oscillator Control register (OSCCON) and the Chip Select registers (CSSEL2 and CSELIO).

Two bits called Combination Lock (CMLK) bits, located in the lower two bits of the PSPCON register, must be set in sequence by user code to gain access to Secured Access registers.

REGISTER 4-2: PSPCON REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	W-0	W-0
_	_	_	_	_		CMLK1	CMLK0
bit 7							bit 0

bit 7-2 **Unimplemented**: Read as '0' bit 1-0 **CMLK<1:0>**: Combination Lock bits

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown	1

The Combination Lock bits must be set sequentially, meaning that as soon as Combination Lock bit CMLK1 is set, the second Combination Lock bit CMLK0 must be set on the following instruction cycle. If user waits more than one machine cycle to set the second bit after setting the first, both bits will automatically be cleared in hardware and the lock will remain closed. To satisfy this condition, all interrupts must be disabled before attempting to unlock the Combination Lock. Once secured registers are modified, interrupts may be re-enabled.

Each instruction must only modify one combination lock bit at a time. This means, user code must use the BSF instruction to set CMLK bits in the PSPCON register.

Note: The Combination Lock bits are write-only bits. These bits will always return '0' when read.

When the Combination Lock is opened, the user will have three instruction cycles to modify the safety critical register of choice. After three instruction cycles have expired, the CMLK bits are cleared, the lock will close and the user will have to set the CMLK bits again, in order to open the lock. Since there are only three instruction cycles allowed after the Combination Lock is opened, if a subroutine is used to unlock Combination Lock bits, user code must preload WREG with the desired value, call unlock subroutine, and write to the desired safety critical register itself.

Note: Successive attempts to unlock the Combination Lock must be separated by at least three instruction cycles.

EXAMPLE 4-4: COMBINATION UNLOCK SUBROUTINE EXAMPLE CODE

```
MOVLW 5Ah ; Preload WREG with data to be stored in a safety critical register BCF INTCON, GIE ; Disable all interrupts
CALL UNLOCK ; Now unlock it ; Write must take place in next instruction cycle

MOVWF OSCCON ; Lock is closed

BSF INTCON, GIE ; Re-enable interrupts

•

UNLOCK
BSF PSPCON, CMLK1
BSF PSPCON, CMLK1
RETURN

•
```

EXAMPLE 4-5: COMBINATION UNLOCK MACRO EXAMPLE CODE

```
UNLOCK_N_MODIFY @REG MACRO

BCF INTCON, GIE ; Disable interrupts

BSF PSPCON, CMLK1

BSF PSPCON, CMLK0

MOVWF @REG ; Modify given register

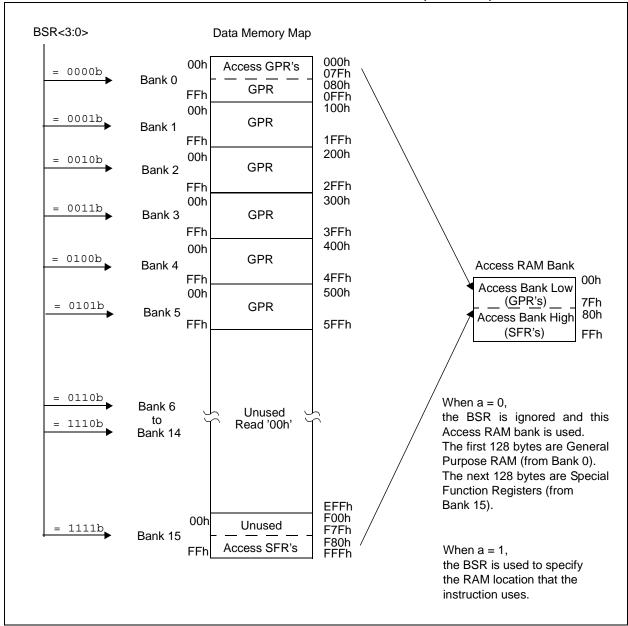
BSF INTCON, GIE ; Enable interrupts

ENDM

MOVLW 5Ah ; Preload WREG for OSCCON register

UNLOCK_N_MODIFY OSCCON ; Modify OSCCON
```

FIGURE 4-7: THE DATA MEMORY MAP FOR PIC18C801/601 (PGRM = 0)



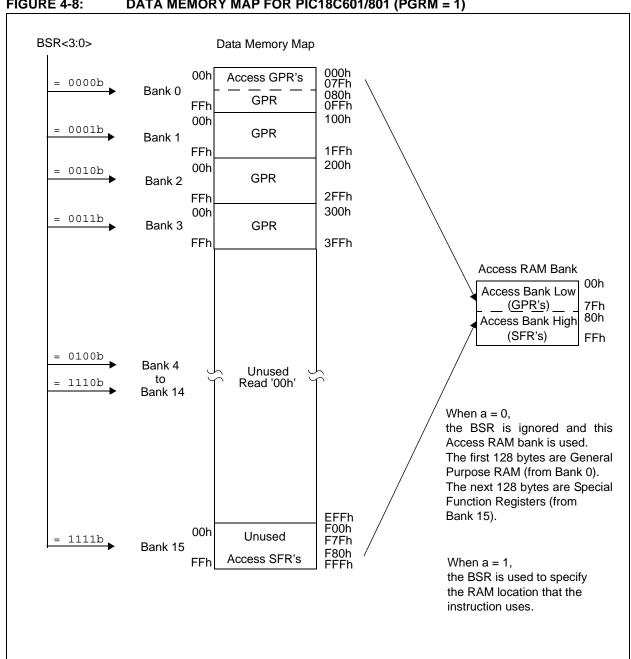


FIGURE 4-8: DATA MEMORY MAP FOR PIC18C601/801 (PGRM = 1)

FIGURE 4-9: SPECIAL FUNCTION REGISTER MAP

FFFh	TOSU	FDFh	INDF2	FBFh	CCPR1H	F9Fh	IPR1
FFEh	TOSH	FDEh	POSTINC2	FBEh	CCPR1L	F9Eh	PIR1
FFDh	TOSL	FDDh	POSTDEC2	FBDh	CCP1CON	F9Dh	PIE1
FFCh	STKPTR	FDCh	PREINC2	FBCh	CCPR2H	F9Ch	MEMCON
FFBh	PCLATU	FDBh	PLUSW2	FBBh	CCPR2L	F9Bh	_
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON	F9Ah	TRISJ
FF9h	PCL	FD9h	FSR2L	FB9h	Reserved	F99h	TRISH
FF8h	TBLPTRU	FD8h	STATUS	FB8h	Reserved	F98h	TRISG
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	Reserved	F97h	TRISF
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	_	F96h	TRISE
FF5h	TABLAT	FD5h	T0CON	FB5h	_	F95h	TRISD
FF4h	PRODH	FD4h	Reserved	FB4h	_	F94h	TRISC
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB
FF2h	INTCON	FD2h	LVDCON	FB2h	TMR3L	F92h	TRISA
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	LATJ
FF0h	INTCON3	FD0h	RCON	FB0h	PSPCON	F90h	LATH
FEFh	INDF0	FCFh	TMR1H	FAFh	SPBRG	F8Fh	LATG
FEEh	POSTINC0	FCEh	TMR1L	FAEh	RCREG	F8Eh	LATF
FEDh	POSTDEC0	FCDh	T1CON	FADh	TXREG	F8Dh	LATE
FECh	PREINC0	FCCh	TMR2	FACh	TXSTA	F8Ch	LATD
FEBh	PLUSW0	FCBh	PR2	FABh	RCSTA	F8Bh	LATC
FEAh	FSR0H	FCAh	T2CON	FAAh	_	F8Ah	LATB
FE9h	FSR0L	FC9h	SSPBUF	FA9h	_	F89h	LATA
FE8h	WREG	FC8h	SSPADD	FA8h	_	F88h	PORTJ
FE7h	INDF1	FC7h	SSPSTAT	FA7h	CSEL2	F87h	PORTH
FE6h	POSTINC1	FC6h	SSPCON1	FA6h	CSELIO	F86h	PORTG
FE5h	POSTDEC1	FC5h	SSPCON2	FA5h	_	F85h	PORTF
FE4h	PREINC1	FC4h	ADRESH	FA4h	_	F84h	PORTE
FE3h	PLUSW1	FC3h	ADRESL	FA3h	_	F83h	PORTD
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA

TABLE 4-2: REGISTER FILE SUMMARY - PIC18C601/801

IADL	E 4-2:	2: REGISTER FILE SUMMARY - PIC18C601/801								1	
Fil	e Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS ⁽¹⁾
FFFh	TOSU	1	I	1	Top-of-Stac	ck Upper Byte	e (TOS<20:16	6>)		0 0000	0 0000
FFEh	TOSH	Top-of-Stack	High Byte (To	OS<15:8>)						0000 0000	0000 0000
FFDh	TOSL	Top-of-Stack	Low Byte (TC	OS<7:0>)						0000 0000	0000 0000
FFCh	STKPTR	STKOVF	STKUNF	_	Return Sta	ck Pointer				00-0 0000	00-0 0000
FFBh	PCLATU	-		1	Holding Re	gister for PC	<20:16>			0 0000	0 0000
FFAh	PCLATH	Holding Regi	olding Register for PC<15:8>								0000 0000
FF9h	PCL	PC Low Byte	C Low Byte (PC<7:0>)								0000 0000
FF8h	TBLPTRU	_	_	r	Program M	emory Table I	Pointer Upper	Byte (TBLPT	R<20:16>)	r0 0000	r0 0000
FF7h	TBLPTRH	Program Mei	mory Table Po	ointer High Byt	te (TBLPTR<	<15:8>)				0000 0000	0000 0000
FF6h	TBLPTRL	Program Mei	mory Table Po	ointer Low Byte	e (TBLPTR<	7:0>)				0000 0000	0000 0000
FF5h	TABLAT	Program Mei	mory Table La	itch						0000 0000	0000 0000
FF4h	PRODH	Product Reg	ister High Byt	е						xxxx xxxx	uuuu uuuu
FF3h	PRODL	Product Reg	ister Low Byte)						xxxx xxxx	uuuu uuuu
FF2h	INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0E	RBIE	TMR0IF	INT0F	RBIF	0000 000x	0000 000u
FF1h	INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	_	T0IP	_	RBIP	1111 -1-1	1111 -1-1
FF0h	INTCON3	INT2P	INT1P	_	INT2E	INT1E	_	INT2F	INT1F	11-0 0-00	11-0 0-00
FEFh	INDF0	Uses conten	ts of FSR0 to	address data	memory - va	lue of FSR0	not changed	(not a physic	al register)	N/A	N/A
FEEh	POSTINC0	Uses content	s of FSR0 to a	ddress data m	emory - value	e of FSR0 pos	st-incremente	d (not a physi	cal register)	N/A	N/A
FEDh	POSTDEC0	Uses content (not a physical		ddress data m	emory - value	e of FSR0 pos	st-decremente	ed		N/A	N/A
FECh	PREINC0	Uses content (not a physic		address data	memory - va	lue of FSR0	pre-incremen	ited		N/A	N/A
FEBh	PLUSW0	Uses content (not a physic		address data	memory -val	ue of FSR0 o	offset by WRE	ĒG		N/A	N/A
FEAh	FSR0H		l	ı	_	Indirect Dat	ta Memory Ad	ddress Pointe	r 0 High	xxxx	uuuu
FE9h	FSR0L	Indirect Data	Memory Add	ress Pointer 0	Low Byte					xxxx xxxx	uuuu uuuu
FE8h	WREG	Working Reg	jister							xxxx xxxx	uuuu uuuu
FE7h	INDF1	Uses conten	ts of FSR1 to	address data	memory - va	lue of FSR1	not changed	(not a physic	al register)	N/A	N/A
FE6h	POSTINC1	Uses content (not a physic		address data	memory - va	lue of FSR1	post-increme	nted		N/A	N/A
FE5h	POSTDEC1	Uses content (not a physic		address data	memory - va	lue of FSR1	post-decreme	ented		N/A	N/A
FE4h	PREINC1	Uses content	s of FSR1 to a	address data m	nemory - valu	e of FSR1 pr	e-incremente	d (not a physi	cal register)	N/A	N/A
FE3h	PLUSW1	Uses content	s of FSR1 to a	address data m	emory - valu	ue of FSR1 of	fset by WREC	G (not a physi	cal register)	N/A	N/A
FE2h	FSR1H	_	_	_	_	Indirect Dat	ta Memory A	ddress Pointe	er 1 High	xxxx	uuuu
FE1h	FSR1L	Indirect Data	Memory Add	ress Pointer 1	Low Byte					xxxx xxxx	uuuu uuuu
FE0h	BSR	_	_	-	_	Bank Selec	t Register			0000	0000
FDFh	INDF2	Uses contents of FSR2 to address data memory - value of FSR2 not changed (not a physical registe							al register)	N/A	N/A
FDEh	POSTINC2	Uses contents of FSR2 to address data memory - value of FSR2 post-incremented (not a physical regis						cal register)	N/A	N/A	
FDDh	POSTDEC2		Jses contents of FSR2 to address data memory - value of FSR2 post-decremented not a physical register)							N/A	N/A
FDCh	PREINC2	Uses content	Uses contents of FSR2 to address data memory - value of FSR2 pre-incremented (not a physical register)						N/A	N/A	
FDBh	PLUSW2	Uses contents of FSR2 to address data memory -value of FSR2 offset by WREG (not a physical registe						cal register)	N/A	N/A	
FDAh	FSR2H			_	_	Indirect Dat	ta Memory A	ddress Pointe	er 2 High	xxxx	uuuu
FD9h	FSR2L	Indirect Data	ndirect Data Memory Address Pointer 2 Low Byte							xxxx xxxx	uuuu uuuu
FD8h	STATUS	_	_	_	N	OV	Z	DC	С	x xxxx	u uuuu
Legend	_				r = value der		1977				

 $\mbox{Legend} \qquad \mbox{$x=$ unknown, $u=$ unchanged, $-=$ unimplemented, $q=$ value depends on condition, $r=$ reserved}$

Note 1: Other (non-power-up) RESETS include external RESET through MCLR and Watchdog Timer Reset.

^{2:} These registers can only be modified when the Combination Lock is open.

^{3:} These registers are available on PIC18C801 only.

REGISTER FILE SUMMARY - PIC18C601/801 (CONTINUED) TABLE 4-2:

IADL	C 4-Z:	KEGISTE		DUNINAR	1 -1 10 10	0001700	1 (0014)	IIIVULD)			
Fi	le Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS ⁽¹⁾
FD7h	TMR0H	Timer0 Regis	ster High Byte)						0000 0000	0000 0000
FD6h	TMR0L	Timer0 Regis	ster Low Byte							xxxx xxxx	uuuu uuuu
FD5h	T0CON	TMR0ON	16BIT	TOCS	TOSE	T0PS3	T0PS2	T0PS1	T0PS0	1111 1111	1111 1111
FD4h	Reserved			•		•		•		rrrr rrrr	rrrr rrrr
FD3h	OSCCON(2)	_	_	_	_	LOCK	PLLEN	SCS1	SCS0	0000	uuu0
FD2h	LVDCON ⁽²⁾	_	_	IRVST	LVDEN	LVV3	LVV2	LVV1	LVV0	00 0101	00 0101
FD1h	WDTCON(2)	_	_	_	_	WDPS2	WDPS1	WDPS0	SWDTEN	0000	xxxx
FD0h	RCON	IPEN	r	_	RI	TO	PD	POR	r	00-1 11qq	00-q qquu
FCFh	TMR1H	Timer1 Regis	ster High Byte)						xxxx xxxx	uuuu uuuu
FCEh	TMR1L	Timer1 Regis	ster Low Byte							xxxx xxxx	uuuu uuuu
FCDh	T1CON	RD16	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	0-00 0000	u-uu uuuu
FCCh	TMR2	Timer2 Regis	ster							0000 0000	0000 0000
FCBh	PR2	Timer2 Perio	d Register							1111 1111	1111 1111
FCAh	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
FC9h	SSPBUF	SSP Receive	Buffer/Trans	mit Register						xxxx xxxx	uuuu uuuu
FC8h	SSPADD	SSP Address	s Register in I	² C Slave Mod	e. SSP Baud	Rate Reload	d Register in	I ² C Master M	lode	0000 0000	0000 0000
FC7h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000
FC6h	SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
FC5h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
FC4h	ADRESH	A/D Result R	Register High	Byte						xxxx xxxx	uuuu uuuu
FC3h	ADRESL	A/D Result R	Register Low E	Byte						xxxx xxxx	uuuu uuuu
FC2h	ADCON0	_	1	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	00 0000	00 0000
FC1h	ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	00 0000	00 0000
FC0h	ADCON2	ADFM	1	_	_	_	ADCS2	ADCS1	ADCS0	0000	0000
FBFh	CCPR1H	Capture/Con	npare/PWM R	egister1 High	Byte					xxxx xxxx	uuuu uuuu
FBEh	CCPR1L	Capture/Con	npare/PWM R	egister1 Low I	Byte					xxxx xxxx	uuuu uuuu
FBDh	CCP1CON	_	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
FBCh	CCPR2H	Capture/Con	npare/PWM R	egister2 High	Byte					xxxx xxxx	uuuu uuuu
FBBh	CCPR2L	Capture/Con	npare/PWM R	egister2 Low I	Byte					xxxx xxxx	uuuu uuuu
FBAh	CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	uu uuuu
FB9h	Reserved									rrrr rrrr	rrrr rrrr
FB8h	Reserved									rrrr rrrr	rrrr rrrr
FB7h	Reserved									rrrr rrrr	rrrr rrrr
FB6h											
FB5h											
FB4h											
FB3h	TMR3H	Timer3 Regis	imer3 Register High Byte								uuuu uuuu
FB2h	TMR3L	Timer3 Regis	ster Low Byte		xxxx xxxx	uuuu uuuu					
FB1h	T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	0000 0000	uuuu uuuu
Legend	v = unkno	wn, u = uncha	angod – uni	mplomontod a	- value der	onds on con	dition == ro	corvod			

x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved

Note 1: Other (non-power-up) RESETS include external RESET through MCLR and Watchdog Timer Reset.

^{2:} These registers can only be modified when the Combination Lock is open.
3: These registers are available on PIC18C801 only.

TABLE 4-2: REGISTER FILE SUMMARY - PIC18C601/801 (CONTINUED)

IADL	E 4-2:	REGISTER FILE SUMMARY - PIC18C601/801 (CONTINUED)										
Fi	le Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS ⁽¹⁾	
FB0h	PSPCON	_	_	_	_	_	_	CMLK1	CMLK0	00	00	
FAFh	SPBRG	USART Bau	d Rate Genera	ator						0000 0000	0000 0000	
FAEh	RCREG	USART Rece	eive Register							0000 0000	0000 0000	
FADh	TXREG	USART Tran	smit Register		0000 0000	0000 0000						
FACh	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010	
FABh	RCSTA	SPEN	RX9	RX9D	0000 000x	0000 000x						
FAAh												
FA9h												
FA8h												
FA7h	CSEL2 ⁽²⁾	CSL7	CSL6	CSL5	CSL4	CSL3	CSL2	CSL1	CSL0	1111 1111	uuuu uuuu	
FA6h	CSELIO ⁽²⁾	CSIO7	CSIO6	CSIO5	CSIO4	CSIO3	CSIO2	CSIO1	CSIO0	1111 1111	uuuu uuuu	
FA5h												
FA4h												
FA3h												
FA2h	IPR2	-	_	_	_	BCLIP	LVDIP	TMR3IP	CCP2IP	1111	1111	
FA1h	PIR2	1	-	-	_	BCLIF	LVDIF	TMR3IF	CCP2IF	0000	0000	
FA0h	PIE2	1	-		_	BCLIE	LVDIE	TMR3IE	CCP2IE	0000	0000	
F9Fh	IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-111 1111	-111 1111	
F9Eh	PIR1	1	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000	
F9Dh	PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000	
F9Ch	MEMCON ⁽²⁾	EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	000000	000000	
F9Bh									•			
F9Ah	TRISJ ⁽³⁾	Data Direction	on Control Reg	gister for POR	TJ					1111 1111	1111 1111	
F99h	TRISH(3)	Data Direction	on Control Reg	gister for POR	TH					1111 1111	1111 1111	
F98h	TRISG	-	_	_	Read POR	TG Data Late	ch, Write POF	RTG Data Lat	tch	1 1111	1 1111	
F96h	TRISF	Read PORTI	F Data Latch,	Write PORTF	Data Latch					1111 1111	1111 1111	
F96h	TRISE	Data Direction	on Control Reg	gister for POR	TE					1111 1111	1111 1111	
F95h	TRISD	Data Direction	on Control Reg	gister for POR	TD					1111 1111	1111 1111	
F94h	TRISC	Data Direction	on Control Reg	gister for POR	тс					1111 1111	1111 1111	
F93h	TRISB	Data Direction	on Control Reg	gister for POR	ТВ					1111 1111	1111 1111	
F92h	TRISA	-	_	Data Direction	n Control Re	gister for PO	RTA			11 1111	11 1111	
F91h	LATJ ⁽³⁾	Read PORT	J Data Latch,	Write PORTJ I	Data Latch					xxxx xxxx	uuuu uuuu	
F90h	LATH ⁽³⁾	Read PORTI	H Data Latch,	Write PORTH	Data Latch					xxxx xxxx	uuuu uuuu	
F8Fh	LATG	-	_	_	Read POR	TG Data Late	ch, Write POF	RTG Data Lat	tch	x xxxx	u uuuu	
F8Eh	LATF	Read PORTI	Read PORTF Data Latch, Write PORTF Data Latch								uuuu uuuu	
F8Dh	LATE	Read PORTE Data Latch, Write PORTE Data Latch								xxxx xxxx	uuuu uuuu	
F8Ch	LATD	Read PORTI	Read PORTD Data Latch, Write PORTD Data Latch									
F8Bh	LATC	Read PORT	C Data Latch,	Write PORTC	Data Latch					xxxx xxxx	uuuu uuuu	
F8Ah	LATB	Read PORTI	B Data Latch,	Write PORTB	Data Latch					xxxx xxxx	uuuu uuuu	
F89h	LATA	_	_	Read PORTA	Data Latch,	Write PORT	A Data Latch	l		xx xxxx	uu uuuu	
F88h	PORTJ ⁽³⁾	Read PORT	J Pins, Write F	PORTJ Data La	atch					xxxx xxxx	uuuu uuuu	
F87h	PORTH ⁽³⁾									xxxx xxxx	uuuu uuuu	
F86h	PORTG	_	d PORTH pins, Write PORTH Data Latch Read PORTG pins, Write PORTG Data Latch x xxxx									
F85h	PORTF	Read PORTI	F pins, Write F	PORTF Data L	l					xxxx xx00	uuuu uu00	
Legend				mplemented o			1111					

x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved

Note 1: Other (non-power-up) RESETS include external RESET through MCLR and Watchdog Timer Reset.

^{2:} These registers can only be modified when the Combination Lock is open.
3: These registers are available on PIC18C801 only.

REGISTER FILE SUMMARY - PIC18C601/801 (CONTINUED) **TABLE 4-2:**

Fil	le Name	Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0								Value on POR	Value on all other RESETS ⁽¹⁾
F84h	PORTE	Read PORTI	E Pins, Write	PORTE Data L	_atch					xxxx xxxx	uuuu uuuu
F83h	PORTD	Read PORTI	D pins, Write I	PORTD Data L	_atch					xxxx xxxx	uuuu uuuu
F82h	PORTC	Read PORT	C pins, Write I	PORTC Data L	_atch					xxxx xxxx	uuuu uuuu
F81h	PORTB	Read PORTE	Read PORTB pins, Write PORTB Data Latch								
F80h	PORTA	Read PORTA pins, Write PORTA Data Latch									0u 0000

x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved

Note 1: Other (non-power-up) RESETS include external RESET through MCLR and Watchdog Timer Reset.
 2: These registers can only be modified when the Combination Lock is open.
 3: These registers are available on PIC18C801 only.

4.10 Access Bank

The Access Bank is an architectural enhancement that is very useful for C compiler code optimization. The techniques used by the C compiler are also useful for programs written in assembly.

This data memory region can be used for:

- · Intermediate computational values
- · Local variables of subroutines
- · Faster context saving/switching of variables
- Common variables
- Faster evaluation/control of SFR's (no banking)

The Access Bank is comprised of the upper 128 bytes in Bank 15 (SFR's) and the lower 128 bytes in Bank 0. These two sections will be referred to as Access Bank High and Access Bank Low, respectively. Figure 4-8 indicates the Access Bank areas.

A bit in the instruction word specifies if the operation is to occur in the bank specified by the BSR register, or in the Access Bank.

When forced in the Access Bank (a = '0'), the last address in Access Bank Low is followed by the first address in Access Bank High. Access Bank High maps all Special Function Registers so that these registers can be accessed without any software overhead.

4.11 Bank Select Register (BSR)

The need for a large general purpose memory space dictates a RAM banking scheme. When using direct addressing, the BSR should be configured for the desired bank.

BSR<3:0> holds the upper 4 bits of the 12-bit RAM address. The BSR<7:4> bits will always read '0's, and writes will have no effect.

A MOVLB instruction has been provided in the instruction set to assist in selecting banks.

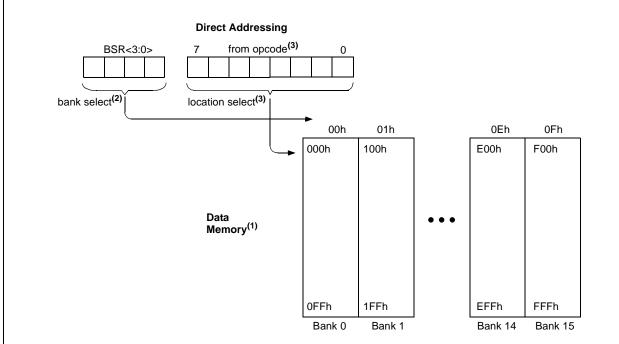
If the currently selected bank is not implemented, any read will return all '0's and all writes are ignored. The STATUS register bits will be set/cleared as appropriate for the instruction performed.

Each Bank extends up to 0FFh (256 bytes). All data memory is implemented as static RAM.

A MOVFF instruction ignores the BSR, since the 12-bit addresses are embedded into the instruction word.

Section 4.12 provides a description of indirect addressing, which allows linear addressing of the entire RAM space.

FIGURE 4-10: DIRECT ADDRESSING



- Note 1: For register file map detail, see Table 4-2.
 - 2: The access bit of the instruction can be used to force an override of the selected bank (BSR<3:0>) to the registers of the Access Bank.
 - 3: The MOVFF instruction embeds the entire 12-bit address in the instruction.

4.12 Indirect Addressing, INDF and FSR Registers

Indirect addressing is a mode of addressing data memory, where the data memory address in the instruction is not fixed. A SFR register is used as a pointer to the data memory location that is to be read or written. Since this pointer is in RAM, the contents can be modified by the program. This can be useful for data tables in the data memory and for software stacks. Figure 4-11 shows the operation of indirect addressing. This shows the moving of the value to the data memory address specified by the value of the FSR register.

Indirect addressing is possible by using one of the INDFn ($0 \le n \le 2$) registers. Any instruction using the INDFn register actually accesses the register indicated by the File Select Register, FSRn ($0 \le n \le 2$). Reading the INDFn register itself indirectly (FSRn = '0'), will read 00h. Writing to the INDFn register indirectly, results in a no-operation. The FSRn register contains a 12-bit address, which is shown in Figure 4-11.

Example 4-6 shows a simple use of indirect addressing to clear the RAM in Bank 1 (locations 100h-1FFh) in a minimum number of instructions.

EXAMPLE 4-6: HOW TO CLEAR RAM (BANK 1) USING INDIRECT ADDRESSING

```
LFSR FSR0, 100h;
NEXTCLRF POSTINCO; Clear INDF; register; & inc pointer
BTFSS FSR0H, 1; All done; with Bank1?
BRA NEXT; NO, clear next
CONTINUE; ; YES, continue
```

There are three indirect addressing registers. To address the entire data memory space (4096 bytes), these registers are 12-bit wide. To store the 12-bits of addressing information, two 8-bit registers are required. These indirect addressing registers are:

- 1. FSR0: composed of FSR0H:FSR0L
- 2. FSR1: composed of FSR1H:FSR1L
- 3. FSR2: composed of FSR2H:FSR2L

In addition, there are registers INDF0, INDF1 and INDF2, which are not physically implemented. Reading or writing to these registers activates indirect addressing, with the value in the corresponding FSR register being the address of the data.

If an instruction writes a value to INDF0, the value will be written to the address indicated by FSR0H:FSR0L. A read from INDF1 reads the data from the address indicated by FSR1H:FSR1L. INDFn can be used in code anywhere an operand can be used.

If INDF0, INDF1, or INDF2 are read indirectly via an FSR, all '0's are read (zero bit is set). Similarly, if INDF0, INDF1, or INDF2 are written to indirectly, the operation will be equivalent to a NOP instruction and the STATUS bits are not affected.

4.12.1 INDIRECT ADDRESSING OPERATION

Each FSR register has an INDF register associated with it, plus four additional register addresses. Performing an operation on one of these five registers determines how the FSR will be modified during indirect addressing.

When data access is done to one of the five INDFn locations, the address selected will configure the FSRn register to:

- Do nothing to FSRn after an indirect access (no change) INDFn
- Auto-decrement FSRn after an indirect access (post-decrement) - POSTDECn
- Auto-increment FSRn after an indirect access (post-increment) - POSTINCn
- Auto-increment FSRn before an indirect access (pre-increment) - PREINCn
- Use the value in the WREG register as an offset to FSRn. Do not modify the value of the WREG or the FSRn register after an indirect access (no change) - PLUSWn

When using the auto-increment or auto-decrement features, the effect on the FSR is not reflected in the STATUS register. For example, if the indirect address causes the FSR to equal '0', the Z bit will not be set.

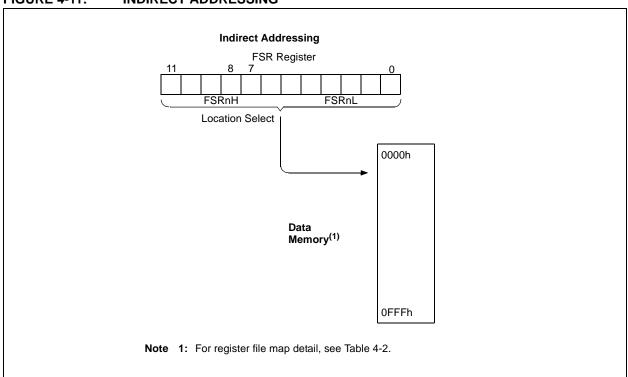
Incrementing or decrementing an FSR affects all 12 bits. That is, when FSRnL overflows from an increment, FSRnH will be incremented automatically.

Adding these features allows the FSRn to be used as a software stack pointer, in addition to its uses for table operations in data memory.

Each FSR has an address associated with it that performs an indexed indirect access. When a data access to this INDFn location (PLUSWn) occurs, the FSRn is configured to add the 2's complement value in the WREG register and the value in FSR to form the address before an indirect access. The FSR value is not changed.

If an indirect addressing operation is done where the target address is an FSRnH or FSRnL register, the write operation will dominate over the pre- or post-increment/decrement functions.

FIGURE 4-11: INDIRECT ADDRESSING



4.13 STATUS Register

The STATUS register, shown in Register 4-3, contains the arithmetic status of the ALU. The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC, C, OV, or N bits, then the write to these five bits is disabled. These bits are set or cleared according to the device logic. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear all implemented bits and set the Z bit. This leaves the STATUS register as ---0 0100 (where - = unimplemented).

It is recommended, therefore, that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect the Z, C, DC, OV, or N bits from the STATUS register. For other instructions which do not affect the status bits, see Table 20-2.

Note: The C and DC bits operate as a borrow and digit borrow bit respectively, in subtraction.

REGISTER 4-3: STATUS REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	_	N	OV	Z	DC	С
bit 7							bit 0

bit 7-5 Unimplemented: Read as '0'

bit 4 N: Negative bit

This bit is used for signed arithmetic (2's complement). It indicates whether the result of the ALU operation was negative (ALU MSb = 1).

- 1 = Result was negative
- 0 = Result was positive

bit 3 **OV:** Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of the 7-bit magnitude, which causes the sign bit (bit 7) to change state.

- 1 = Overflow occurred for signed arithmetic (in this arithmetic operation)
- 0 = No overflow occurred
- bit 2 **Z:** Zero bit
 - 1 = The result of an arithmetic or logic operation is zero
 - 0 = The result of an arithmetic or logic operation is not zero
- bit 1 **DC:** Digit carry/borrow bit

For arithmetic addition and subtraction instructions

- 1 = A carry-out from the 4th low order bit of the result occurred
- 0 = No carry-out from the 4th low order bit of the result

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRCF, RRNCF, RLCF, and RLNCF) instructions, this bit is loaded with either the bit 4, or bit 3 of the source register.

bit 0 C: Carry/borrow bit

For arithmetic addition and subtraction instructions

- 1 = A carry-out from the most significant bit of the result occurred
- 0 = No carry-out from the most significant bit of the result occurred

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRCF, RLCF) instructions, this bit is loaded with either the high, or low order bit of the source register.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

4.14 RCON Register

The Reset Control (RCON) register contains flag bits that allow differentiation between the <u>sources</u> of a device RESET. These flags include the $\overline{\text{TO}}$, $\overline{\text{PD}}$, $\overline{\text{POR}}$ and $\overline{\text{RI}}$ bits. This register is readable and writable.

Note: It is recommended that the POR bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.

REGISTER 4-4: RCON REGISTER

R/W-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-0	U-0
IPEN	r	_	RI	TO	PD	POR	r
bit 7							bit 0

bit 7 IPEN: Interrupt Priority Enable bit

1 = Enable priority levels on interrupts

0 = Disable priority levels on interrupts (16CXXX compatibility mode)

bit 6 Reserved: Maintain as '0'

bit 5 Unimplemented: Read as '0'

bit 4 RI: RESET Instruction Flag bit

1 = The RESET instruction was not executed

0 = The RESET instruction was executed causing a device RESET (must be set in software after RESET instruction was executed)

bit 3 TO: Watchdog Time-out Flag bit

1 = After power-up, CLRWDT instruction, or SLEEP instruction

0 = A WDT time-out occurred

bit 2 PD: Power-down Detection Flag bit

1 = After power-up or by the CLRWDT instruction

0 = By execution of the SLEEP instruction

bit 1 POR: Power-on Reset Status bit

1 = A Power-on Reset has not occurred

0 = A Power-on Reset occurred

(must be set in software after a Power-on Reset occurs)

bit 0 Reserved: Maintain as '0'

5.0 EXTERNAL MEMORY INTERFACE

The External Memory Interface is a feature of the PIC18C601/801 that allows the processor to access external memory devices, such as FLASH, EPROM, SRAM, etc. Memory mapped peripherals may also be accessed.

The External Memory Interface physical implementation includes up to 26 pins on the PIC18C601 and up to 38 pins on the PIC18C801. These pins are reserved for external address/data bus functions.

These pins are multiplexed with I/O port pins, but the I/O functions are only enabled when program execution takes place in internal Boot RAM and the EBDIS bit in the MEMCON register is set (see Register 5-1).

5.1 Memory Control Register (MEMCON)

Register 5-1 shows the Memory Control Register (MEMCON). This register contains bits used to control the operation of the External Memory Interface.

REGISTER 5-1: MEMCON REGISTER

bit7							bit0	-
EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	
R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	

- bit 7 EBDIS: External Bus Disable
 - 1 = External system bus disabled, all external bus drivers are mapped as I/O ports
 - 0 = External system bus enabled, and I/O ports are disabled
- bit 6 **PGRM**: Program RAM Enable
 - 1 = 512 bytes of internal RAM enabled as internal program memory from location 1FFE00h to 1FFFFFh, external program memory at these locations is unused. Internal GPR memory from 400h to 5FFh is disabled and returns 00h.
 - 0 = Internal RAM enabled as internal GPR memory from 400h to 5FFh. Program memory from location 1FFE00h to 1FFFFh is configured as external program memory.
- bit 5-4 WAIT<1:0>: Table Reads and Writes Bus Cycle Wait Count
 - 11 = Table reads and writes will wait 0 TcY
 - 10 = Table reads and writes will wait 1 Tcy
 - 01 = Table reads and writes will wait 2 Tcy
 - 00 = Table reads and writes will wait 3 TcY
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 **WM<1:0>**: TABLWT Operation with 16-bit Bus
 - 1X = Word Write mode: TABLAT0 and TABLAT1 word output, WRH active when TABLAT1 written
 - 01 = Byte Select mode: TABLAT data copied on both MS and LS Byte, WRH and (UB or LB) will activate
 - 00 = Byte Write mode: TABLAT data copied on both MS and LS Byte, WRH or WRL will activate

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.2 8-bit Mode

The External Memory Interface can operate in 8-bit mode. The mode selection is not software configurable, but is programmable via the configuration bits.

There are two types of connections in 8-bit mode. They are referred to as:

- 8-bit Multiplexed
- 8-bit De-Multiplexed

5.2.1 8-BIT MULTIPLEXED MODE

The 8-bit Multiplexed mode applies only to the PIC18C601. Data and address lines are multiplexed on port pins and must be decoded with glue logic.

For 8-bit Multiplexed mode on the PIC18C601, the instructions will be fetched as two 8-bit bytes on a shared data/address bus (PORTD). The two bytes are sequentially fetched within one instruction cycle (Tcy).

Therefore, the designer must choose external memory devices according to timing calculations based on 1/2 Tcy (2 times instruction rate). For proper memory speed selection, glue logic propagation delay times must be considered along with setup and hold times.

The Address Latch Enable (ALE) pin indicates that the address bits A<7:0> are available on the External Memory Interface bus. The OE output enable signal will enable one byte of program memory for a portion of the instruction cycle, then BA0 will change and the second byte will be enabled to form the 16-bit instruction word. The least significant bit of the address, BA0, must be connected to the memory devices in this mode. Figure 5-1 shows an example of 8-bit Multiplexed mode on the PIC18C601. The control signals used in 8-bit Multiplexed mode are outlined in Table 5-1. Register 5-2 describes 8-bit Multiplexed mode timing.

FIGURE 5-1: 8-BIT MULTIPLEXED MODE EXAMPLE

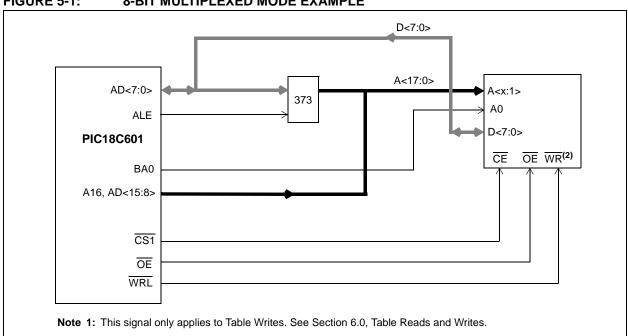


TABLE 5-1: 8-BIT MULTIPLEXED MODE CONTROL SIGNALS

Name	8-bit Mux Mode	Function
RG0/ALE	ALE	Address Latch Enable (ALE) control pin
RG1/OE	OE	Output Enable (OE) control pin
RG2/WRL	WRL	Write Low (WRL) control pin
RG4/BA0	BA0	Byte address bit 0
RF3/CSIO	CSIO	Chip Select I/O (See Section 5.4)
RF5/CS1	CS1	Chip Select 1 (See Section 5.4)

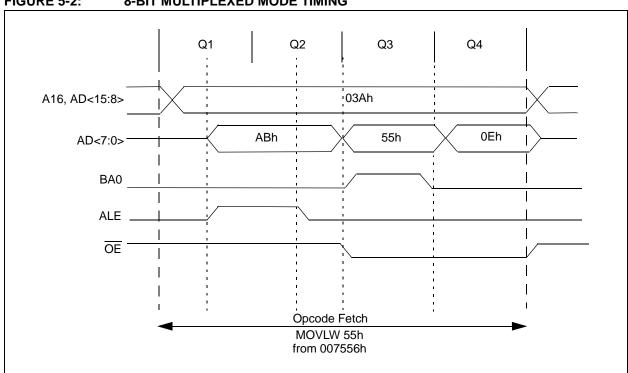


FIGURE 5-2: 8-BIT MULTIPLEXED MODE TIMING

5.2.2 8-BIT DE-MULTIPLEXED MODE

The 8-bit De-Multiplexed mode applies only to the PIC18C801. Data and address lines are available separately. External components are not necessary in this mode.

For 8-bit De-Multiplexed mode on the PIC18C801, the instructions are fetched as two 8-bit bytes on a dedicated data bus (PORTJ). The address will be presented for the entire duration of the fetch cycle on a separate address bus. The two instruction bytes are sequentially fetched within one instruction cycle (Tcy). Therefore, the designer must choose external memory devices according to timing calculations, based on 1/2 Tcy (2 times instruction rate). For proper memory speed selection, setup and hold times must be considered.

The Address Latch Enable (ALE) pin is left unconnected, since glue logic is not necessary. The $\overline{\text{OE}}$ output enable signal will enable one byte of program memory for a portion of the instruction cycle, then BA0 will change and the second byte will be enabled to form the 16-bit instruction word. The least significant bit of the address, BA0, must be connected to the memory devices in this mode. Figure 5-3 shows an example of 8-bit De-Multiplexed mode on the PIC18C801. The control signals used in 8-bit De-Multiplexed mode are outlined in Register 5-2. Register 5-4 describes 8-bit De-Multiplexed mode timing.

FIGURE 5-3: 8-BIT DE-MULTIPLEXED MODE EXAMPLE

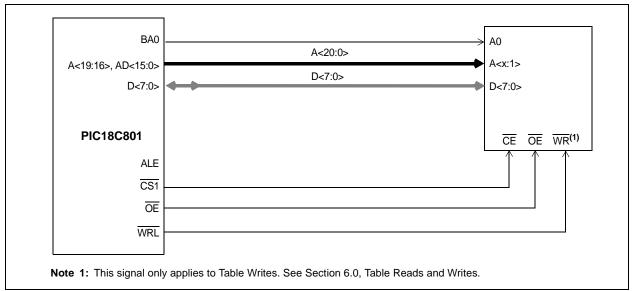
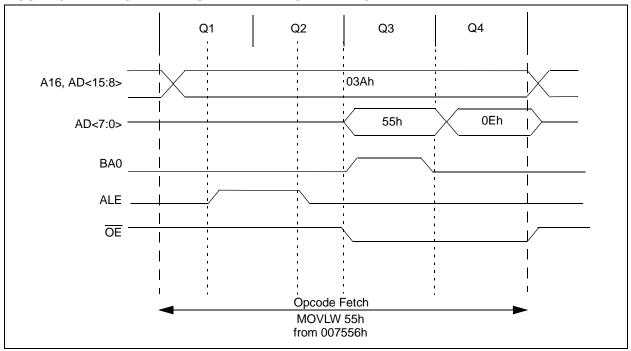


TABLE 5-2: 8-BIT DE-MULTIPLEXED MODE CONTROL SIGNALS

Name	8-bit De-Mux Mode	Function
RG0/ALE	ALE	Address Latch Enable (ALE) control pin
RG1/OE	OE	Output Enable (OE) control pin
RG2/WRL	WRL	Write Low (WRL) control pin
RG4/BA0	BA0	Byte address bit 0
RF3/CSIO	CSIO	Chip Select I/O (See Section 5.4)
RF4/CS2	CS2	Chip Select 2 (See Section 5.4)
RF5/CS1	CS1	Chip Select 1 (See Section 5.4)

FIGURE 5-4: 8-BIT DE-MULTIPLEXED MODE TIMING



5.3 16-bit Mode

The External Memory Interface can operate in 16-bit mode. The mode selection is not software configurable, but is programmable via the configuration bits.

The WM<1:0> bits in the MEMCON register determine three types of connections in 16-bit mode. They are referred to as:

- 16-bit Byte Write
- 16-bit Word Write
- 16-bit Byte Select

These three different configurations allow the designer maximum flexibility in using 8-bit and 16-bit memory devices.

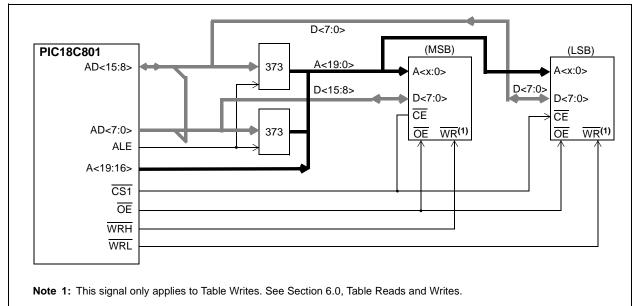
For all 16-bit modes, the Address Latch Enable (ALE) pin indicates that the address bits A<15:0> are available on the External Memory Interface bus. Following the address latch, the output enable signal ($\overline{\text{OE}}$) will enable both bytes of program memory at once to form a 16-bit instruction word.

In Byte Select mode, JEDEC standard FLASH memories will require BA0 for the byte address line, and one I/O line, to select between byte and word mode. The other 16-bit modes do not need BA0. JEDEC standard static RAM memories will use the $\overline{\text{UB}}$ or $\overline{\text{UL}}$ signals for byte selection.

5.3.1 16-BIT BYTE WRITE MODE

Figure 5-5 shows an example of 16-bit Byte Write mode for the PIC18C601/801.

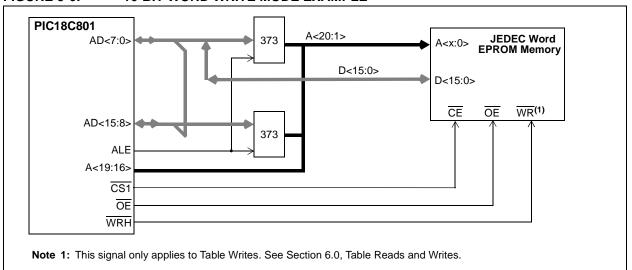
FIGURE 5-5: 16-BIT BYTE WRITE MODE EXAMPLE



5.3.2 16-BIT WORD WRITE MODE

Figure 5-6 shows an example of 16-bit Word Write mode for the PIC18C801.

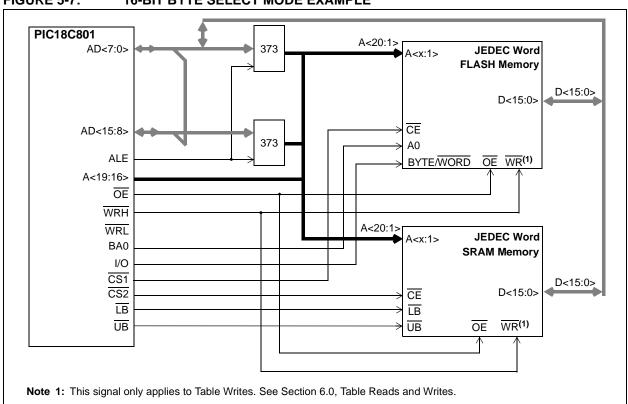
FIGURE 5-6: 16-BIT WORD WRITE MODE EXAMPLE



5.3.3 16-BIT BYTE SELECT MODE

Figure 5-7 shows an example of 16-bit Byte Select mode for the PIC18C801.

FIGURE 5-7: 16-BIT BYTE SELECT MODE EXAMPLE



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5.3.4 16-BIT MODE CONTROL SIGNALS

Table 5-3 describes the 16-bit mode control signals for the PIC18C601/801.

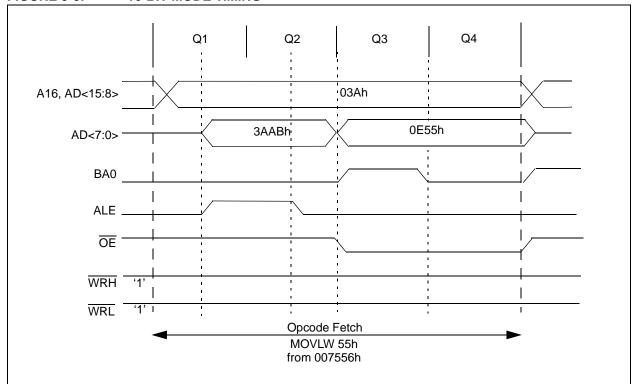
TABLE 5-3: PIC18C601/801 16-BIT MODE CONTROL SIGNALS

Name	18C601 16-bit Mode	18C801 16-bit Mode	Function
RG0/ALE	ALE	ALE	Address Latch Enable (ALE) control pin
RG1/OE	OE	OE	Output Enable (OE) control pin
RG2/WRL	WRL	WRL	Write Low (WRL) control pin
RG3/WRH	WRH	WRH	Write High (WRH) control pin
RG4/BA0	BA0	BA0	Byte address bit 0
RF3/CSIO	CSIO	CSIO	Chip Select I/O (See Section 5.4)
RF4/CS2	N/A	CS2	Chip Select 2 (See Section 5.4)
RF5/CS1	CS1	CS1	Chip Select 1 (See Section 5.4)
RF6/UB	UB	UB	Upper Byte Enable (UB) control pin
RF7/LB	LB	LB	Lower Byte Enable (LB) control pin
I/O	I/O	I/O	I/O as BYTE/WORD control pin for JEDEC FLASH

5.3.5 16-BIT MODE TIMING

Figure 5-8 describes the 16-bit mode timing for the PIC18C601/801.

FIGURE 5-8: 16-BIT MODE TIMING



5.4 Chip Selects

Chip select signals are used to select regions of external memory and I/O devices for access. The PIC18C801 has three chip selects and all are programmable. The chip select signals are $\overline{CS1}$, $\overline{CS2}$ and \overline{CSIO} . $\overline{CS1}$ and $\overline{CS2}$ are general purpose chip selects that are used to enable large portions of program memory. \overline{CSIO} is used to enable external I/O expansion. The PIC18C601uses two of these programmable chip selects: $\overline{CS1}$ and \overline{CSIO} .

Two SFRs are used to control the chip select signals. These are CSEL2 and CSELIO (see Register 5-2 and Register 5-3). A chip select signal is asserted low when the CPU makes an access to a dedicated range of addresses specified in the chip select registers, CSEL2 and CSELIO. The 8-bit value found in either of these registers is decoded as one of 256, 8K banks of program memory. If both chip select registers are 00h, all of the chip select signals are disabled and their corresponding pins are configured as I/O. Since the last 512 bytes of program memory are dedicated to internal program RAM, the chip select signals will not activate if the program memory address falls in this range.

REGISTER 5-2: CSEL2 REGISTER

	R/W-1							
	CSL7	CSL6	CSL5	CSL4	CSL3	CSL2	CSL1	CSL0
Ī	bit 7							bit 0

bit 7-0 CSL<7:0>: Chip Select 2 Address Decode bits

XXh = All eight bits are compared to the Most Significant bits PC < 20:13 > 0 the program counter. If PC < 20:13 > 2 CSL < 7:0 > 0 register, then the $\overline{CS2}$ signal is low. If PC < 20:13 > 2 CSL < 7:0 > 0 is high.

 $00h = \overline{CS2}$ is inactive

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 5-3: CSELIO REGISTER

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CSIO7 | CSIO6 | CSIO5 | CSIO4 | CSIO3 | CSIO2 | CSIO1 | CSIO0 |
| bit7 | | | | | | | bit0 |

bit 7-0 CSIO<7:0>: Chip Select IO Address Decode bits

XXh = All eight bits are compared to the Most Significant bits PC<20:13> of the program counter. If PC<20:13> = CSIO<7:0>, then the $\overline{\text{CSIO}}$ signal is low. If not, $\overline{\text{CSIO}}$ is high. 00h = $\overline{\text{CSIO}}$ is inactive

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.4.1 CHIP SELECT 1 (CS1)

CS1 is enabled by writing a value other than 00h into either the CSEL2 register, or the CSELIO register. If both of the chip select registers are programmed to 00h, the CS1 signal is not enabled and the RF5 pin is configured as I/O.

 $\overline{\text{CS1}}$ is low for all addresses in which $\overline{\text{CS2}}$ and $\overline{\text{CSELIO}}$ are high. Therefore, if CSEL2 = 20h and CSELIO = 80h, then the $\overline{\text{CS1}}$ signal will be low for the address that falls between 000000h and (2000h x 20h) - 1 = 03FFFFh. $\overline{\text{CS1}}$ will always be low for the lower 8K of program memory. Figure 5-9 shows an example address map for $\overline{\text{CS1}}$.

5.4.2 CHIP SELECT 2 (CS2)

 $\overline{\text{CS2}}$ is enabled for program memory accesses, starting at the address derived by the 8-bit value contained in CSEL2. For example, if the value contained in the CSEL2 register is 80h, then the $\overline{\text{CS2}}$ signal will be asserted low whenever the address is greater than or equal to 2000h x 80h = 100000h.

A 00h value in the CSEL2 register will disable the $\overline{\text{CS2}}$ signal and will configure the RF4 pin as I/O. Figure 5-9 shows an example address map for $\overline{\text{CS2}}$.

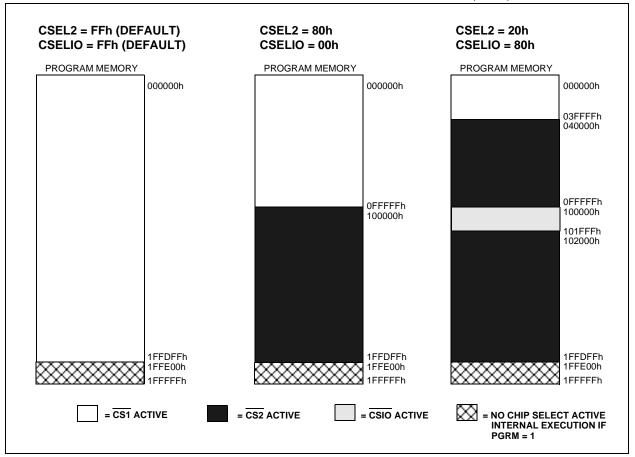
5.4.3 CHIP SELECT I/O (CSIO)

CSIO is enabled for a fixed 8K address range starting at the address defined by the 8-bit value contained in CSELIO. If, for instance, the value contained in the CSELIO register is 80h, then the CSIO signal will be low for the address range between 100000h and 101FFFh.

If the 8K address block overlaps the address range specified in the CSEL2 register, the $\overline{\text{CSIO}}$ signal will be low, and the $\overline{\text{CS2}}$ signal will be high, for that region.

A 00h value in the CSELIO register will disable the CSIO signal and will configure the RF3 pin as I/O. Figure 5-9 shows an example address map for CSIO.

FIGURE 5-9: EXAMPLE CONFIGURATION ADDRESS MAP FOR CS1, CS2, AND CSIO



5.5 External Wait Cycles

The external memory interface supports wait cycles. Wait cycles only apply to Table Read and Table Write operations over the external bus. See Section 6.0 for more details.

Since the device execution is tied to instruction fetches, there is no need to execute faster than the fetch rate. So, if the program needs to be slowed, the processor speed must be slowed with a different Tcy time.

6.0 TABLE READS/TABLE WRITES

PIC18C601/801 devices use two memory spaces: the external program memory space and the data memory space. Table Reads and Table Writes have been provided to move data between these two memory spaces through an 8-bit register (TABLAT).

The operations that allow the processor to move data between the data and external program memory spaces are:

- Table Read (TBLRD)
- Table Write (TBLWT)

Table Read operations retrieve data from external program memory and place it into the data memory space. Figure 6-1 shows the operation of a Table Read with program and data memory.

Table Write operations store data from the data memory space into external program memory. Figure 6-2 shows the operation of a Table Write with external program and data memory.

Table operations work with byte entities. A table block containing data is not required to be word aligned, so a table block can start and end at any byte address. If a Table Write is being used to write an executable program to program memory, program instructions must be word aligned.

FIGURE 6-1: TABLE READ OPERATION

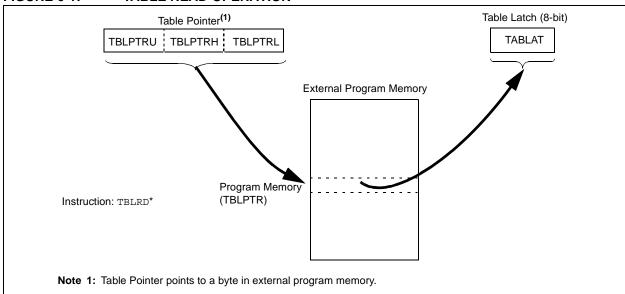
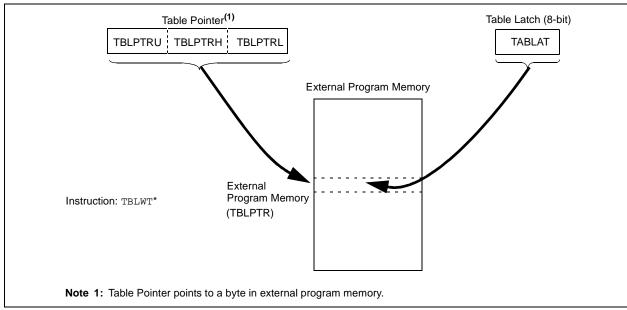


FIGURE 6-2: TABLE WRITE OPERATION



6.1 Control Registers

Several control registers are used in conjunction with the TBLRD and TBLWT instructions. These include:

- · TABLAT register
- · TBLPTR registers

6.1.1 TABLAT - TABLE LATCH REGISTER

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch is used to hold 8-bit data during data transfers between program memory and data memory.

6.1.2 TBLPTR - TABLE POINTER REGISTER

The Table Pointer (TBLPTR) addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers (Table Pointer Upper byte, High byte and Low byte). These three registers (TBLPTRU:TBLPTRH:TBLPTRL) join to form a 21-bit wide pointer. The 21-bits allow the device to address up to 2 Mbytes of program memory space.

The table pointer TBLPTR is used by the TBLRD and TBLWRT instructions. These instructions can update the TBLPTR in one of four ways, based on the table operation. These operations are shown in Table 6-1. These operations on the TBLPTR only affect the low order 21-bits.

TABLE 6-1: TABLE POINTER OPERATIONS WITH TBLRD AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

6.2 Table Read

The TBLRD instruction is used to retrieve data from external program memory and place it into data memory.

TBLPTR points to a byte address in external program memory space. Executing TBLRD places the byte into TABLAT. In addition, TBLPTR can be modified automatically for the next Table Read operation.

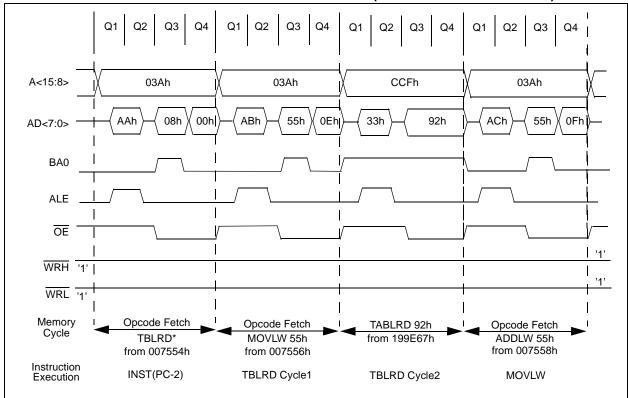
Table Reads from external program memory are performed one byte at a time. If the external interface is 8-bit, the bus interface circuitry in TABLAT will load the external value into TABLAT. If the external interface is 16-bit, interface circuitry in TABLAT will select either the high or low byte of the data from the 16-bit bus, based on the least significant bit of the address.

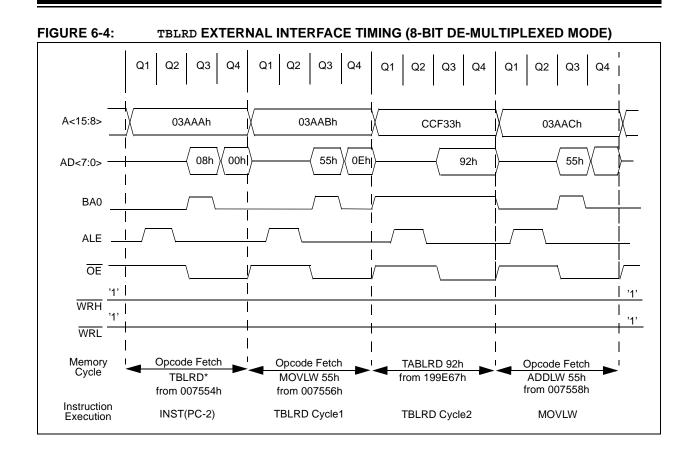
Example 6-1describes how to use TBLRD. Figure 6-3 and Figure 6-4 show Table Read timings for an 8-bit external interface, and Figure 6-5 describes Table Read timing for a 16-bit interface.

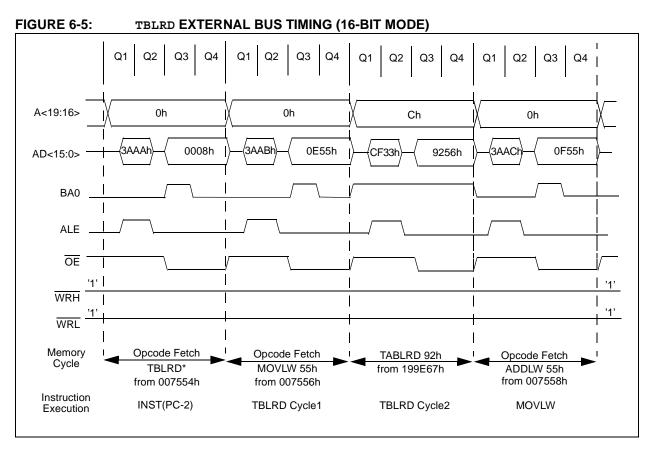
EXAMPLE 6-1: TABLE READ CODE EXAMPLE

```
; Read a byte from location 0020h
CLRF TBLPTRU ; clear upper 5 bits of TBLPTR
CLRF TBLPTRH ; clear higher 8 bits of TBLPTR
MOVLW 20h ; Load 20h into
MOVWF TBLPTRL ; TBLPTRL
TBLRD* ; Data is in TABLAT
```

FIGURE 6-3: TBLRD EXTERNAL INTERFACE TIMING (8-BIT MULTIPLEXED MODE)







6.3 Table Write

Table Write operations store data from the data memory space into external program memory.

PIC18C601/801devices perform Table Writes one byte at a time. Table Writes to external memory are two-cycle instructions, unless wait states are enabled. The last cycle writes the data to the external memory location.

16-bit interface Table Writes depend on the type of external device that is connected and the WM<1:0> bits in the MEMCON register (See Figure 5-2).

Example 6-2 describes how to use TBLWT.

EXAMPLE 6-2: TABLE WRITE CODE EXAMPLE

```
; Write a byte to location 0020h
CLRF
     TBLPTRU
                      ; clear upper 5 bits of TBLPTR
                       ; clear higher 8 bits of TBLPTR
CLRF
      TBLPTRH
                       ; Load 20h into
MOVLW 20h
MOVWF TBLPTRL
                       ; TBLPTRL
                       ; Load 55h into
MOVLW 55h
MOVWF TBLAT
                       ; TBLAT
                        ; Write it
TBLWT*
```

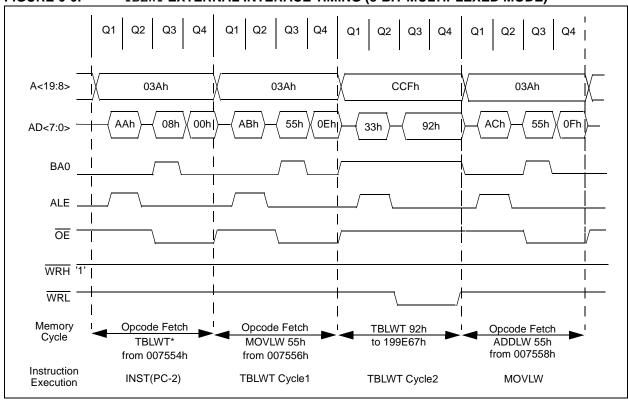
6.3.1 8-BIT EXTERNAL TABLE WRITES

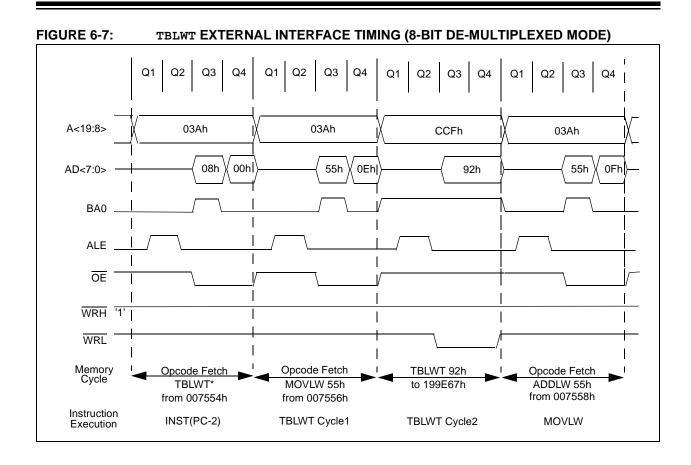
When the external bus is 8-bit, the byte-wide Table Write exactly corresponds to the bus length and there are no special considerations required.

The $\overline{\text{WRL}}$ signal is used as the active write signal.

Figure 6-6 and Figure 6-7 show the timings associated with the 8-bit modes.

FIGURE 6-6: TBLWT EXTERNAL INTERACE TIMING (8-BIT MULTIPLEXED MODE)

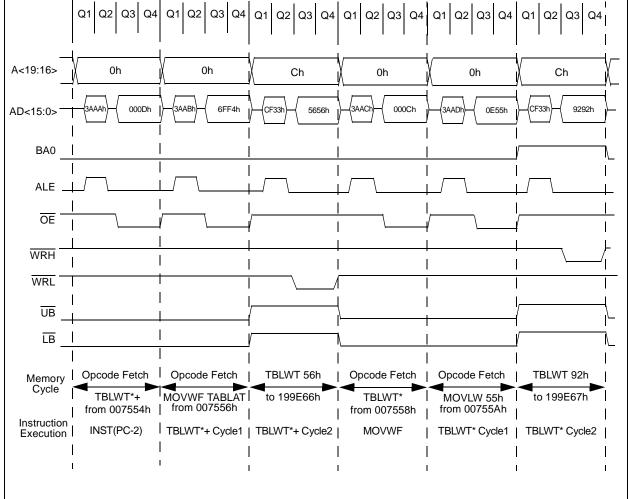




6.3.2 16-BIT EXTERNAL TABLE WRITE (BYTE WRITE MODE)

This mode allows Table Writes to byte-wide external memories. During a TBLWT cycle, the TABLAT data is presented on the upper and lower byte of the AD<15:0> bus. The appropriate WRH or WRL line is strobed based on the LSb of the TBLPTR. Figure 6-8 shows the timing associated with this mode.

FIGURE 6-8: TBLWT EXTERNAL INTERFACE TIMING (16-BIT BYTE WRITE MODE) Q2 Q3 Q4 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3



6.3.3 EXTERNAL TABLE WRITE IN 16-BIT WORD WRITE MODE

This mode allows Table Writes to any type of word-wide external memories.

This method makes a distinction between TBLWT cycles to even or odd addresses.

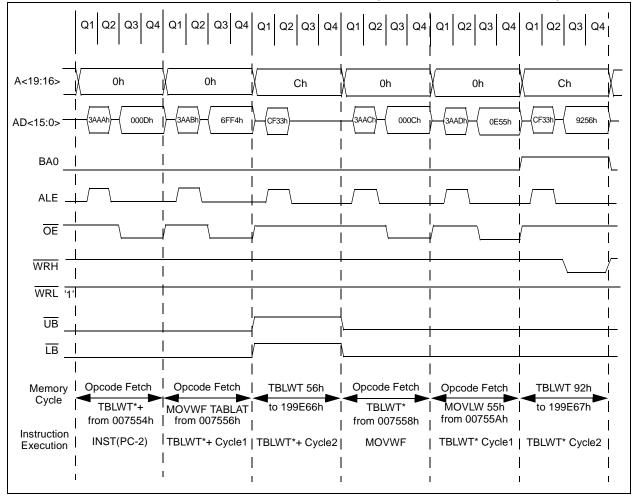
During a TBLWT cycle to an even address, where TBLPTR<0> = 0, the TABLAT data is transferred to a holding latch and the external address data bus is tristated for the data portion of the bus cycle. No write signals are activated.

During a TBLWT cycle to an odd address, where TBLPTR<0> = 1, the TABLAT data is presented on the upper byte of the AD<15:0> bus. The contents of the holding latch are presented on the lower byte of the AD<15:0> bus. The \overline{WRH} line is strobed for each write cycle and the \overline{WRL} line is unused. The BAO line indicates the LSb of TBLPTR, but it is unnecessary. The \overline{UB} and \overline{LB} lines are active to select both bytes.

The obvious limitation to this method is that the TBLWT must be done in pairs on a specific word boundary to correctly write a word location.

Figure 6-9 shows the timing associated with this mode.





6.3.4 16-BIT EXTERNAL TABLE WRITE (BYTE SELECT MODE)

This mode allows Table Writes to word-wide external memories that have byte selection capabilities. This generally includes word-wide FLASH devices and word-wide static RAM devices.

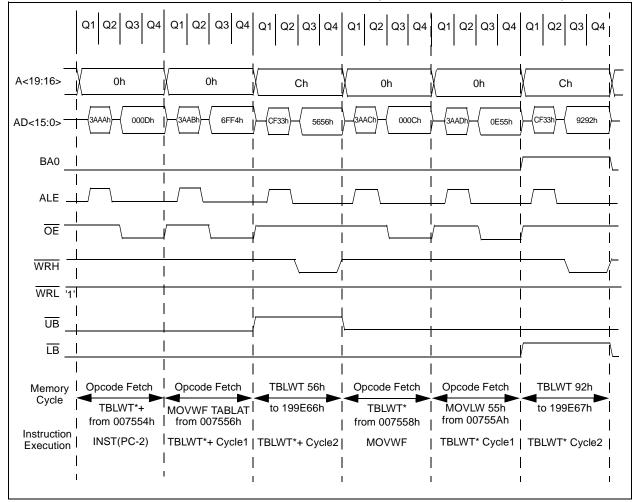
During a TBLWT cycle, the TABLAT data is presented on the upper and lower byte of the AD<15:0> bus. The WRH line is strobed for each write cycle and the

WRL line is unused. The BA0 or UB or UL lines are used to select the byte to be written, based on the LSb of the TBLPTR.

JEDEC standard flash memories will require a I/O port line to become a BYTE/WORD input signal and will use the BA0 signal as a byte address. <u>JEDEC</u> standard static RAM memories will use the <u>UB</u> or <u>UL</u> signals to select the byte.

Figure 6-10 shows the timing associated with this mode.

FIGURE 6-10: TBLWT EXTERNAL INTERFACE TIMING (16-BIT BYTE SELECT MODE)



6.4 Long Writes

Long writes will not be supported on the PIC18C601/801 to program FLASH configuration memory. The configuration locations can only be programmed in ICSP mode.

6.5 External Wait Cycles

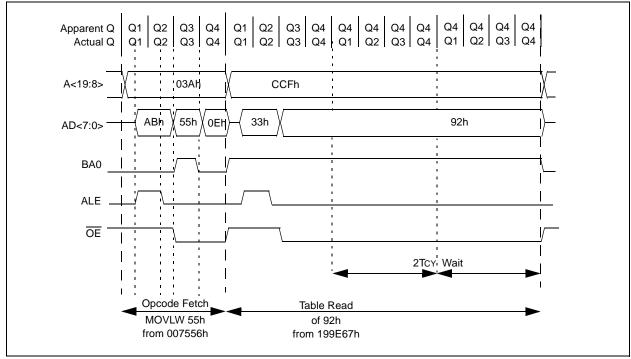
The Table Reads and Writes have the capability to insert wait states when accessing external memory. These wait states only apply to the execution of a Table Read or Write to external memory and not to instruction fetches out of external memory. The guidelines presented in Section 5.0 must be followed to select the proper memory speed grade for the device operating frequency.

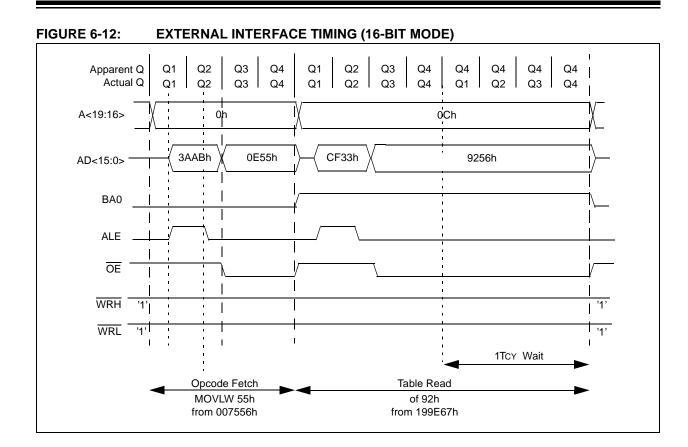
The WAIT<1:0> bits in the MEMCON register will select 0, 1, 2, or 3 extra TCY cycles per TBLRD/TBWLT cycle. The wait will occur on Q4.

The default setting of the wait on power-up is to assert a maximum wait of 3TcY cycles. This insures that slow memories will work in Microprocessor mode immediately after RESET.

Figure 6-11 shows 8-bit external bus timing for a Table Read with 2 wait cycles. Figure 6-12 shows 16-bit external bus timing for a Table Read with 1 wait cycle.







7.0 8 X 8 HARDWARE MULTIPLIER

An 8 x 8 hardware multiplier is included in the ALU of PIC18C601/801 devices. By making the multiply a hardware operation, it completes in a single instruction cycle. This is an unsigned multiply that gives a 16-bit result. The result is stored into the 16-bit product register pair (PRODH:PRODL). The multiplier does not affect any flags in the STATUS register.

Making the 8 x 8 multiplier execute in a single cycle gives the following advantages:

- · Higher computational throughput
- Reduces code size requirements for multiply algorithms

The performance increase allows the device to be used in some applications previously reserved for Digital Signal Processors.

Table 7-1 shows a performance comparison between enhanced devices using the single cycle hardware multiply, and performing the same function without the hardware multiply.

TABLE 7-1: PERFORMANCE COMPARISON

		Program	Cycles	Time			
Routine	Multiply Method	Memory (Words)	(Max)	@ 25 MHz	@ 10 MHz	@ 4 MHz	
8 x 8 unsigned	Without hardware multiply	13	69	11.0 μs	27.6 μs	69.0 μs	
o x o unsigned	Hardware multiply	1	1	160.0 ns	400.0 ns	1.0 μs	
0 v 0 signed	Without hardware multiply	33	91	14.6 μs	36.4 μs	91.0 μs	
8 x 8 signed	Hardware multiply	6	6	960.0 ns	2.4 μs	6.0 μs	
16 v 16 uncigned	Without hardware multiply	21	242	38.7 μs	96.8 μs	242.0 μs	
16 x 16 unsigned	Hardware multiply	24	24	3.8 μs	9.6 μs	24.0 μs	
16 v 16 signed	Without hardware multiply	52	254	40.6 μs	102.6 μs	254.0 μs	
16 x 16 signed	Hardware multiply	36	36	5.8 μs	14.4 μs	36.0 μs	

7.1 Operation

Example 7-1 shows the sequence to perform an 8 x 8 unsigned multiply. Only one instruction is required when one argument of the multiply is already loaded in the WREG register.

Example 7-2 shows the sequence to do an 8 x 8 signed multiply. To account for the sign bits of the arguments, each argument's most significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 7-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

```
MOVFF ARG1, WREG ;
MULWF ARG2 ; ARG1 * ARG2 ->
; PRODH:PRODL
```

EXAMPLE 7-2: 8 x 8 SIGNED MULTIPLY ROUTINE

```
MOVFF
        ARG1, WREG
MULWF
        ARG2
                        ; ARG1 * ARG2 ->
                        ; PRODH:PRODL
                       ; Test Sign Bit
BTFSC
        ARG2, SB
SUBWF
        PRODH
                        ; PRODH = PRODH
                                  - ARG1
MOVFF
        ARG2, WREG
BTFSC
                        ; Test Sign Bit
        ARG1, SB
SUBWF
        PRODH
                        ; PRODH = PRODH
                                  - ARG2
```

Example 7-3 shows the sequence to perform a 16 x 16 unsigned multiply. Equation 7-1 shows the algorithm that is used. The 32-bit result is stored in 4 registers RES3:RES0.

EQUATION 7-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L • ARG2H:ARG2L

= (ARG1H • ARG2H • 2<sup>16</sup>) +

(ARG1H • ARG2L • 2<sup>8</sup>) +

(ARG1L • ARG2H • 2<sup>8</sup>) +

(ARG1L • ARG2L)
```

EXAMPLE 7-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
MOVFF
         ARG1L, WREG
MULWF
         ARG2L
                       ; ARG1L * ARG2L ->
                       ; PRODH: PRODL
         PRODH, RES1
MOVFF
MOVEE
         PRODL, RESO
MOVFF
         ARG1H, WREG
MULWF
         ARG2H
                       ; ARG1H * ARG2H ->
                       ; PRODH: PRODL
         PRODH, RES3
MOVEE
                       ;
MOVFF
         PRODL, RES2
                       ;
MOVFF
         ARG1L, WREG
                       ; ARG1L * ARG2H ->
         ARG2H
MULWF
                       ; PRODH: PRODL
MOVF
         PRODL, W
ADDWF
         RES1
                       ; Add cross
MOVF
         PRODH, W
                       ; products
         RES2
ADDWFC
         WREG
CLRF
ADDWFC
         RES3
         ARG1H, WREG
MOVFF
                       ; ARG1H * ARG2L ->
MULWF
         ARG2L
                       ; PRODH:PRODL
         PRODL, W
MOVF
                       ; Add cross
ADDWF
         RES1
MOVE
         PRODH, W
                       ; products
         RES2
ADDWFC
CLRF
         WREG
                       ;
ADDWFC
         RES3
                       ;
```

Example 7-4 shows the sequence to perform a 16 x 16 signed multiply. Equation 7-2 shows the algorithm used. The 32-bit result is stored in four registers, RES3:RES0. To account for the sign bits of the arguments, each argument pairs' most significant bit (MSb) is tested and the appropriate subtractions are done.

EQUATION 7-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0

= ARG1H:ARG1L • ARG2H:ARG2L

= (ARG1H • ARG2H • 2<sup>16</sup>) +
(ARG1H • ARG2L • 2<sup>8</sup>) +
(ARG1L • ARG2H • 2<sup>8</sup>) +
(ARG1L • ARG2L) +
(-1 • ARG2H<7> • ARG1H:ARG1L • 2<sup>16</sup>) +
(-1 • ARG1H<7> • ARG2H:ARG2L • 2<sup>16</sup>)
```

EXAMPLE 7-4: 16 x 16 SIGNED MULTIPLY ROUTINE

MOVFF	ARG1L,	WREG	_	
MULWF	ARG2L		;	ARG1L * ARG2L ->
			;	PRODH: PRODL
MOVFF	PRODH,	RES1	;	
MOVFF	PRODL,	RES0		
;				
	ARG1H,	WREG		
MULWF	ARG2H			ARG1H * ARG2H ->
				PRODH: PRODL
MOVFF	PRODH,	RES3	;	
	PRODL,			
;	•		•	
MOVFF	ARG1L,	WREG		
MULWF	ARG2H			ARG1L * ARG2H ->
				PRODH: PRODL
MOVF	PRODL,	W	;	
ADDWF	RES1			Add cross
MOVF	PRODH,	W		products
ADDWFC		••	;	produces
CLRF	WREG		;	
ADDWFC			;	
;	RESS		,	
MOVFF	ARG1H,	WREG	;	
MULWF	ARG2I	ппшо		ARG1H * ARG2L ->
1102111	IMCZL		;	
MOVF	PRODL,	W	;	11102111111022
ADDWF	RES1	••		Add cross
MOVF	PRODH,	W		products
ADDWFC	RES2	••	;	
CLRF	WREG		;	
ADDWFC			;	
;			,	
BTFSS	ARG2H,	7		ARG2H:ARG2L neg?
GOTO	SIGN AR	G1	•	no, check ARG1
MOVFF	ARG1L,	WREG	;	, 0110011 11101
SUBWF	RES2		;	
MOVFF	ARG1H,	WREG		
SUBWFB			,	
];	*=			
SIGN ARG1				
BTFSS	ARG1H.	7	;	ARG1H:ARG1L neg?
GOTO	CONT_CO	DE	,	no, done
MOVFF	ARG2L,			,
SUBWF	RES2	-	;	
MOVFF	ARG2H,	WREG		
SUBWFB	-	-	,	
,				
CONT CODE				
:				

NOTES:

8.0 INTERRUPTS

PIC18C601/801 devices have 15 interrupt sources and an interrupt priority feature that allows each interrupt source to be assigned a high priority level, or a low priority level. The high priority interrupt vector is at 000008h and the low priority interrupt vector is at 000018h. High priority interrupt events will override any low priority interrupts that may be in progress.

There are 10 registers that are used to control interrupt operation. These registers are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2
- PIE1, PIE2
- IPR1, IPR2

It is recommended that the Microchip header files supplied with MPLAB® IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

Each interrupt source has three bits to control its operation. The functions of these bits are:

- Flag bit to indicate that an interrupt event occurred
- Enable bit that allows program execution to branch to the interrupt vector address when the flag bit is set
- · Priority bit to select high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON register). When interrupt priority is enabled, there are two bits that enable interrupts globally. Setting the GIEH bit (INTCON register) enables all interrupts that have the priority bit set. Setting the GIEL bit (INTCON register) enables all interrupts that have the priority bit cleared. When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 000008h or 000018h, depending on the priority level. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PICmicro® mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. The PEIE bit (INTCON register) enables/disables all peripheral interrupt sources. The GIE bit (INTCON register) enables/disables all interrupt sources. All interrupts branch to address 000008h in Compatibility mode.

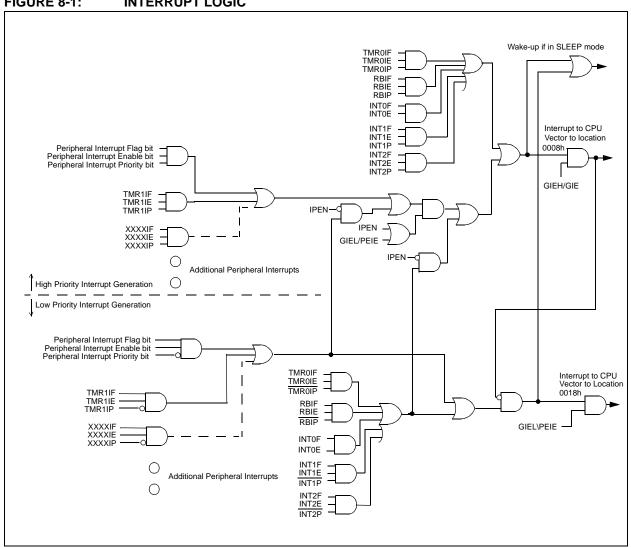
When an interrupt is responded to, the Global Interrupt Enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High priority interrupt sources can interrupt a low priority interrupt.

The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (000008h or 000018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts, to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used), which re-enables interrupts.

For external interrupt events, such as the INT pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two cycle instructions. Individual interrupt flag bits are set, regardless of the status of their corresponding enable bit or the GIE bit.

FIGURE 8-1: **INTERRUPT LOGIC**



8.1 Control Registers

8.1.1 INTCON REGISTERS

This section contains the control and status registers.

The INTCON Registers are readable and writable registers, which contain various enable, priority, and flag bits.

REGISTER 8-1: INTCON REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
bit 7							bit 0

bit 7 GIE/GIEH: Global Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked interrupts
- 0 = Disables all interrupts

When IPEN = 1:

- 1 = Enables all high priority interrupts
- 0 = Disables all high priority interrupts
- bit 6 PEIE/GIEL: Peripheral Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked peripheral interrupts
- 0 = Disables all peripheral interrupts

When IPEN = 1:

- 1 = Enables all low priority peripheral interrupts
- 0 = Disables all priority peripheral interrupts
- bit 5 TMR0IE: TMR0 Overflow Interrupt Enable bit
 - 1 = Enables the TMR0 overflow interrupt
 - 0 = Disables the TMR0 overflow interrupt
- bit 4 INT0IE: INT0 External Interrupt Enable bit
 - 1 = Enables the INT0 external interrupt
 - 0 = Disables the INT0 external interrupt
- bit 3 RBIE: RB Port Change Interrupt Enable bit
 - 1 = Enables the RB port change interrupt
 - 0 = Disables the RB port change interrupt
- bit 2 TMR0IF: TMR0 Overflow Interrupt Flag bit
 - 1 = TMR0 register has overflowed (must be cleared in software)
 - 0 = TMR0 register did not overflow
- bit 1 INT0IF: INT0 External Interrupt Flag bit
 - 1 = The INT0 external interrupt occurred (must be cleared in software)
 - 0 = The INT0 external interrupt did not occur
- bit 0 RBIF: RB Port Change Interrupt Flag bit
 - 1 = At least one of the RB7:RB4 pins changed state (must be cleared in software)
 - 0 = None of the RB7:RB4 pins have changed state

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Note: Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows software polling.

REGISTER 8-2: INTCON2 REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	U-0	R/W-1	U-0	R/W-1
RBPU	INTEDG0	INTEDG1	INTEDG2		TMR0IP		RBIP
bit 7							bit 0

bit 7 RBPU: PORTB Pull-up Enable bit

1 = All PORTB pull-ups are disabled

0 = PORTB pull-ups are enabled by individual port latch values

bit 6 INTEDG0: External Interrupt 0 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 5 INTEDG1: External Interrupt 1 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 4 INTEDG2: External Interrupt 2 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 3 Unimplemented: Read as '0'

bit 2 TMR0IP: TMR0 Overflow Interrupt Priority bit

1 = High priority

0 = Low priority

bit 1 Unimplemented: Read as '0'

bit 0 RBIP: RB Port Change Interrupt Priority bit

1 = High priority

0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows software polling.

REGISTER 8-3: INTCON3 REGISTER

bit 5

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP	INT1IP	_	INT2IE	INT1IE	_	INT2IF	INT1IF
bit 7	•			•		•	bit 0

bit 7 INT2IP: INT2 External Interrupt Priority bit

1 = High priority

0 = Low priority

bit 6 INT1IP: INT1 External Interrupt Priority bit

1 = High priority0 = Low priority

Unimplemented: Read as '0'

bit 4 INT2IE: INT2 External Interrupt Enable bit

1 = Enables the INT2 external interrupt

0 = Disables the INT2 external interrupt

bit 3 INT1IE: INT1 External Interrupt Enable bit

1 = Enables the INT1 external interrupt0 = Disables the INT1 external interrupt

bit 2 Unimplemented: Read as '0'

bit 1 INT2IF: INT2 External Interrupt Flag bit

1 = The INT2 external interrupt occurred (must be cleared in software)

0 = The INT2 external interrupt did not occur

bit 0 INT1IF: INT1 External Interrupt Flag bit

1 = The INT1 external interrupt occurred (must be cleared in software)

0 = The INT1 external interrupt did not occur

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows software polling.

8.1.2 PIR REGISTERS

The Peripheral Interrupt Request (PIR) registers contain the individual flag bits for the peripheral interrupts (Register 8-5). There are two Peripheral Interrupt Request (Flag) registers (PIR1, PIR2).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit, GIE (INTCON register).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt, and after servicing that interrupt.

8.1.3 PIE REGISTERS

The Peripheral Interrupt Enable (PIE) registers contain the individual enable bits for the peripheral interrupts (Register 8-6). There are two two Peripheral Interrupt Enable registers (PIE1, PIE2). When IPEN is clear, the PEIE bit must be set to enable any of these peripheral interrupts.

8.1.4 IPR REGISTERS

The Interrupt Priority (IPR) registers contain the individual priority bits for the peripheral interrupts (Register 8-9). There are two Peripheral Interrupt Priority registers (IPR1, IPR2). The operation of the priority bits requires that the Interrupt Priority Enable bit (IPEN) be set.

8.1.5 RCON REGISTER

The Reset Control (RCON) register contains the bit that is used to enable prioritized interrupts (IPEN).

REGISTER 8-4: RCON REGISTER

R/W-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-0	U-0
IPEN	r	_	RI	TO	PD	POR	r
bit 7	•		•	•	•		bit 0

1 = Enable priority levels on interrupts

0 = Disable priority levels on interrupts (16CXXX compatibility mode)

bit 6 Reserved: Maintain as '0'

bit 5 Unimplemented: Read as '0'

bit 4 RI: RESET Instruction Flag bit

For details of bit operation, see Register 4-4

bit 3 TO: Watchdog Time-out Flag bit

For details of bit operation, see Register 4-4

bit 2 PD: Power-down Detection Flag bit

For details of bit operation, see Register 4-4

bit 1 POR: Power-on Reset Status bit

For details of bit operation, see Register 4-4

bit 0 Reserved: Maintain as '0'

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

REGISTER 8-5: PIR1 REGISTER

_	U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF
	bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6 ADIF: A/D Converter Interrupt Flag bit

1 = An A/D conversion completed (must be cleared in software)

0 = The A/D conversion is not complete

bit 5 RCIF: USART Receive Interrupt Flag bit

1 = The USART receive buffer, RCREG, is full (cleared when RCREG is read)

0 = The USART receive buffer is empty

bit 4 TXIF: USART Transmit Interrupt Flag bit

1 = The USART transmit buffer, TXREG, is empty (cleared when TXREG is written)

0 = The USART transmit buffer is full

bit 3 SSPIF: Master Synchronous Serial Port Interrupt Flag bit

1 = The transmission/reception is complete (must be cleared in software)

0 = Waiting to transmit/receive

bit 2 **CCP1IF**: CCP1 Interrupt Flag bit

Capture mode:

1 = A TMR1 register capture occurred (must be cleared in software)

0 = No TMR1 register capture occurred

Compare mode:

1 = A TMR1 register compare match occurred (must be cleared in software)

0 = No TMR1 register compare match occurred

PWM mode:

Unused in this mode

bit 1 TMR2IF: TMR2 to PR2 Match Interrupt Flag bit

1 = TMR2 to PR2 match occurred (must be cleared in software)

0 = No TMR2 to PR2 match occurred

bit 0 TMR1IF: TMR1 Overflow Interrupt Flag bit

1 = TMR1 register overflowed (must be cleared in software)

0 = TMR1 register did not overflow

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

REGISTER 8-6: PIR2 REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	_	BCLIF	LVDIF	TMR3IF	CCP2IF
bit 7							bit 0

bit 7-4 Unimplemented: Read as'0'

bit 3 BCLIF: Bus Collision Interrupt Flag bit

1 = A bus collision occurred (must be cleared in software)0 = No bus collision occurred

bit 2 LVDIF: Low Voltage Detect Interrupt Flag bit

1 = A low voltage condition occurred (must be cleared in software)

0 = The device voltage is above the Low Voltage Detect trip point

bit 1 TMR3IF: TMR3 Overflow Interrupt Flag bit

1 = TMR3 register overflowed (must be cleared in software)0 = TMR3 register did not overflow

bit 0 CCP2IF: CCPx Interrupt Flag bit

Capture mode:

1 = A TMR1 register capture occurred (must be cleared in software)

0 = No TMR1 register capture occurred

Compare mode:

1 = A TMR1 register compare match occurred (must be cleared in software)

0 = No TMR1 register compare match occurred

PWM mode:

Unused in this mode

REGISTER 8-7: PIE1 REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

bit 7 Unimplemented: Read as '0'

bit 6 ADIE: A/D Converter Interrupt Enable bit

> 1 = Enables the A/D interrupt 0 = Disables the A/D interrupt

bit 5 RCIE: USART Receive Interrupt Enable bit

1 = Enables the USART receive interrupt

0 = Disables the USART receive interrupt

bit 4 TXIE: USART Transmit Interrupt Enable bit

> 1 = Enables the USART transmit interrupt 0 = Disables the USART transmit interrupt

SSPIE: Master Synchronous Serial Port Interrupt Enable bit bit 3

> 1 = Enables the MSSP interrupt 0 = Disables the MSSP interrupt

bit 2 CCP1IE: CCP1 Interrupt Enable bit

> 1 = Enables the CCP1 interrupt 0 = Disables the CCP1 interrupt

bit 1 TMR2IE: TMR2 to PR2 Match Interrupt Enable bit

1 = Enables the TMR2 to PR2 match interrupt

0 = Disables the TMR2 to PR2 match interrupt

bit 0 TMR1IE: TMR1 Overflow Interrupt Enable bit

1 = Enables the TMR1 overflow interrupt

0 = Disables the TMR1 overflow interrupt

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-8: PIE2 REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	_	BCLIE	LVDIE	TMR3IE	CCP2IE
bit 7							bit 0

bit 7-4 Unimplemented: Read as '0'

bit 3 BCLIE: Bus Collision Interrupt Enable bit

1 = Enabled0 = Disabled

bit 2 LVDIE: Low Voltage Detect Interrupt Enable bit

1 = Enabled0 = Disabled

bit 1 TMR3IE: TMR3 Overflow Interrupt Enable bit

1 = Enables the TMR3 overflow interrupt0 = Disables the TMR3 overflow interrupt

bit 0 CCP2IE: CCP2 Interrupt Enable bit

1 = Enables the CCP2 interrupt0 = Disables the CCP2 interrupt

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-9: IPR1 REGISTER

U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6 ADIP: A/D Converter Interrupt Priority bit

1 = High priority0 = Low priority

bit 5 RCIP: USART Receive Interrupt Priority bit

1 = High priority0 = Low priority

bit 4 TXIP: USART Transmit Interrupt Priority bit

1 = High priority0 = Low priority

bit 3 SSPIP: Master Synchronous Serial Port Interrupt Priority bit

1 = High priority0 = Low priority

bit 2 **CCP1IP**: CCP1 Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 TMR2IP: TMR2 to PR2 Match Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 TMR1IP: TMR1 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-10: IPR2 REGISTER

U-0	U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1
_		_	_	BCLIP	LVDIP	TMR3IP	CCP2IP
bit 7							bit 0

bit 7-4 Unimplemented: Read as '0'

bit 3 BCLIP: Bus Collision Interrupt Priority bit

1 = High priority0 = Low priority

bit 2 LVDIP: Low Voltage Detect Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 TMR3IP: TMR3 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 CCP2IP: CCP2 Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

8.1.6 INT INTERRUPTS

External interrupts on the RB0/INT0, RB1/INT1 and RB2/INT2 pins are edge triggered: either rising, if the corresponding INTEDGx bit is set in the INTCON2 register, or falling, if the INTEDGx bit is clear. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit INTxIF is set. This interrupt can be disabled by clearing the corresponding enable bit INTxIE. Flag bit INTxIF must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt. All external interrupts (INT0, INT1 and INT2) can wake-up the processor from SLEEP, if bit INTxIE was set prior to going into SLEEP. If the global interrupt enable bit GIE is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1 and INT2 is determined by the value contained in the interrupt priority bits INT1IP (INTCON3 register) and INT2IP (INTCON3 register). There is no priority bit associated with INT0; it is always a high priority interrupt source.

8.1.7 TMR0 INTERRUPT

In 8-bit mode (which is the default), an overflow (0FFh \rightarrow 00h) in the TMR0 register will set flag bit TMR0IF. In 16-bit mode, an overflow (0FFFh \rightarrow 0000h)

in the TMR0H:TMR0L registers will set flag bit TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit TMR0IE (INTCON register). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit TMR0IP (INTCON2 register). See Section 10.0 for further details on the Timer0 module.

8.1.8 PORTB INTERRUPT-ON-CHANGE

An input change on PORTB<7:4> sets flag bit RBIF (INTCON register). The interrupt can be enabled/disabled by setting/clearing enable bit RBIE (INTCON register). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit RBIP (INTCON2 register).

8.2 Context Saving During Interrupts

During an interrupt, the return PC value is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the fast return stack. If a fast return from interrupt is not used (See Section 4.3), the user may need to save the WREG, STATUS and BSR registers in software. Depending on the user's application, other registers may also need to be saved. Example 8-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 8-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

```
; W TEMP is in Low Access bank
MOVWF
         W TEMP
MOVEE
         STATUS, STATUS TEMP
                                     ; STATUS TEMP located anywhere
MOVFF
         BSR, BSR TEMP
                                     ; BSR located anywhere
; USER ISR CODE
MOVEE
         BSR TEMP, BSR
                                     ; Restore BSR
MOVE
         W TEMP, W
                                     ; Restore WREG
MOVFF
         STATUS TEMP, STATUS
                                     ; Restore STATUS
```

NOTES:

9.0 I/O PORTS

Depending on the device selected, there are up to 9 ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Each port has three registers for its operation. These registers are:

- TRIS register (data direction register)
- PORT register (reads the levels on the pins of the device)
- LAT register (output latch)

The data latch (LAT register) is useful for read-modifywrite operations on the value that the I/O pins are driving.

9.1 PORTA, TRISA and LATA Registers

PORTA is a 6-bit wide, bi-directional port. The corresponding data direction register is TRISA. Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., put the contents of the output latch on the selected pin). On a Power-on Reset, these pins are configured as analog inputs and read as '0'.

Reading the PORTA register reads the status of the pins, whereas writing to it will write to the port latch.

Read-modify-write operations on the LATA register, reads and writes the latched output value for PORTA.

The RA4 pin is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin. The RA4/T0CKI pin is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers.

The other PORTA pins are multiplexed with analog inputs and the analog VREF+ and VREF- inputs. The operation of each pin is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register1). On a Power-on Reset, these pins are configured as analog inputs and read as '0'.

The TRISA register controls the direction of the RA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

Note: On a Power-on Reset, PORTA pins RA3:RA0 and RA5 default to analog inputs.

EXAMPLE 9-1: INITIALIZING PORTA

CLRF	PORTA	; Initialize PORTA by
		; clearing output
		; data latches
CLRF	LATA	; Alternate method
		; to clear output
		; data latches
MOVLW	07h	; Configure A/D
MOVWF	ADCON1	; for digital inputs
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISA	; Set RA3:RA0 as inputs
		; RA5:RA4 as outputs
		_

FIGURE 9-1: RA3:RA0 AND RA5 PINS BLOCK DIAGRAM

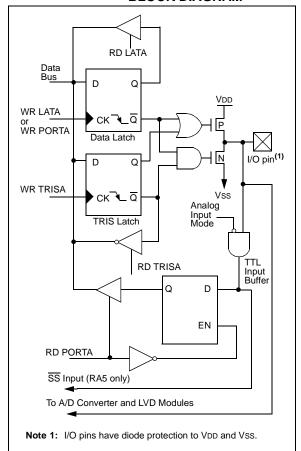


FIGURE 9-2: RA4/T0CKI PIN BLOCK DIAGRAM

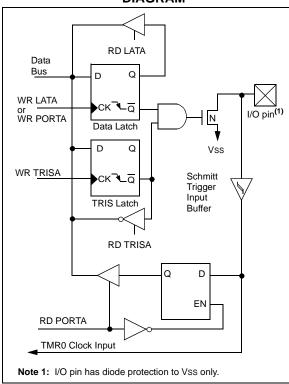


TABLE 9-1: PORTA FUNCTIONS

Name	Bit#	Buffer	Function
RA0/AN0	bit0	TTL	Input/output or analog input
RA1/AN1	bit1	TTL	Input/output or analog input
RA2/AN2/VREF-	bit2	TTL	Input/output or analog input or VREF-
RA3/AN3/VREF+	bit3	TTL	Input/output or analog input or VREF+
RA4/T0CKI	bit4	ST/OD	Input/output or external clock input for Timer0, output is open drain type
RA5/SS/AN4/LVDIN	bit5	TTL	Input/output or slave select input for synchronous serial port or analog input or low voltage detect input

Legend: TTL = TTL input, ST = Schmitt Trigger input, OD = Open Drain

TABLE 9-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	uu uuuu
LATA	_	Latch A	_atch A Data Output Register							-uuu uuuu
TRISA	_	PORTA	PORTA Data Direction Register							-111 1111
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	00 0000	uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

9.2 PORTB, TRISB and LATB Registers

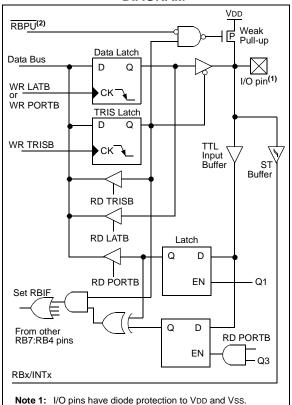
PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. Setting a TRISB bit (= 1) will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISB bit (= 0) will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATB register read and write the latched output value for PORTB.

EXAMPLE 9-2: INITIALIZING PORTB

CLRF	PORTB	<pre>; Initialize PORTB by ; clearing output</pre>
CLRF	LATB	<pre>; data latches ; Alternate method</pre>
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB3:RB0 as inputs
		; RB5:RB4 as outputs
		; RB7:RB6 as inputs

FIGURE 9-3: RB7:RB4 PINS BLOCK DIAGRAM



To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the RBPU bit (INTCON2 register).

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit RBPU (INTCON2 register). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Pin RB3 is multiplexed with the CCP input/output. The weak pull-up for RB3 is disabled when the RB3 pin is configured as CCP pin. By disabling the weak pull-up when pin is configured as CCP, allows the remaining weak pull-up devices of PORTB to be used while the CCP is being used.

Four of PORTB's pins, RB7:RB4, have an interrupt-onchange feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupton-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'd together to generate the RB Port Change Interrupt with flag bit RBIF (INTCON register).

This interrupt can wake the device from SLEEP. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB (except with the MOVFF instruction). This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

FIGURE 9-4: RB2:RB0 PINS BLOCK DIAGRAM

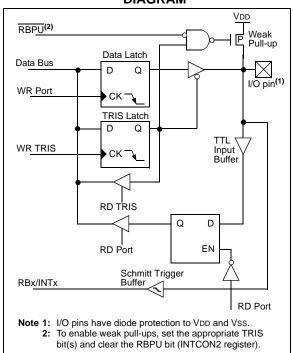


FIGURE 9-5: RB3 PIN BLOCK DIAGRAM

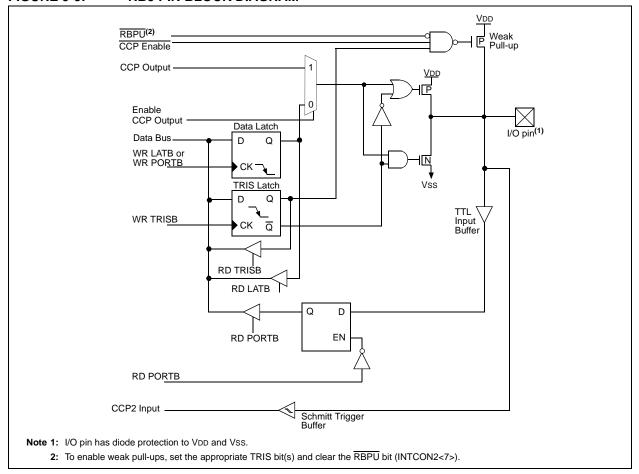


TABLE 9-3: PORTB FUNCTIONS

Name	Bit#	Buffer	Function
RB0/INT0	bit0	TTL/ST ⁽¹⁾	Input/output pin or external interrupt 0 input. Internal software programmable weak pull-up.
RB1/INT1	bit1	TTL/ST ⁽¹⁾	Input/output pin or external interrupt 1 input. Internal software programmable weak pull-up.
RB2/INT2	bit2	TTL/ST ⁽¹⁾	Input/output pin or external interrupt 2 input. Internal software programmable weak pull-up.
RB3/CCP2	bit3	TTL/ST ⁽³⁾	Input/output pin or Capture2 input or Capture2 output or PWM2 output. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up. Serial programming clock.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up. Serial programming data.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: This pin is a Schmitt Trigger input when configured as the external interrupt.

2: This pin is a Schmitt Trigger input when used in Serial Programming mode.

3: This pin is a Schmitt Trigger input when used in a Capture input.

TABLE 9-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
LATB	LATB Data Output Register								xxxx xxxx	uuuu uuuu
TRISB	PORTB Data Direction Register								1111 1111	1111 1111
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	_	RBIP	1111 1111	1111 1111
INTCON3	INT2IP	INT1IP	_	INT2IE	INT1IE	_	INT2IF	INT1IF	1100 0000	1100 0000

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTD.

9.3 PORTC, TRISC and LATC Registers

PORTC is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISC. Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATC register, read and write the latched output value for PORTC.

PORTC is multiplexed with several peripheral functions (Table 9-5). PORTC pins have Schmitt Trigger input buffers.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register, without concern due to peripheral overrides.

EXAMPLE 9-3: INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by
		; clearing output
		; data latches
CLRF	LATC	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISC	; Set RC3:RC0 as inputs
		; RC5:RC4 as outputs
		; RC7:RC6 as inputs



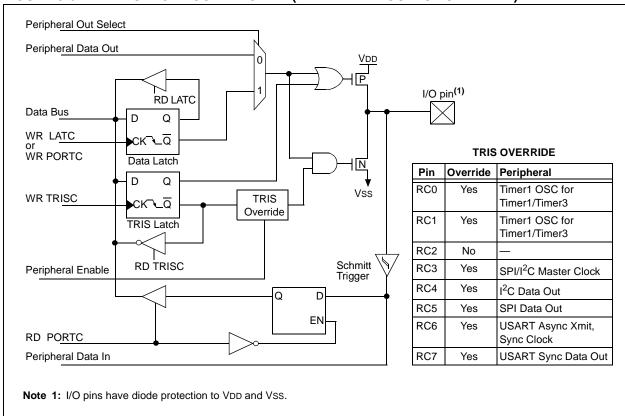


TABLE 9-5: PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T13CKI	bit0	ST	Input/output port pin or Timer1 oscillator output or Timer1/Timer3 clock input.
RC1/T1OSI	bit1	ST	Input/output port pin, Timer1 oscillator input.
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	bit3	ST	Input/output port pin or synchronous serial clock for SPI/I ² C.
RC4/SDI/SDA	bit4	ST	Input/output port pin or SPI Data in (SPI mode) or Data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or Synchronous Serial Port Data output.
RC6/TX/CK	bit6	ST	Input/output port pin, Addressable USART Asynchronous Transmit, or Addressable USART Synchronous Clock.
RC7/RX/DT	bit7	ST	Input/output port pin, Addressable USART Asynchronous Receive, or Addressable USART Synchronous Data.

Legend: ST = Schmitt Trigger input

TABLE 9-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
LATC	LATC D	ata Outpu	t Register		xxxx xxxx	uuuu uuuu				
TRISC	PORTC	PORTC Data Direction Register 1111 1111 1111 1111								

Legend: x = unknown, u = unchanged

9.4 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISD. Setting a TRISD bit (= 1) will make the corresponding PORTD pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISD bit (= 0) will make the corresponding PORTD pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATD register reads and writes the latched output value for PORTD.

PORTD is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

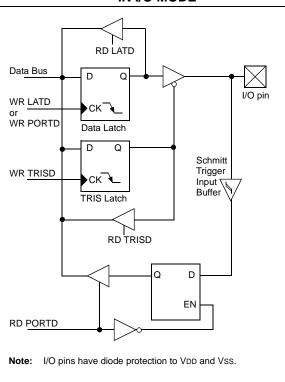
PORTD is multiplexed with the system bus and is available only when the system bus is disabled, by setting EBIDS bit in register MEMCON. When operating as the system bus, PORTD is the low order byte of the address/data bus (AD7:AD0), or as the low order address byte (A15:A8) if the address and data buses are de-multiplexed.

Note: On a Power-on Reset, PORTD defaults to the system bus.

EXAMPLE 9-4: INITIALIZING PORTD

(CLRF	PORTD	;	Initialize PORTD by
			;	clearing output
			;	data latches
(CLRF	LATD	;	Alternate method
			;	to clear output
			;	data latches
1	MOVLW	0CFh	;	Value used to
			;	initialize data
			;	direction
1	MOVWF	TRISD	;	Set RD3:RD0 as inputs
			;	RD5:RD4 as outputs
			;	RD7:RD6 as inputs
- 1				

FIGURE 9-7: PORTD BLOCK DIAGRAM IN I/O MODE



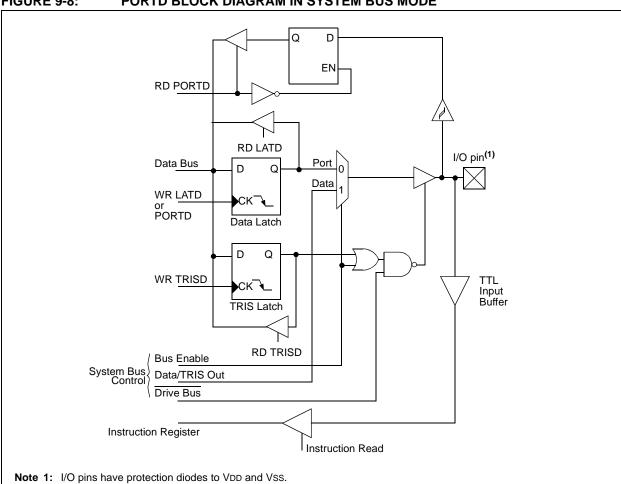


FIGURE 9-8: PORTD BLOCK DIAGRAM IN SYSTEM BUS MODE

TABLE 9-7: PORTD FUNCTIONS

Name	Bit#	Buffer Type	Function
RD0/AD0/A0 ⁽²⁾	bit0	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 0
RD1/AD1/A1 ⁽²⁾	bit1	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 1
RD2/AD2/A2 ⁽²⁾	bit2	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 2
RD3/AD3/A3 ⁽²⁾	bit3	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 3
RD4/AD4/A4 ⁽³⁾	bit4	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 4
RD5/AD5/A5 ⁽²⁾	bit5	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 5
RD6/AD6/A6 ⁽²⁾	bit6	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 6
RD7/AD7/A7 ⁽²⁾	bit7	ST/TTL ⁽¹⁾	Input/output port pin or system bus bit 7

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Input buffers are Schmitt Triggers when in I/O mode and TTL buffers when in System Bus mode.

2: RDx is used as a multiplexed address/data bus for PIC18C601 and PIC18C801 in 16-bit mode, and as an address only for PIC18C801 in 8-bit mode.

TABLE 9-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	uuuu uuuu
LATD	LATD Data	LATD Data Output Register								uuuu uuuu
TRISD	PORTD D	PORTD Data Direction Register								1111 1111
MEMCON	EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by PORTD.

9.5 PORTE, TRISE and LATE Registers

PORTE is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATE register reads and writes the latched output value for PORTE.

PORTE is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output. PORTE is multiplexed with several peripheral functions (Table 9-9).

PORTE is multiplexed with the system bus and is available only when the system bus is disabled, by setting EBDIS bit in register MEMCON. When operating as the system bus, PORTE is configured as the high order

byte of the address/data bus (AD15:AD8), or as the high order address byte (A15:A8), if address and data buses are de-multiplexed.

Note: On Power-on Reset, PORTE defaults to the system bus.

EXAMPLE 9-5: INITIALIZING PORTE

CLRF	PORTE	; Initialize PORTE by
		; clearing output
		; data latches
CLRF	LATE	; Alternate method
		; to clear output
		; data latches
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE1:RE0 as inputs
		; RE7:RE2 as outputs

FIGURE 9-9: PORTE BLOCK DIAGRAM IN I/O MODE

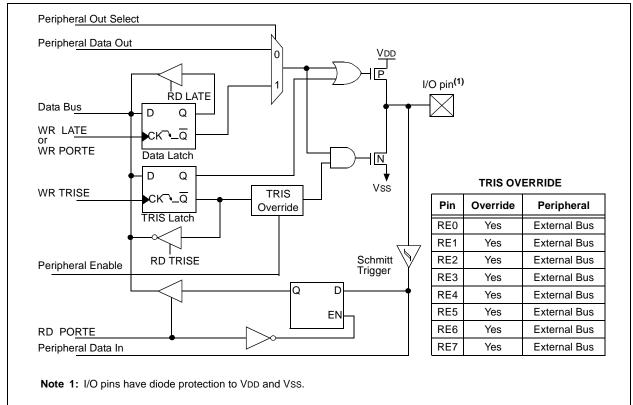


FIGURE 9-10: PORTE BLOCK DIAGRAM IN SYSTEM BUS MODE

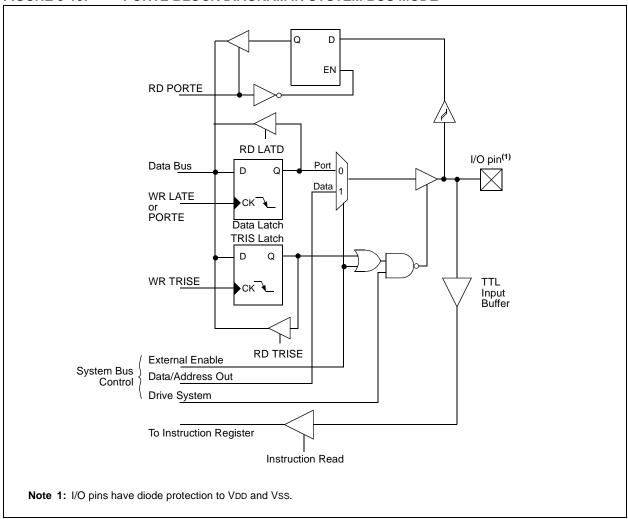


TABLE 9-9: PORTE FUNCTIONS

Name	Bit#	Buffer Type	Function
RE0/AD8/A8 ⁽²⁾	bit0	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 8
RE1/AD9/A9 ⁽²⁾	bit1	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 9
RE2/AD10/A10 ⁽²⁾	bit2	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 10
RE3/AD11/A11 ⁽²⁾	bit3	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 11
RE4/AD12/A12 ⁽²⁾	bit4	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 12
RE5/AD13/A13 ⁽²⁾	bit5	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 13
RE6/AD14/A14 ⁽²⁾	bit6	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 14
RE7/AD15/A15 ⁽²⁾	bit7	ST/TTL ⁽¹⁾	Input/output port pin or Address/Data bit 15

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Input buffers are Schmitt Triggers when in I/O mode and TTL buffers when in System Bus mode.

2: REx is used as a multiplexed address/data bus for PIC18C601 and PIC18C801 in 16-bit mode, and as an address only for PIC18C801 in 8-bit mode.

TABLE 9-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
TRISE	PORTE	Data Dire	ection Cor	trol Regis	ster				1111 1111	1111 1111
PORTE	Read PO	Read PORTE pin/Write PORTE Data Latch								uuuu uuuu
LATE	Read PORTE Data Latch/Write PORTE Data Latch xxxx xxxx uuuu								uuuu uuuu	
MEMCON	EBDIS	PGRM	WAIT1	WAIT0			WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTE.

9.6 PORTF, LATF, and TRISF Registers

PORTF is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISF. Setting a TRISF bit (= 1) will make the corresponding PORTF pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISF bit (= 0) will make the corresponding PORTF pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATF register reads and writes the latched output value for PORTF.

PORTF pins, RF2:RF0, are multiplexed with analog inputs. The operation of these pins are selected by ADCON0 and ADCON1 registers.

PORTF pins, RF3 and RF5, are multiplexed with two of the integrated chip select signals $\overline{\text{CSIO}}$ and $\overline{\text{CS1}}$. For PIC18C801, pin RF4 is multiplexed with chip select signal $\overline{\text{CS2}}$, while for PIC18C601, it is multiplexed with system bus signal A16. For PIC18C801 devices, both CSEL2 and CSELIO registers must set to all zero, to enable these pins as I/O pins, while for PIC18C601 devices, only CSELIO register needs to be set to zero. For PIC18C601 devices, pin RF4 can only be configured as I/O when the EBDIS bit is set and execution is taking place in internal Boot RAM.

PORTF pins, RF7:RF6, are multiplexed with the system bus control signal \overline{UB} and \overline{LB} , respectively, when a device with 16-bit bus execution is used. These pins can be configured as I/O pins by setting WM bits in the MEMCON register to any value other than '01'.

Note 1: On Power-on Reset, PORTF pins RF2:RF0 default to A/D inputs.

2: On Power-on Reset, PORTF pins RF7:RF3 for PIC18C801 and pins

RF7:RF3 for PIC18C801 and pins RF7:RF5, RF3 for PIC18C601, default to system bus signals.

EXAMPLE 9-6: INITIALIZING PORTF

CLRF	PORTF	; Initialize PORTF by ; clearing output
		; data latches
CLRF	LATF	; Alternate method
		; to clear output
		; data latches
MOVLW	0Fh	;
MOVWF	ADCON1	; Set PORTF as digital I/O
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISF	; Set RF3:RF0 as inputs
		; RF5:RF4 as outputs
		; RF7:RF6 as inputs

EXAMPLE 9-7: PROGRAMMING CHIP SELECT SIGNALS

Program chip select to activate CS1 ; for all address less than 03FFFFh, ; while activate CS2 for rests of the ; addresses ; CSEL2 register is secured register. ; Before it can be modified it, ; combination lock must be opened MOVLW 20h ; Preload WREG with ; correct CSEL2 valu ; Disable interrupts BCF INTCON, GIE CALL UNLOCK ; Now unlock it ; Lock is open. Modify CSEL2... MOVWF CSEL2 ; Lock is closed BSF INTCON, GIE ; Re-enable interrupts ; Chip select is programmed. UNLOCK BSF PSPCON, CMLK1 BSF PSPCON, CMLKO RETURN

FIGURE 9-11: RF2:RF0 PINS BLOCK DIAGRAM

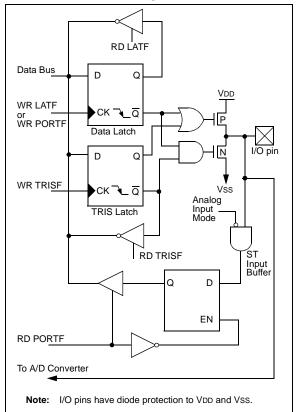


FIGURE 9-12: RF5:RF3 PINS BLOCK DIAGRAM

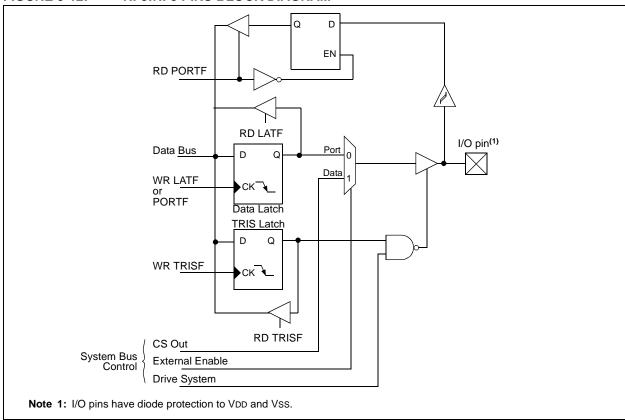


FIGURE 9-13: RF7:RF6 PINS BLOCK DIAGRAM

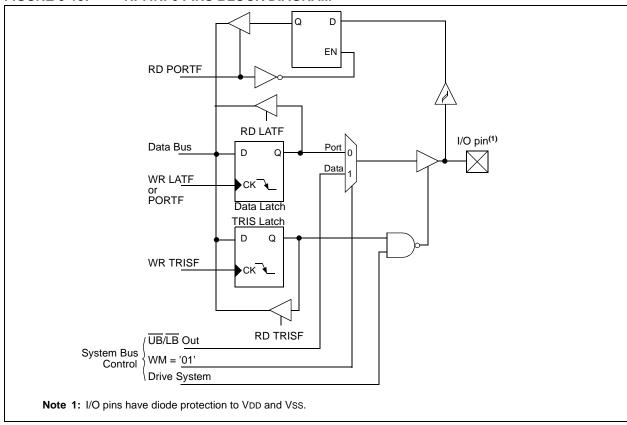


TABLE 9-11: PORTF FUNCTIONS

Name	Bit#	Buffer Type	Function
RF0/AN5	bit0	ST	Input/output port pin or analog input
RF1/AN6	bit1	ST	Input/output port pin or analog input
RF2/AN7	bit2	ST	Input/output port pin or analog input
RF3/CSIO	bit3	ST	Input/output port pin or I/O chip select
RF4/A16/CS2 ⁽¹⁾	bit4	ST	Input/output port pin or chip select 2 or address bit 16
RF5/CS1	bit5	ST	Input/output port pin or chip select 1
RF6/LB	bit6	ST	Input/output port pin or low byte select signal for external memory
RF7/UB	bit7	ST	Input/output port pin or high byte select signal for external memory

Legend: ST = Schmitt Trigger input

Note 1: $\overline{\text{CS2}}$ is available only on PIC18C801.

TABLE 9-12: SUMMARY OF REGISTERS ASSOCIATED WITH PORTF

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
TRISF	PORTF D	ata Directi	ion Contr	ol Registe	er				1111 1111	1111 1111
PORTF	Read PO	RTF pin/W	rite POR	TF Data I	_atch				xxxx xxxx	uuuu uuuu
LATF	Read PO	RTF Data	Latch/Wri	ite PORT	F Data La	atch			0000 0000	uuuu uuuu
ADCON1	_	-	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	00 0000	00 0000
MEMCON	EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTF.

9.7 PORTG, LATG, and TRISG Registers

PORTG is a 5-bit wide, bi-directional port. The corresponding data direction register is TRISG. Setting a TRISG bit (= 1) will make the corresponding PORTG pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISG bit (= 0) will make the corresponding PORTG pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATG register read and write the latched output value for PORTG.

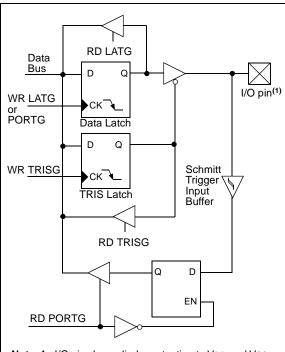
PORTG is multiplexed with system bus control signals ALE, \overline{OE} , \overline{WRH} , \overline{WRL} and BA0. The \overline{WRH} signal is the only signal that is disabled and configured as a port pin (RG3) during external program execution in 8-bit mode. All other pins are by default, system bus control signals. PORTG can be configured as an I/O port by setting EBDIS bit in the MEMCON register and when execution is taking place in internal program RAM.

Note: On Power-on Reset, PORTG defaults to system bus signals.

EXAMPLE 9-8: INITIALIZING PORTG

CLRF	PORTG	; Initialize PORTG by ; clearing output
		; data latches
CLRF	LATG	; Alternate method
		; to clear output
		; data latches
MOVLW	04h	; Value used to
		; initialize data
		; direction
MOVWF	TRISG	; Set RG1:RG0 as outputs
		; RG2 as input
		; RG4:RG3 as outputs

FIGURE 9-14: PORTG BLOCK DIAGRAM IN I/O MODE



Note 1: I/O pins have diode protection to VDD and Vss.

FIGURE 9-15: PORTG BLOCK DIAGRAM IN SYSTEM BUS MODE

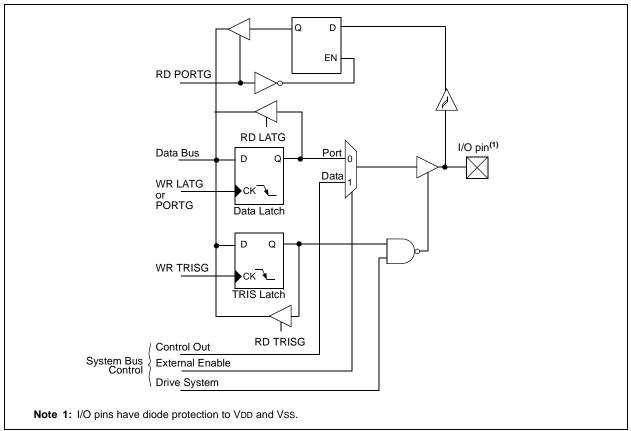


TABLE 9-13: PORTG FUNCTIONS

Name	Bit#	Buffer Type	Function				
RG0/ALE	bit0	ST	Input/output port pin or Address Latch Enable signal for external memory				
RG1/OE	bit1	ST	Input/output port pin or Output Enable signal for external memory				
RG2/WRL	bit2	ST	Input/output port pin or Write Low byte signal for external memory				
RG3/WRH	bit3	ST	Input/output port pin or Write High byte signal for external memory				
RG4/BA0	bit4	ST	Input/output port pin or Byte Address 0 signal for external memory				

Legend: ST = Schmitt Trigger input

TABLE 9-14: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
TRISG	PORTG D	ata Direct		1 1111	1 1111					
PORTG	Read POF	RTG pin/W	/rite PORT	G Data Latc	h				x xxxx	u uuuu
LATG	Read POF	RTG Data		x xxxx	u uuuu					
MEMCON	EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTG.

9.8 PORTH, LATH, and TRISH Registers

Note: PORTH is available only on PIC18C801 devices.

PORTH is an 8-bit wide, bi-directional I/O port. The corresponding data direction register is TRISH. Setting a TRISH bit (= 1) will make the corresponding PORTH pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISH bit (= 0) will make the corresponding PORTH pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATH register read and write the latched output value for PORTH.

Pins RH7:RH4 are multiplexed with analog inputs AN18:AN11, while pins RH3:RH0 are multiplexed with system address bus A19:A16. By default, pins RH7:RH4 will setup as A/D inputs and pins RH3:RH0 will setup as system address bus. Register ADCON1 configures RH7:RH4 as I/O or A/D inputs. Register MEMCON configures RH3:RH0 as I/O or system bus pins.

- Note 1: On Power-on Reset, PORTH pins RH7:RH4 default to A/D inputs and read as '0'.
 - **2:** On Power-on Reset, PORTH pins RH3:RH0 default to system bus signals.

EXAMPLE 9-9: INITIALIZING PORTH

CLRF	PORTH	; Initialize PORTH by
		; clearing output
		; data latches
CLRF	LATH	; Alternate method
		; to clear output
		; data latches
MOVLW	0Fh	;
MOVWF	ADCON1	;
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISH	; Set RH3:RH0 as inputs
		; RH5:RH4 as outputs
		; RH7:RH6 as inputs

FIGURE 9-16: RH3:RH0 PINS BLOCK DIAGRAM IN I/O MODE

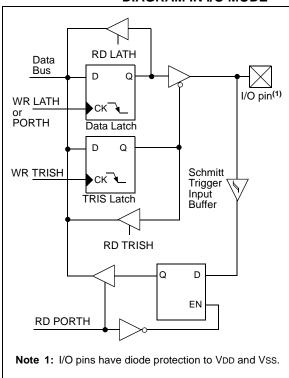


FIGURE 9-17: RH7:RH4 PINS BLOCK DIAGRAM

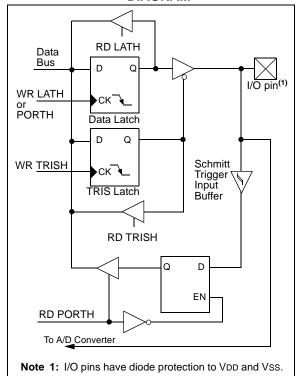


FIGURE 9-18: RH3:RH0 PINS BLOCK DIAGRAM IN SYSTEM BUS MODE Q D ΕN **RD PORTH RD LATD** I/O pin(1) P<u>ort</u> Data Bus D D<u>ata</u> WR LATH or PORTH

Data Latch

∙ск¬⊾ TRIS Latch

Q

RD TRISH

Instruction Read

D

WR TRISH

External Enable.

Address Out Drive System

Note 1: I/O pins have diode protection to VDD and Vss.

To Instruction Register

System Bus Control

TTL Input Buffer

TABLE 9-15: PORTH FUNCTIONS

Name	Bit#	Buffer Type	Function
RH0/A16 ⁽¹⁾	bit0	ST	Input/output port pin or Address bit 16 for external memory interface
RH1/A17 ⁽¹⁾	bit1	ST	Input/output port pin or Address bit 17 for external memory interface
RH2/A18 ⁽¹⁾	bit2	ST	Input/output port pin or Address bit 18 for external memory interface
RH3/A19 ⁽¹⁾	bit3	ST	Input/output port pin or Address bit 19 for external memory interface
RH4/AN8 ⁽¹⁾	bit4	ST	Input/output port pin or analog input channel 8
RH5/AN9 ⁽¹⁾	bit5	ST	Input/output port pin or analog input channel 9
RH6/AN10 ⁽¹⁾	bit6	ST	Input/output port pin or analog input channel 10
RH7/AN11 ⁽¹⁾	bit7	ST	Input/output port pin or analog input channel 11

Legend: ST = Schmitt Trigger input

Note 1: PORTH is available only on PIC18C801 devices.

TABLE 9-16: SUMMARY OF REGISTERS ASSOCIATED WITH PORTH

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
TRISH	PORTH	Data Dire		1111 1111	1111 1111					
PORTH	Read PC	RTH pin/	Write POF	RTH Data	Latch				xxxx xxxx	uuuu uuuu
LATH	Read PC	RTH Dat	a Latch/W	rite PORT	TH Data L	atch			xxxx xxxx	uuuu uuuu
ADCON1	— — VCFG1 VCFG0 PCFG3 PCFG2 PCFG1 PCFG0								00 0000	00 0000
MEMCON	EBDIS	PGRM	WAIT1	WAIT0	_	_	WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged, - = unimplemented. Shaded cells are not used by PORTH.

9.9 PORTJ, LATJ, and TRISJ Registers

Note: PORTJ is available only on PIC18C801 devices.

PORTJ is an 8-bit wide, bi-directional I/O port. The corresponding data direction register is TRISJ. Setting a TRISJ bit (= 1) will make the corresponding PORTJ pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISJ bit (= 0) will make the corresponding PORTJ pin an output (i.e., put the contents of the output latch on the selected pin).

Read-modify-write operations on the LATJ register read and write the latched output value for PORTJ.

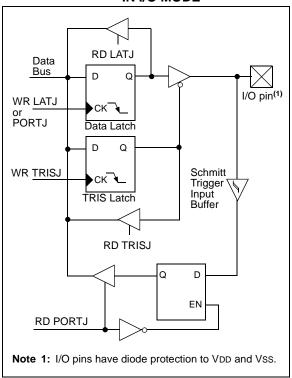
PORTJ is multiplexed with de-multiplexed system data bus D7:D0, when device is configured in 8-bit execution mode. Register MEMCON configures PORTJ as I/O or system bus pins.

Note: On Power-on Reset, PORTJ defaults to system bus signals.

EXAMPLE 9-10: INITIALIZING PORTJ

CLRF	PORTJ	; Initialize PORTJ by
		; clearing output
		; data latches
CLRF	LATJ	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISJ	; Set RJ3:RJ0 as inputs
		; RJ5:RJ4 as outputs
		; RJ7:RJ6 as inputs

FIGURE 9-19: PORTJ BLOCK DIAGRAM IN I/O MODE



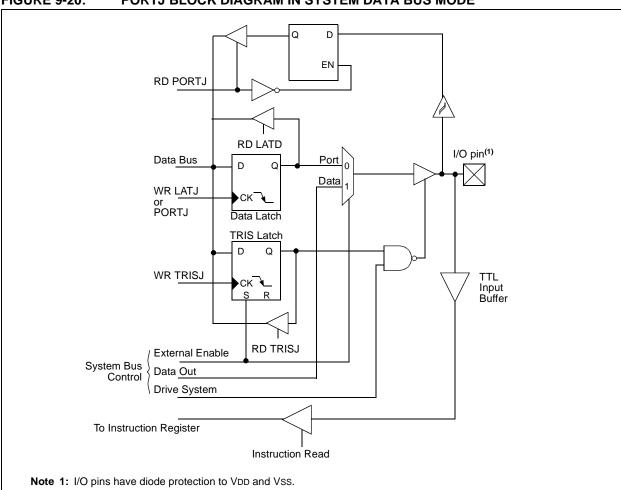


FIGURE 9-20: PORTJ BLOCK DIAGRAM IN SYSTEM DATA BUS MODE

TABLE 9-17: PORTJ FUNCTIONS

Name	Bit#	Buffer Type	Function					
RJ0/D0 ⁽¹⁾	bit0	ST/TTL	Input/output port pin or Data bit 0 for external memory interface					
RJ1/D1 ⁽¹⁾	bit1	ST/TTL	Input/output port pin or Data bit 1 for external memory interface					
RJ2/D2 ⁽¹⁾	bit2	ST/TTL	Input/output port pin or Data bit 2 for external memory interface					
RJ3/D3 ⁽¹⁾	bit3	ST/TTL	Input/output port pin or Data bit 3 for external memory interface					
RJ4/D4 ⁽¹⁾	bit4	ST/TTL	Input/output port pin or Data bit 4 for external memory interface					
RJ5/D5 ⁽¹⁾	bit5	ST/TTL	Input/output port pin or Data bit 5 for external memory interface					
RJ6/D6 ⁽¹⁾	bit6	ST/TTL	Input/output port pin or Data bit 6 for external memory interface					
RJ7/D7 ⁽¹⁾	bit7	ST/TTL	Input/output port pin or Data bit 7 for external memory interface					

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: PORTJ is available only on PIC18C801 devices.

TABLE 9-18: SUMMARY OF REGISTERS ASSOCIATED WITH PORTJ

Name	Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0						Value on: POR, BOR	Value on all other RESETS		
TRISJ	PORTJ	Data Dire	ction Cor		1111 1111	1111 1111				
PORTJ	Read Po	ORTJ pin	Write PC	RTJ Data	a Latch				xxxx xxxx	uuuu uuuu
LATJ	Read Po	ORTJ Dat	ta Latch/V		xxxx xxxx	uuuu uuuu				
MEMCON	EBDIS	PGRM	WAIT1	WAIT0		1	WM1	WM0	000000	000000

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTJ.

10.0 TIMERO MODULE

The Timer0 module has the following features:

- Software selectable as an 8-bit or 16-bit timer/ counter
- · Readable and writable
- · Dedicated 8-bit software programmable prescaler
- · Clock source selectable to be external or internal
- Interrupt on overflow from FFh to 00h in 8-bit mode and FFFFh to 0000h in 16-bit mode
- Edge select for external clock

Register 10-1 shows the Timer0 Control register (T0CON).

Figure 10-1 shows a simplified block diagram of the Timer0 module in 8-bit mode and Figure 10-2 shows a simplified block diagram of the Timer0 module in 16-bit mode.

The T0CON register is a readable and writable register that controls all the aspects of Timer0, including the prescale selection.

Note: Timer0 is enabled on POR.

REGISTER 10-1: TOCON REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR00N	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

bit 7 TMR0ON: Timer0 On/Off Control bit

1 = Enables Timer0

0 = Stops Timer0

bit 6 **T08BIT**: Timer0 8-bit/16-bit Control bit

1 = Timer0 is configured as an 8-bit timer/counter

0 = Timer0 is configured as a 16-bit timer/counter

bit 5 TOCS: Timer0 Clock Source Select bit

1 = Transition on TOCKI pin

0 = Internal instruction cycle clock (CLKOUT)

bit 4 T0SE: Timer0 Source Edge Select bit

1 = Increment on high-to-low transition on T0CKI pin

0 = Increment on low-to-high transition on T0CKI pin

bit 3 **PSA**: Timer0 Prescaler Assignment bit

1 = TImer0 prescaler is NOT assigned. Timer0 clock input bypasses prescaler.

0 = Timer0 prescaler is assigned. Timer0 clock input comes from prescaler output.

bit 2-0 TOPS2:TOPS0: Timer0 Prescaler Select bits

111 = 1:256 prescale value

110 = 1:128 prescale value

101 = 1:64 prescale value

100 = 1:32 prescale value

011 = 1:16 prescale value

010 = 1:8 prescale value

001 = 1:4 prescale value

000 = 1:2 prescale value

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

FIGURE 10-1: TIMERO BLOCK DIAGRAM IN 8-BIT MODE

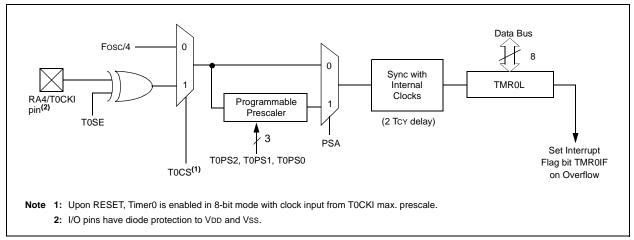
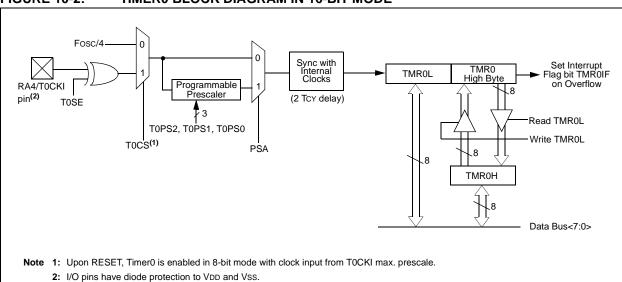


FIGURE 10-2: TIMERO BLOCK DIAGRAM IN 16-BIT MODE



10.1 Timer0 Operation

Timer0 can operate as a timer or as a counter.

Timer mode is selected by clearing the T0CS bit. In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If the TMR0L register is written, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0L register.

Counter mode is selected by setting the ToCS bit. In Counter mode, Timer0 will increment either on every rising, or falling edge, of pin RA4/ToCKI. The incrementing edge is determined by the Timer0 Source Edge Select bit (ToSE). Clearing the ToSE bit selects the rising edge. Restrictions on the external clock input are discussed below.

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (Tosc). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

10.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not readable or writable.

The PSA and T0PS2:T0PS0 bits determine the prescaler assignment and prescale ratio.

Clearing bit PSA will assign the prescaler to the Timer0 module. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4, ..., 1:256 are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF $\,$ TMR0, MOVWF TMR0, BSF TMR0, x.... etc.) will clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0, will clear the prescaler count but will not change the prescaler assignment.

10.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on-the-fly" during program execution).

10.3 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF bit. The interrupt can be masked by clearing the TMR0IE bit. The TMR0IF bit must be cleared in software by the Timer0 module Interrupt Service Routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP, since the timer is shut-off during SLEEP.

10.4 16-Bit Mode Timer Reads and Writes

Timer0 can be set in 16-bit mode by clearing T0CON T08BIT. Registers TMR0H and TMR0L are used to access 16-bit timer value.

TMR0H is not the high byte of the timer/counter in 16-bit mode, but is actually a buffered version of the high byte of Timer0 (refer to Figure 10-1). The high byte of the Timer0 counter/timer is not directly readable nor writable. TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16-bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

A write to the high byte of Timer0 must also take place through the TMR0H buffer register. Timer0 high byte is updated with the contents of the buffered value of TMR0H, when a write occurs to TMR0L. This allows all 16-bits of Timer0 to be updated at once.

TABLE 10-1:	REGISTERS ASSOCIA	ATED WITH TIMER0

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
TMR0L	Timer0 Mod	lule's Low Byt	e Register		xxxx xxxx	uuuu uuuu				
TMR0H	Timer0 Mod	lule's High By	te Registe	r					0000 0000	0000 0000
INTCON	N GIE/GIEH PEIE/GIEL TMR0IE INT0IE RBIE TMR0IF INT0IF RBIF						RBIF	0000 000x	0000 000u	
T0CON	TMR0ON	ROON TO8BIT TOCS TOSE PSA TOPS2 TOPS1 TOPS0							1111 1111	1111 1111
TRISA	_	PORTA Data	Direction		11 1111	11 1111				

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

11.0 TIMER1 MODULE

The Timer1 module timer/counter has the following features:

- 16-bit timer/counter
 The Chit remistered TMD411.
- (Two 8-bit registers: TMR1H and TMR1L)
- Readable and writable (both registers)
- · Internal or external clock select
- Interrupt on overflow from FFFFh to 0000h
- · RESET from CCP module special event trigger

Register 11-1 shows the Timer1 Control register. This register controls the operating mode of the Timer1 module as well as contains the Timer1 oscillator enable bit (T1OSCEN). Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON register).

Figure 11-1 is a simplified block diagram of the Timer1 module.

Note: Timer1 is disabled on POR.

REGISTER 11-1: T1CON REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N
bit 7							bit 0

- bit 7 RD16: 16-bit Read/Write Mode Enable bit
 - 1 = Enables register Read/Write of TImer1 in one 16-bit operation
 - 0 = Enables register Read/Write of Timer1 in two 8-bit operations
- bit 6 Unimplemented: Read as '0'
- bit 5-4 T1CKPS1:T1CKPS0: Timer1 Input Clock Prescale Select bits
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- bit 3 T10SCEN: Timer1 Oscillator Enable bit
 - 1 = Timer1 Oscillator is enabled
 - 0 = Timer1 Oscillator is shut-off

The oscillator inverter and feedback resistor are turned off to eliminate power drain.

bit 2 T1SYNC: Timer1 External Clock Input Synchronization Select bit

When TMR1CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR1CS = 0:

This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

- bit 1 TMR1CS: Timer1 Clock Source Select bit
 - 1 = External clock from pin RC0/T10S0/T13CKI (on the rising edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR10N: Timer1 On bit
 - 1 = Enables Timer1
 - 0 = Stops Timer1

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

11.1 Timer1 Operation

Timer1 can operate in one of these modes:

· As a timer

Note:

- · As a synchronous counter
- · As an asynchronous counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON register).

When Timer1 is configured in an Asynchronous mode, care must be taken to make sure that there is no incoming pulse while Timer1 is being turned off. If there is an incoming pulse while Timer1 is being turned off, Timer1 value may become unpredictable.

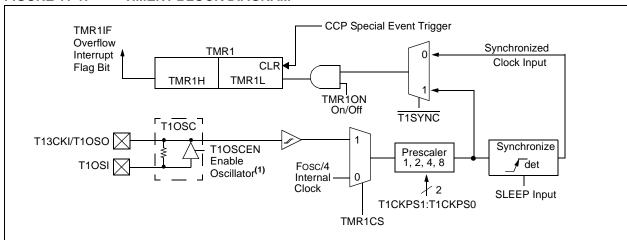
If an application requires that Timer1 be turned off and if it is possible that Timer1 may receive an incoming pulse while being turned off, synchronize the external clock first, by clearing the T1SYNC bit of register T1CON. Please note that this may cause Timer1 to miss up to one count.

When TMR1CS is clear, Timer1 increments every instruction cycle. When TMR1CS is set, Timer1 increments on every rising edge of the external clock input or the Timer1 oscillator, if enabled.

When the Timer1 oscillator is enabled (T10SCEN is set), the RC1/T10SI and RC0/T10SO/T1CKI pins become inputs. That is, the TRISC<1:0> value is ignored.

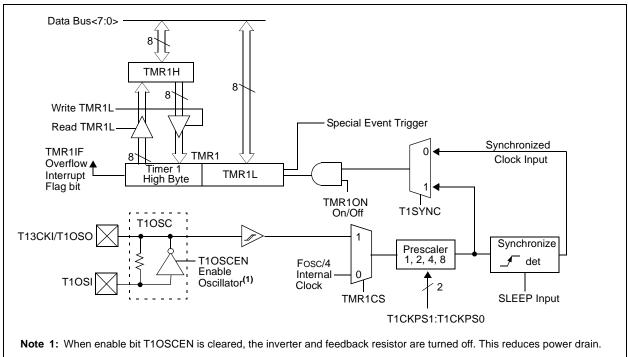
Timer1 also has an internal "RESET input". This RESET can be generated by the CCP module (Table 14.0).

FIGURE 11-1: TIMER1 BLOCK DIAGRAM



Note 1: When enable bit T1OSCEN is cleared, the inverter and feedback resistor are turned off. This reduces power drain.

FIGURE 11-2: TIMER1 BLOCK DIAGRAM: 16-BIT READ/WRITE MODE



11.2 Timer1 Oscillator

A crystal oscillator circuit is built-in between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON register). The oscillator is a low power oscillator rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for a 32 kHz crystal. Table 11-1 shows the capacitor selection for the Timer1 oscillator.

The user must provide a software time delay to ensure proper start-up of the Timer1 oscillator.

TABLE 11-1: CAPACITOR SELECTION FOR THE ALTERNATE OSCILLATOR

Osc Type		Freq	C1	C2				
L	.Р	32 kHz	TBD ⁽¹⁾	TBD(1)				
		Crystal to	be Tested:					
32.76	8 kHz	Epson C-001	R32.768K-A	± 20 PPM				
Note	ро 2: Ніс	point in validating the oscillator circuit. Higher capacitance increases the stability						
	sta 3: Sin ch res pri	of the oscillator out also increases the start-up time. Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components. Capacitor values are for design guidance						

11.3 Timer1 Interrupt

only.

The TMR1 Register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR1 interrupt, if enabled, is generated on overflow, which is latched in interrupt flag bit TMR1IF (PIR registers). This interrupt can be enabled/disabled by setting/clearing TMR1 interrupt enable bit TMR1IE (PIE registers).

11.4 Resetting Timer1 using a CCP Trigger Output

If the CCP module is configured in Compare mode to generate a "special event trigger" (CCP1M3:CCP1M0 = 1011), this signal will reset Timer1 and start an A/D conversion (if the A/D module is enabled).

Note: The special event triggers from the CCP1 module will not set interrupt flag bit TMR1IF (PIR registers).

Timer1 must be configured for either Timer, or Synchronized Counter mode, to take advantage of this feature. If Timer1 is running in Asynchronous Counter mode, this RESET operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1, the write will take precedence.

In this mode of operation, the CCPR1H:CCPR1L registers pair, effectively becomes the period register for Timer1.

11.5 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes (see Figure 11-2). When the RD16 control bit (T1CON register) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L will load the contents of the high byte of Timer1 into the Timer1 high byte buffer. This provides the user with the ability to accurately read all 16 bits of Timer1, without having to determine whether a read of the high byte followed by a read of the low byte is valid, due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H buffer register. Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16-bits to both the high and low bytes of Timer1 at once.

The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 high byte buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

TABLE 11-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
TMR1L	1L Holding register for the Least Significant Byte of the 16-bit TMR1 register								xxxx xxxx	uuuu uuuu
TMR1H	Holding register for the Most Significant Byte of the 16-bit TMR1 register								xxxx xxxx	uuuu uuuu
T1CON	RD16	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0-00 0000	u-uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

12.0 TIMER2 MODULE

The Timer2 module timer has the following features:

- 8-bit timer (TMR2 register)
- 8-bit period register (PR2)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- · Interrupt on TMR2 match of PR2
- SSP module optional use of TMR2 output to generate clock shift

Register 12-1 shows the Timer2 Control register. Timer2 can be shut-off by clearing control bit TMR2ON (T2CON register), to minimize power consumption. Figure 12-1 is a simplified block diagram of the Timer2 module. The prescaler and postscaler selection of Timer2 are controlled by this register.

12.1 Timer2 Operation

Timer2 can be used as the PWM time-base for the PWM mode of the CCP module. The TMR2 register is readable and writable, and is cleared on any device RESET. The input clock (Fosc/4) has a prescale option of 1:1, 1:4, or 1:16, selected by control bits T2CKPS1:T2CKPS0 (T2CON register). The match output of TMR2 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling inclusive) to generate a TMR2 interrupt (latched in flag bit TMR2IF, PIR registers).

The prescaler and postscaler counters are cleared when any of the following occurs:

- A write to the TMR2 register
- A write to the T2CON register
- Any device RESET (Power-on Reset, MCLR Reset, or Watchdog Timer Reset)

TMR2 is not cleared when T2CON is written.

Note: Timer2 is disabled on POR.

REGISTER 12-1: T2CON REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6-3 **TOUTPS3:TOUTPS0**: Timer2 Output Postscale Select bits

0000 = 1:1 Postscale 0001 = 1:2 Postscale

•

•

1111 = 1:16 Postscale

bit 2 TMR2ON: Timer2 On bit

1 = Timer2 is on

0 = Timer2 is off

bit 1-0 T2CKPS1:T2CKPS0: Timer2 Clock Prescale Select bits

00 = Prescaler is 1

01 = Prescaler is 4

1x = Prescaler is 16

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

12.2 Timer2 Interrupt

The Timer2 module has an 8-bit period register, PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h on the next increment cycle. PR2 is a readable and writable register. The PR2 register is initialized to FFh upon RESET.

12.3 Output of TMR2

The output of TMR2 (before the postscaler) is a clock input to the Synchronous Serial Port module, which optionally uses it to generate the shift clock.

FIGURE 12-1: TIMER2 BLOCK DIAGRAM

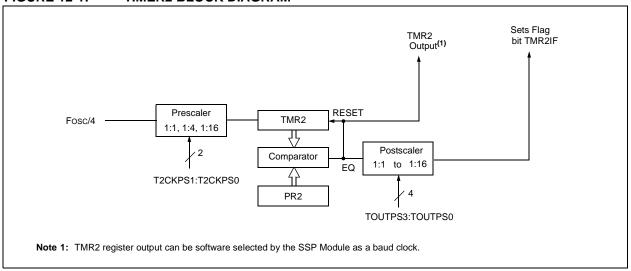


TABLE 12-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INTOIE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
TMR2	2 Timer2 Module's Register								0000 0000	0000 0000
T2CON	-	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
PR2	Timer2 Pe	Fimer2 Period Register							1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

13.0 TIMER3 MODULE

The Timer3 module timer/counter has the following features:

- 16-bit timer/counter (Two 8-bit registers: TMR3H and TMR3L)
- Readable and writable (both registers)
- · Internal or external clock select
- Interrupt on overflow from FFFFh to 0000h
- · RESET from CCP module trigger

Figure 13-1 is a simplified block diagram of the Timer3 module.

Register 13-1 shows the Timer3 Control register. This register controls the operating mode of the Timer3 module and sets the CCP clock source.

Register 11-1 shows the Timer1 Control register. This register controls the operating mode of the Timer1 module, as well as contains the Timer1 oscillator enable bit (T1OSCEN), which can be a clock source for Timer3.

Note: Timer3 is disabled on POR.

REGISTER 13-1: T3CON REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON
bit 7							bit 0

- bit 7 RD16: 16-bit Read/Write Mode Enable
 - 1 = Enables register Read/Write of Timer3 in one 16-bit operation
 - 0 = Enables register Read/Write of Timer3 in two 8-bit operations
- bit 6.3 T3CCP2:T3CCP1: Timer3 and Timer1 to CCPx Enable bits
 - 1x = Timer3 is the clock source for compare/capture CCP modules
 - 01 = Timer3 is the clock source for compare/capture of CCP2, Timer1 is the clock source for compare/capture of CCP1
 - 00 = Timer1 is the clock source for compare/capture CCP modules
- T3CKPS1:T3CKPS0: Timer3 Input Clock Prescale Select bits bit 5-4
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- T3SYNC: Timer3 External Clock Input Synchronization Control bit bit 2

(Not usable if the system clock comes from Timer1/Timer3)

When TMR3CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR3CS = 0:

This bit is ignored. Timer3 uses the internal clock when TMR3CS = 0.

- bit 1 TMR3CS: Timer3 Clock Source Select bit
 - 1 = External clock input from Timer1 oscillator or T1CKI (on the rising edge after the first falling edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR3ON: Timer3 On bit
 - 1 = Enables Timer3
 - 0 = Stops Timer3

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L	ec	ıe	n	a	i

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

13.1 Timer3 Operation

Timer3 can operate in one of these modes:

- · As a timer
- · As a synchronous counter
- As an asynchronous counter

The operating mode is determined by the clock select bit, TMR3CS (T3CON register).

When TMR3CS = 0, Timer3 increments every instruction cycle. When TMR3CS = 1, Timer3 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

When the Timer1 oscillator is enabled (T1OSCEN is set), the RC1/T1OSI and RC0/T1OSO/T1CKI pins become inputs. That is, the TRISC<1:0> value is ignored.

Timer3 also has an internal "RESET input". This RESET can be generated by the CCP module (Section 13.0).

FIGURE 13-1: TIMER3 BLOCK DIAGRAM

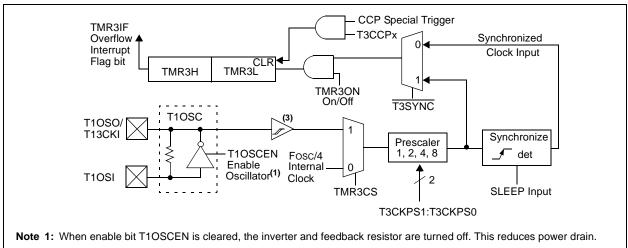
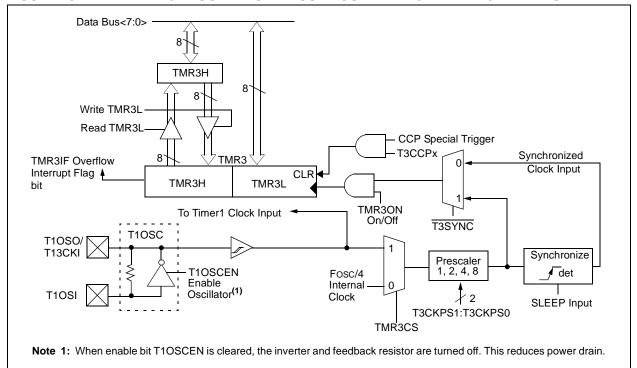


FIGURE 13-2: TIMER3 BLOCK DIAGRAM CONFIGURED IN 16-BIT READ/WRITE MODE



13.2 Timer1 Oscillator

The Timer1 oscillator may be used as the clock source for Timer3. The Timer1 oscillator is enabled by setting the T1OSCEN bit (T1CON Register). The oscillator is a low power oscillator rated up to 200 kHz. Refer to "Timer1 Module", Section 11.0, for Timer1 oscillator details.

13.3 Timer3 Interrupt

The TMR3 register pair (TMR3H:TMR3L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR3 interrupt, if enabled, is generated on overflow, which is latched in interrupt flag bit TMR3IF (PIE registers). This interrupt can be enabled/disabled by setting/clearing TMR3 interrupt enable bit TMR3IE (PIE registers).

13.4 Resetting Timer3 Using a CCP Trigger Output

If the CCP module is configured in Compare mode to generate a "special event trigger" (CCP1M3:CCP1M0 = 1011), this signal will reset Timer3.

Note: The special event triggers from the CCP module will not set interrupt flag bit TMR3IF (PIR registers).

Timer3 must be configured for either Timer, or Synchronized Counter mode, to take advantage of this feature. If Timer3 is running in Asynchronous Counter mode, this RESET operation may not work. In the event that a write to Timer3 coincides with a special event trigger from CCP1, the write will take precedence. In this mode of operation, the CCPR1H:CCPR1L registers pair becomes the period register for Timer3. Refer to Section 14.0, "Capture/Compare/PWM (CCP) Modules", for CCP details.

TABLE 13-1: REGISTERS ASSOCIATED WITH TIMER3 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INTOIE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR2	_	_	_	_	BCLIF	LVDIF	TMR3IF	CCP2IF	0000	-0 0000
PIE2	_	_	_	_	BCLIE	LVDIE	TMR3IE	CCP2IE	0000	-0 0000
IPR2	_	_	_	_	BCLIP	LVDIP	TMR3IP	CCP2IP	0000	-0 0000
TMR3L	Holding	register fo	r the Least S	Significant B	yte of the 16-	bit TMR3 re	egister		xxxx xxxx	uuuu uuuu
TMR3H	Holding register for the Most Significant Byte of the 16-bit TMR3 register xxxx xxxx uuuu uuu							uuuu uuuu		
T1CON	RD16	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	0-00 0000	u-uu uuuu
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	0000 0000	uuuu uuuu

 $\label{eq:local_equation} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \textbf{u} = \textbf{unchanged}, \textbf{-} = \textbf{unimplemented}, \textbf{read as '0'}. \textbf{Shaded cells are not used by the Timer3 module}.$

NOTES:

14.0 CAPTURE/COMPARE/PWM (CCP) MODULES

Each CCP (Capture/Compare/PWM) module contains a 16-bit register that can operate as a 16-bit capture register, as a 16-bit compare register, or as a PWM Duty Cycle register. Table 14-1 shows the timer resources of the CCP module modes.

The operation of CCP1 is identical to that of CCP2, with the exception of the special event trigger. Therefore, operation of a CCP module in the following sections is described, with respect to CCP1.

Table 14-2 shows the interaction of the CCP modules.

Register 14-1 shows the CCPx Control registers (CCPxCON). For the CCP1 module, the register is called CCP1CON and for the CCP2 module, the register is called CCP2CON.

REGISTER 14-1: CCP1CON REGISTER CCP2CON REGISTER

CCP1CON

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit 7							bit 0
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0

CCP2CON

bit 7 bit 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 DCxB1:DCxB0: PWM Duty Cycle bit1 and bit0

Capture mode:

Unused

Compare mode:

Unused

PWM mode:

These bits are the two LSbs (bit1 and bit0) of the 10-bit PWM duty cycle. The upper eight bits (DCx9:DCx2) of the duty cycle are found in CCPRxL.

bit 3-0 CCPxM3:CCPxM0: CCPx Mode Select bits

0000 = Capture/Compare/PWM off (resets CCPx module)

0001 = Reserved

0010 = Compare mode, toggle output on match (CCPxIF bit is set)

0011 = Reserved

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode,

Initialize CCP pin Low, on compare match force CCP pin High (CCPIF bit is set)

1001 = Compare mode,

Initialize CCP pin High, on compare match force CCP pin Low (CCPIF bit is set)

1010 = Compare mode,

Generate software interrupt on compare match (CCPIF bit is set, CCP pin is unaffected)

1011 = Compare mode,

Trigger special event (CCPIF bit is set, reset TMR1 or TMR3)

11xx = PWM mode

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

14.1 CCP1 Module

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. All are readable and writable.

14.2 CCP2 Module

Capture/Compare/PWM Register2 (CCPR2) is comprised of two 8-bit registers: CCPR2L (low byte) and CCPR2H (high byte). The CCP2CON register controls the operation of CCP2. All are readable and writable.

TABLE 14-1: CCP MODE - TIMER RESOURCE

CCP Mode	Timer Resource		
Capture	Timer1 or Timer3		
Compare	Timer1 or Timer3		
PWM	Timer2		

14.3 Capture Mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 or TMR3 registers, when an event occurs on pin RC2/CCP1. An event is defined as:

- · every falling edge
- · every rising edge
- · every 4th rising edge
- · every 16th rising edge

An event is selected by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR registers) is set. It must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost.

14.3.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note:	If the RC2/CCP1 is configured as an out-
	put, a write to the port can cause a capture
	condition.

14.3.2 TIMER1/TIMER3 MODE SELECTION

The timers used with the capture feature (either Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer used with each CCP module is selected in the T3CON register.

TABLE 14-2: INTERACTION OF TWO CCP MODULES

CCPx Mode	CCPy Mode	Interaction
Capture	Capture	TMR1 or TMR3 time-base. Time-base can be different for each CCP.
Capture	Compare	The compare could be configured for the special event trigger, which clears either TMR1 or TMR3, depending upon which time-base is used.
Compare	Compare	The compare(s) could be configured for the special event trigger, which clears TMR1 or TMR3, depending upon which time-base is used.
PWM	PWM	The PWMs will have the same frequency and update rate (TMR2 interrupt).
PWM	Capture	None.
PWM	Compare	None.

14.3.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit CCP1IE (PIE registers) clear to avoid false interrupts and should clear the flag bit CCP1IF, following any such change in operating mode.

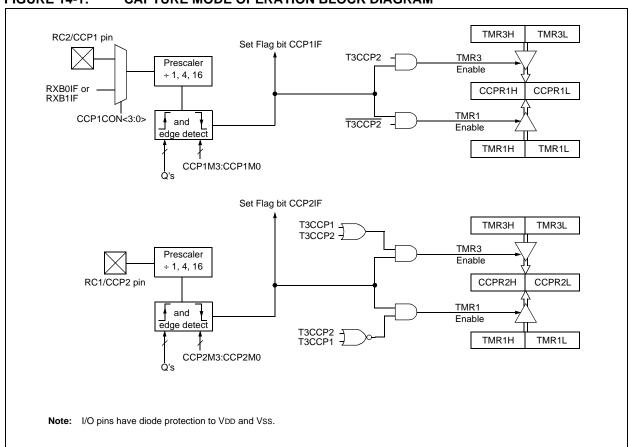
14.3.4 CCP PRESCALER

There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any RESET will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 14-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 14-1: CHANGING BETWEEN CAPTURE PRESCALERS

FIGURE 14-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



14.4 Compare Mode

In Compare mode, the 16-bit CCPR1 (CCPR2) register value is constantly compared against either the TMR1 register pair value, or the TMR3 register pair value. When a match occurs, the RC2/CCP1 (RC1/CCP2) pin can have one of the following actions:

- · Driven high
- · Driven low
- Toggle output (high to low or low to high)
- · Remains unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP2M3:CCP2M0). At the same time, interrupt flag bit CCP1IF (CCP2IF) is set.

14.4.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRISC bit.

default low level. This is not the data latch.

Note: Clearing the CCP1CON register will force the RC2/CCP1 compare output latch to the

TIMER1/TIMER3 MODE SELECTION

14.4.2

Timer1 and/or Timer3 must be running in Timer mode, or Synchronized Counter mode, if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

14.4.3 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

14.4.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated, which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

The special trigger output of CCPx resets either the TMR1, or TMR3 register pair. Additionally, the CCP2 Special Event Trigger will start an A/D conversion, if the A/D module is enabled.

Note: The special event trigger from the CCP2 module will not set the Timer1 or Timer3 interrupt flag bits.

FIGURE 14-2: COMPARE MODE OPERATION BLOCK DIAGRAM

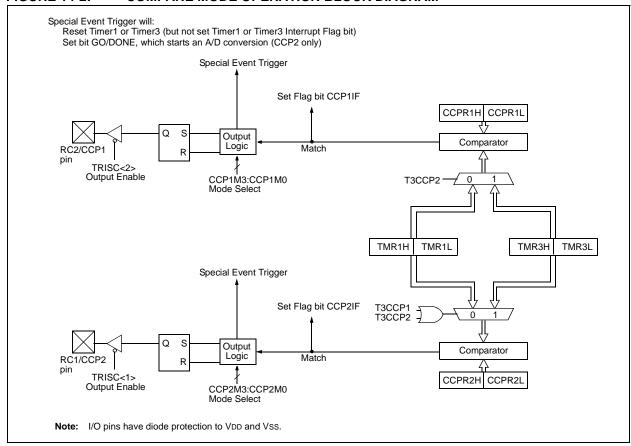


TABLE 14-3: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1 AND TIMER3

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INTOIE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
TRISC	PORTC D	ata Directio	n Register						1111 1111	1111 1111
TMR1L	Holding re	gister for th	ne Least Sig	nificant Byte	of the 16-bi	t TMR1 Reg	gister		xxxx xxxx	uuuu uuuu
TMR1H	Holding re	gister for th	ne Most Sigr	nificant Byte	of the 16-bit	TMR1 Reg	ister		xxxx xxxx	uuuu uuuu
T1CON	RD16	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	0-00 0000	u-uu uuuu
CCPR1L	Capture/C	ompare/PV	VM Register	1 (LSB)					xxxx xxxx	uuuu uuuu
CCPR1H	Capture/C	ompare/PV	VM Register	1 (MSB)					xxxx xxxx	uuuu uuuu
CCP1CON	_	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
CCPR2L	Capture/C	ompare/PV	VM Register	2 (LSB)					xxxx xxxx	uuuu uuuu
CCPR2H	Capture/C	ompare/PV	VM Register	2 (MSB)			_		xxxx xxxx	uuuu uuuu
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
PIR2	_	_	_	_	BCLIF	LVDIF	TMR3IF	CCP2IF	0000	0000
PIE2	_	_	_	_	BCLIE	LVDIE	TMR3IE	CCP2IE	0000	0000
IPR2	_	_	_	_	BCLIP	LVDIP	TMR3IP	CCP2IP	0000	0000
TMR3L	Holding register for the Least Significant Byte of the 16-bit TMR3 register						er	xxxx xxxx	uuuu uuuu	
TMR3H	F	Holding register for the Most Significant Byte of the 16-bit TMR3 register							xxxx xxxx	uuuu uuuu
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	0000 0000	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by Capture and Timer1.

14.5 PWM Mode

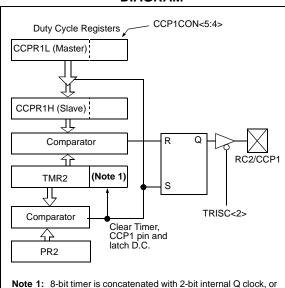
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 14-3 shows a simplified block diagram of the CCP module in PWM mode.

For a step-by-step procedure on how to setup the CCP module for PWM operation, see Section 14.5.3.

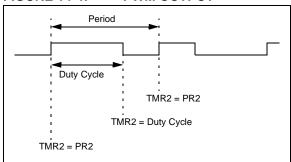
FIGURE 14-3: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 14-4) has a time-base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

2 bits of the prescaler, to create 10-bit time-base.

FIGURE 14-4: PWM OUTPUT



14.5.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated by the formula:

where PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- · TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

Note: The Timer2 postscaler (see Section 12.1) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

14.5.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

PWM Resolution (max) =
$$\frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)}$$
bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP1 pin will not be cleared.

14.5.3 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR1L register and CCP1CON<5:4> bits.
- Make the CCP1 pin an output by clearing the TRISC<2> bit.
- 4. Set the TMR2 prescale value and enable Timer2 by writing to T2CON.
- 5. Configure the CCP1 module for PWM operation.

TABLE 14-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 25 MHz

PWM Frequency	1.53 kHz	6.10 kHz	24.41 kHz	97.66kHz	195.31 kHz	260.42 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	6.6

TABLE 14-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
TRISC	PORTC D	ata Direction	Register						1111 1111	1111 1111
TMR2	Timer2 Module's Register								0000 0000	0000 0000
PR2	Timer2 Mo	dule's Perio	d Register						1111 1111	1111 1111
T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
CCPR1L	Capture/C	ompare/PW	M Register1	(LSB)					xxxx xxxx	uuuu uuuu
CCPR1H	Capture/C	ompare/PW	M Register1	(MSB)					xxxx xxxx	uuuu uuuu
CCP1CON	_	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
CCPR2L	Capture/C	ompare/PW	M Register2	(LSB)	I.				xxxx xxxx	uuuu uuuu
CCPR2H	Capture/C	ompare/PW	M Register2	(MSB)					xxxx xxxx	uuuu uuuu
CCP2CON								CCP2M0	00 0000	00 0000
PIR2	_	_	_	_	BCLIF	LVDIF	TMR3IF	CCP2IF	0000	0000
PIE2	_	_	_	_	BCLIE	LVDIE	TMR3IE	CCP2IE	0000	0000
IPR2	_	_	_	_	BCLIP	LVDIP	TMR3IP	CCP2IP	0000	0000

Legend: x = unknown, u = unchanged, — = unimplemented, read as '0'. Shaded cells are not used by PWM and Timer2.

NOTES:

15.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

15.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface™ (SPI)
- Inter-Integrated Circuit[™] (I²C)
 - Full Master mode
 - Slave mode (with general address call)

The I^2C interface supports the following modes in hardware:

- · Master mode
- · Multi-Master mode
- · Slave mode

15.2 Control Registers

The MSSP module has three associated registers. These include a status register and two control registers.

Register 15-1 shows the MSSP Status Register (SSPSTAT), Register 15-2 shows the MSSP Control Register 1 (SSPCON1), and Register 15-3 shows the MSSP Control Register 2 (SSPCON2).

REGISTER 15-1: SSPSTAT REGISTER

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	Р	S	R/W	UA	BF
hit 7							hit Ω

bit 7 SMP: Sample bit

SPI Master mode:

- 1 = Input data sampled at end of data output time
- 0 = Input data sampled at middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode

In I²C Master or Slave mode:

- 1= Slew rate control disabled for standard speed mode (100 kHz and 1 MHz)
- 0= Slew rate control enabled for high speed mode (400 kHz)
- bit 6 CKE: SPI Clock Edge Select

CKP = 0:

- 1 = Data transmitted on rising edge of SCK
- 0 = Data transmitted on falling edge of SCK

CKP = 1:

- 1 = Data transmitted on falling edge of SCK
- 0 = Data transmitted on rising edge of SCK
- bit 5 **D/A:** Data/Address bit (I²C mode only)
 - 1 = Indicates that the last byte received or transmitted was data
 - 0 = Indicates that the last byte received or transmitted was address
- bit 4 **P:** STOP bi

(I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)

- 1 = Indicates that a STOP bit has been detected last (this bit is '0' on RESET)
- 0 = STOP bit was not detected last
- bit 3 S: START bit

(I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)

- 1 = Indicates that a START bit has been detected last (this bit is '0' on RESET)
- 0 = START bit was not detected last
- bit 2 **R/W**: Read/Write bit Information (I²C mode only)

This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next START bit, STOP bit, or not ACK bit.

In I²C Slave mode:

- 1 = Read
- 0 = Write

In I²C Master mode:

- 1 = Transmit is in progress
- 0 = Transmit is not in progress.

OR-ing this bit with SEN, RSEN, PEN, RCEN, or ACKEN will indicate if the MSSP is in IDLE mode.

- bit 1 **UA:** Update Address (10-bit I²C mode only)
 - 1 = Indicates that the user needs to update the address in the SSPADD register
 - 0 = Address does not need to be updated
- bit 0 **BF:** Buffer Full Status bit

Receive (SPI and I²C modes):

- 1 = Receive complete, SSPBUF is full
- 0 = Receive not complete, SSPBUF is empty

Transmit (I²C mode only):

- 1 = Data transmit in progress (does not include the ACK and STOP bits), SSPBUF is full
- 0 = Data transmit complete (does not include the ACK and STOP bits), SSPBUF is empty

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

REGISTER 15-2: **SSPCON1 REGISTER**

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| WCOL | SSPOV | SSPEN | CKP | SSPM3 | SSPM2 | SSPM1 | SSPM0 |
| bit 7 | | | | | | | bit 0 |

bit 0

WCOL: Write Collision Detect bit bit 7

Master mode:

- 1 = A write to the SSPBUF register was attempted while the I²C conditions were not valid for a transmission to be started
- 0 = No collision

Slave mode:

- 1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

bit 6 SSPOV: Receive Overflow Indicator bit

In SPI mode:

- 1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in Slave mode. In Slave mode, the user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register. (Must be cleared in software.)
- 0 = No overflow

In I²C mode:

- 1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in Transmit mode. (Must be cleared in software.)
- bit 5 SSPEN: Synchronous Serial Port Enable bit

In both modes, when enabled, these pins must be properly configured as input or output.

- 1 = Enables serial port and configures SCK, SDO, SDI, and SS as the source of the serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

- 1 = Enables the serial port and configures the SDA and SCL pins as the source of the serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

bit 4 CKP: Clock Polarity Select bit

In SPI mode:

- 1 = Idle state for clock is a high level
- 0 = Idle state for clock is a low level

In I2C Slave mode:

SCK release control

- 1 = Enable clock
- 0 = Holds clock low (clock stretch). (Used to ensure data setup time.)

In I²C Master mode:

Unused in this mode

bit 3 - 0 SSPM3:SSPM0: Synchronous Serial Port Mode Select bits

- 0000 = SPI Master mode, clock = Fosc/4
- 0001 = SPI Master mode, clock = Fosc/16
- 0010 = SPI Master mode, clock = Fosc/64
- 0011 = SPI Master mode, clock = TMR2 output/2
- 0100 = SPI Slave mode, clock = SCK pin. \overline{SS} pin control enabled.
- 0101 = SPI Slave mode, clock = SCK pin. SS pin control disabled. SS can be used as I/O pin.
- $0110 = I^2C$ Slave mode, 7-bit address
- $0111 = I^2C$ Slave mode, 10-bit address
- $1000 = I^2C$ Master mode, clock = Fosc / (4 * (SSPADD+1))
- 1001 = Reserved
- 1010 = Reserved
- $1011 = I^2C$ firmware controlled Master mode (Slave idle)
- 1100 = Reserved
- 1101 = Reserved
- 1110 = I²C Slave mode, 7-bit address with START and STOP bit interrupts enabled
- 1111 = I²C Slave mode, 10-bit address with START and STOP bit interrupts enabled

Legend:

W = Writable bit U = Unimplemented bit, read as '0' R = Readable bit

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 15-3: SSPCON2 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

bit 7 **GCEN:** General Call Enable bit (In I²C Slave mode only)

1 = Enable interrupt when a general call address (0000h) is received in the SSPSR

0 = General call address disabled

bit 6 ACKSTAT: Acknowledge Status bit (In I²C Master mode only)

In Master Transmit mode:

1 = Acknowledge was not received from slave

0 = Acknowledge was received from slave

bit 5 ACKDT: Acknowledge Data bit (In I²C Master mode only)

In Master Receive mode:

Value transmitted when the user initiates an Acknowledge sequence at the end of a receive

1 = Not Acknowledge

0 = Acknowledge

bit 4 ACKEN: Acknowledge Sequence Enable bit (In I²C Master mode only)

In Master Receive mode:

1 = Initiate Acknowledge sequence on SDA and SCL pins, and transmit ACKDT data bit. Automatically cleared by hardware.

0 = Acknowledge sequence idle

bit 3 RCEN: Receive Enable bit (In I²C Master mode only)

1 = Enables Receive mode for I²C

0 = Receive idle

bit 2 **PEN:** STOP Condition Enable bit (In I²C Master mode only)

SCK release control

1 = Initiate STOP condition on SDA and SCL pins. Automatically cleared by hardware.

0 = STOP condition idle

bit 1 RSEN: Repeated START Condition Enabled bit (In I²C Master mode only)

1 = Initiate Repeated START condition on SDA and SCL pins. Automatically cleared by hardware.

0 = Repeated START condition idle

bit 0 **SEN:** START Condition Enabled bit (In I²C Master mode only)

1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware.

0 = START condition idle

Note: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I²C module is not in the IDLE mode, this bit may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

15.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received, simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO) RC5/SDO
- · Serial Data In (SDI) RC4/SDI/SDA
- Serial Clock (SCK) RC3/SCK/SCL/LVOIN

Additionally, a fourth pin may be used when in any Slave mode of operation:

• Slave Select (SS) - RA5/SS/AN4

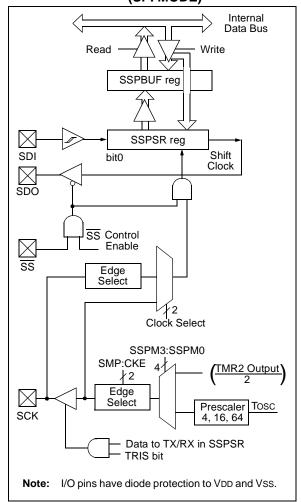
15.3.1 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits SSPCON1<5:0> and SSPSTAT<7:6>. These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- · Slave mode (SCK is the clock input)
- · Clock polarity (Idle state of SCK)
- Data input sample phase (middle or end of data output time)
- Clock edge (output data on rising/falling edge of SCK)
- Clock rate (Master mode only)
- Slave Select mode (Slave mode only)

Figure 15-1 shows the block diagram of the MSSP module, when in SPI mode.

FIGURE 15-1: MSSP BLOCK DIAGRAM (SPI MODE)



The MSSP consists of a transmit/receive shift register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit, BF (SSPSTAT register), and the interrupt flag bit, SSPIF (PIR registers), are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit, WCOL (SSPCON1 register), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. The buffer full (BF) bit (SSPSTAT register) indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 15-1 shows the loading of the SSPBUF (SSPSR) for data transmission.

The SSPSR is not directly readable or writable, and can only be accessed by addressing the SSPBUF register. Additionally, the MSSP status register (SSPSTAT register) indicates the various status conditions.

15.3.2 ENABLING SPI I/O

To enable the serial port, SSP enable bit, SSPEN (SSPCON1 register), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, re-initialize the SSPCON registers, and then set the SSPEN bit. This configures the SDI, SDO, SCK, and $\overline{\rm SS}$ pins as serial port pins. For the pins to behave as the serial port function, corresponding pins must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- · SDI is automatically controlled by the SPI module
- SDO must have TRISC<5> bit cleared
- SCK (Master mode) must have TRISC<3> bit cleared
- SCK (Slave mode) must have TRISC<3> bit set
- RA5 must be configured as digital I/O using ADCON1 register
- SS must have TRISA<5> bit set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

EXAMPLE 15-1: LOADING THE SSPBUF (SSPSR) REGISTER

	S SSPSTAT, BF	;Has data been received (transmit complete)?
	LOOP	; No
MOVF	SSPBUF, W	;WREG reg = contents of SSPBUF
MOVW	F RXDATA	;Save in user RAM, if data is meaningful
MOVF	TXDATA, W	;W reg = contents of TXDATA
MOVW	F SSPBUF	;New data to xmit

15.3.3 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

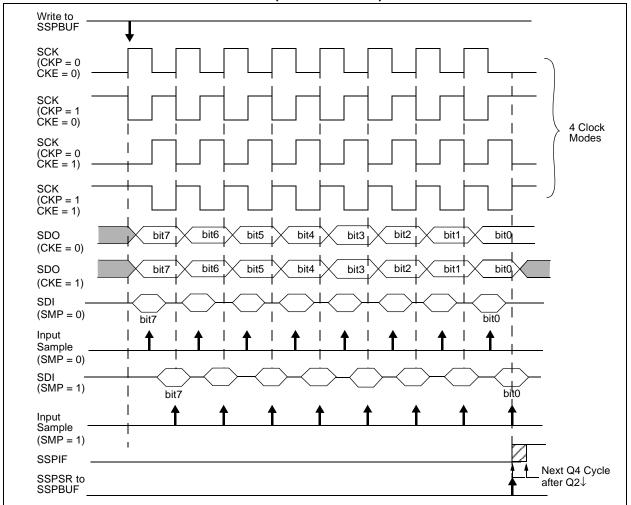
The clock polarity is selected by appropriately programming the CKP bit (SSPCON1 register). This, then, would give waveforms for SPI communication as shown in Figure 15-2, Figure 15-4, and Figure 15-5, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 25 MHz) of 6.25 Mbps.

Figure 15-2 shows the waveforms for Master mode. When the CKE bit is set, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.





15.3.4 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched, the SSPIF interrupt flag bit is set.

While in Slave mode, the external clock is supplied by the external clock source on the SCK pin. This external clock must meet the minimum high and low times, as specified in the electrical specifications.

While in SLEEP mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from SLEEP.

15.3.5 SLAVE SELECT SYNCHRONIZATION

The \overline{SS} pin allows a Synchronous Slave mode. The SPI must be in Slave mode with \overline{SS} pin control enabled (SSPCON1<3:0> = 04h). The pin must not be driven low for the \overline{SS} pin to function as an input. The data latch must be high. When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is driven. When the \overline{SS} pin goes high,

the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. External pull-up/pull-down resistors may be desirable, depending on the application.

- Note 1: When the SPI is in Slave mode with SS pin control enabled, (SSPCON<3:0> = 0100), the SPI module will reset if the SS pin is set to VDD.
 - 2: If the SPI is used in Slave mode with CKE set, then the SS pin control must be enabled.

When the SPI module resets, the bit counter is forced to 0. This can be done by either forcing the \overline{SS} pin to a high level, or clearing the SSPEN bit.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver, the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function), since it cannot create a bus conflict.



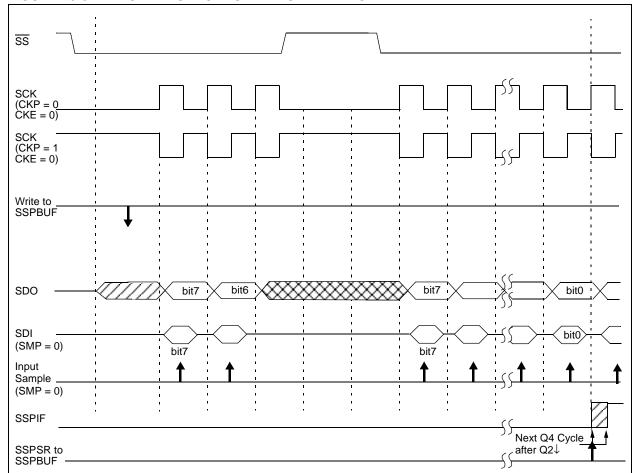


FIGURE 15-4: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

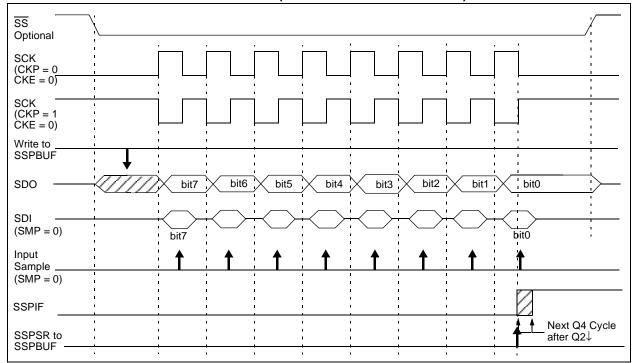
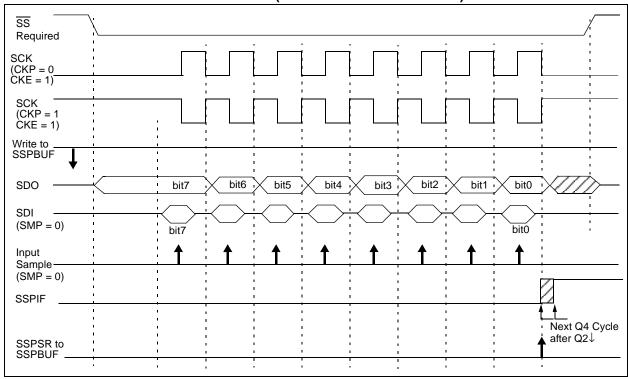


FIGURE 15-5: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



15.3.6 SLEEP OPERATION

In Master mode, all module clocks are halted, and the transmission/reception will remain in that state until the device wakes from SLEEP. After the device returns to normal mode, the module will continue to transmit/receive data.

In Slave mode, the SPI transmit/receive shift register operates asynchronously to the device. This allows the device to be placed in SLEEP mode, and data to be shifted into the SPI transmit/receive shift register. When all eight bits have been received, the MSSP interrupt flag bit will be set and, if enabled, will wake the device from SLEEP.

15.3.7 EFFECTS OF A RESET

A RESET disables the MSSP module and terminates the current transfer.

15.3.8 BUS MODE COMPATIBILITY

Table 15-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

TABLE 15-1: SPI BUS MODES

Standard SPI Mode	Control Bits State				
Terminology	СКР	CKE			
0, 0	0	1			
0, 1	0	0			
1, 0	1	1			
1, 1	1	0			

There is also a SMP bit that controls when the data will be sampled.

TABLE 15-2: REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
TRISC	PORTC D	ata Direct	tion Regist	er					1111 1111	1111 1111
SSPBUF	Synchrono	us Serial	Port Rece	ive Buffe	r/Transmit	Register			xxxx xxxx	uuuu uuuu
SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
TRISA	_	PORTA Data Direction Register						11 1111	11 1111	
SSPSTAT	SMP	CKE	D/\overline{A}	Р	S	R/W	UA	BF	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the MSSP in SPI mode.

15.4 MSSP I²C Operation

The MSSP module in I²C mode, fully implements all master and slave functions (including general call support) and provides interrupts on START and STOP bits in hardware to determine a free bus (Multi-Master mode). The MSSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

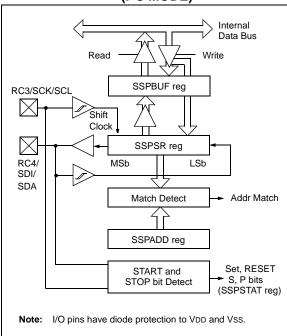
Two pins are used for data transfer. These are the RC3/SCK/SCL pin, which is the clock (SCL), and the RC4/SDI/SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits.

The MSSP module functions are enabled by setting MSSP Enable bit SSPEN (SSPCON1 register).

The MSSP module has these six registers for I²C operation:

- MSSP Control Register1 (SSPCON1)
- MSSP Control Register2 (SSPCON2)
- MSSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- MSSP Shift Register (SSPSR) Not directly accessible
- MSSP Address Register (SSPADD)

FIGURE 15-6: MSSP BLOCK DIAGRAM (I²C MODE)



The SSPCON1 register allows control of the I²C operation. The SSPM3:SSPM0 mode selection bits (SSPCON1 register) allow one of the following I²C modes to be selected:

- I²C Master mode, clock = OSC/(4*(SSPADD +1))
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with START and STOP bit interrupts enabled
- I²C Slave mode (10-bit address), with START and STOP bit interrupts enabled
- I²C firmware controlled master operation, slave is idle

Selection of any I²C mode with the SSPEN bit set, forces the SCL and SDA pins to be open drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits.

15.4.1 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the acknowledge (ACK) pulse and load the SSPBUF register with the received value currently in the SSPSR register.

If either or both of the following <u>cond</u>itions are true, the MSSP module will not give this ACK pulse:

- a) The buffer full bit BF (SSPCON1 register) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON1 register) was set before the transfer was received.

In this event, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR registers) is set. The BF bit is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, is shown in timing parameter #100 and parameter #101.

15.4.1.1 Addressing

Once the MSSP module has been enabled, it waits for a START condition to occur. Following the START condition, the eight bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register.
- b) The buffer full bit BF is set.
- c) An ACK pulse is generated.
- d) MSSP interrupt flag bit SSPIF (PIR registers) is set on the falling edge of the ninth SCL pulse (interrupt is generated, if enabled).

In 10-bit Address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSb) of the first address byte, specify if this is a 10-bit address. The R/\overline{W} bit (SSPSTAT register) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal `1111 0 A9 A8 0', where A9 and A8 are the two MSb's of the address.

The sequence of events for 10-bit addressing is as follows, with steps 7- 9 for slave-transmitter:

- Receive first (high) byte of address (the SSPIF, BF and UA bits (SSPSTAT register) are set).
- Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- Receive second (low) byte of address (bits SSPIF, BF, and UA are set).
- Update the SSPADD register with the first (high) byte of address. If match releases SCL line, this will clear bit UA.
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive repeated START condition.
- Receive first (high) byte of address (bits SSPIF and BF are set).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

15.4.1.2 Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT register) is set or bit SSPOV (SSPCON1 register) is set.

An MSSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR registers) must be cleared in software. The SSPSTAT register is used to determine the status of the byte.

15.4.1.3 Transmission

When the R/\overline{W} bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The \overline{ACK} pulse will be sent on the ninth bit and pin RC3/SCK/SCL is held low. The transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP (SSPCON1 register). The master must monitor the SCL pin prior to asserting another clock pulse. The slave devices may be holding off the master by stretching the clock. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 15-8).

An MSSP interrupt is generated for each data transfer byte. The SSPIF bit must be cleared in software and the SSPSTAT register is used to determine the status of the byte. The SSPIF bit is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the master-receiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line is high (not \overline{ACK}), then the data transfer is complete. When the \overline{ACK} is latched by the slave, the slave logic is reset (resets SSPSTAT register) and the slave monitors for another occurrence of the START bit. If the SDA line was low (\overline{ACK}), the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Pin RC3/SCK/SCL should be enabled by setting bit CKP.

FIGURE 15-7: I²C SLAVE MODE WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)

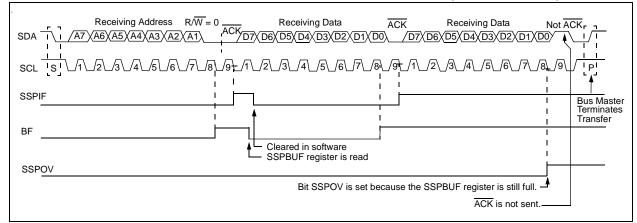
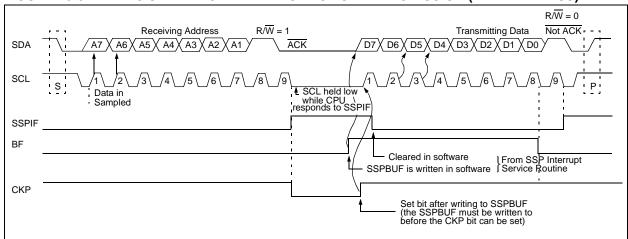


FIGURE 15-8: I²C SLAVE MODE WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)



15.4.2 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I²C bus is such that the first byte after the START condition usually determines which device will be the slave addressed by the master. The exception is the general call address, which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I^2C protocol. It consists of all 0's with $R/\overline{W} = 0$.

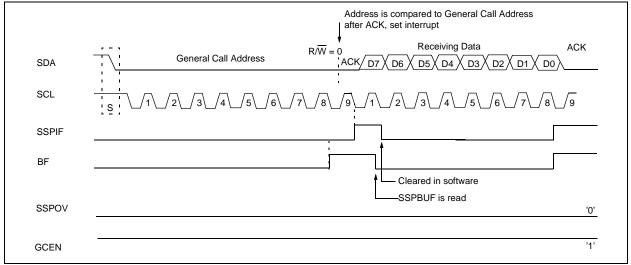
The general call address is recognized (enabled) when the General Call Enable (GCEN) bit is set (SSPCON2 register). Following a START bit detect, eight bits are shifted into the SSPSR and the address is compared against the SSPADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPSR is transferred to the SSPBUF, the BF bit is set (eighth bit), and on the falling edge of the ninth bit (ACK bit), the SSPIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPBUF. The value can be used to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPADD is required to be updated for the second half of the address to match, and the UA bit is set (SSPSTAT register). If the general call address is sampled when the GCEN bit is set and while the slave is configured in 10-bit address mode, then the second half of the address is not necessary. The UA bit will not be set, and the slave will begin receiving data after the Acknowledge (Figure 15-9).





15.4.3 MASTER MODE

Master mode of operation is supported by interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a RESET, or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit is set, or the bus is idle, with both the S and P bits clear

In Master mode, the SCL and SDA lines are manipulated by the MSSP hardware.

The following events will cause SSP Interrupt Flag bit, SSPIF, to be set (SSP Interrupt if enabled):

- START condition
- · STOP condition
- Data transfer byte transmitted/received
- · Acknowledge Transmit
- · Repeated START condition

15.4.4 I²C MASTER MODE SUPPORT

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPCON1 and by setting the SSPEN bit. Once Master mode is enabled, the user has the following six options:

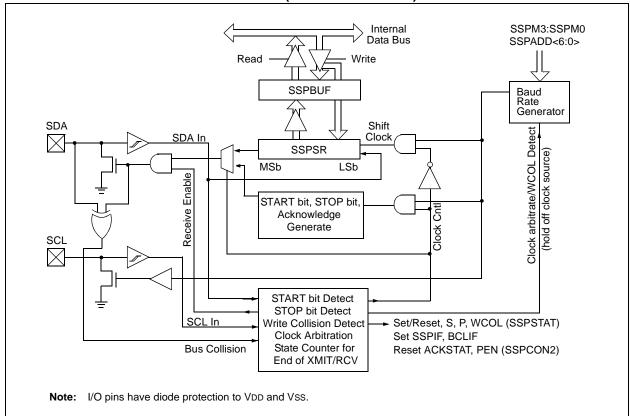
- Assert a START condition on SDA and SCL.
- Assert a Repeated START condition on SDA and SCI
- Write to the SSPBUF register initiating transmission of data/address.
- 4. Generate a STOP condition on SDA and SCL.
- Configure the I²C port to receive data.

Note:

6. Generate an Acknowledge condition at the end of a received byte of data.

The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a START condition and immediately write the SSPBUF register to imitate transmission, before the START condition is complete. In this case, the SSPBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPBUF did not occur.

FIGURE 15-10: MSSP BLOCK DIAGRAM (I²C MASTER MODE)



15.4.4.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a Repeated START condition. Since the Repeated START condition is also the beginning of the next serial transfer, the I^2C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. START and STOP conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/\overline{W} bit. In this case, the R/\overline{W} bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received eight bits at a time. After each byte is received, an Acknowledge bit is transmitted. START and STOP conditions indicate the beginning and end of transmission.

The baud rate generator used for the SPI mode operation is now used to set the SCL clock frequency for either 100 kHz, 400 kHz, or 1 MHz I²C operation. The baud rate generator reload value is contained in the lower 7 bits of the SSPADD register. The baud rate generator will automatically begin counting on a write to the SSPBUF. Once the given operation is complete (i.e., transmission of the last data bit is followed by ACK), the internal clock will automatically stop counting and the SCL pin will remain in its last state.

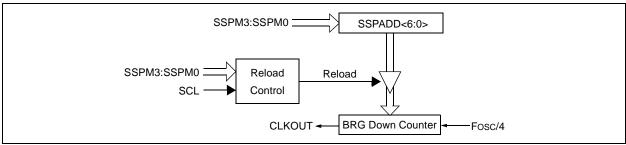
A typical transmit sequence would go as follows:

- The user generates a START condition by setting the START enable (SEN) bit (SSPCON2 register).
- SSPIF is set. The MSSP module will wait the required start time before any other operation takes place.
- The user loads the SSPBUF with the address to transmit.
- Address is shifted out the SDA pin until all eight bits are transmitted.
- e) The MSSP module shifts in the ACK bit from the slave device and writes its value into the ACKSTAT bit (SSPCON2 register).
- f) The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- The user loads the SSPBUF with eight bits of data.
- Data is shifted out the SDA pin until all eight bits are transmitted.
- The MSSP module shifts in the ACK bit from the slave device and writes its value into the ACKSTAT bit (SSPCON2 register).
- j) The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- k) The user generates a STOP condition by setting the STOP enable bit PEN (SSPCON2 register).
- Interrupt is generated once the STOP condition is complete.

15.4.5 BAUD RATE GENERATOR

In I²C Master mode, the reload value for the BRG is located in the lower 7 bits of the SSPADD register (Figure 15-11). When the BRG is loaded with this value, the BRG counts down to 0 and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TcY) on the Q2 and Q4 clocks. In I²C Master mode, the BRG is reloaded automatically. If clock arbitration is taking place, for instance, the BRG will be reloaded when the SCL pin is sampled high (Figure 15-12).

FIGURE 15-11: BAUD RATE GENERATOR BLOCK DIAGRAM



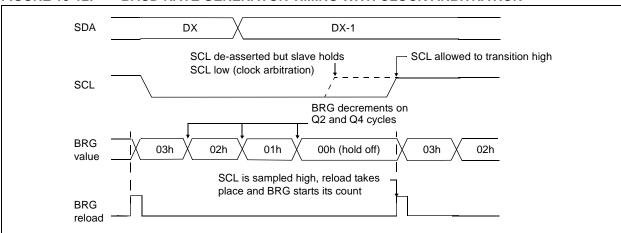


FIGURE 15-12: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION

15.4.6 I²C MASTER MODE START CONDITION TIMING

To initiate a START condition, the user sets the START Condition Enable (SEN) bit (SSPCON2 register). If the SDA and SCL pins are sampled high, the baud rate generator is re-loaded with the contents of SSPADD<6:0> and starts its count. If SCL and SDA are both sampled high when the baud rate generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high, is the START condition, and causes the S bit (SSPSTAT register) to be set. Following this, the baud rate generator is reloaded with the contents of SSPADD<6:0> and resumes its count. When the baud rate generator times out (TBRG), the SEN bit (SSPCON2 register) will be automatically cleared by hardware, the baud rate generator is suspended leaving the SDA line held low and the START condition is complete.

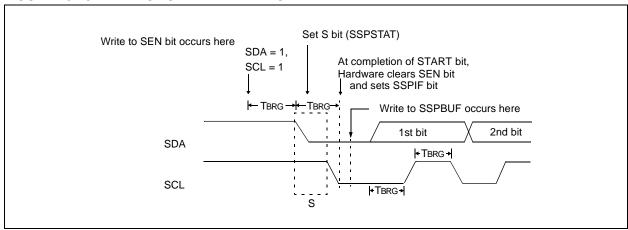
Note: If at the beginning of the START condition, the SDA and SCL pins are already sampled low, or if during the START condition the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag BCLIF is set, the START condition is aborted, and the I²C module is reset into its IDLE state.

15.4.6.1 WCOL Status Flag

If the user writes the SSPBUF when a START sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPCON2 is disabled until the START condition is complete.





15.4.7 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated START condition occurs when the RSEN bit (SSPCON2 register) is programmed high and the I²C logic module is in the IDLE state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the baud rate generator is loaded with the contents of SSPADD<5:0> and begins counting. The SDA pin is released (brought high) for one baud rate generator count (TBRG). When the baud rate generator times out, if SDA is sampled high, the SCL pin will be de-asserted (brought high). When SCL is sampled high, the baud rate generator is re-loaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA = 0) for one TBRG while SCL is high. Following this, the RSEN bit (SSPCON2 register) will be automatically cleared and the baud rate generator will not be reloaded. leaving the SDA pin held low. As soon as a START condition is detected on the SDA and SCL pins, the S bit (SSPSTAT register) will be set. The SSPIF bit will not be set until the baud rate generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

- **2:** A bus collision during the Repeated START condition occurs, if:
 - SDA is sampled low when SCL goes from low to high.
 - SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data "1".

Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode, or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

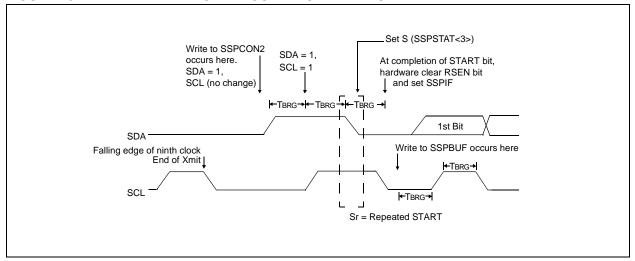
15.4.7.1 WCOL Status Flag

Note:

If the user writes the SSPBUF when a Repeated START sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated START condition is complete.

FIGURE 15-14: REPEATED START CONDITION WAVEFORM



15.4.8 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address, or the other half of a 10-bit address, is accomplished by simply writing a value to the SSPBUF register. This action will set the Buffer Full bit, BF, and allow the baud rate generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted (see data hold time specification parameter 106). SCL is held low for one baud rate generator rollover count (TBRG). Data should be valid before SCL is released high (see data setup time specification parameter 107). When the SCL pin is released high, it is held that way for TBRG. The data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF bit is cleared and the master releases SDA, allowing the slave device being addressed to respond with an ACK bit during the ninth bit time, if an address match occurs, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPIF bit is set and the master clock (baud rate generator) is suspended until the next data byte is loaded into the SSPBUF, leaving SCL low and SDA unchanged (Figure 15-15).

After the write to the SSPBUF, each bit of address will be shifted out on the falling edge of SCL, until all seven address bits and the R/W bit, are completed. On the falling edge of the eighth clock, the master will deassert the SDA pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDA pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPCON2 register). Following the falling edge of the ninth clock transmission of the address, the SSPIF is set, the BF bit is cleared and the baud rate generator is turned off, until another write to the SSPBUF takes place, holding SCL low and allowing SDA to float.

15.4.8.1 BF Status Flag

In Transmit mode, the BF bit (SSPSTAT register) is set when the CPU writes to SSPBUF, and is cleared when all eight bits are shifted out.

15.4.8.2 WCOL Status Flag

If the user writes the SSPBUF when a transmit is already in progress (i.e., SSPSR is still shifting out a data byte), the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

WCOL must be cleared in software.

15.4.8.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPCON2 register) is cleared when the slave has sent an Acknowledge ($\overline{ACK}=0$), and is set when the slave does not Acknowledge ($\overline{ACK}=1$). A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

15.4.9 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPCON2 register).

Note: The MSSP module must be in an IDLE state before the RCEN bit is set, or the RCEN bit will be disregarded.

The baud rate generator begins counting and on each rollover, the state of the SCL pin changes (high to low/ low to high) and data is shifted into the SSPSR. After the falling edge of the eighth clock, the RCEN bit is automatically cleared, the contents of the SSPSR are loaded into the SSPBUF, the BF bit is set, the SSPIF flag bit is set and the baud rate generator is suspended from counting, holding SCL low. The MSSP is now in IDLE state, awaiting the next command. When the buffer is read by the CPU, the BF bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception, by setting the Acknowledge Sequence Enable bit ACKEN (SSPCON2 register).

15.4.9.1 BF Status Flag

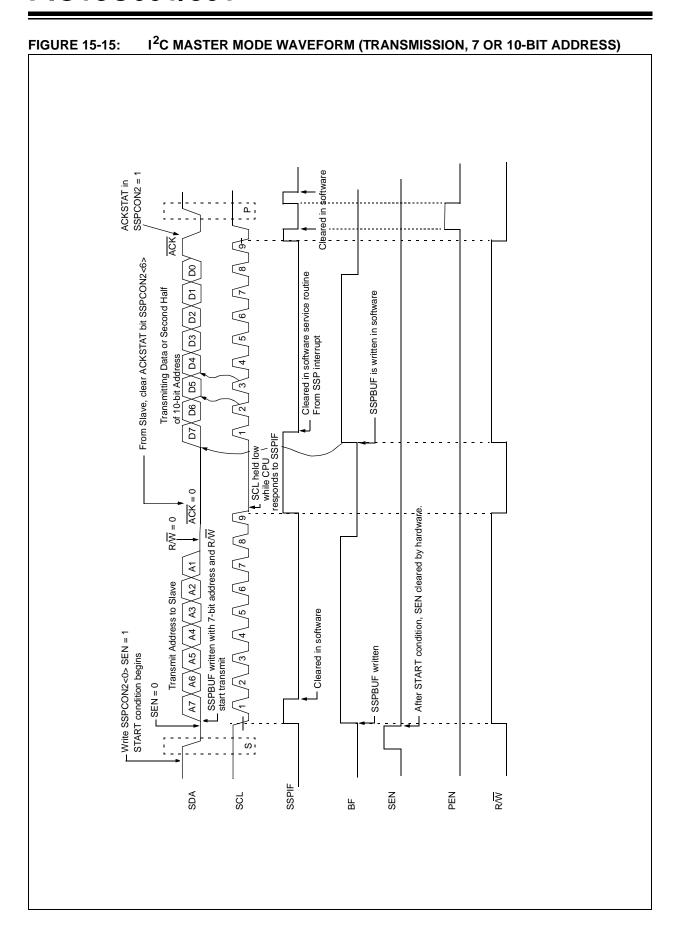
In receive operation, the BF bit is set when an address or data byte is loaded into SSPBUF from SSPSR. It is cleared when the SSPBUF register is read.

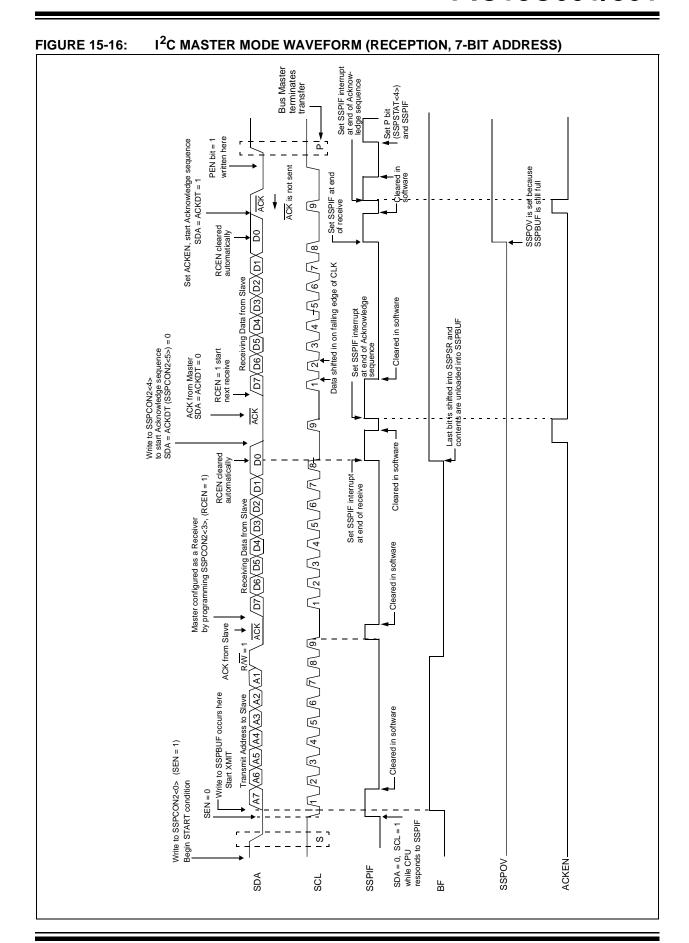
15.4.9.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when eight bits are received into the SSPSR and the BF bit is already set from a previous reception.

15.4.9.3 WCOL Status Flag

If the user writes the SSPBUF when a receive is already in progress (i.e., SSPSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).





15.4.10 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence enable bit, ACKEN (SSPCON2 register). When this bit is set, the SCL pin is pulled low and the contents of the Acknowledge Data bit (ACKDT) is presented on the SDA pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The baud rate generator then counts for one rollover period (TBRG) and the SCL pin is de-asserted (pulled high). When the SCL pin is sampled high (clock arbitration), the baud rate generator counts for TBRG. The SCL pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the baud rate generator is turned off and the MSSP module then goes into IDLE mode (Figure 15-17).

15.4.10.1 WCOL Status Flag

If the user writes the SSPBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

15.4.11 STOP CONDITION TIMING

A STOP bit is asserted on the SDA pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPCON2 register). At the end of a receive/transmit, the SCL line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDA line low. When the SDA line is sampled low, the baud rate generator is reloaded and counts down to 0. When the baud rate generator times out, the SCL pin will be brought high, and one TBRG (baud rate generator rollover count) later, the SDA pin will be de-asserted. When the SDA pin is sampled high while SCL is high, the P bit (SSPSTAT register) is set. A TBRG later, the PEN bit is cleared and the SSPIF bit is set (Figure 15-18).

15.4.11.1 WCOL Status Flag

If the user writes the SSPBUF when a STOP sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 15-17: ACKNOWLEDGE SEQUENCE WAVEFORM

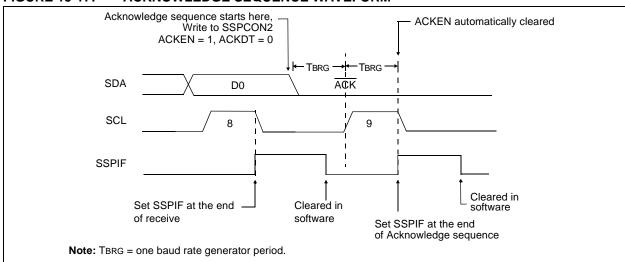
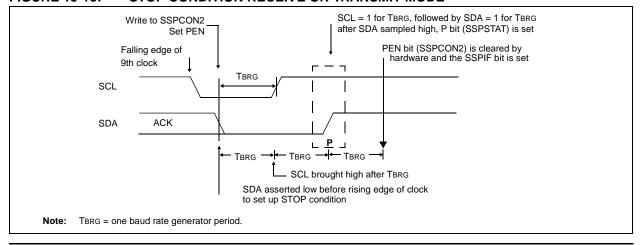


FIGURE 15-18: STOP CONDITION RECEIVE OR TRANSMIT MODE



15.4.12 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit or Repeated START/STOP condition, de-asserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the baud rate generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count, in the event that the clock is held low by an external device (Figure 15-19).

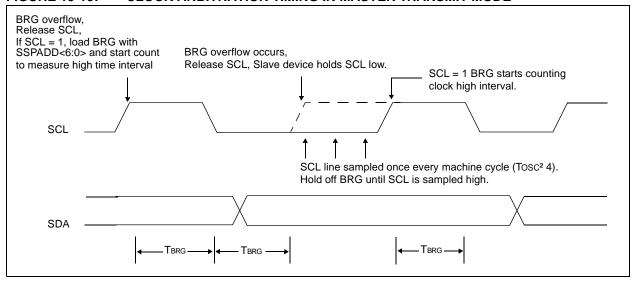
15.4.13 SLEEP OPERATION

While in SLEEP mode, the I²C module can receive addresses or data, and when an address match or complete byte transfer occurs, wake the processor from SLEEP (if the MSSP interrupt is enabled).

15.4.14 EFFECT OF A RESET

A RESET disables the MSSP module and terminates the current transfer.

FIGURE 15-19: CLOCK ARBITRATION TIMING IN MASTER TRANSMIT MODE



15.4.15 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a RESET, or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit (SSPSTAT register) is set, or the bus is idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the STOP condition occurs.

In Multi-Master operation, the SDA line must be monitored for arbitration, to see if the signal level is the expected output level. This check is performed in hardware, with the result placed in the BCLIF bit.

Arbitration can be lost in the following states:

- · Address transfer
- · Data transfer
- A START condition
- · A Repeated START condition
- · An Acknowledge condition

15.4.16 MULTI -MASTER COMMUNICATION, BUS COLLISION, AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on

SDA is a '1' and the data sampled on the SDA pin = '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag (BCLIF) and reset the I^2C port to its IDLE state. (Figure 15-20).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF bit is cleared, the SDA and SCL lines are de-asserted, and the SSPBUF can be written to. When the user services the bus collision Interrupt Service Routine, and if the I^2C bus is free, the user can resume communication by asserting a START condition.

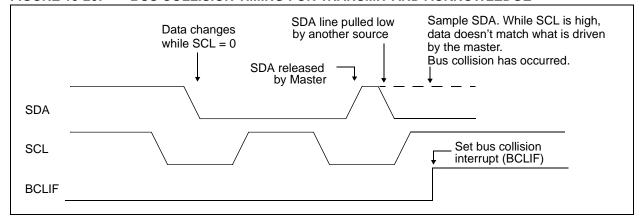
If a START, Repeated START, STOP, or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are de-asserted, and the respective control bits in the SSPCON2 register are cleared. When the user services the bus collision Interrupt Service Routine, and if the I²C bus is free, the user can resume communication by asserting a START condition.

The master will continue to monitor the SDA and SCL pins. If a STOP condition occurs, the SSPIF bit will be set.

A write to the SSPBUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of START and STOP conditions allows the determination of when the bus is free. Control of the $\rm I^2C$ bus can be taken when the P bit is set in the SSPSTAT register, or the bus is idle and the S and P bits are cleared.





15.4.16.1 Bus Collision During a START Condition

During a START condition, a bus collision occurs if:

- SDA or SCL are sampled low at the beginning of the START condition (Figure 15-21).
- b) SCL is sampled low before SDA is asserted low (Figure 15-22).

During a START condition, both the SDA and the SCL pins are monitored.

If the SDA pin is already low, or the SCL pin is already low, then all of the following occur:

- · the START condition is aborted;
- · the BCLIF flag is set, and
- the MSSP module is reset to its IDLE state (Figure 15-21).

The START condition begins with the SDA and SCL pins de-asserted. When the SDA pin is sampled high, the baud rate generator is loaded from SSPADD<6:0> and counts down to 0. If the SCL pin is sampled low while SDA is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the START condition.

If the SDA pin is sampled low during this count, the BRG is reset and the SDA line is asserted early (Figure 15-23). If, however, a '1' is sampled on the SDA pin, the SDA pin is asserted low at the end of the BRG count. The baud rate generator is then reloaded and counts down to 0, and during this time, if the SCL pin is sampled as '0', a bus collision does not occur. At the end of the BRG count, the SCL pin is asserted low.

Note: The reason that bus collision is not a factor during a START condition, is that no two bus masters can assert a START condition at the exact same time. Therefore, one master will always assert SDA before the other. This condition does not cause a bus collision, because the two masters must be allowed to arbitrate the first address following the START condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated START or STOP conditions.

FIGURE 15-21: BUS COLLISION DURING START CONDITION (SDA ONLY)

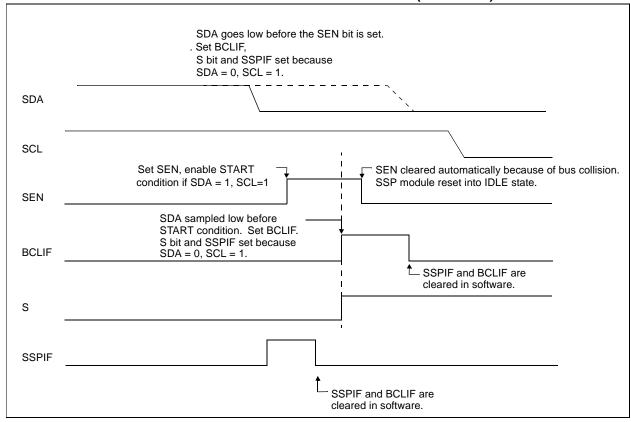


FIGURE 15-22: BUS COLLISION DURING START CONDITION (SCL = 0)

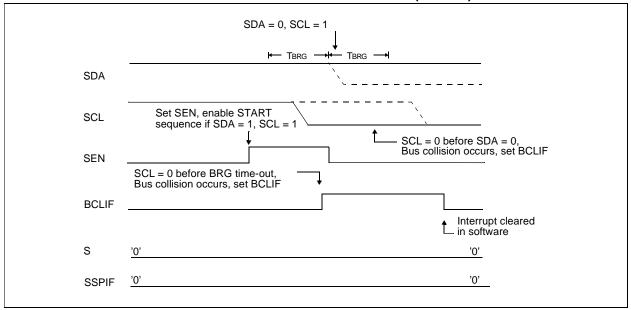
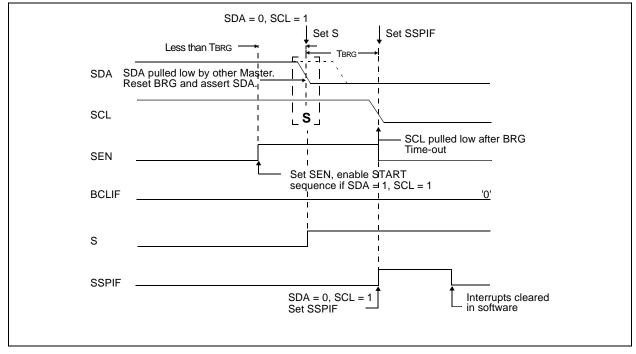


FIGURE 15-23: BRG RESET DUE TO SDA ARBITRATION DURING START CONDITION



15.4.16.2 Bus Collision During a Repeated START Condition

During a Repeated START condition, a bus collision occurs if:

- A low level is sampled on SDA when SCL goes from low level to high level.
- SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user de-asserts SDA and the pin is allowed to float high, the BRG is loaded with SSPADD<6:0> and counts down to 0. The SCL pin is then de-asserted and when sampled high, the SDA pin is sampled.

If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', see Figure 15-24). If SDA is sampled high, the BRG is

reloaded and begins counting. If SDA goes from high to low before the BRG times out, no bus collision occurs because no two masters can assert SDA at exactly the same time.

If SCL goes from high to low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated START condition (Figure 15-25).

If, at the end of the BRG time-out both SCL and SDA are still high, the SDA pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated START condition is complete.

FIGURE 15-24: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

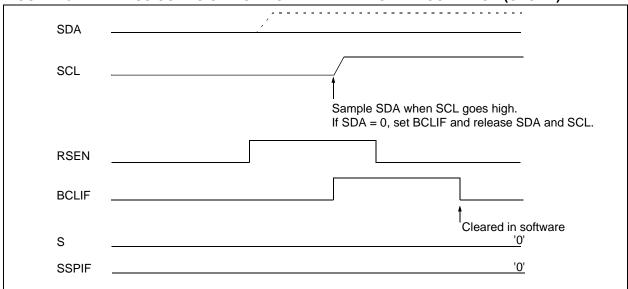
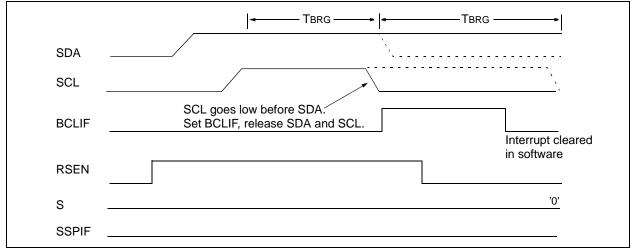


FIGURE 15-25: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



15.4.16.3 Bus Collision During a STOP Condition

Bus collision occurs during a STOP condition if:

- After the SDA pin has been de-asserted and allowed to float high, SDA is sampled low after the BRG has timed out.
- b) After the SCL pin is de-asserted, SCL is sampled low before SDA goes high.

The STOP condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the baud rate generator is loaded with SSPADD<6:0> and counts down to 0. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 15-26). If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 15-27).

FIGURE 15-26: BUS COLLISION DURING A STOP CONDITION (CASE 1)

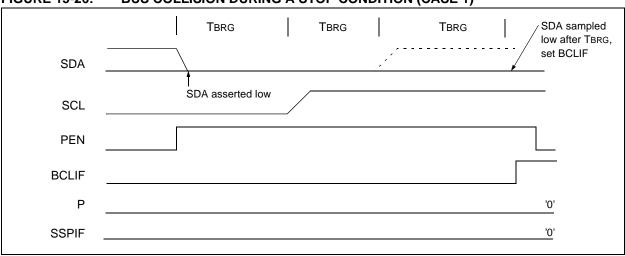
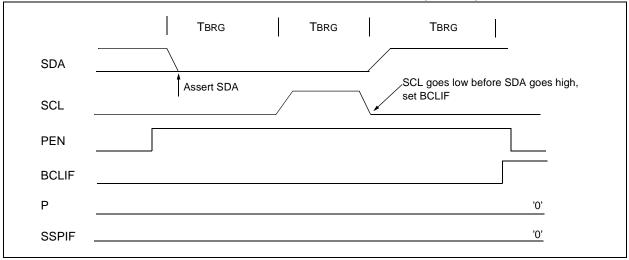


FIGURE 15-27: BUS COLLISION DURING A STOP CONDITION (CASE 2)



16.0 ADDRESSABLE UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART)

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI.) The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

The SPEN (RCSTA register) and the TRISC<7> bits have to be set, and the TRISC<6> bit must be cleared, in order to configure pins RC6/TX/CK and RC7/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

Register 16-1 shows the Transmit Status and Control Register (TXSTA) and Register 16-2 shows the Receive Status and Control Register (RCSTA).

REGISTER 16-1: TXSTA REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D
bit 7							bit 0

bit 7 CSRC: Clock Source Select bit

Asynchronous mode:

Don't care

Synchronous mode:

1 = Master mode (Clock generated internally from BRG)

0 = Slave mode (Clock from external source)

bit 6 **TX9**: 9-bit Transmit Enable bit

1 = Selects 9-bit transmission

0 = Selects 8-bit transmission

bit 5 TXEN: Transmit Enable bit

1 = Transmit enabled

0 = Transmit disabled

SREN/CREN overrides TXEN in SYNC mode.

bit 4 SYNC: USART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3 Unimplemented: Read as '0'

bit 2 BRGH: High Baud Rate Select bit

Asynchronous mode:

1 = High speed

0 = Low speed

Synchronous mode:

Unused in this mode

bit 1 TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data. Can be Address/Data bit or a parity bit.

Legend:	L	_egei	nd:	•
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R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 16-2: RCSTA REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

bit 7 SPEN: Serial Port Enable bit

1 = Serial port enabled (Configures RX/DT and TX/CK pins as serial port pins)

0 = Serial port disabled

bit 6 RX9: 9-bit Receive Enable bit

1 = Selects 9-bit reception

0 = Selects 8-bit reception

bit 5 SREN: Single Receive Enable bit

Asynchronous mode:

Don't care

Synchronous mode - Master:

1 = Enables single receive

0 = Disables single receive

This bit is cleared after reception is complete.

Synchronous mode - Slave:

Unused in this mode

bit 4 CREN: Continuous Receive Enable bit

Asynchronous mode:

1 = Enables continuous receive

0 = Disables continuous receive

Synchronous mode:

1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)

0 = Disables continuous receive

bit 3 ADDEN: Address Detect Enable bit

Asynchronous mode 9-bit (RX9 = 1):

1 = Enables address detection, enable interrupt and load of the receive buffer when RSR<8> is set

0 = Disables address detection, all bytes are received, and ninth bit can be used as parity bit

bit 2 FERR: Framing Error bit

1 = Framing error (Can be updated by reading RCREG register and receive next valid byte)

0 = No framing error

bit 1 **OERR**: Overrun Error bit

1 = Overrun error (Can be cleared by clearing bit CREN)

0 = No overrun error

bit 0 **RX9D:** 9th bit of Received Data. Can be Address/Data bit or a parity bit.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

16.1 USART Baud Rate Generator (BRG)

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In Asynchronous mode, bit BRGH (TXSTA register) also controls the baud rate. In Synchronous mode, bit BRGH is ignored. Table 16-1 shows the formula for computation of the baud rate for different USART modes, which only apply in Master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 16-1. From this, the error in baud rate can be determined.

Example 16-1 shows the calculation of the baud rate error for the following conditions:

Fosc = 16 MHz Desired Baud Rate = 9600 BRGH = 0 SYNC = 0

It may be advantageous to use the high baud rate (BRGH = 1), even for slower baud clocks. This is because the Fosc/(16(X + 1)) equation can reduce the baud rate error in some cases.

Writing a new value to the SPBRG register causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

16.1.1 SAMPLING

The data on the RC7/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin.

EXAMPLE 16-1: CALCULATING BAUD RATE ERROR

Desired Baud Rate	=	Fosc / (64 (X + 1))
Solving for X:		
X X X	= = =	((Fosc / Desired Baud Rate) / 64) - 1 ((16000000 / 9600) / 64) - 1 [25.042] = 25
Calculated Baud Rate	= =	16000000 / (64 (25 + 1)) 9615
Error	= = =	(Calculated Baud Rate - Desired Baud Rate) Desired Baud Rate (9615 - 9600) / 9600 0.16%

TABLE 16-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = Fosc/(64(X+1))	Baud Rate = Fosc/(16(X+1))
1	(Synchronous) Baud Rate = Fosc/(4(X+1))	NA NA

Legend: X = value in SPBRG (0 to 255)

TABLE 16-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
SPBRG	Baud Rat	e Gener		0000 0000	0000 0000					

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used by the BRG.

TABLE 16-3: BAUD RATES FOR SYNCHRONOUS MODE

BAUD RATE (Kbps)	F	osc =25 M	Hz	20 MHz					
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)			
0.3	NA	-	-	NA	-	-			
1.2	NA	-	-	NA	-	-			
2.4	NA	-	-	NA	-	-			
9.6	NA	-	-	NA	-	-			
19.2	NA	-	-	NA	-	-			
76.8	77.16	+0.47	80	76.92	+0.16	64			
96	96.15	+0.16	64	96.15	+0.16	51			
300	297.62	-0.79	20	294.12	-1.96	16			
500	480.77	-3.85	12	500	0	9			
HIGH	6250	-	0	5000	-	0			
LOW	24.41	-	255	19.53	-	255			

BAUD RATE (Kbps)	Fosc = 16 MHz			10 MHz			7.15909 MHz			5.0688 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
2.4	NA	-	-	NA	-	-	NA	-	-	NA	-	-
9.6	NA	-	-	NA	-	-	9.62	+0.23	185	9.60	0	131
19.2	19.23	+0.16	207	19.23	+0.16	129	19.24	+0.23	92	19.20	0	65
76.8	76.92	+0.16	51	75.76	-1.36	32	77.82	+1.32	22	74.54	-2.94	16
96	95.24	-0.79	41	96.15	+0.16	25	94.20	-1.88	18	97.48	+1.54	12
300	307.70	+2.56	12	312.50	+4.17	7	298.35	-0.57	5	NA	-	-
500	500	0	7	500	0	4	NA	-	-	NA	-	-
HIGH	4000	-	0	2500	-	0	1789.80	-	0	1267.20	-	0
LOW	15.63	-	255	9.77	-	255	6.99	-	255	4.95	-	255

BAUD RATE (Kbps)	Fosc = 4 MHz			3.579545 MHz			1 MHz			32.768 kHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-		NA	-		NA	-		0.30	+1.14	
1.2	NA	-	-	NA	-	-	1.20	+0.16	207	1.17	-2.48	6
2.4	NA	-	-	NA	-	-	2.40	+0.16	103	NA	-	-
9.6	9.62	+0.16	103	9.62	+0.23	92	9.62	+0.16	25	NA	-	-
19.2	19.23	+0.16	51	19.04	-0.83	46	19.23	+0.16	12	NA	-	-
76.8	76.92	+0.16	12	74.57	-2.90	11	NA	-	-	NA	-	-
96	1000	+4.17	9	99.43	+3.57	8	NA	-	-	NA	-	-
300	NA	-	-	298.30	-0.57	2	NA	-	-	NA	-	-
500	500	0	1	NA	-	-	NA	-	-	NA	-	-
HIGH	1000	-	0	894.89	-	0	250	-	0	8.20	-	0
LOW	3.91	-	255	3.50	-	255	0.98	-	255	0.03	-	255

TABLE 16-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD	F	osc = 25 N	lHz	20 MHz					
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)			
0.3	NA	-		NA	-				
1.2	NA	-	-	NA	-	-			
2.4	2.40	-0.15	162	2.40	+0.16	129			
9.6	9.53	-0.76	40	9.47	-1.36	32			
19.2	19.53	+1.73	19	19.53	+1.73	15			
76.8	78.13	+1.73	4	78.13	+1.73	3			
96	97.66	+1.73	3	NA	-	-			
300	NA	-	-	312.50	+4.17	0			
500	NA	-	-	NA	-	-			
HIGH	390.63	-	0	312.50	-	0			
LOW	1.53	-	255	1.22	-	255			

BAUD	F	osc = 16 M	Hz	10 MHz			,	7.15909 MH	z	5.0688 MHz			
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	NA	-		NA	-		NA	-		NA	-		
1.2	1.20	+0.16	207	1.20	+0.16	129	1.20	+0.23	92	1.20	0	65	
2.4	2.40	+0.16	103	2.40	+0.16	64	2.38	-0.83	46	2.40	0	32	
9.6	9.62	+0.16	25	9.77	+1.73	15	9.32	-2.90	11	9.90	+3.13	7	
19.2	19.23	+0.16	12	19.53	+1.73	7	18.64	-2.90	5	19.80	+3.13	3	
76.8	NA	-	-	78.13	+1.73	1	NA	-	-	79.20	+3.13	0	
96	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
300	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
HIGH	250	-	0	156.25	-	0	111.86	-	0	79.20	-	0	
LOW	0.98	-	255	0.61	-	255	0.44	-	255	0.31	-	255	

BAUD	F	osc = 4 M	Hz	3	3.579545 MI	Hz	1 MHz			32.768 kHz			
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	0.30	-0.16		0.30	+0.23		0.30	+0.16		NA	-		
1.2	1.20	+1.67	51	1.19	-0.83	46	1.20	+0.16	12	NA	-	-	
2.4	2.40	+1.67	25	2.43	+1.32	22	NA	-	-	NA	-	-	
9.6	NA	-	-	9.32	-2.90	5	NA	-	-	NA	-	-	
19.2	NA	-	-	18.64	-2.90	2	NA	-	-	NA	-	-	
76.8	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
96	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
300	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
HIGH	62.50	-	0	55.93	-	0	15.63	-	0	0.51	-	0	
LOW	0.24	-	255	0.22	-	255	0.06	-	255	0.002	-	255	

TABLE 16-5: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD	F	osc = 25 N	1Hz	20 MHz					
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)			
0.3	NA	-		NA	-				
1.2	NA	-	-	NA	-	-			
2.4	NA	-	-	NA	-	-			
9.6	9.59	-0.15	162	9.62	+0.16	129			
19.2	19.30	+0.47	80	19.23	+0.16	64			
76.8	78.13	+1.73	19	78.13	+1.73	15			
96	97.66	+1.73	15	96.15	+0.16	12			
300	312.50	+4.17	4	312.50	+4.17	3			
500	520.83	+4.17	2	NA	-	-			
HIGH	1562.50	-	0	1250	-	0			
LOW	6.10	-	255	4.88	-	255			

BAUD	F	osc = 16 M	1Hz	10 MHz				7.15909 MI	Нz	5.0688 MHz			
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	NA	-		NA	-		NA	-		NA	-		
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
2.4	NA	-	-	NA	-	-	2.41	+0.23	185	2.40	0	131	
9.6	9.62	+0.16	103	9.62	+0.16	64	9.52	-0.83	46	9.60	0	32	
19.2	19.23	+0.16	51	18.94	-1.36	32	19.45	+1.32	22	18.64	-2.94	16	
76.8	76.92	+0.16	12	78.13	+1.73	7	74.57	-2.90	5	79.20	+3.13	3	
96	100	+4.17	9	NA	-	-	NA	-	-	NA	-	-	
300	NA	-	-	312.50	+4.17	1	NA	-	-	NA	-	-	
500	500	0	1	NA	-	-	NA	-	-	NA	-	-	
HIGH	1000	-	0	625	-	0	447.44	-	0	316.80	-	0	
LOW	3.91	-	255	2.44	-	255	1.75	-	255	1.24	-	255	

BALID	Fosc = 4 MHz		Hz	3.579545 MHz				1 MHz		32.768 kHz			
RATE (Kbps)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	NA	-	-	NA	-	-	0.30	+0.16	207	0.29	-2.48	6	
1.2	1.20	+0.16	207	1.20	+0.23	185	1.20	+0.16	51	NA	-	-	
2.4	2.40	+0.16	103	2.41	+0.23	92	2.40	+0.16	25	NA	-	-	
9.6	9.62	+0.16	25	9.73	+1.32	22	NA	-	-	NA	-	-	
19.2	19.23	+0.16	12	18.64	-2.90	11	NA	-	-	NA	-	-	
76.8	NA	-	-	74.57	-2.90	2	NA	-	-	NA	-	-	
96	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
300	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	
HIGH	250	-	0	55.93	-	0	62.50	-	0	2.05	-	0	
LOW	0.98	-	255	0.22	-	255	0.24	-	255	0.008	-	255	

16.2 USART Asynchronous Mode

In this mode, data is transmitted in non-return-to-zero (NRZ) format. Data consists of one START bit, eight or nine data bits and one STOP bit. Data is transmitted in serial fashion with LSb first. An on-chip 8-bit baud rate generator can be programmed to generate the desired baud rate. The baud rate generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH bit (TXSTA register). USART does not automatically calculate the parity bit for the given data byte. If parity is to be transmitted, USART must be programmed to transmit nine bits and software must set/ clear ninth data bit as parity bit. Asynchronous mode is stopped during SLEEP.

Asynchronous mode is selected by clearing the SYNC bit (TXSTA register).

The USART Asynchronous module consists of the following important elements:

- · Baud Rate Generator
- Sampling Circuit
- Asynchronous Transmitter
- · Asynchronous Receiver

16.2.1 USART ASYNCHRONOUS TRANSMITTER

The USART transmitter block diagram is shown in Figure 16-1. The heart of the transmitter is the Transmit (serial) Shift Register (TSR). The TSR register obtains its data from the Read/Write Transmit Buffer register (TXREG). The TXREG register is loaded with data in software. The TSR register is not loaded until the STOP bit has been transmitted from the previous load. As soon as the STOP bit is transmitted, the TSR is loaded with new data from the TXREG register (if available).

Once the TXREG register transfers the data to the TSR register (occurs in one TcY), the TXREG register is empty and flag bit TXIF (PIR registers) is set. This interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE registers). Flag bit TXIF will be set, regardless of the state of enable bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicated the status of the TXREG register, another bit TRMT (TXSTA register) shows the status of the TSR register. Status bit TRMT is a read only bit, which is set when the TSR register is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty.

- **Note 1:** The TSR register is not mapped in data memory, so it is not available to the user.
 - 2: Flag bit TXIF is set when enable bit TXEN is set.

Steps to follow when setting up an Asynchronous Transmission:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 16.1).
- Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit TXIE.
- If 9-bit transmission is desired, set transmit bit TX9. Can be used as address/data bit.
- Enable the transmission by setting bit TXEN, which will also set bit TXIF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Load data to the TXREG register (starts transmission).

FIGURE 16-1: USART TRANSMIT BLOCK DIAGRAM

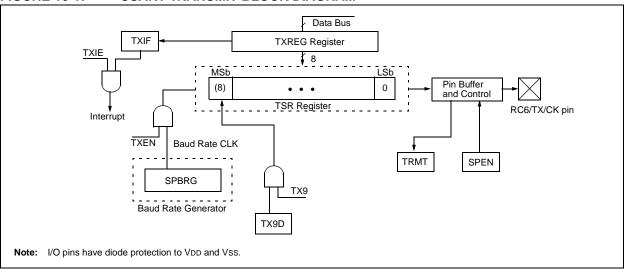


FIGURE 16-2: ASYNCHRONOUS TRANSMISSION

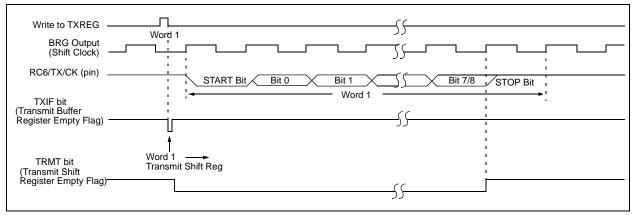


FIGURE 16-3: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

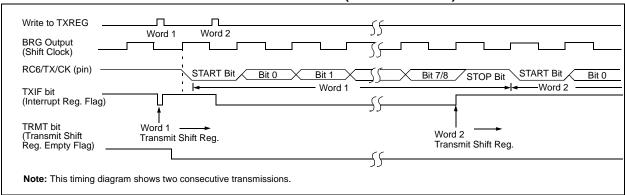


TABLE 16-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	1	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	1	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	x00-0000	0000 -00x
TXREG	USART Tra	ansmit Regis	ster						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator F	Register						0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Transmission.

16.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 16-4. The data is received on the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter, operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

Steps to follow when setting up an Asynchronous Reception:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 16.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit RCIE.
- 4. If 9-bit reception is desired, set bit RX9.
- 5. Enable the reception by setting bit CREN.
- Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing enable bit CREN.

16.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. Steps to follow when setting up an Asynchronous Reception with Address Detect Enable:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is required, set the BRGH bit.
- 2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- If interrupts are required, set the RCEN bit and select the desired priority level with the RCIP bit.
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- Enable reception by setting the CREN bit.
- The RCIF bit will be set when reception is complete. The interrupt will be acknowledged if the RCIE and GIE bits are set.
- 8. Read the RCSTA register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- Read RCREG to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.

FIGURE 16-4: USART RECEIVE BLOCK DIAGRAM

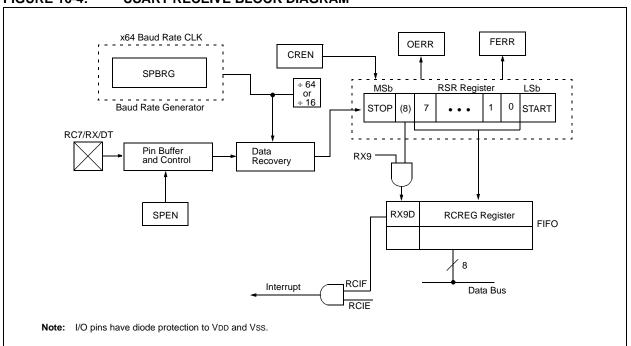


FIGURE 16-5: ASYNCHRONOUS RECEPTION

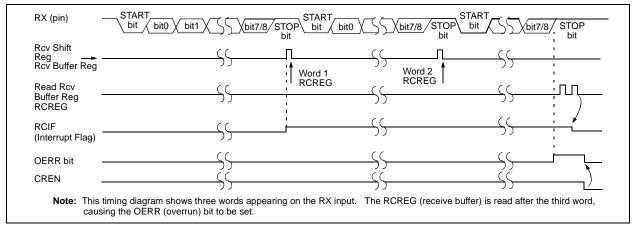


TABLE 16-7: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	x000 -000	0000 -00x
RCREG	USART Red	ceive Registe	r						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator Re	gister	•		•			0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Reception.

16.3 USART Synchronous Master Mode

In Synchronous Master mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA register). In addition, enable bit SPEN (RCSTA register) is set, in order to configure the RC6/TX/CK and RC7/RX/DT I/O pins to CK (clock) and DT (data) lines, respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting bit CSRC (TXSTA register).

16.3.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART transmitter block diagram is shown in Figure 16-1. The heart of the transmitter is the Transmit (serial) Shift register (TSR). The shift register obtains its data from the Read/Write Transmit Buffer register (TXREG). The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcy), the TXREG is empty and interrupt

bit TXIF (PIR registers) is set. The interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE registers). Flag bit TXIF will be set, regardless of the state of enable bit TXIE, and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit TRMT (TXSTA register) shows the status of the TSR register. TRMT is a read only bit, which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory, so it is not available to the user.

Steps to follow when setting up a Synchronous Master Transmission:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 16.1).
- Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. If interrupts are desired, set enable bit TXIE.
- If 9-bit transmission is desired, set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.

TABLE 16-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
TXREG	USART Tra	nsmit Registe	er						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator Re	egister	•	•				0000 0000	0000 0000

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Master Transmission.

FIGURE 16-6: SYNCHRONOUS TRANSMISSION

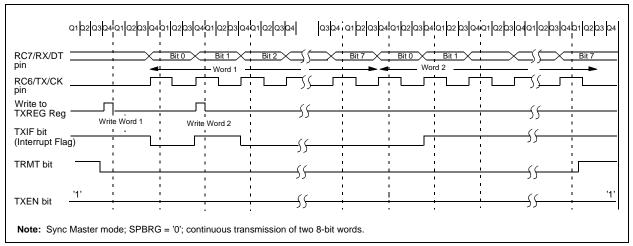
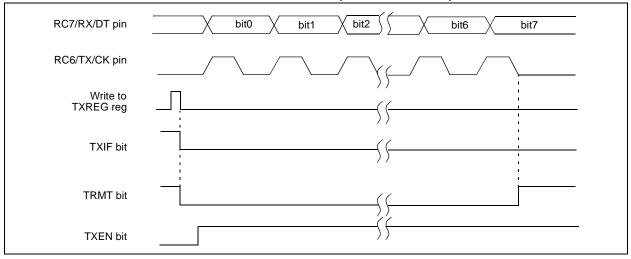


FIGURE 16-7: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)



16.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once Synchronous Master mode is selected, reception is enabled by setting either enable bit SREN (RCSTA register), or enable bit CREN (RCSTA register). Data is sampled on the RC7/RX/DT pin on the falling edge of the clock. If enable bit SREN is set, only a single word is received. If enable bit CREN is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

When setting up a Synchronous Master reception, follow these steps:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 16.1).
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.

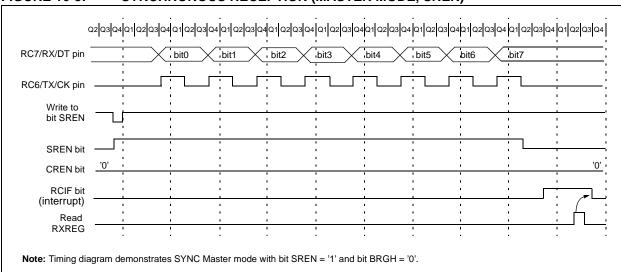
- 3. Ensure bits CREN and SREN are clear.
- 4. If interrupts are desired, set enable bit RCIE.
- 5. If 9-bit reception is desired, set bit RX9.
- 6. If a single reception is required, set bit SREN. For continuous reception, set bit CREN.
- Interrupt flag bit RCIF will be set when reception is complete and an interrupt will be generated if the enable bit RCIE was set.
- 8. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 9. Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing bit CREN.

TABLE 16-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
RCREG	USART Re	ceive Registe	er						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator Re	egister						0000 0000	0000 0000

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Master Reception.

FIGURE 16-8: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



16.4 USART Synchronous Slave Mode

Synchronous Slave mode differs from the Master mode, in that the shift clock is supplied externally at the RC6/TX/CK pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in SLEEP mode. Slave mode is entered by clearing bit CSRC (TXSTA register).

16.4.1 USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the Synchronous Master and Slave modes are identical, except in the case of the SLEEP mode.

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

- a) The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in TXREG register.
- c) Flag bit TXIF will not be set.
- d) When the first word has been shifted out of TSR, the TXREG register will transfer the second word to the TSR and flag bit TXIF will be set.
- If enable bit TXIE is set, the interrupt will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector.

When setting up a Synchronous Slave Transmission, follow these steps:

- Enable the synchronous slave serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. Clear bits CREN and SREN.
- 3. If interrupts are desired, set enable bit TXIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- Enable the transmission by setting enable bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.

16.4.2 USART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical, except in the case of the SLEEP mode and bit SREN, which is a "don't care" in Slave mode

If receive is enabled by setting bit CREN prior to the SLEEP instruction, then a word may be received during SLEEP. On completely receiving the word, the RSR register will transfer the data to the RCREG register, and if enable bit RCIE bit is set, the interrupt generated will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector.

When setting up a Synchronous Slave Reception, follow these steps:

- Enable the synchronous master serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. If interrupts are desired, set enable bit RCIE.
- 3. If 9-bit reception is desired, set bit RX9.
- 4. To enable reception, set enable bit CREN.
- Flag bit RCIF will be set when reception is complete. An interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing bit CREN.

TARI F 16-10-	REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
TXREG	USART Tra	ansmit Regist	er						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator Re	egister						0000 0000	0000 0000

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Slave Transmission.

TABLE 16-11: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INTOIE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
RCREG	USART Re	ceive Registe	er						0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	ADDEN	BRGH	TRMT	TX9D	0000 0010	0000 0010
SPBRG	Baud Rate	Generator Re		0000 0000	0000 0000					

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Slave Reception.

NOTES:

17.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The analog-to-digital (A/D) converter module has 8 inputs for the PIC18C601 devices and 12 for the PIC18C801 devices. This module has the ADCON0, ADCON1, and ADCON2 registers.

The A/D allows conversion of an analog input signal to a corresponding 10-bit digital number.

The A/D module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 17-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 17-2, configures the functions of the port pins. The ADCON2, shown in Register 16-3, configures the A/D clock source and justification.

REGISTER 17-1: ADCONO REGISTER

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5-2 CHS3:CHS0: Analog Channel Select bits

0000 = channel 00, (AN0)

0001 = channel 01, (AN1)

0010 = channel 02, (AN2)

0011 = channel 03, (AN3)

0100 = channel 04, (AN4)

0101 = channel 05, (AN5)

0110 = channel 06, (AN6)

0111 = channel 07, (AN7) 1000 = channel 08, (AN8)⁽¹⁾

1001 = channel 09, $(AN9)^{(1)}$

 $1010 = \text{channel } 10, (AN10)^{(1)}$

1011 = channel 11, (AN11)(1)

1100 = Reserved

1101 = Reserved

1110 = Reserved

1111 = Reserved

These channels are not available on the PIC18C601 devices.

bit 1 GO/DONE: A/D Conversion Status bit

When ADON = 1:

- 1 = A/D conversion in progress. Setting this bit starts an A/D conversion cycle. This bit is automatically cleared by hardware when the A/D conversion is complete.
- 0 = A/D conversion not in progress

bit 0 ADON: A/D On bit

- 1 = A/D converter module is operating
- 0 = A/D converter module is shut-off and consumes no operating current

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 17-2: ADCON1 REGISTER

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0
bit 7							bit 0

bit 7-6 Unimplemented: Read as '0'

bit 5-4 VCFG1:VCFG0: Voltage Reference Configuration bits

	A/D VREF+	A/D VREF-
0.0	AVDD	Avss
01	External VREF+	Avss
10	AVDD	External VREF-
11	External VREF+	External VREF-

bit 3-0 **PCFG3:PCFG0:** A/D Port Configuration Control bits

	AN11	AN10	AN9	AN8	AN7	AN6	AN5	AN4	AN3	AN2	AN1	AN0
0000	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0001	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0010	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0011	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0100	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0101	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0110	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α
0111	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α
1000	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α
1001	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α
1010	D	D	D	D	D	D	D	Α	Α	Α	Α	Α
1011	D	D	D	D	D	D	D	D	Α	Α	Α	Α
1100	D	D	D	D	D	D	D	D	D	Α	Α	Α
1101	D	D	D	D	D	D	D	D	D	D	Α	Α
1110	D	D	D	D	D	D	D	D	D	D	D	Α
1111	D	D	D	D	D	D	D	D	D	D	D	D

A = Analog input D = Digital I/O

Shaded cells = Additional A/D channels available on PIC18C801 devices.

REGISTER 17-3: ADCON2 REGISTER

R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
ADFM	_	_	_	_	ADCS2	ADCS1	ADCS0
hit 7							hit 0

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified0 = Left justified

bit 6-3 Unimplemented: Read as '0'

bit 2-0 ADCS2:ADCS0: A/D Conversion Clock Select bits

000 = Fosc/2 001 = Fosc/8 010 = Fosc/32

011 = FRC (clock derived from an internal RC oscillator = 1 MHz max)

100 = Fosc/4 101 = Fosc/16 110 = Fosc/64

111 = FRC (clock derived from an internal RC oscillator = 1 MHz max)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (VDD and VSS), or the voltage level on the RA3/AN3/VREF+ pin and RA2/AN2/VREF-.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

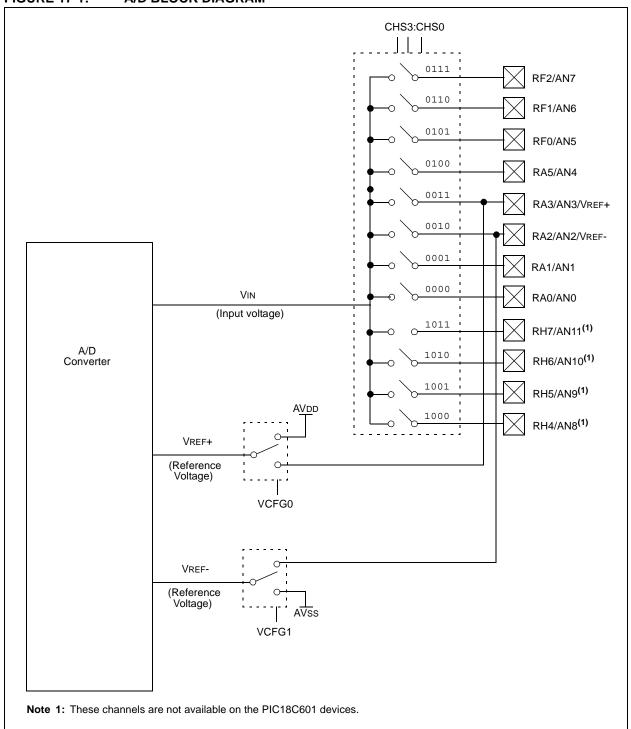
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off and any conversion is aborted.

Each port pin associated with the A/D converter can be configured as an analog input (RA3 can also be a voltage reference), or as a digital I/O.

The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH/ADRESL registers, the GO/DONE bit (ADCON0 register) is cleared, and A/D interrupt flag bit ADIF is set. The block diagram of the A/D module is shown in Figure 17-1.

FIGURE 17-1: A/D BLOCK DIAGRAM



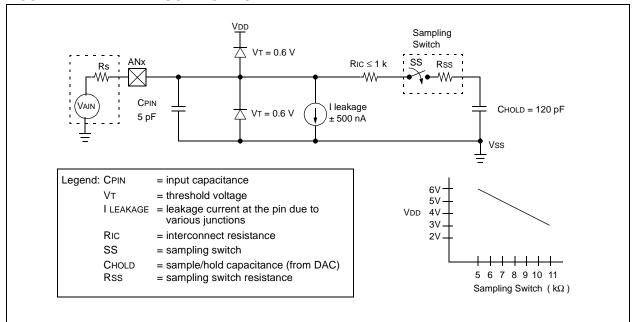
The value in the ADRESH/ADRESL registers is not modified for a Power-on Reset. The ADRESH/ADRESL registers will contain unknown data after a Power-on Reset.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see Section 17.1. After this acquisition time has elapsed, the A/D conversion can be started. The following steps should be followed to do an A/D conversion:

- 1. Configure the A/D module:
 - Configure analog pins, voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON2)
 - Turn on A/D module (ADCON0)

- 2. Configure A/D interrupt (if desired):
 - · Clear ADIF bit
 - Set ADIE bit
 - Set GIE bit
- 3. Wait the required acquisition time.
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0 register)
- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared, OR
 - Waiting for the A/D interrupt
- Read A/D Result registers (ADRESH:ADRESL); clear bit ADIF, if required.
- 7. For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2TAD is required before next acquisition starts.

FIGURE 17-2: ANALOG INPUT MODEL



17.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (Chold) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 17-2. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor Chold. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is $2.5 k\Omega$. After the analog input channel is selected (changed), this acquisition must be done before the conversion can be started.

Note: When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 17-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Example 17-1 shows the calculation of the minimum required acquisition time TACQ. This calculation is based on the following application system assumptions:

 $\begin{array}{lll} \text{CHOLD} & = & 120 \text{ pF} \\ \text{Rs} & = & 2.5 \text{ k}\Omega \\ \text{Conversion Error} & \leq & 1/2 \text{ LSb} \\ \end{array}$

 $\begin{array}{lll} \text{VDD} & = & 5\text{V} \rightarrow \text{Rss} = 7 \text{ k}\Omega \\ \text{Temperature} & = & 50^{\circ}\text{C (system max.)} \\ \text{VHOLD} & = & 0\text{V @ time} = 0 \end{array}$

EQUATION 17-1: ACQUISITION TIME

TACQ = Amplifier Settling Time +
Holding Capacitor Charging Time +
Temperature Coefficient

= TAMP + TC + TCOFF

EQUATION 17-2: A/D MINIMUM CHARGING TIME

```
VHOLD = (VREF - (VREF/2048)) • (1 - e^{(-Tc/CHOLD(RIC + RSS + RS))}) or 
TC = -(120 pF)(1 kΩ + RSS + RS) ln(1/2047)
```

EXAMPLE 17-1: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

```
 \begin{array}{lll} TACQ & = & TAMP + TC + TCOFF \\ Temperature coefficient is only required for temperatures > 25°C. \\ TACQ & = & 2 \, \mu s + TC + \left[ (Temp - 25°C)(0.05 \, \mu s/°C) \right] \\ TC & = & -CHOLD \left( RIC + Rss + Rs \right) \ln(1/2047) \\ & & -120 \, pF \left( 1 \, k\Omega + 7 \, k\Omega + 2.5 \, k\Omega \right) \ln(0.0004885) \\ & & -120 \, pF \left( 10.5 \, k\Omega \right) \ln(0.0004885) \\ & & -1.26 \, \mu s \left( -7.6241 \right) \\ & & 9.61 \, \mu s \\ \\ TACQ & = & 2 \, \mu s + 9.61 \, \mu s + \left[ (50°C - 25°C)(0.05 \, \mu s/°C) \right] \\ & & 11.61 \, \mu s + 1.25 \, \mu s \\ & & 12.86 \, \mu s \\ \\ \end{array}
```

17.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 12 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable. There are seven possible options for TAD:

- 2Tosc
- 4Tosc
- 8Tosc
- 16Tosc
- 32Tosc
- 64Tosc
- · Internal RC oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 $\mu s.$

Table 17-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

17.3 Configuring Analog Port Pins

The ADCON1, TRISA, TRISF and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS3:CHS0 bits and the TRIS bits.

- Note 1: When reading the port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.
 - 2: Analog levels on any pin defined as a digital input may cause the input buffer to consume current out of the device's specification limits.

TABLE 17-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock S	ource (TAD)	Maximum Device Frequency				
Operation	ADCS2:ADCS0	PIC18C601/801	PIC18LC601/801 ⁽⁵⁾			
2Tosc	000	1.25 MHz	666 kHz			
4Tosc	100	2.50 MHz	1.33 MHz			
8Tosc	001	5.00 MHz	2.67 MHz			
16Tosc	101	10.0 MHz	5.33 MHz			
32Tosc	010	20.0 MHz	10.67 MHz			
64Tosc	110	_	_			
RC	x11	_	_			

- Note 1: The RC source has a typical TAD time of $4 \mu s$.
 - 2: These values violate the minimum required TAD time.
 - 3: For faster conversion times, the selection of another clock source is recommended.
 - **4:** For device frequencies above 1 MHz, the device must be in SLEEP for the entire conversion or the A/D accuracy may be out of specification.
 - 5: This column is for the LC devices only.

17.4 A/D Conversions

Figure 17-3 shows the operation of the A/D converter after the GO bit has been set. Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D result register pair will NOT be updated with the partially completed A/D conversion sample. That is, the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers). After the A/D conversion is aborted, a 2TAD wait is required before the next acquisition is started. After this 2TAD wait, acquisition on the selected channel is automatically started.

Note: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

17.5 Use of the CCP2 Trigger

An A/D conversion can be started by the "special event trigger" of the CCP2 module. This requires that the CCP2M3:CCP2M0 bits (CCP2CON<3:0>) be programmed as 1011, and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D conversion and the Timer1 (or Timer3) counter will be reset to zero. Timer1 (or Timer3) is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH/ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition done before the "special event trigger" sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the "special event trigger" will be ignored by the A/D module, but will still reset the Timer1 (or Timer3) counter.

FIGURE 17-3: A/D CONVERSION TAD CYCLES

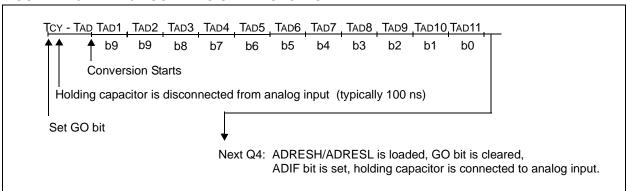


TABLE 17-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	_	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PIE1	_	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
IPR1	_	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	-000 0000	-000 0000
PIR2	_				BCLIF	LVDIF	TMR3IF	CCP2IF	-0 0000	-0 0000
PIE2	_	_	_	_	BCLIE	LVDIE	TMR3IE	CCP2IE	0000	0000
IPR2	_	_	_	_	BCLIP	LVDIP	TMR3IP	CCP2IP	0000	0000
ADRESH	A/D Result	Register		xxxx xxxx	uuuu uuuu					
ADRESL	A/D Result	Register							xxxx xxxx	uuuu uuuu
ADCON0	_	_	CHS3	CHS3	CHS1	CHS0	GO/DONE	ADON	0000 00-0	0000 00-0
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	000	000
ADCON2	ADFM	_	_	_	_	ADCS2	ADCS1	ADCS0	0000	0000
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	0u 0000
TRISA	_	PORTA Data	a Direction	Register					11 1111	11 1111
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	RF0	x000 0000	u000 0000
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	LATF0	xxxx xxxx	uuuu uuuu
TRISF	PORTF Dat	a Direction C	ontrol Reg	ister					1111 1111	1111 1111
PORTH ⁽¹⁾	RH7	7 RH6 RH5 RH4 RH3 RH2 RH1 RH0						0000 xxxx	0000 xxxx	
LATH ⁽¹⁾	LATH7	ATH7 LATH6 LATH5 LATH4 LATH3 LATH2 LATH1 LATH0						xxxx xxxx	uuuu uuuu	
TRISH ⁽¹⁾	PORTH Dat	ta Direction C	ontrol Reg	ister					1111 1111	1111 1111

Legend: x = unknown, u = unchanged, -= unimplemented, read as '0'. Shaded cells are not used for A/D conversion. **Note 1:** Only available on PIC18C801 devices.

NOTES:

18.0 LOW VOLTAGE DETECT

In many applications, the ability to determine if the device voltage (VDD) is below a specified voltage level is a desirable feature. A window of operation for the application can be created, where the application software can do "housekeeping tasks", before the device voltage exits the valid operating range. This can be done using the Low Voltage Detect module.

This module is software programmable circuitry, where a device voltage trip point can be specified (internal reference voltage or external voltage input). When the voltage of the device becomes lower than the specified point, an interrupt flag is set. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to that interrupt source.

The Low Voltage Detect circuitry is completely under software control. This allows the circuitry to be "turned off" by the software, which minimizes the current consumption for the device.

Figure 18-1 shows a possible application voltage curve (typically for batteries). Over time, the device voltage decreases. When the device voltage equals voltage VA, the LVD logic generates an interrupt. This occurs at time TA. The application software then has the time, until the device voltage is no longer in valid operating range, to shut-down the system. Voltage point VB is the minimum valid operating voltage specification. This occurs at time TB. TB - TA is the total time for shut-down.

FIGURE 18-1: TYPICAL LOW VOLTAGE DETECT APPLICATION

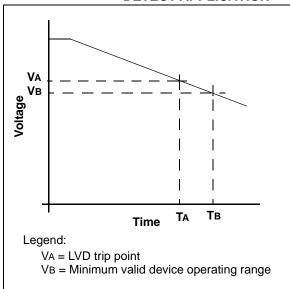
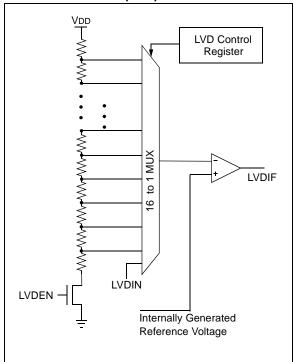


Figure 18-2 shows the block diagram for the LVD module. A comparator uses an internally generated reference voltage as the set point. When the selected tap output of the device voltage crosses the set point (is lower than), the LVDIF bit (PIR registers) is set.

Each node in the resister divider represents a "trip point" voltage. The "trip point" voltage is the minimum supply voltage level at which the device can operate, before the LVD module asserts an interrupt. When the supply voltage is equal to the trip point, the voltage tapped off of the resistor array (or external LVDIN input pin) is equal to the voltage generated by the internal voltage reference module. The comparator then generates an interrupt signal setting the LVDIF bit. This voltage is software programmable to any one of 16 values (see Figure 18-2). The trip point is selected by programming the LVDL3:LVDL0 bits (LVDCON<3:0>).

FIGURE 18-2: LOW VOLTAGE DETECT (LVD) BLOCK DIAGRAM



18.1 Control Register

The Low Voltage Detect Control register (Register 18-1) controls the operation of the Low Voltage Detect circuitry.

REGISTER 18-1: LVDCON REGISTER

U-0	U-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-1
_	_	IRVST	LVDEN	LVDL3	LVDL2	LVDL1	LVDL0
bit 7							bit 0

bit 7-6 Unimplemented: Read as '0'

bit 5 IRVST: Internal Reference Voltage Stable Flag bit

- 1 = Indicates that the Low Voltage Detect logic will generate the interrupt flag at the specified voltage range
- 0 = Indicates that the Low Voltage Detect logic will not generate the interrupt flag at the specified voltage range and the LVD interrupt should not be enabled
- bit 4 LVDEN: Low Voltage Detect Power Enable bit
 - 1 = Enables LVD, powers up LVD circuit
 - 0 = Disables LVD, powers down LVD circuit
- bit 3-0 LVDL3:LVDL0: Low Voltage Detection Limit bits
 - 1111 = External analog input is used (input comes from the LVDIN pin)
 - 1110 = 4.5V
 - 1101 = 4.2V
 - 1100 = 4.0V Reserved on PIC18C601/801
 - 1011 = 3.8V Reserved on PIC18C601/801
 - 1010 = 3.6V Reserved on PIC18C601/801
 - 1001 = 3.5V Reserved on PIC18C601/801
 - 1000 = 3.3V Reserved on PIC18C601/801 0111 = 3.0V - Reserved on PIC18C601/801
 - 0110 = 2.8V Reserved on PIC18C601/801
 - 0101 = 2.7V Reserved on PIC18C601/801
 - 0100 = 2.5V Reserved on PIC18C601/801
 - 0011 = 2.4V Reserved on PIC18C601/801
 - 0010 = 2.2V Reserved on PIC18C601/801
 - 0001 = 2.0V Reserved on PIC18C601/801
 - 0000 = Reserved on PIC18C601/801 and PIC18LC801/601

LVDL3:LVDL0 modes which result in a trip point below the valid operating voltage of the device are not tested.

L	ec	ıe.	n	d	•

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

18.2 Operation

Depending on the power source for the device voltage, the voltage normally decreases relatively slowly. This means that the LVD module does not need to be constantly operating. To decrease current consumption, the LVD circuitry only needs to be enabled for short periods, where the voltage is checked. After doing the check, the LVD module may be disabled.

Each time that the LVD module is enabled, the circuitry requires some time to stabilize. After the circuitry has stabilized, all status flags may be cleared. The module will then indicate the proper state of the system.

The following steps are needed to setup the LVD module:

- 1. Write the value to the LVDL3:LVDL0 bits (LVDCON register), which selects the desired LVD trip point.
- 2. Ensure that LVD interrupts are disabled (the LVDIE bit is cleared or the GIE bit is cleared).
- 3. Enable the LVD module (set the LVDEN bit in the LVDCON register).
- 4. Wait for the LVD module to stabilize (the IRVST bit to become set).
- 5. Clear the LVD interrupt flag, which may have falsely become set, until the LVD module has stabilized (clear the LVDIF bit).
- 6. Enable the LVD interrupt (set the LVDIE and the GIE bits).

Figure 18-3 shows typical waveforms that the LVD module may be used to detect.

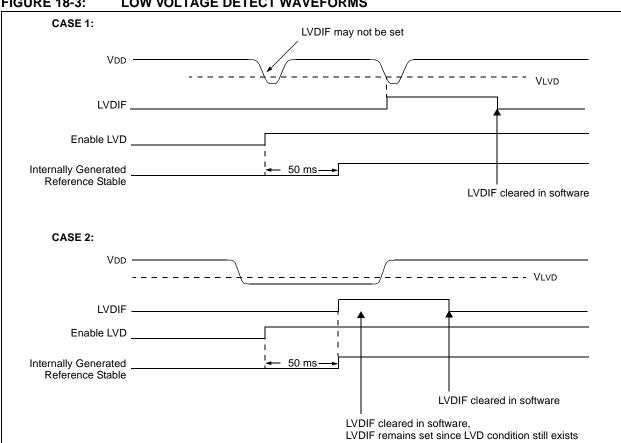


FIGURE 18-3: LOW VOLTAGE DETECT WAVEFORMS

18.2.1 REFERENCE VOLTAGE SET POINT

The Internal Reference Voltage of the LVD module may be used by other internal circuitry (the programmable Brown-out Reset). If these circuits are disabled (lower current consumption), the reference voltage circuit requires time to become stable before a low voltage condition can be reliably detected. This time is invariant of system clock speed. This start-up time is specified in electrical specification parameter #36. The low voltage interrupt flag will not be enabled until a stable reference voltage is reached. Refer to the waveform in Figure 18-3.

18.2.2 CURRENT CONSUMPTION

When the module is enabled, the LVD comparator and voltage divider are enabled and will consume static current. The voltage divider can be tapped from multiple places in the resistor array. Total current consumption, when enabled, is specified in electrical specification parameter #D022B.

18.3 External Analog Voltage Input

The LVD module has an additional feature that allows the user to supply the trip point voltage to the module from an external source (the LVDIN pin). The LVDIN pin is used as the trip point when the LVDL3:LVDL0 bits equal '1111'. This state connects the LVDIN pin voltage to the comparator. The other comparator input is connected to an internal reference voltage source.

18.4 Operation During SLEEP

When enabled, the LVD circuitry continues to operate during SLEEP. If the device voltage crosses the trip point, the LVDIF bit will be set and the device will wake-up from SLEEP. Device execution will continue from the interrupt vector address, if interrupts have been globally enabled.

18.5 Effects of a RESET

A device RESET forces all registers to their RESET state. This forces the LVD module to be turned off.

19.0 SPECIAL FEATURES OF THE CPU

There are several features intended to maximize system reliability, minimize cost through elimination of external components and provide power saving operating modes:

- OSC Selection
- RESET
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
- Interrupts
- · Watchdog Timer (WDT)
- SLEEP
- ID Locations

PIC18C601/801 devices have a Watchdog Timer, which can be permanently enabled/disabled via the configuration bits, or it can be software controlled. By default, the Watchdog Timer is disabled to allow software control. It runs off its own RC oscillator for cost reduction. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay on power-up only, designed to keep the part in RESET

while the power supply stabilizes. With these two timers on-chip, most applications need no external RESET circuitry.

SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. By default, HS oscillator mode is selected. There are two main modes of operations for external memory interface: 8-bit and 16-bit (default). A set of configuration bits are used to select various options.

19.1 Configuration Bits

The configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location 300000h.

The user will note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h - 3FFFFFh), which can only be accessed using table reads and table writes.

TABLE 19-1: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value
300001h	CONFIG1H	_	_	_	_	_	_	FOSC1	FOSC0	11
300002h	CONFIG2L	_	BW	_	_	_	_	_	PWRTEN	-11
300003h	CONFIG2H	_	_	_	_	WDTPS2	WDTPS1	WDTPS0	WDTEN	1110
300006h	CONFIG4L	r	_	_	_	_	_	_	STVREN	11
3FFFFEh	DEVID1	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	0000 0000
3FFFFFh	DEVID2	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	0000 0000

Legend: x = unknown, u = unchanged, -= unimplemented, q = value depends on condition, r = reserved, maintain '1'. Shaded cells are unimplemented, read as '0'.

REGISTER 19-1: CONFIGURATION REGISTER 1 HIGH (CONFIG1H: BYTE ADDRESS 0300001h)

U-0	U-0	U-0	U-0	U-0	U-0	R/P-1	R/P-1
_	_	_	_	_	_	FOSC1	FOSC0
hit 7							bit 0

bit 7-2 Unimplemented: Read as '0'

bit 2-0 FOSC1:FOSC0: Oscillator Selection bits

11 = RC oscillator 10 = HS oscillator 01 = EC oscillator 00 = LP oscillator

Legend:

r = Reserved

 $R = Readable \ bit$ $P = Programmable \ bit$ $U = Unimplemented \ bit, read as '0'$ $- <math>n = Value \ when \ device \ is \ unprogrammed$ $u = Unchanged \ from \ programmed \ state$

REGISTER 19-2: CONFIGURATION REGISTER 2 LOW (CONFIG2L: BYTE ADDRESS 300002h)

U-0	R/P-1	U-0	U-0	U-0	U-0	U-0	R/P-1
_	BW	_	_	_	_	_	PWRTEN
bit 7							bit 0

bit 7 Unimplemented: Read as '0'

bit 6 **BW:** External Bus Data Width bit

1 = 16-bit external bus mode

0 = 8-bit external bus mode

bit 5-1 **Unimplemented:** Read as '0'

bit 0 **PWRTEN:** Power-up Timer Enable bit

1 = PWRT disabled

0 = PWRT enabled

Legend:

r = Reserved

 $R = Readable \ bit \qquad \quad P = Programmable \ bit \quad \quad U = Unimplemented \ bit, \ read \ as \ '0'$

n = Value when device is unprogrammed

u = Unchanged from programmed state

REGISTER 19-3: CONFIGURATION REGISTER 2 HIGH (CONFIG2H: BYTE ADDRESS 300003H)

U-0	U-0	U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
_	_	_	_	WDTPS2	WDTPS1	WDTPS0	WDTEN
bit 7							hit 0

bit 7-4 Unimplemented: Read as '0'

bit 3-1 WDTPS2:WDTPS0: Watchdog Timer Postscale Select bits

000 =1:128 001 =1:64 010 =1:32 011 =1:16 100 =1:8 101 =1:4 110 =1:2 111 =1:1

bit 0 WDTEN: Watchdog Timer Enable bit

1 = WDT enabled

0 = WDT disabled (control is placed on the SWDTEN bit)

REGISTER 19-4: CONFIGURATION REGISTER 4 LOW (CONFIG4L: BYTE ADDRESS 300006H)

R/P-1	U-0	U-0	U-0	U-0	U-0	R/P-1	R/P-1
r	_	_	_	_	_	_	STVREN
bit 7							bit 0

bit 7 **Reserved:** Maintain as '1' bit 6-1 **Unimplemented:** Read as '0'

bit 0 STVREN: Stack Full/Underflow RESET Enable bit

1 = Stack Full/Underflow will cause RESET

0 = Stack Full/Underflow will not cause RESET

Legend:

r = Reserved

 $R = Readable \ bit \qquad P = Programmable \ bit \qquad U = Unimplemented \ bit, \ read \ as \ '0'$ $-n = Value \ when \ device \ is \ unprogrammed \qquad u = Unchanged \ from \ programmed \ state$

19.2 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator, which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKI pin. That means that the WDT will run, even if the clock on the OSC1/CLKI and OSC2/CLKO pins of the device has been stopped; for example, by execution of a SLEEP instruction.

During normal operation, a WDT time-out generates a device RESET (Watchdog Timer Reset). If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (Watchdog Timer Wake-up). The $\overline{\text{TO}}$ bit in the RCON register will be cleared upon a WDT time-out.

By default, the Watchdog Timer is disabled by configuration to allow software control over Watchdog Timer operation. If the WDT is enabled by configuration, software execution may not disable this function. When the Watchdog Timer is disabled by configuration, the SWDTEN bit in the WDTCON register enables/ disables the operation of the WDT.

The WDT time-out period values may be found in the Electrical Specifications section under parameter #31. Values for the WDT postscaler may be assigned by using configuration bits WDPS<3:1> in CONFIG2H register. If the Watchdog Timer is disabled by configuration, values for the WDT postscaler may be assigned using the SWDPS bits in the WDTCON register.

- Note 1: The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.
 - 2: When a CLRWDT instruction is executed and the prescaler is assigned to the WDT, the prescaler count will be cleared, but the prescaler assignment is not changed.

19.2.1 CONTROL REGISTER

Register 19-5 shows the WDTCON register. This is a readable and writable register. It contains control bits to control the Watchdog Timer from user software. If the Watchdog Timer is enabled by configuration, this register setting is ignored.

REGISTER 19-5: WDTCON REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	_	SWDPS2	SWDPS1	SWDPS0	SWDTEN
bit 7							hit 0

bit 7-4 Unimplemented: Read as '0'

bit 3-1 SWDPS2:SWDPS0: Software Watchdog Timer Postscale Select bits

111 = 1:128

110 = 1:64

101 = 1:32

100 = 1:16

011 = 1:8

011 = 1.0010 = 1.4

001 = 1:2

000 = 1:1

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit

1 = Watchdog Timer is on

0 = Watchdog Timer is turned off if it is not disabled

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented I	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

19.2.2 WDT POSTSCALER

The WDT has a postscaler that can extend the WDT Reset period. The postscaler may be programmed by the user software or is selected by configuration bits WDTPS<2:0> in the CONFIG2H register. If the device has the Watchdog Timer enabled by configuration bits,

the device will use predefined set postscaler value. If the device has the Watchdog Timer disabled by configuration bits, user software can set desired postscaler value. When the device has the Watchdog Timer enabled by configuration bits, by default, Watchdog postscaler of 1:128 is selected.

FIGURE 19-1: Watchdog Timer Block Diagram

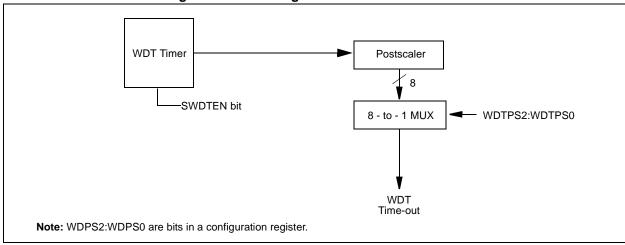


TABLE 19-2: SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CONFIG2H	_	_	_	_	WDTPS2	WDTPS1	WDTPS0	WDTEN
RCON	IPEN	r	_	RI	TO	PD	POR	r
WDTCON	_	_	_	_	SWDPS2	SWDPS1	SWDPS0	SWDTEN

Legend: Shaded cells are not used by the Watchdog Timer.

19.3 Power-down Mode (SLEEP)

Power-down mode is entered by executing a SLEEP instruction.

Upon entering into Power-down mode, the following actions are performed:

- Watchdog Timer is cleared and kept running.
- 2. PD bit in RCON register is cleared.
- 3. TO bit in RCON register is set.
- 4. Oscillator driver is turned off.
- I/O ports maintain the status they had before the SLEEP instruction was executed.

To achieve lowest current consumption, follow these steps before switching to Power-down mode:

- Place all I/O pins at either VDD or Vss and ensure no external circuitry is drawing current from I/O pin.
- 2. Power-down A/D and external clocks.
- Pull all hi-impedance inputs to high or low, externally.
- 4. Place T0CKI at Vss or VDD.
- Current consumption by PORTB on-chip pullups should be taken into account and disabled, if necessary.

The MCLR pin must be at a logic high level (VIHMC).

19.3.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on MCLR pin.
- Watchdog Timer Wake-up (if WDT was enabled).
- Interrupt from INT pin, RB port change, or a peripheral interrupt.

The following peripheral interrupts can wake the device from SLEEP:

- 4. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 5. TMR3 interrupt. Timer3 must be operating as an asynchronous counter.
- 6. CCP Capture mode interrupt.
- Special event trigger (Timer1 in Asynchronous mode using an external clock).
- 8. MSSP (START/STOP) bit detect interrupt.
- MSSP transmit or receive in Slave mode (SPI/I²C).
- 10. USART RX or TX (Synchronous Slave mode).
- 11. A/D conversion (when A/D clock source is RC).

Other peripherals cannot generate interrupts, since during SLEEP, no on-chip clocks are present.

External MCLR Reset will cause a device RESET. All other events are considered a continuation of program execution and will cause a "wake-up". The TO and PD bits in the RCON register can be used to determine the cause of the device RESET. The PD bit, which is set on power-up, is cleared when SLEEP is invoked. The TO bit is cleared, if a WDT time-out occurred (and caused wake-up).

When the SLEEP instruction is being executed, the next instruction (PC + 2) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address. In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

19.3.2 WAKE-UP USING INTERRUPTS

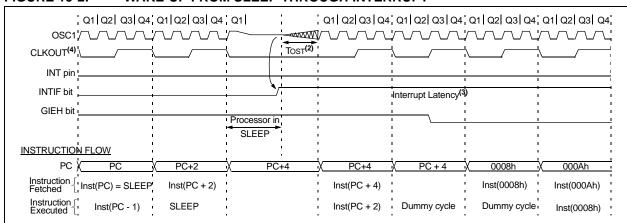
When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If an interrupt condition (interrupt flag bit and interrupt enable bits are set) occurs **before** the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt condition occurs during or after
 the execution of a SLEEP instruction, the device
 will immediately wake-up from sleep. The SLEEP
 instruction will be completely executed before the
 wake-up. Therefore, the WDT and WDT
 postscaler will be cleared, the TO bit will be set
 and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the $\overline{\text{PD}}$ bit. If the $\overline{\text{PD}}$ bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

FIGURE 19-2: WAKE-UP FROM SLEEP THROUGH INTERRUPT^(1,2)



Note 1: HS or LP oscillator mode assumed.

- 2: GIE set is assumed. In this case, after wake- up, the processor jumps to the interrupt routine. If GIE is cleared, execution will continue in-line.
- 3: Tost = 1024Tosc (drawing not to scale). This delay will not occur for RC and EC osc modes.
- 4: CLKOUT is not available in these oscillator modes, but shown here for timing reference.

NOTES:

20.0 INSTRUCTION SET SUMMARY

The PIC18C601/801 instruction set adds many enhancements to the previous PICmicro® instruction sets, while maintaining an easy migration path from them.

With few exceptions, instructions are a single program memory word (16-bits). Each single word instruction is divided into an OPCODE, which specifies the instruction type, and one or more operands which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- Byte-oriented operations
- · Bit-oriented operations
- Literal operations
- · Control operations

The PIC18C601/801 instruction set summary in Table 20-2 lists **byte-oriented**, **bit-oriented**, **literal** and **control** operations. Table 20-1 shows the opcode field descriptions.

Most **byte-oriented** instructions have three operands:

- 1. The file register (represented by 'f')
- The destination of the result (represented by 'd')
- 3. The accessed memory (represented by 'a')

The file register designator 'f' specifies which file register is to be used by the instruction.

The destination designator 'd' specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All bit-oriented instructions have three operands:

- 1. The file register (represented by 'f')
- 2. The bit in the file register (represented by 'b')
- 3. The accessed memory (represented by 'a')

The bit field designator 'b' selects the number of the bit affected by the operation, while the file register designator 'f' represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (represented by 'k')
- The desired FSR register to load the literal value into (represented by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (represented by 'n')
- The mode of the Call or Return instructions (represented by 's')
- The mode of the Table Read and Table Write instructions (represented by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double word instructions. These four instructions were made double word instructions so that all the required information is available in these 32 bits. In the second word, the 4 MSbs are 1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single word instructions are executed in a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP. The double word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs . If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs . Two word branch instructions (if true) would take 3 μs .

Figure 20-1 shows the general formats that the instructions can have. All examples use the format `nnh' to represent a hexadecimal number, where `h' signifies a hexadecimal digit.

The Instruction Set Summary, shown in Table 20-2, lists the instructions recognized by the Microchip assembler (MPASM TM).

Section 20.1 provides a description of each instruction.

TABLE 20-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit
	a = 0: RAM location in Access RAM (BSR register is ignored)
ACCESS	a = 1: RAM bank is specified by BSR register ACCESS = 0: RAM access bit symbol
BANKED	BANKED = 1: RAM access bit symbol
bbb	Bit address within an 8-bit file register (0 to 7)
BSR	Bank Select Register. Used to select the current RAM bank.
d	Destination select bit;
u	d = 0: store result in WREG,
	d = 1: store result in file register f.
dest	Destination either the WREG register or the specified register file location
f	8-bit Register file address (00h to FFh)
f _s	12-bit Register file address (000h to FFFh). This is the source address.
f _d	12-bit Register file address (000h to FFFh). This is the destination address.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value)
label	Label name
mm	The mode of the TBLPTR register for the Table Read and Table Write instructions Only used with Table Read and Table Write instructions:
*	No change to register (such as TBLPTR with Table reads and writes)
*+	Post-Increment register (such as TBLPTR with Table reads and writes)
*-	Post-Decrement register (such as TBLPTR with Table reads and writes)
+*	Pre-Increment register (such as TBLPTR with Table reads and writes)
n	The relative address (2's complement number) for relative branch instructions, or the direct
	address for Call/Branch and Return instructions
PRODH	Product of Multiply high byte (Register at address FF4h)
PRODL	Product of Multiply low byte (Register at address FF3h)
s	Fast Call / Return mode select bit.
	s = 0: do not update into/from shadow registers
	s = 1: certain registers loaded into/from shadow registers (Fast mode)
u	Unused or Unchanged (Register at address FE8h)
W	W = 0: Destination select bit symbol
WREG	Working register (accumulator) (Register at address FE8h)
x	Don't care $(0 \text{ or } 1)$ The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility
	with all Microchip software tools.
TBLPTR	21-bit Table Pointer (points to a Program Memory location) (Register at address FF6h)
TABLAT	8-bit Table Latch (Register at address FF5h)
TOS	Top-of-Stack
PC	Program Counter
PCL	Program Counter Low Byte (Register at address FF9h)
PCH	Program Counter High Byte
PCLATH	Program Counter High Byte Latch (Register at address FFAh)
PCLATU	Program Counter Upper Byte Latch (Register at address FFBh)
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer
TO	Time-out bit
PD	Power-down bit
C, DC, Z, OV, 1	37 6 37 7 8
[]	Optional
()	Contents
\rightarrow	Assigned to
< >	Register bit field
€	In the set of
italics	User defined term (font is courier)

FIGURE 20-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations **Example Instruction** 10 OPCODE f (FILE #) d а ADDWF MYREG, W d = 0 for result destination to be WREG register d = 1 for result destination to be file register (f) a = 0 to force Access Bank a = 1 for BSR to select Bank f = 8-bit file register address Byte to Byte move operations (2-word) 12 11 0 OPCODE f (Source FILE #) MOVFF MYREG1, MYREG2 12 11 0 1111 f (Destination FILE #) f = 12-bit file register address Bit-oriented file register operations OPCODE b (BIT #) а f (FILE #) BSF MYREG, bit b = 3-bit position of bit in file register (f) a = 0 to force Access Bank a = 1 for BSR to select Bank f = 8-bit file register address Literal operations 15 **OPCODE** k (literal) MOVLW 7Fh k = 8-bit immediate value **Control operations** CALL, GOTO and Branch operations **GOTO Label OPCODE** n<7:0> (literal) 15 12 11 1111 n<19:8> (literal) n = 20-bit immediate value 15 0 **CALL MYFUNC OPCODE** n<7:0> (literal) 12 11 15 0 1111 n<19:8> (literal) S = Fast bit 11 10 **BRA MYFUNC OPCODE** n<10:0> (literal) 15 8 7 0 **BC MYFUNC OPCODE** n<7:0> (literal) 15 LFSR FSR0, 100h **OPCODE** k<11:8>(lit.) 15 11 1111 0000 k<7:0> (literal)

TABLE 20-2: PIC18C601/801 INSTRUCTION SET

Mnemonic, Operands		Decembries	Cycles	16-Bit Instruction Word		ord/	Status	Notes	
		Description	Cycles	MSb			LSb	Affected	Notes
BYTE-ORI	ENTED FI	LE REGISTER OPERATIONS							
ADDWF	f [,d [,a]]	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 6
ADDWFC	f [,d [,a]]	Add WREG and Carry bit to f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 6
ANDWF	f [,d [,a]]	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2, 6
CLRF	f [,a]	Clear f	1	0110	101a	ffff	ffff	Z	2, 6
COMF	f [,d [,a]]	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2, 6
CPFSEQ	f [,a]	Compare f with WREG, skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4, 6
CPFSGT	f [,a]	Compare f with WREG, skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4, 6
CPFSLT	f [,a]	Compare f with WREG, skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2, 6
DECF	f [,d [,a]]	Decrement f	1 ` ′	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4, 6
DECFSZ	f [,d [,a]]	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4, 6
DCFSNZ	f [,d [,a]]	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2, 6
INCF	f [,d [,a]]	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4, 6
INCFSZ	f [,d [,a]]	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4, 6
INFSNZ	f [,d [,a]]	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2, 6
IORWF	f [,d [,a]]	Inclusive OR WREG with f	1	0001	00da	ffff	ffff	Z, N	1, 2, 6
MOVF	f [,d [,a]]	Move f	1	0101	00da	ffff	ffff	Z, N	1, 6
MOVFF	f_s, f_d	Move f _s (source) to 1st word	2	1100	ffff	ffff	ffff	None	., 0
	·s, ·a	f _d (destination)2nd word	-	1111	ffff	ffff	ffff		
MOVWF	f [,a]	Move WREG to f	1	0110	111a	ffff	ffff	None	6
MULWF	f [,a]	Multiply WREG with f	1	0000	001a	ffff	ffff	None	6
NEGF	f [,a]	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	1. 2. 6
RLCF	f [,d [,a]]	Rotate Left f through Carry	i	0011	01da	ffff	ffff	C, Z, N	6
RLNCF	f [,d [,a]]	Rotate Left f (No Carry)	i	0100	01da	ffff	ffff	Z, N	1, 2, 6
RRCF	f [,d [,a]]	Rotate Right f through Carry	<u> </u>	0011	00da	ffff	ffff	C, Z, N	6
RRNCF	f [,d [,a]]	Rotate Right f (No Carry)	<u> </u>	0100	00da	ffff	ffff	Z, N	6
SETF	f [,a]	Set f	1	0110	100a	ffff	ffff	None	6
SUBFWB	f [,d [,a]]	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 6
SOBI WB	ا زبد زبما	borrow	'	0101	Ulua	TILL	TITI	0, 00, 2, 00, 10	1, 2, 0
SUBWF	f [,d [,a]]	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	6
SUBWFB	f [,d [,a]]	Subtract WREG from f with		0101	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 6
SOBWID	ı [,u [,a]]	borrow		0101	Iuua	TILL	TITI	C, DC, Z, CV, N	1, 2, 0
SWAPF	f [,d [,a]]	Swap nibbles in f	1	0011	10da	ffff	ffff	None	4, 6
TSTFSZ	f [,a]	Test f, skip if 0	1 (2 or 3)	0110	10da 011a	ffff	ffff	None	1, 2, 6
XORWF		Exclusive OR WREG with f	1 (2 01 3)					Z, N	6
	f [,d [,a]]] '	0001 10da ffff ffff		TITI	Z, IN	О	
		REGISTER OPERATIONS	<u> </u>					INI	4.0.0
BCF	f, b [,a]	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2, 6
BSF	f, b [,a]	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2, 6
BTFSC	f, b [,a]	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4, 6
BTFSS	f, b [,a]	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4, 6
BTG	f [,d [,a]]	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2, 6

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
- 3: If Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
- **4:** Some instructions are 2-word instructions. The second word of these instructions will be executed as a NOP, unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
- 5: If the table write starts the write cycle to internal memory, the write will continue until terminated.
- **6:** Microchip's MPASM[™] Assembler automatically defaults destination bit 'd' to '1', while access bit 'a' defaults to '1' or '0', according to address of register being used.

TABLE 20-2: PIC18C601/801 INSTRUCTION SET (CONTINUED)

Mnemonic,		Description	Cycles	16-Bit Instruction Word			/ord	Status	Notes
Opera	ands	Description	Cycles	MSb			LSb	Affected	Notes
CONTROL	OPERAT	IONS							
вс	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	2	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	1 (2)	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call subroutine1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to address1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	_	No Operation	1	0000	0000	0000	0000	None	
NOP	_	No Operation (Note 4)	1	1111	xxxx	xxxx	xxxx	None	
POP	_	Pop top of return stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	_	Push top of return stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software device RESET	1	0000	0000	1111	1111	All	
RETFIE	S	Return from interrupt enable	2	0000	0000	0001	000s	GIE/GIEH,	
								PEIE/GIEL	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	S	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

- Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
 - 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
 - 3: If Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
 - 4: Some instructions are 2-word instructions. The second word of these instructions will be executed as a NOP, unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
 - 5: If the table write starts the write cycle to internal memory, the write will continue until terminated.
 - 6: Microchip's MPASMTM Assembler automatically defaults destination bit 'd' to '1', while access bit 'a' defaults to '1' or '0', according to address of register being used.

TABLE 20-2: PIC18C601/801 INSTRUCTION SET (CONTINUED)

Mnemonic,		Description	Cycles	16-Bit Instruction Word			Vord	Status	Notes
Ope	rands	Description	Cycles	MSb			LSb	Affected	Notes
LITERAL	OPERATIO	ONS							
ADDLW	k	Add literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N	
ANDLW	k	AND literal with WREG	1	0000	1011	kkkk	kkkk	Z, N	
IORLW	k	Inclusive OR literal with WREG	1	0000	1001	kkkk	kkkk	Z, N	
LFSR	f, k	Load FSR (f) with a 12-bit	2	1110	1110	OOff	kkkk	None	
		literal (k)		1111	0000	kkkk	kkkk		
MOVLB	k	Move literal to BSR<3:0>	1	0000	0001	0000	kkkk	None	
MOVLW	k	Move literal to WREG	1	0000	1110	kkkk	kkkk	None	
MULLW	k	Multiply literal with WREG	1	0000	1101	kkkk	kkkk	None	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk	None	
SUBLW	k	Subtract WREG from literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N	
XORLW	k	Exclusive OR literal with WREG	1	0000	1010	kkkk	kkkk	Z, N	
DATA ME	$MORY \leftrightarrow F$	PROGRAM MEMORY OPERATIO	NS						
TBLRD*		Table Read	2	0000	0000	0000	1000	None	
TBLRD*+		Table Read with post-increment		0000	0000	0000	1001	None	
TBLRD*-		Table Read with post-decrement		0000	0000	0000	1010	None	
TBLRD+*		Table Read with pre-increment		0000	0000	0000	1011	None	
TBLWT*		Table Write	2 (5)	0000	0000	0000	1100	None	
TBLWT*+		Table Write with post-increment		0000	0000	0000	1101	None	
TBLWT*-		Table Write with post-decrement		0000	0000	0000	1110	None	
TBLWT+*		Table Write with pre-increment		0000	0000	0000	1111	None	

- Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
 - 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
 - 3: If Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
 - 4: Some instructions are 2-word instructions. The second word of these instructions will be executed as a NOP, unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
 - 5: If the table write starts the write cycle to internal memory, the write will continue until terminated.
 - **6:** Microchip's MPASMTM Assembler automatically defaults destination bit 'd' to '1', while access bit 'a' defaults to '1' or '0', according to address of register being used.

20.1 **Instruction Set**

ADDLW	ADD liter	ral to Wi	REG			
Syntax:	[label] A	ADDLW	k			
Operands:	$0 \leq k \leq 255$					
Operation:	(WREG) + $k \rightarrow WREG$					
Status Affected:	N,OV, C, DC, Z					
Encoding:	0000	1111	kkkk	kkkk		
Description:	The contents of WREG are added to the 8-bit literal 'k' and the result is placed in WREG.					

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	WREG

Example: ADDLW 15h

Before Instruction

WREG = 10h Ν ? OV ? С ? ? DC Ζ ?

After Instruction

WREG 25h Ν 0 OV 0 С 0 DC = 0 Ζ 0

ADDWF	ADD WREG to f				
Syntax:	[label] ADDWF	f [,d [,a]]			

Operands: $0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$

 $(\mathsf{WREG}) + (\mathsf{f}) \to \mathsf{dest}$ Operation: Status Affected: N,OV, C, DC, Z

Encoding: 0010 01da ffff ffff Add WREG to register 'f'. If 'd' is 0, Description: the result is stored in WREG. If 'd' is 1, the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected. If 'a' is 1, the Bank will be selected as per the BSR

value.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: ADDWF REG, W

Before Instruction

WREG 17h REG 0C2h Ν ? OV ? С ? DC ? ? Ζ

After Instruction WREG

> REG 0C2h Ν OV 0 С 0 DC 0 Ζ 0

0D9h

ADDWFC	ADD WREG and Carry bit to f					
Syntax:	[label] AD	DDWFC	f [,d [,a	1]]		
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$					
Operation:	(WREG) +	(f) + (C)	\rightarrow dest			
Status Affected:	N,OV, C, DC, Z					
Encoding:	0010	00da	ffff	ffff		
Description:	Add WREG, the Carry Flag and data memory location 'f'. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed in data memory location 'f'. If 'a' is 0, the Access Bank will be selected. If 'a' is 1, the Bank will be selected as per the BSR value.					
Words:	1					
Cycles:	1					
Q Cycle Activity:						

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: ADDWFC REG, W

Before Instruction

C = 1

REG = 02h

WREG = 4Dh

N = ?

OV = ?

DC = ?

After Instruction

Ζ

C = 0 REG = 02h WREG = 50h N = 0 OV = 0 DC = 0 Z = 0

ANDLW AND literal with WREG [label] ANDLW Syntax: Operands: $0 \le k \le 255$ Operation: (WREG) .AND. $k \to \text{WREG}$ Status Affected: N,Z Encoding: 0000 1011 kkkk kkkk The contents of WREG are AND'ed Description: with the 8-bit literal 'k'. The result is placed in WREG. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read literal Process Write to WREG 'k' Data

Example: ANDLW 5Fh Before Instruction WREG 0A3h Ν ? Ζ ? After Instruction WREG 03h 0 Ζ 0

ANDWF AND WREG with f Syntax: [label] ANDWF f [,d [,a]] Operands: $0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$ (WREG) .AND. (f) \rightarrow dest Operation: Status Affected: N,Z Encoding: 0001 01da ffff ffff The contents of WREG are AND'ed Description: with register 'f'. If 'd' is 0, the result is stored in WREG. If 'd' is 1, the result

with register 'f'. If 'd' is 0, the result is stored in WREG. If 'd' is 1, the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected. If 'a' is 1, the bank will be selected as per the BSR value.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: ANDWF REG, W

Before Instruction

WREG = 17h REG = 0C2h N = ? Z = ?

After Instruction

WREG = 02h REG = 0C2h N = 0 Z = 0 BC Branch if Carry

Syntax: [label] BC n Operands: $-128 \le n \le 127$ Operation: if carry bit is '1'

 $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0010 nnnn nnnn

Description: If the Carry bit is '1', then the pro-

gram will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BC 5

Before Instruction

PC = address (HERE)

After Instruction

If Carry = 1;

PC = address (HERE+12)

If Carry = 0;

PC = address (HERE+2)

BCF		Bit Clear	f		
Synt	ax:	[label] E	BCF f,	b [,a]	
Ope	rands:	$0 \le f \le 25$ $0 \le b \le 7$ $a \in [0,1]$	5		
Ope	ration:	$0 \rightarrow f < b >$			
Statu	us Affected:	None			
Enco	oding:	1001	bbba	ffff	ffff
Description: Bit 'b' in register 'f' is cleared. If 'a 0, the Access Bank will be select overriding the BSR value. If 'a' = the Bank will be selected as per BSR value.			e selected, e. If 'a' = 1,		
Word	ds:	1			
Cycl	es:	1			
Q Cy	cle Activity:				
	Q1	Q2	Q	3	Q4
	Decode	Read	Proce	ess	Write

Example: BCF FLAG_REG, 7

Read register 'f'

Data

register 'f'

Before Instruction FLAG_REG = 0C7h After Instruction FLAG_REG = 47h

BN	Branch in	f Negati	ve	
Syntax:	[label] E	3N n		
Operands:	-128 ≤ n s	≤ 127		
Operation:	if negative (PC) + 2			
Status Affected:	None			
Encoding:	1110	0110	nnnn	nnnn
Description:	If the Neg gram will		is '1', ther	n the pro-
	The 2's condition added to have incrinstruction PC+2+2ntwo-cycle	the PC. emented n, the ne n. This in	Since the I to fetch w address struction	e PC will the next s will be
Words:	1			
Cycles:	1(2)			
Q Cycle Activity: If Jump:				

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BN Jump

Before Instruction

PC = address (HERE)

After Instruction

If Negative = 1;

PC = address (Jump)

If Negative = 0;

PC = address (HERE+2)

BNC Branch if Not Carry Syntax: [label] BNC n Operands: $-128 \le n \le 127$ Operation: if carry bit is '0' $(PC) + 2 + 2n \rightarrow PC$ Status Affected: None Encoding: 1110 0011 nnnn nnnn If the Carry bit is '0', then the Description:

program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity:

If Jump:

_	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	Write to PC
		'n'	Data	
	No	No	No	No
	operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNC Jump

Before Instruction

PC address (HERE)

After Instruction

If Carry 0;

> PC address (Jump)

If Carry 1;

> PC address (HERE+2)

BNN Branch if Not Negative

Syntax: [label] BNN n Operands: $-128 \le n \le 127$ Operation: if negative bit is '0' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0111

If the Negative bit is '0', then the Description:

program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNN Jump

Before Instruction

PC address (HERE)

After Instruction

If Negative 0;

PC address (Jump)

If Negative

PC address (HERE+2)

BNOV	Branch if Not Overflow		
Syntax:	[label] BNOV n		
Operands:	-128 ≤ n ≤ 127		
Operation:	if overflow bit is '0' $(PC) + 2 + 2n \rightarrow PC$		
Status Affected:	None		
Encoding:	1110 0101 nnnn nnnn		
Description:	If the Overflow bit is '0', then the program will branch.		

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

Ω3

Ω4

two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	
Decode	Read literal	Pr
	'n'	

∝.	~-	QU	∝.
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow 0;

> PC address (Jump)

If Overflow

PC address (HERE+2) **BNZ Branch if Not Zero**

Syntax: [label] BNZ n Operands: $-128 \le n \le 127$ Operation: if zero bit is '0' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0001 nnnn

If the Zero bit is '0', then the program Description:

will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNZ Jump

Before Instruction

PC address (HERE)

After Instruction

If Zero

PC address (Jump)

If Zero

PC address (HERE+2)

BRA	Unconditional Branch			
Syntax:	[label] B	BRA n		
Operands:	-1024 ≤ n	≤ 1023		
Operation:	$(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1101	0nnn	nnnn	nnnn
Description:	Add the 2's	s comple	ement nur	nber'2n'

Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is a two-

cycle instruction.

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

Example: HERE BRA Jump

Before Instruction

PC = address (HERE)

After Instruction

PC = address (Jump)

Syntax: [label] BSF f, b [,a]

Operands: $0 \le f \le 255$ $0 \le b \le 7$

a ∈ [0,1] 1 → f

Status Affected: None

Operation:

Encoding: 1000 bbba ffff ffff

Description: Bit 'b' in register 'f' is set. If 'a' is 0

Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR

value (default).

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: BSF FLAG_REG, 7

Before Instruction

FLAG_REG = 0Ah

After Instruction

FLAG_REG = 8Ah

BTFSC	Bit Test File, Skip if Clear				
Syntax:	[label] [BTFSC f	, b [,a]		
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$				
Operation:	skip if $(f < b >) = 0$				
Status Affected:	None				
Encoding:	1011	bbba	ffff	ffff	
Description:	If bit 'b' in register 'f' is 0, then the next instruction is skipped.				

If bit 'b' is 0, then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1 Cycles: 1(2)

Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
орегации	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE BTFSC FLAG, 1

FALSE : TRUE :

Before Instruction

PC = address (HERE)

After Instruction

If FLAG<1> = 0;

PC = address (TRUE)

If FLAG<1> = 1;

PC = address (FALSE)

BTFSS	Bit Test File,	Skip if Set
-------	----------------	-------------

Syntax: [label] BTFSS f, b [,a]

Operands: $0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$

Operation: $skip\ if\ (f < b >) = 1$

Status Affected: None

Encoding: 1010 bbba ffff ffff

Description: If bit 'b' in register 'f' is 1 then the next

instruction is skipped.

If bit 'b' is 1, then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR

value.

Words: 1

Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No operation	No operation	No operation	No operation

Example: HERE BTFSS FLAG, 1

FALSE : TRUE :

Before Instruction

PC = address (HERE)

After Instruction

If FLAG<1> = 0;

PC = address (FALSE)

If FLAG<1> = 1;

PC = address (TRUE)

BTG Bit Toggle f Syntax: [label] BTG f, b [,a] Operands: $0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$ $(\overline{f < b >}) \rightarrow f < b >$ Operation: Status Affected: None Encoding: 0111 bbba ffff ffff Description: Bit 'b' in data memory location 'f' is inverted. If 'a' is 0, the Access Bank will be selected, overriding the BSR

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

value. If 'a' is 1, the Bank will be

selected as per the BSR value.

Example: BTG PORTC, 4

Before Instruction:

PORTC = 0111 0101 [75h]

After Instruction:

PORTC = 0110 0101 [65h]

BOV	Branch if Overflow
Syntax:	[label] BOV n
Operands:	-128 ≤ n ≤ 127
Operation:	if overflow bit is '1' (PC) + 2 + $2n \rightarrow PC$
Status Affected:	None
Encoding:	1110 0100 nnnn nnnn
Description:	If the Overflow bit is '1', then the pro-

Description: If the Overflow bit is '1', then the program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BOV Jump

Before Instruction

PC = address (HERE)

After Instruction

If Overflow = 1;

PC = address (Jump)

If Overflow = 0;

PC = address (HERE+2)

BZ	Branch if Zero			
Syntax:	[label] E	3Z n		
Operands:	-128 ≤ n ≤	≤ 127		
Operation:	if Zero bit is '1' $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1110	0000	nnnn	nnnn
Description:	If the Zero bit is '1', then the program will branch.			

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be

PC+2+2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

_	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	No
		'n'	Data	operation

Example: HERE BZ Jump

Before Instruction

PC = address (HERE)

After Instruction

If Zero = 1;

PC = address (Jump)

If Zero = 0;

PC = address (HERE+2)

CALL Subroutine Call

Syntax: [label] CALL k[,s] Operands: $0 \le k \le 1048575$

 $s \in [0,1]$

Operation: (PC) + 4 \rightarrow TOS,

 $k \rightarrow PC {<} 20:1{>},$

if s = 1

 $(WREG) \rightarrow WS$,

 $(STATUS) \rightarrow STATUSS$,

 $(BSR) \rightarrow BSRS$

Status Affected: None

Encoding:

1st word (k<7:0>)
2nd word(k<19:8>)

1110	110s	k ₇ kkk	kkkk ₀
1111	k ₁₉ kkk	kkkk	kkkk ₈

Description: Subroutine call of entire 2M byte

memory range. First, return address (PC+ 4) is pushed onto the return stack. If 's' = 1, the WREG, STATUS and BSR registers are also pushed into their respective shadow registers, WS, STATUSS and BSRS. If 's' = 0, no update occurs

(default). Then the 20-bit value 'k' is loaded into PC<20:1>. CALL is a

two-cycle instruction.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>,	Push PC to stack	Read literal 'k'<19:8>, Write to PC
No	No	No	No
operation	operation	operation	operation

Example: HERE CALL THERE, FAST

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (THERE)
TOS = Address (HERE + 4)

WS = WREGREG BSRS = BSR STATUSS = STATUS

CLRF	Clear f
Syntax:	[label] CLRF f [,a]
Operands:	$0 \le f \le 255$ $a \in [0,1]$
Operation:	$\begin{array}{c} 000h \rightarrow f \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Encoding:	0110 101a ffff ffff
Description:	Clears the contents of the specified register. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be

selected as per the BSR value.

Words:
1
Cycles:
1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: CLRF FLAG_REG

Before Instruction

 $FLAG_REG = 5Ah$ Z = ?

After Instruction

 $FLAG_REG = 00h$ Z = 0 CLRWDT Clear Watchdog Timer

Syntax: [label] CLRWDT

Operands: None

Operation: $000h \rightarrow WDT$,

 $000h \rightarrow WDT$ postscaler,

 $\begin{array}{l} 1 \rightarrow \overline{TO}, \\ 1 \rightarrow \overline{PD} \end{array}$

Status Affected: TO, PD

Encoding: 0000 0000 0000 0100

Description: CLRWDT instruction resets the

Watchdog Timer. It also resets the postscaler of the WDT. Status bits

 $\overline{\mathsf{TO}}$ and $\overline{\mathsf{PD}}$ are set.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	Process	No
	operation	Data	operation

Example: CLRWDT

Before Instruction

WDT counter = ?
WDT postscaler = ?
TO = ?
PD = ?

After Instruction

 $\begin{array}{llll} \text{WDT counter} & = & \text{00h} \\ \underline{\text{WDT postscaler}} & = & 0 \\ \hline \overline{\text{TO}} & = & 1 \\ \hline \text{PD} & = & 1 \\ \end{array}$

CON	ИF	Complem	ent f		
Synt	tax:	[label] (COMF	f [,d [,a]]
Ope	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	5		
Ope	ration:	$(\overline{f}) \rightarrow de$	est		
Statu	us Affected:	N,Z			
Enco	oding:	0001	11da	ffff	ffff
Desc	cription:	The contents of register 'f' are complemented. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.			
Wor	ds:	1			
Cycl	es:	1			
Q C	ycle Activity:				
	Q1	Q2	Q3	3	Q4
	Decode	Read	Proce	ss \	Write to

Example:	COMF		REG
Before Instr	uctio	n	
REG	=	13h	
N	=	?	
Z	=	?	
After Instruc	ction		
REG	=	13h	
WREG	=	0ECh	

Ζ

register 'f'

Data

destination

CPFSEQ	Compare f with WREG, skip if f = WREG			
Syntax:	[label]	CPFSEC) f [,a]	
Operands:	$0 \le f \le 255$ $a \in [0,1]$			
Operation:	<pre>(f) - (WREG), skip if (f) = (WREG) (unsigned comparison)</pre>			
Status Affected:	None			
Encoding:	0110	001a	ffff	ffff
Description:	Compares the contents of data memory location 'f' to the contents of WREG by performing an unsigned subtraction. If 'f' = WREG, then the fetched instruction is discarded and a NOP is executed instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.			
Words:	1			
Cycles:	1(2) Note: 3 c	cycles if	skip and f	followed

Q1 Q2 Q3 Q4 Decode Read Process No register 'f' Data operation If skip: Q1 Q2 Q3 Q4 No No No operation operation operation operation

by a 2-word instruction.

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example:	HERE	CPFSEQ	REG
	NEQUAL	:	
	EQUAL	:	

Before Instruction

Q Cycle Activity:

PC Address = HERE WREG = ? REG = ? After Instruction

If REG = WREG;

PC = Address (EQUAL)

If REG \neq WREG;

PC = Address (NEQUAL)

CPFSGT Compare f with WREG,

skip if f > WREG

Syntax: [label] CPFSGT f [,a]

Operands: $0 \le f \le 255$ $a \in [0,1]$

Operation: (f) - (WREG),

skip if (f) > (WREG) (unsigned comparison)

Status Affected: None

Encoding: 0110 010a ffff ffff

Description: Compares the contents of data

memory location 'f' to the contents of the WREG by performing an

unsigned subtraction.

If the contents of 'f' are greater than the contents of , then the fetched instruction is discarded and a \mathtt{NOP} is executed instead, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR

value.

Words: 1

Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CPFSGT REG

NGREATER : GREATER :

Before Instruction

PC = Address (HERE)

WREG = ?

After Instruction

If REG > WREG;

PC = Address (GREATER)

If REG ≤ WREG:

PC = Address (NGREATER)

CPFSLT Compare f with WREG,

skip if f < WREG

Syntax: [label] CPFSLT f [,a]

Operands: $0 \le f \le 255$

a ∈ [0,1]

Operation: (f) - (WREG),

skip if (f) < (WREG)

(unsigned comparison)

Status Affected: None

Encoding: 0110 000a ffff ffff

Description: Compares the contents of data

memory location 'f' to the contents of WREG by performing an

unsigned subtraction.

If the contents of 'f' are less than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected. If 'a' is 1, the Bank will be selected as per

the BSR value.

Words: 1 Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CPFSLT REG

NLESS :

Before Instruction

PC = Address (HERE)

WREG = ?

After Instruction

If REG < WREG;

PC = Address (LESS)

If REG \geq WREG;

PC = Address (NLESS)

DAW	D	ecimal A	djust V	VREG	Re	gister
Syntax:	[/	abel] DA	١W			
Operands:	N	lone				
Operation:	(\ e	[WREG< WREG<3 Ise WREG<3	:0>) + 6	$i \rightarrow W$	/<3:0	
	(\ e	[WREG< WREG<7 Ise WREG<7	:4>) + 6	$S \to V$	/REC	- G<7:4>;
Status Affected	l: <u>C</u>	;				
Encoding:		0000	0000	000	0	0111
Description:		AW adjust VREG rest ddition of acked BC orrect pace	sulting for two var D forma	om thriable: at) and	ne ea s (ea d prod	rlier ch in
Words:	1					
Cycles:	1					
Q Cycle Activity	y:					
Q1	-	Q2	Q	3	(Q4
Decode		Read er WREG	Proce Data			rite REG
Example1:	D.	AW				
Before Ins						
WREG C	; = =	0A5h 0				
DC	=	0				
After Instru	uction					
WREG		05h				
C DC	=	1 0				
Example 2:		Ū				
Before Ins	tructio	n				
WREG		0CEh				
C DC	=	0 0				
After Instru		J				
WREG		34h				
С	=	1				
DC	=	0				

DEC	F	Decreme	nt f				
Synt	ax:	[label] [[label] DECF f [,d [,a]]				
Ope	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	• • •				
Ope	ration:	$(f)-1\to c$	dest				
Statu	us Affected:	C,DC,N,O	V,Z				
Enco	oding:	0000	01da	fff	f	ffff	
Des	cription:	Decrement result is stated the result is (default). I will be selected a selected a	ored in s stored f 'a' is 0, ected, o a' is 1, t	WRE back the A verrid he Ba	G. If in re locce ing ink	f 'd' is 1, egister 'f' ess Bank the BSR will be	
Wor	ds:	1					
Cycles:		1	1				
Q Cycle Activity:							
	Q1	Q2	Q	3		Q4	
	Decode	Read register 'f'	Proce Data			/rite to	

 $\begin{array}{llll} \underline{Example} \colon & \mathtt{DECF} & \mathtt{CNT} \\ & & \mathtt{Before\ Instruction} \\ & & \mathtt{CNT} & = & 01h \\ & & Z & = & 0 \\ & & \mathtt{After\ Instruction} \\ & & & \mathtt{CNT} & = & 00h \\ & & Z & = & 1 \\ & & & \end{array}$

DECFSZ	Decreme	nt f, skip if 0)	DCF	SNZ	Decreme	nt f, skip if r	ot 0
Syntax:	[label] [DECFSZ f[,	d [,a]]	Syn	tax:	[label] D	CFSNZ f[,c	l [,a]]
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	5		Ope	rands:	$0 \le f \le 258$ $d \in [0,1]$ $a \in [0,1]$	5	
Operation:	(f) $-1 \rightarrow 0$ skip if res			Ope	ration:	(f) $-1 \rightarrow 0$ skip if resu		
Status Affected	: None			Stat	us Affected:	None		
Encoding:	0010	11da fff	f ffff	Enc	oding:	0100	11da fff	f ffff
Description:	mented. If placed in \ is placed b If the resu	'd' is 0, the r WREG. If 'd' is back in registe It is 0, the nex	s 1, the result er 'f' (default). tt instruction,	Des	cription:	mented. If placed in \ is placed but If the resul	'd' is 0, the in WREG. If 'd' is pack in registe the sack in registe the transfer of the world in the interval in th	s 1, the result er 'f' (default). next instruc-
	carded, and instead, moderation instruction Bank will be able to the care of t	Iready fetchend a NOP is enaking it a two. If 'a' is 0, to be selected, one. If 'a' is 1, to do as per the	executed o-cycle he Access verriding the he Bank will			discarded instead, m instruction Bank will b BSR value	n is already for, and a NOP in aking it a two in lifa is 0, to see selected, on each of it is 1, to do as per the	s executed o-cycle he Access verriding the he Bank will
Words:	1			Wor	ds:	1		
Cycles:		ycles if skip a a 2-word inst		Сус	les:		cles if skip a 2-word inst	
Q Cycle Activity	/ :			QC	ycle Activity:			
Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination		Decode	Read register 'f'	Process Data	Write to destination
If skip:	1 20 212			If sk	ip:	1 3		
Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
No	No	No	No		No	No	No	No
operation If skip and follo	operation	operation	operation	lf ek	operation ip and follow	operation	operation	operation
Q1	Q2	Q3	Q4	11 31	Q1	Q2	Q3	Q4
No	No	No	No		No	No	No	No
operation	operation	operation	operation		operation	operation	operation	operation
No operation	No operation	No operation	No operation		No operation	No operation	No operation	No operation
Example:	HERE CONTINUE	DECFSZ GOTO	CNT	<u>Exa</u>	mple:	ZERO	DCFSNZ TEM :	1P
Before Ins		s (HERE)			Before Instru	uction =	?	
If CNT	= CNT - 1 = 0; C = Address ≠ 0;	s (CONTINUE))		After Instruc TEMP If TEMP PC If TEMP PC	tion = = = = = ≠ = = = = = = = = = = = = =	TEMP - 1, 0; Address (Z 0; Address (N	,

GOTO	Unconditional Branch			
Syntax:	[label]	GOTO	k	·
Operands:	$0 \le k \le 10$	048575		
Operation:	$k \rightarrow PC < 20:1 >$			
Status Affected:	None			
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111	1111 k ₁₉ kkk	k ₇ kkk kkkk	kkkk ₀ kkkk ₈
Description	пошо еПе			

Description: GOTO allows an unconditional

branch anywhere within entire 2M byte memory range. The 20-bit value 'k' is loaded into PC<20:1>. GOTO is always a two-cycle

instruction.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	No	Read literal
	'k'<7:0>,	operation	'k'<19:8>,
			Write to PC
No	No	No	No
operation	operation	operation	operation

Example: GOTO THERE

After Instruction

PC = Address (THERE)

INCF	Increme	nt f		
Syntax:	[label]	INCF f	[,d [,a]]	
Operands:	$0 \le f \le 25$ $d \in [0,1]$ $a \in [0,1]$	55		
Operation:	(f) + 1 \rightarrow	dest		
Status Affected:	C,DC,N,	OV,Z		
Encoding:	0010	10da	ffff	ffff
Description:	The contone mented. If in WREG are in the contone i	f'd'is 0, t i. If 'd' is ack in reg ne Acces overridir the Ban	he result 1, the res ister 'f' (de s Bank w ng the BS k will be s	is placed ult is efault). If ill be R value.
Words:	1			

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: INCF CNT

Before Instruction

CNT = 0FFh Z = 0 C = ? DC = ?

After Instruction

CNT = 00h Z = 1 C = 1 DC = 1

INCFSZ	Increment f, skip if 0			
Syntax:	[label]	INCFSZ	f [,d [,a]]
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	(f) + 1 \rightarrow dest, skip if result = 0			
Status Affected:	None			
Encoding:	0011	11da	ffff	ffff
Description:	The contents of register 'f' are incremented. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default).			

mented. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). If the result is 0, the next instruction, which is already fetched, is discarded, and a NOP is executed instead, making it a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1

Cycles: 1(2)

Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No No		No	No
operation	operation	operation	operation

Example: HERE INCFSZ CNT NZERO :

Before Instruction

PC = Address (HERE)

After Instruction

CNT = CNT + 1If CNT = 0;

PC = Address (ZERO)

If CNT \neq 0;

PC = Address (NZERO)

INFSNZ	Increment f, skip if not 0			
Syntax:	[<i>label</i>] INFSNZ f [,d [,a]]			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	(f) + 1 \rightarrow dest, skip if result \neq 0			
Status Affected:	None			
Encoding:	0100	10da	ffff	ffff

Description:

The contents of register 'f' are incremented. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default).

If the result is not 0, the next instruction, which is already fetched, is discarded, and a NOP is executed instead, making it a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank

will be selected as per the BSR value.

Words: 1 Cycles: 1(2)

Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
	register i	Data	acstination

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE INFSNZ REG ZERO

Before Instruction

PC = Address (HERE)

After Instruction

REG = REG + 1 If REG \neq 0;

PC = Address (NZERO)

If REG = 0;

PC = Address (ZERO)

IORLW	Inclusive OR	literal with WREG

Syntax: [label] IORLW k

Operands: $0 \le k \le 255$

Operation: (WREG) .OR. $k \rightarrow WREG$

Status Affected: N,Z

Encoding: 0000 1001 kkkk kkkk

Description: The contents of WREG are OR'ed

with the eight bit literal 'k'. The result

is placed in WREG.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	WREG

Example: IORLW 35h

Before Instruction

WREG = 9Ah N = ? Z = ?

After Instruction

 $\begin{array}{rcl} \mathsf{WREG} &=& \mathsf{OBFh} \\ \mathsf{N} &=& \mathsf{1} \\ \mathsf{Z} &=& \mathsf{0} \end{array}$

IORWF Inclusive OR WREG with f
Syntax: [label] IORWF f [,d [,a]]

 $\begin{array}{ll} \text{Operands:} & 0 \leq f \leq 255 \\ \text{d} \in [0,1] \\ \text{a} \in [0,1] \end{array}$

Operation: $(WREG) .OR. (f) \rightarrow dest$

Status Affected: N,Z

Encoding: 0001 00da ffff ffff

Description: Inclusive OR WREG with register 'f'. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default).

If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected

as per the BSR value.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: IORWF RESULT, W

Before Instruction

RESULT = 13h WREG = 91h N = ? Z = ?

After Instruction

RESULT = 13h WREG = 93h N = 1 Z = 0

Load FSR **LFSR** Syntax: [label] LFSR f,k Operands: $0 \le f \le 2$ $0 \le k \le 4095$ Operation: $k \to \mathsf{FSRf}$ Status Affected: None Encoding: 1110 1110 OOff k₁₁kkk 0000 1111 k₇kkk kkkk Description: The 12-bit literal 'k' is loaded into the file select register pointed to

by 'f'.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k' MSB	Process Data	Write literal'k'MSB to FSRfH
Decode	Read literal 'k' LSB	Process Data	Writeliteral'k' to FSRfL

Example: LFSR FSR2, 3ABh

After Instruction

FSR2H 03h FSR2L 0ABh

MOVF	Move f			
Syntax:	[label]	MOVF	f [,d [,a]]	
Operands:	$0 \le f \le 25$ $d \in [0,1]$ $a \in [0,1]$	5		
Operation:	$f \to \text{dest}$			
Status Affected:	N,Z			
Encoding:	0101	00da	ffff	ffff
Description:	The contents of register 'f' is moved to a destination dependent upon the status of 'd'. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). Location 'f' can be anywhere in the 256 byte Bank. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	WREG

Example: MOVF REG, W

Before Instruction

REG 22h WREG 0FFh Ν ? Ζ ?

After Instruction

REG 22h WREG 22h Ν 0 Ζ 0

MOVFF Move f to f

Syntax: [label] MOVFF f_s,f_d

Operands: $0 \le f_s \le 4095$ $0 \le f_d \le 4095$

Operation: $(f_s) \rightarrow f_d$

Status Affected: None

Encoding: 1st word (source) 2nd word (destin.)

1100 1111	ffff ffff	ffff ffff	ffff _s
1111	TTTT	TILL	rrrrd

Description:

The contents of source register ${}^tf_s{}^{\prime}$ are moved to destination register ${}^tf_d{}^{\prime}$. Location of source ${}^tf_s{}^{\prime}$ can be anywhere in the 4096 byte data space (000h to FFFh), and location of destination ${}^tf_d{}^{\prime}$ can also be anywhere from 000h to FFFh.

Either source or destination can be WREG (a useful special situation). MOVFF is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port).

The ${\tt MOVFF}$ instruction cannot use the PCL, TOSU, TOSH or TOSL as

the destination register.

Words: 2 Cycles: 2 (3)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f' (src)	Process Data	No operation
Decode	No operation No dummy read	No operation	Write register 'f' (dest)

Example: MOVFF REG1, REG2

Before Instruction

 $\begin{array}{rcl} \mathsf{REG1} & = & 33\mathsf{h} \\ \mathsf{REG2} & = & 11\mathsf{h} \end{array}$

After Instruction

 $\begin{array}{rcl} \mathsf{REG1} & = & 33\mathsf{h}, \\ \mathsf{REG2} & = & 33\mathsf{h} \end{array}$

MOVLB Move litera	l to	low	nibble in	BSR
-------------------	------	-----	-----------	-----

Syntax: [label] MOVLB k

Operands: $0 \le k \le 255$ Operation: $k \to BSR$ Status Affected: None

Encoding: 0000 0001 kkkk kkkk

Description: The 8-bit literal 'k' is loaded into

the Bank Select Register (BSR).

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write
	'k'	Data	literal 'k' to
			BSR

Example: MOVLB 05h

Before Instruction

BSR register = 02h

After Instruction

BSR register = 05h

MOVLW Move literal to WREG Syntax: [label] MOVLW k Operands: $0 \le k \le 255$ Operation: $k \to \mathsf{WREG}$ Status Affected: None Encoding: 0000 1110 kkkk kkkk Description: The eight bit literal 'k' is loaded into WREG. Words: 1

Words: 1
Cycles: 1
Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	WREG

Example: MOVLW 5Ah

After Instruction WREG = 0x5A

Syntax: [label] MOVWF f [,a] Operands: $0 \le f \le 255$ $a \in [0,1]$ Operation: (WREG) \rightarrow f Status Affected: None Encoding: 0110 111a ffff ffff Description: Move data from WREG to register 'f'. Location 'f' can be anywhere in the 256 byte Bank. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4

Move WREG to f

Example: MOVWF REG

Read

register 'f'

Process

Data

Write

register 'f'

Before Instruction

Decode

MOVWF

WREG = 4Fh REG = 0FFh

After Instruction

WREG = 4Fh REG = 4Fh

MULLW	Multiply Literal with WREG				
Syntax:	[label] MULLW k				
Operands:	$0 \le k \le 255$				
Operation:	(WREG) $x k \rightarrow PRODH:PRODL$				
Status Affected:	None				
Encoding:	0000 1101 kkkk kkkk				
Description:	An unsigned multiplication is carried out between the contents of WREG and the 8-bit literal 'k'. The 16-bit result is placed in PRODH:PRODL register pair. PRODH contains the high byte. WREG is unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q4
/rite isters ODH:

Example: MULLW C4h

Before Instruction

WREG 0E2h PRODH ? ? PRODL

After Instruction

WREG 0E2h = **PRODH** = 0ADh PRODL 08h

Syntax: $[label]$ MULWF $f[,a]$ Operands: $0 \le f \le 255$ $a \in [0,1]$ Operation: (WREG) x (f) → PRODH:PRODL Status Affected: None Encoding: 0000 $001a$ $fffff$ $fffff$ Description: An unsigned multiplication is carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the	MULWF	Multiply WREG with f					
$a \in [0,1]$ Operation: $(WREG) \times (f) \rightarrow PRODH:PRODL$ Status Affected: None $Encoding: $	Syntax:	[label] MULWF f [,a]					
Status Affected: None Encoding: 0000 001a fffff ffff Description: An unsigned multiplication is carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the	Operands:	* - : *					
Encoding: Description: An unsigned multiplication is carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the	Operation:	(WREG) $x (f) \rightarrow PRODH:PRODL$					
Description: An unsigned multiplication is carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the	Status Affected:	None					
carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the	Encoding:	0000 001a ffff ffff					
		carried out between the contents of WREG and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both WREG and 'f' are unchanged. None of the status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.					
Words: 1		•					

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	registers
			PRODH:
			PRODL

Example: MULWF REG

Before Instruction

WREG 0C4h REG 0B5h PRODH PRODL

After Instruction

WREG 0C4h REG 0B5h PRODH 8Ah PRODL 94h

NEGF Negate f Syntax: [label] NEGF f [,a] Operands: $0 \le f \le 255$ $a \in [0,1]$ $(\overline{f}) + 1 \rightarrow f$ Operation: N,OV, C, DC, Z Status Affected: Encoding: 0110 110a ffff ffff Description: Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'. If 'a' is

0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the

BSR value.

Words: 1 Cycles:

Q Cycle Activity:

	Q1	Q2	Q3	Q4
De	code	Read	Process	Write
		register 'f'	Data	register 'f'

Example: NEGF REG

Before Instruction

REG 0011 1010 [3Ah] = Ν =

? OV ? С DC ? Z

After Instruction

REG 1100 0110 [0C6h]

Ν OV 0 = 0 С = DC 0 = Ζ 0

NOP No Operation NOP Syntax: [label] Operands: None Operation: No operation Status Affected: None Encoding: 0000 0000 0000 0000 1111 xxxx xxxx xxxx No operation. Description: Words: 1 Cycles: Q Cycle Activity: Q1 Q2 Q3 Q4 Decode No No No

operation

operation

operation

Example:

None.

POP	Po	р Тор	of Retu	rn Sta	ack	
Syntax:	[<i>l</i> a	abel]	POP			
Operands:	No	one				
Operation:	(T	$(TOS) \rightarrow bit bucket$				
Status Affect	ed: No	None				
Encoding:		0000	0000	000	0.0	0110
Description:	ref TC ou ref Th the ref	The TOS value is pulled off the return stack and is discarded. The TOS value then becomes the previous value that was pushed onto the return stack. This instruction is provided to enable the user to properly manage the return stack to incorporate a software stack.				
Words:	1					
Cycles:	1					
Q Cycle Activ	vity:					
Q1		Q2	Q	3		Q4
Decod	-	No eration	Pop T valu		оре	No eration
Example:	PO GO	P TO	NEW			
Before Instruc TOS Stack (1 le		-		0031A 014332		

014332h

NEW

PUS	·⊔	Push Top	of Pot	urn St	ack	
Synt			PUSH	urii St	ack	_
•			-0311			
•	rands:	None				
•	ration:	(PC+2) →	IOS			
Stati	us Affected:	None				
Enco	oding:	0000	0000	000	0 0101	
Des	cription:	The PC+2 is pushed onto the top of the return stack. The previous TO value is pushed down on the stack. This instruction allows implementing a software stack by modifying TOS and then push it onto the return stack.				S k. ng
Wor	ds:	1				
Cycl	es:	1				
Q C	ycle Activity:					
	Q1	Q2	Q3	3	Q4	
	Decode	Push PC+2 onto return stack	No operat		No operation	
Exa	mple:	PUSH				
Before Instruction TOS PC		ıction	-	0345A 00124		
After Instruction PC TOS Stack (1 level down)		= 0	00126 000126 00345A	h		

After Instruction TOS

PC

RCALL Relative Call Syntax: [label] RCALL n Operands: $\textbf{-}1024 \leq n \leq 1023$ Operation: (PC) + $2 \rightarrow TOS$, $(PC) + 2 + 2n \rightarrow PC$ Status Affected: None Encoding: 1101 1nnn nnnn Description: Subroutine call with a jump up to 1K

Subroutine call with a jump up to 1K from the current location. First, return address (PC+2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is a two-cycle instruction.

Words: 1 Cycles: 2

Q Cycle Activity:

	Q1	Q2	Q3	Q4
	Decode	Read literal 'n'	Process Data	Write to PC
		Push PC to stack		
Ī	No	No	No	No
	operation	operation	operation	operation

Example: HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump)
TOS = Address (HERE+2)

RESET	Reset			
Syntax:	[label]	RESET		
Operands:	None			
Operation:	Reset all affected I			
Status Affected:	All			
Encoding:	0000	0000	1111	1111
Description:	This instr			-
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3	3	Q4

Example: RESET

Decode

After Instruction

Registers = Reset Value Flags* = Reset Value

Start

reset

No

operation

No

operation

RETFIE	Return from I	nterrupt	
Syntax:	[label] RET	FIE [s]	
Operands:	$s \in [0,1]$		
Operation:	if s = 1 (WS) \rightarrow WRE0 (STATUSS) \rightarrow (BSRS) \rightarrow BS	STATUS,	ged.
Status Affected:	None		
Encoding:	0000 000	00 0001 00	00s
Description:	Return from Interrupt. Stack is popped and Top-of-Stack (TOS) is loaded into the PC. Interrupts are		

loaded into the PC. Interrupts are enabled by setting the either the high or low priority global interrupt enable bit. If 's' = 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into their corresponding registers, WREG, STATUS and BSR. If 's' = 0, no update of these registers occurs (default).

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No operation	No operation	Pop PC from stack
	operation	operation	
			Set GIEH or
			GIEL
No	No	No	No
operation	operation	operation	operation

Example: RETFIE 1

After Interrupt

PC TOS WREG WS BSR **BSRS** STATUS **STATUSS**

GIE/GIEH, PEIE/GIEL

RETLW	Return L	iteral to	WREG	
Syntax:	[label]	RETLW	k	
Operands:	$0 \le k \le 25$	55		
Operation:	$k \rightarrow W$, (TOS) \rightarrow PC, PCLATU, PCLATH are unchanged			
Status Affected:	None			
Encoding:	0000	1100	kkkk	kkkk
Description:	W is load 'k'. The p from the t address). (PCLATH	rogram of top of the . The hig	counter is stack (the haddres	loaded ne return s latch
Words:	1			
Cycles:	2			
Q Cycle Activity:				

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Pop PC from stack, write to WREG
No operation	No operation	No operation	No operation

Example:

```
CALL TABLE ; WREG contains table
              ; offset value
              ; WREG now has
                 table value
TABLE
              ; WREG = offset
  ADDWF PCL
  RETLW k0
              ; Begin table
  RETLW k1
  RETLW kn
               ; End of table
```

Before Instruction WREG = 07h

After Instruction

WREG = value of kn

RETURN	Return from Subroutine			
Syntax:	[label] RETURN [s]			
Operands:	s ∈ [0,1]			
Operation:	$(TOS) \rightarrow PC$, if s = 1 $(WS) \rightarrow W$, $(STATUSS) \rightarrow STATUS$, $(BSRS) \rightarrow BSR$, $PCLATU$, $PCLATH$ are unchanged			
Status Affected:	None			
Encoding:	0000 0000 0001 001s			
Description:	Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. If 's' = 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into			

Words: 1 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	Process	Pop PC
	operation	Data	from stack
No	No	No	No
operation	operation	operation	operation

their corresponding registers, WREG, STATUS and BSR. If 's' = 0, no update of these registers occurs (default).

Example: RETURN

After Call

PC TOS

RETURN FAST

Before Instruction

WRG 04h = STATUS = 00h BSR 00h

After Instruction

WREG = 04h STATUS = 00h **BSR** 00h = PC TOS

RLCF	Rotate Lo	eft f thro	ough Car	ry	
Syntax:	[label]	RLCF	f [,d [,a]]		
Operands:	$0 \le f \le 25$ $d \in [0,1]$ $a \in [0,1]$	5			
Operation:	$(f) \rightarrow dest, (f<7>) \rightarrow C, (C) \rightarrow dest<0>$				
Status Affected:	C,N,Z				
Encoding:	0011	01da	ffff	ffff	
Description:	The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.				

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: RLCF REG, W

Before Instruction

REG 1110 0110 С 0 Ν ? Ζ ?

After Instruction

REG 1110 0110 WREG 1100 1100 С 1 Ν 1 Ζ 0

RLNCF	Rotate Left f (no carry)			
Syntax:	[label] RLNCF f [,d [,a]]			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	$(f) \rightarrow dest, (f<7>) \rightarrow dest<0>$			
Status Affected:	N,Z			
Encoding:	0100 01da ffff ffff			
Description:	The contents of register 'f' are rotated one bit to the left. If 'd' is 0 the result is placed in WREG. If 'd' is 1, the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.			

Words: 1 Cycles: 1

Q Cycle Activity:

 Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: RLNCF REG

Before Instruction

REG = 1010 1011 N = ? Z = ?

After Instruction

RRCF Rotate Right f through Carry

Syntax: [label] RRCF f [,d [,a]] Operands: $0 \le f \le 255$

 $d \in [0,1]$ $a \in [0,1]$

Operation: $(f<n>) \rightarrow dest<n-1>$,

 $(f<0>) \rightarrow C,$ (C) \rightarrow dest<7>

Status Affected: C,N,Z

Encoding: 0011 00da ffff ffff

Description: The contents of register 'f' are

rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected

as per the BSR value.



Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: RRCF REG, W

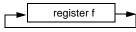
Before Instruction

After Instruction

REG = 1110 0110 WREG = 0111 0011 C = 0 N = 0 Z = 0

RRNCF	Rotate Right f (no carry)			
Syntax:	[label]	RRNCF	f [,d [,a]]
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	$(f) \rightarrow dest,$ $(f<0>) \rightarrow dest<7>$			
Status Affected:	N,Z			
Encoding:	0100	00da	ffff	ffff
Description:	The contents of register 'f' are rotated one bit to the right. If 'd' is 0,			

rotated one bit to the right. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.



Words: 1
Cycles: 1

Q Cycle Activity:

	Q1	Q2	Q3	Q4
ĺ	Decode	Read	Process	Write to
		register 'f'	Data	destination

Example 1: RRNCF REG

Before Instruction

REG = 1101 0111 N = ? Z = ?

After Instruction

REG = 1110 1011 N = 1 Z = 0

Example 2: RRNCF REG, 0, 0

Before Instruction

WREG = ? REG = 1101 0111 N = ? Z = ?

After Instruction

WREG = 1110 1011 REG = 1101 0111 N = 1 Z = 0

SETF	Set f			
Syntax:	[label] SETF f [,a]			
Operands:	$0 \le f \le 255$ $a \in [0,1]$			
Operation:	$FFh \to f$			
Status Affected:	None			
Encoding:	0110	100a	ffff	ffff
Description:	The conte		•	U

are set to FFh. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1 Cycles: 1

Q Cycle Activity:

_	Q1	Q2	Q3	Q4
	Decode	Read	Process	Write
		register 'f'	Data	register 'f'

Example: SETF REG

Before Instruction

REG = 5Ah

After Instruction

REG = 0FFh

SLEEP	Enter SLEEP mode				
Syntax:	[label] :	[label] SLEEP			
Operands:	None	None			
Operation:					
Status Affected:	Affected: TO, PD				
Encoding:	0000	0000	000	0.0	0011
Description:	The power-down status bit (PD) is cleared. The time-out status bit (TO) is set. Watchdog Timer and its postscaler are cleared. The processor is put into SLEEP mode with the oscillator stopped.			us bit ner and SLEEP	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3			Q4
Decode	No	Proce	ss	(Go to

Example: SLEEP

Before Instruction

 $\frac{\overline{\text{TO}}}{\overline{\text{PD}}} = ?$

After Instruction

 $\frac{\overline{TO}}{\overline{PD}} = 1 \uparrow 0$

† If WDT causes wake-up, this bit is cleared.

operation

Data

sleep

SUBFWB	Subtract	f from W	REG witl	n borrow
Syntax:	[label]	SUBFWE	3 f [,d [,a	a]]
Operands:	$0 \le f \le 25$ $d \in [0,1]$ $a \in [0,1]$	55		
Operation:	$(WREG) - (f) - (\overline{C}) \to dest$			
Status Affected:	N,OV, C, DC, Z			
Encoding:	0101	01da	ffff	ffff
Description:	Subtract register 'f' and carry flag (borrow) from WREG (2's complement method). If 'd' is 0, the result is stored in WREG. If 'd' is 1, the result is stored in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3	3	Q4

Read

register 'f'

Process

Data

Write to

destination

Decode

SUBFWB (Cont.) **SUBLW Subtract WREG from literal** Example 1: SUBFWB REG Syntax: [label] SUBLW k Before Instruction Operands: $0 \le k \le 255$ REG 3 Operation: $k - (WREG) \rightarrow WREG$ WREG 2 С 1 Status Affected: N,OV, C, DC, Z After Instruction Encoding: 0000 1000 kkkk kkkk 0FFh REG Description: WREG is subtracted from the eight WREG 2 = bit literal 'k'. The result is placed in С 0 = WREG. Z 0 = Ν ; result is negative Words: 1 Cycles: 1 Example 2: SUBFWB REG Q Cycle Activity: Before Instruction Q1 Q2 Q3 Q4 REG 2 Decode Read **Process** Write to WREG = 5 literal 'k' Data WREG С 1 After Instruction Example 1: SUBLW 02h REG Before Instruction WREG 3 WREG 1 С 1 С ? Ζ 0 Ν 0 ; result is positive After Instruction WREG Example 3: SUBFWB REG С ; result is positive Before Instruction Z 0 = REG = 0 Ν WREG = 2 С 0 Example 2: SUBLW 02h After Instruction Before Instruction REG 0 WREG = 2 WREG 2 = С С = Ζ 1 ; result is zero After Instruction Ν 0 WREG 0 С 1 ; result is zero Ζ 1 Ν 0 Example 3: SUBLW Before Instruction WREG C

After Instruction WREG =

С

Ζ

Ν

0FFh ; (2's complement)

; result is negative

0

0

= 1

SUB	WF	Subtract	Subtract WREG from f			
Syntax:		[label] S	[label] SUBWF f [,d [,a]]			
Operands:		$0 \le f \le 25$ $d \in [0,1]$ $a \in [0,1]$	- · -			
Ope	ration:	(f) - (WR	EG) \rightarrow 0	dest		
Statu	ıs Affected:	N,OV, C,	DC, Z			
Enco	oding:	0101 11da ffff ffff			ffff	
Description:		the result is 1, the re ister 'f' (d Access B	element r is store esult is s efault). ank will t BSR va be sele	method d in W tored b If 'a' is be sele lue. If	d). If 'd' is 0, /REG. If 'd' back in reg- s 0, the ected, over- 'a' is 1, the	
Words:		1				
Cycles:		1				
Q Cycle Activity:						
	Q1	Q2	Q3		Q4	
	Decode	Read	Proces	ss	Write to	

register 'f'

Data

destination

```
SUBWF (Cont.)
Example 1:
                   SUBWF
                            REG
    Before Instruction
        REG
        WREG
                     2
        С
    After Instruction
        REG
        WREG
        С
                         ; result is positive
        Ζ
                     0
        Ν
Example 2:
                   SUBWF
                             REG, W
    Before Instruction
        REG
                     2
        WREG
        С
    After Instruction
        REG
                     2
        WREG
        С
                         ; result is zero
        Ζ
        Ν
                     0
Example 3:
                   SUBWF
                             REG
    Before Instruction
        REG
        WREG
                     2
        С
    After Instruction
        REG
                     0FFh ;(2's complement)
        WREG
        С
                     0
                         ; result is negative
                 =
        Ζ
        Ν
```

SUB	WFB	Subtract Borrow	Subtract WREG from f with Borrow					
Synt	ax:	[label]	[label] SUBWFB f [,d [,a]]					
Ope	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$						
Ope	ration:	(f) - (WR	EG) – ($\overline{C}) \rightarrow d\epsilon$	est			
Statu	us Affected:	N,OV, C,	DC, Z					
Enco	oding:	0101	10da	ffff	ffff			
	cription:	(borrow) plement result is s the result 'f' (defaul Bank will	from reg method) stored in s is stored t). If 'a' be seled value. If	ister 'f' If 'd' is WREG back i is 0, the cted, ov 'a' is 1,	If 'd' is 1, n register Access verriding the Bank			
Wor	ds:	1	1					
Cycles:		1	1					
Q Cycle Activity:								
	Q1	Q2	Q3		Q4			
	Decode	Read register 'f'	Proces Data		Write to estination			

SUBWFB (Cont.)

Example 1:	S	UBWFB I	REG
Before Instru	uctio	n	
REG	=	19h	(0001 1001)
WREG C	=	0Dh 1	(0000 1101)
After Instruc	tion		
REG	=	0Ch	(0000 1011)
WREG C	=	0Dh 1	(0000 1101)
Z	=	0	
N	=	0	; result is positive
Example 2:		SUBWFB	REG, W
Before Instru	uctio		
REG	=	1Bh	(0001 1011)
WREG C	=	1Ah 0	(0001 1010)
After Instruc	tion		
REG	=	1Bh	(0001 1011)
WREG C	=	00h 1	
Z	=	1	; result is zero
N	=	0	•
Example 3:		SUBWFB	REG
Before Instru	uctio		
REG WREG	=		(0000 0011)
WREG C	=	0Eh 1	(0000 1101)
After Instruc	tion		
REG	=	0F5h	(1111 0100) [2's comp]
WREG C	=	0Eh 0	(0000 1101)
Z	=	0	
N	=	1	; result is negative

SWAPF Swap nibbles in f

Syntax: [label] SWAPF f [,d [,a]]

Operands: $0 \le f \le 255$ $d \in [0,1]$

 $d \in [0,1]$ $a \in [0,1]$

Operation: $(f<3:0>) \rightarrow dest<7:4>$,

 $(f<7:4>) \rightarrow dest<3:0>$

Status Affected: None

Encoding: 0011 10da ffff ffff

Description: The upper and lower nibbles of reg-

ister 'f' are exchanged. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: SWAPF REG

Before Instruction

REG = 53h

After Instruction

REG = 35h

01A358h

Syntax: [label] TBLRD (*; *+; *-; +*) Operands: None if TBLRD *, Operation: (Prog Mem (TBLPTR)) → TABLAT; TBLPTR - No Change; if TBLRD *+, $(Prog Mem (TBLPTR)) \rightarrow TABLAT;$ (TBLPTR) $+1 \rightarrow$ TBLPTR; if TBLRD *-, (Prog Mem (TBLPTR)) → TABLAT; (TBLPTR) -1 \rightarrow TBLPTR; if TBLRD +*, (TBLPTR) $+1 \rightarrow$ TBLPTR; (Prog Mem (TBLPTR)) → TABLAT;

Table Read

Status	Affected	: Non
Olalus	Allected	

TBLRD

0000	0000	0000	10nn
			nn=0 *
			=1 *+
			=2 *-
			=3 +*

Description:

This instruction is used to read the contents of Program Memory (P.M.). To address the program memory, a pointer called Table Pointer (TBLPTR) is used.

The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2 Mbyte address range.

TBLPTR[0] = 0: Least Significant

Byte of Program Memory Word

TBLPTR[0] = 1: Most Significant

Byte of Program Memory Word

The TBLRD instruction can modify the value of TBLPTR as follows:

no changepost-incrementpost-decrementpre-increment

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No operation	No operation	No operation
No operation	No operation (Read Program Memory)	No operation	No operation (Write TABLAT)

TBLRD (Cont.)

TBLPTR

IBLKD (Colit.)					
Example 1:	TBLRD	*+	;		
Before Instru	ction				
TABLAT			=	55h	
TBLPTR			=	00A356h	
MEMOR'	r(00A356h)	=	34h	
After Instruct	ion				
TABLAT			=	34h	
TBLPTR			=	00A357h	
Example 2:	TBLRD	+*	;		
Before Instru	ction				
TABLAT			=	0AAh	
TBLPTR			=	01A357h	
MEMOR'	Y(01A357h)	=	12h	
MEMOR'	r(01A358h)	=	34h	
After Instruction					
TABLAT			=	34h	

TBLWT Table Write

Syntax: [label] TBLWT (*; *+; *-; +*)

Operands: None
Operation: if TBLWT*,

(TABLAT) → Prog Mem (TBLPTR) or

Holding Register; TBLPTR - No Change;

if TBLWT*+,

(TABLAT) → Prog Mem (TBLPTR) or

Holding Register;

 $(TBLPTR) +1 \rightarrow TBLPTR;$

if TBLWT*-,

(TABLAT) → Prog Mem (TBLPTR) or

Holding Register;

(TBLPTR) $-1 \rightarrow$ TBLPTR;

if TBLWT+*,

(TBLPTR) $+1 \rightarrow$ TBLPTR;

 $(TABLAT) \rightarrow Prog Mem (TBLPTR)$ or

Holding Register;

Status Affected: None

Encoding:

0000	0000	0000	11nn
			nn=0 *
			=1 *+
			=2 *-
			=3 +*

Description:

This instruction is used to program the contents of Program Memory (P.M.).

The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2 MByte address range. The LSb of the TBLPTR selects which byte of the program memory location to access.

TBLPTR[0] = 0: Least Significant

Byte of Program Memory Word

TBLPTR[0] = 1:Most Significant Byte of Program Memory Word

The TBLWT instruction can modify the value of TBLPTR as follows:

• no change

post-increment

post-decrement

• pre-increment

Words: 1

Cycles: 2 (many if long write is to on-chip

EPROM program memory)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	No
	operation	operation	operation
No	No operation	No	No operation
operation	(Read	operation	(Write to Holding
	TABLAT)		Register or Memory)

TBLWT (Cont.)

Example 1:
TBLWT *+;

Before Instruction

TABLAT = 55h TBLPTR = 00A356h MEMORY(00A356h) = 0FFh

After Instructions (table write completion)

TABLAT = 55h TBLPTR = 00A357h MEMORY(00A356h) = 55h

Example 2:
TBLWT +*;

Before Instruction

TABLAT = 34h TBLPTR = 01389Ah MEMORY(01389Ah) = 0FFh MEMORY(01389Bh) = 0FFh

After Instruction (table write completion)

TABLAT = 34h TBLPTR = 01389Bh MEMORY(01389Ah) = 0FFh MEMORY(01389Bh) = 34h TSTFSZ Test f, skip if 0

Syntax: [label] TSTFSZ f [,a]

Operands: $0 \le f \le 255$ $a \in [0,1]$

Operation: skip if f = 0

Status Affected: None

Encoding: 0110 011a ffff ffff

Description: If 'f' = 0, the next instruction, fetched

during the current instruction execution, is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1 Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4		
No No		No	No		
operation	operation operation		operation		
No No		No	No		
operation operation		operation	operation		

Example: HERE TSTFSZ CNT

NZERO :

Before Instruction

PC = Address (HERE)

After Instruction

If CNT = 00h,

PC = Address (ZERO)

If CNT \neq 00h,

PC = Address (NZERO)

XORLW Exclusive OR literal with WREG

Syntax: [label] XORLW k

Operands: $0 \le k \le 255$

Operation: (WREG) .XOR. $k \rightarrow WREG$

Status Affected: N,Z

Encoding: 0000 1010 kkkk kkkk

Description: The contents of WREG are

XOR'ed with the 8-bit literal 'k'. The

result is placed in WREG.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4	
Decode	Read	Process	Write to	
	literal 'k'	Data	WREG	

Example: XORLW 0AFh

Before Instruction

WREG = 0B5h N = ? Z = ?

After Instruction

WREG = 1Ah N = 0 Z = 0

XORWF	Exclusive OR WREG with f
-------	--------------------------

Syntax: [label] XORWF f [,d [,a]]

Operands: $0 \le f \le 255$

 $d \in [0,1]$ $a \in [0,1]$

Operation: (WREG) .XOR. (f) \rightarrow dest

Status Affected: N,Z

Encoding: 0001 10da ffff ffff

Description: Exclusive OR the contents of WREG

with register 'f'. If 'a' is 0, the result is stored in WREG. If 'd' is 1, the result is stored back in the register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, the Bank will be selected as per the BSR value.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4		
Decode	Read	Process	Write to		
	register 'f'	Data	destination		

Example: XORWF REG

Before Instruction

REG = 0AFh WREG = 0B5h N = ? Z = ?

After Instruction

REG = 1Ah WREG = 0B5h N = 0 Z = 0

21.0 DEVELOPMENT SUPPORT

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- · Assemblers/Compilers/Linkers
 - MPASM™ Assembler
 - MPLAB C17 and MPLAB C18 C Compilers
 - MPLINKTM Object Linker/ MPLIBTM Object Librarian
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - ICEPIC™ In-Circuit Emulator
- · In-Circuit Debugger
 - MPLAB ICD for PIC16F87X
- · Device Programmers
 - PRO MATE® II Universal Device Programmer
 - PICSTART® Plus Entry-Level Development Programmer
- Low Cost Demonstration Boards
 - PICDEM™ 1 Demonstration Board
 - PICDEM 2 Demonstration Board
 - PICDEM 3 Demonstration Board
 - PICDEM 17 Demonstration Board
 - KEELOQ® Demonstration Board

21.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8-bit microcontroller market. The MPLAB IDE is a Windows®-based application that contains:

- · An interface to debugging tools
 - simulator
 - programmer (sold separately)
 - emulator (sold separately)
 - in-circuit debugger (sold separately)
- · A full-featured editor
- · A project manager
- · Customizable toolbar and key mapping
- · A status bar
- · On-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - source files
 - absolute listing file
 - machine code

The ability to use MPLAB IDE with multiple debugging tools allows users to easily switch from the cost-effective simulator to a full-featured emulator with minimal retraining.

21.2 MPASM Assembler

The MPASM assembler is a full-featured universal macro assembler for all PICmicro MCU's.

The MPASM assembler has a command line interface and a Windows shell. It can be used as a stand-alone application on a Windows 3.x or greater system, or it can be used through MPLAB IDE. The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, an absolute LST file that contains source lines and generated machine code, and a COD file for debugging.

The MPASM assembler features include:

- · Integration into MPLAB IDE projects.
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process.

21.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI 'C' compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers, respectively. These compilers provide powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compilers provide symbol information that is compatible with the MPLAB IDE memory display.

21.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for precompiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

21.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PICmicro series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multiproject software development tool.

21.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PICmicro microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PICmicro microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft® Windows environment were chosen to best make these features available to you, the end user.

21.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

21.8 MPLAB ICD In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD, is a powerful, low cost, run-time development tool. This tool is based on the FLASH PIC16F87X and can be used to develop for this and other PICmicro microcontrollers from the PIC16CXXX family. The MPLAB ICD utilizes the in-circuit debugging capability built into the PIC16F87X. This feature, along with Microchip's In-Circuit Serial Programming™ protocol, offers cost-effective in-circuit FLASH debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by watching variables, single-stepping and setting break points. Running at full speed enables testing hardware in real-time.

21.9 PRO MATE II Universal Device Programmer

The PRO MATE II universal device programmer is a full-featured programmer, capable of operating in stand-alone mode, as well as PC-hosted mode. The PRO MATE II device programmer is CE compliant.

The PRO MATE II device programmer has programmable VDD and VPP supplies, which allow it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for instructions and error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode, the PRO MATE II device programmer can read, verify, or program PICmicro devices. It can also set code protection in this mode.

21.10 PICSTART Plus Entry Level Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient.

The PICSTART Plus development programmer supports all PICmicro devices with up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

21.11 PICDEM 1 Low Cost PICmicro Demonstration Board

The PICDEM 1 demonstration board is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42. PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The user can program the sample microcontrollers provided with the PICDEM 1 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The user can also connect the PICDEM 1 demonstration board to the MPLAB ICE incircuit emulator and download the firmware to the emulator for testing. A prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs connected to PORTB.

21.12 PICDEM 2 Low Cost PIC16CXX Demonstration Board

The PICDEM 2 demonstration board is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 2 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a serial EEPROM to demonstrate usage of the I²C[™] bus and separate headers for connection to an LCD module and a keypad.

21.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

21.14 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

21.15 KEELOQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.

TABLE 21-1: DEVELOPMENT TOOLS FROM MICROCHIP

MCREXXX	
HC2XXX	
HCRXXX HCXXXX H	
C	
C	
HCSXXX	
HCRXXX	
C	
HC2XXX HC2XXX HC2XXX SQCXX SQCXX	
C	
HC2XXX HC2XXX SQCXX SQ	
HC2XXX HC2XXX 33CXX SQCXX SQ	
HC2XXX HC2XXX 33CXX 54CXX 54CXX	
HC2XXX	
	+
	`
WCF2510	_

Contact the Microchip Technology Inc. web site at www.microchip.com for information on how to use the MPLAB® ICD In-Circuit Debugger (DV164001) with PIC16C62, 63, 64, 65, 72, 73, 74, 76, 77. Contact Microchip Technology Inc. for availability date.

Development tool is available on select devices.

NOTES:

22.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings(†)

Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +13.25V
Voltage on RA4 with respect to Vss	0V to +8.5V
Total power dissipation (Note 1)	
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, Iik (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loκ (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by all ports (combined)	200 mA
Maximum current sourced by all ports (combined)	200 mA

- **Note 1:** Power dissipation is calculated as follows: Pdis = VDD x {IDD Σ IOH} + Σ {(VDD-VOH) x IOH} + Σ (VOI x IOL)
 - 2: Voltage spikes below Vss at the $\overline{\text{MCLR}/\text{VPP}}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{\text{MCLR}/\text{VPP}}$ pin, rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

FIGURE 22-1: PIC18C601/801 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

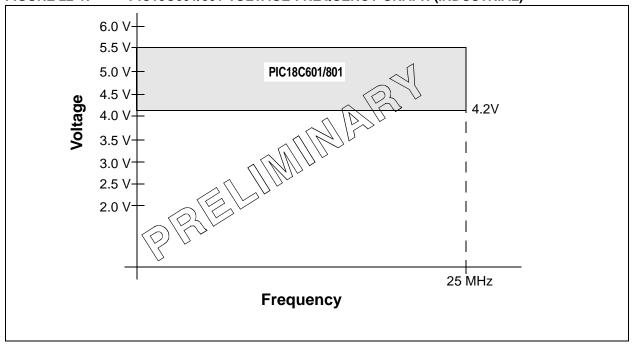
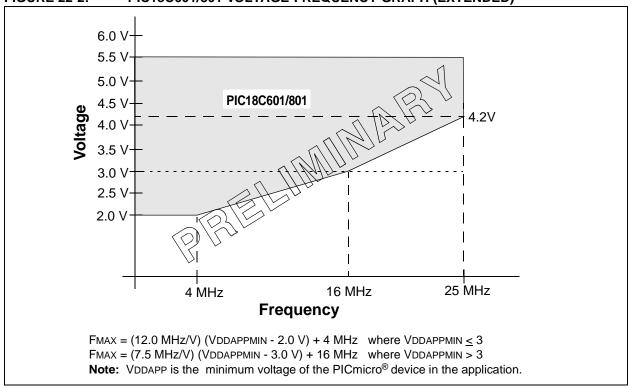


FIGURE 22-2: PIC18C601/801 VOLTAGE-FREQUENCY GRAPH (EXTENDED)



22.1 DC Characteristics

PIC18LC601/801 (Industrial)				Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
PIC18C601/801 (Industrial, Extended)				Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended				
Param Symbol Characteristic/ No. Device			Min	Тур	Max	Units	Conditions	
D001	VDD	Supply Voltage						
		PIC18LC601/801	2.0	_	5.5	V		
D001		PIC18C601/801	4.2	_	5.5	V		
D002	VDR	RAM Data Retention Voltage ⁽¹⁾	1.5		~	\ \\		
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	-		15		See section on Power-on Reset for details	
D004	SVDD	VDD Rise Rate to ensure internal Power- on Reset signal	0.05			V/ms	See section on Power-on Reset for details	

Legend: Rows with industrial-extended data are shaded for improved readability.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode, or during a device RESET, without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - SC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD
 - $\overline{MCLR} = VDD$; WDT enabled/disabled as specified.
- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or Vss, and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, ...).
- **4:** For RC osc option, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.

22.1 DC Characteristics (Continued)

PIC18LC601/801 (Industrial)				Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
PIC18C601 (Industrial	/801 I, Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic/ Device	Min	Тур	Max	Units	Conditions		
D010	IDD	Supply Current ^(2,4)							
		PIC18LC601/801		TBD	TBD	mA	RC osc option Fosc = 4 MHz, VDQ = 2.5V		
D010		PIC18C601/801	1	TBD	TBD	√mA	RC osc options Fpsc = 4 MHz, VDD = 4.2V		
D010A		PIC18LC601/801	1	TBD <	(TBD)	/ <u>F</u>	LP osc option FOSC = 32 kHz, VDD = 2.5V		
D010A		PIC18C601/801	>	TBP	TBD	μA	LP osc option Fosc = 32 kHz, VDD = 4.2V		
D010C		PIC18LC601/801		TBD	\\\ 45	mA	EC osc option, Fosc = 25 MHz, VDD = 5.5V		
D010C		PIC18@601/801			45	mA	EC osc option, Fosc = 25 MHz, VDD = 5.5V		
D013		PIC18LC601/801			TBD 50	mA mA	HS osc options FOSC = 6 MHz, VDD = 2.5V FOSC = 25 MHz, VDD = 5.5V HS + PLL osc option		
			_		50	mA	FOSC = 10 MHz, VDD = 5.5V		
D013 \		PIC18C601/801	_	_	50	mA	HS osc option Fosc = 25 MHz, VDD = 5.5V HS + PLL osc option		
	\triangleright		1	1	50	mA	Fosc = 10 MHz, VDD = 5.5V		
D014		PIC18LC601/801	_	_	48 TBD	μΑ μΑ	Timer1 osc option Fosc = 32 kHz, VDD = 2.5V Fosc = 32 kHz, VDD = 2.5V, 25°C		
D014		PIC18C601/801	_	_	TBD TBD	μΑ μΑ	OSCB osc option FOSC = 32 kHz, VDD = 4.2V FOSC = 32 kHz, VDD = 4.2V, 25°C		

Legend: Rows with industrial-extended data are shaded for improved readability.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode, or during a device RESET, without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD
 - MCLR = VDD; WDT enabled/disabled as specified.
- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or Vss, and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, ...).
- **4:** For RC osc option, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.

22.1 DC Characteristics (Continued)

PIC18LC601/801 (Industrial)				Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
PIC18C601 (Industrial	/801 I, Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic/ Device	Min	Тур	Max	Units	Conditions		
D020	IPD	Power-down Current ⁽³⁾)						
		PIC18LC601/801	_	TBD	5	μΑ	VDD = 2.5V, -46°C to +85°C		
			_	_	36	μĄ	VDD = 5.5V, -40°C to +85°C		
			—		TBD	μA	VDQ = 2,5¼, 25°C		
D020		PIC18C601/801	_	TBD	TBI	\ μA\	$V_{DD} = 4.2V, -40^{\circ}C \text{ to } +85^{\circ}C$		
			_	_ <	^36 \	μA	$\forall DD \cong 5.5V, -40^{\circ}C \text{ to } +85^{\circ}C$		
D020A			_		/TRB	2 μ/A L	VDD = 4.2V, 25°C		
D021B				/твр/	TBD	μA	VDD = 4.2V, -40°C to +125°C		
		/	<u> </u>	$^{\prime}$	42	·	$VDD = 5.5V, -40^{\circ}C \text{ to } +125^{\circ}C$		
D022	$\Delta IWDT$	Module Differential Cu	yrent //						
		PIC18LC801/601	17/	<u>1BD</u>	TBD	μΑ	VDD = 2.5V		
		Watchdog Timer	$\langle + \rangle$	6.5	12	μA	VDD = 3.0V		
			\rightarrow	_	TBD	μΑ	VDD = 5.5V		
	<		_	_	TBD	μΑ	VDD = 2.5V, 25°C		
D022		P1C18C601/801	_	_	TBD	μΑ	$VDD = 5.5V, -40^{\circ}C \text{ to } +85^{\circ}C$		
		Watchdog Timer	_	_	TBD	μΑ	$VDD = 5.5V, -40^{\circ}C \text{ to } +125^{\circ}C$		
			_	_	TBD	μΑ	VDD = 4.2V, 25°C		
D022B	\\\ \D\\\	> PIC18LC801/601	_	_	50	μΑ	VDD = 2.5V		
		Low Voltage Detect	_		TBD	μΑ	VDD = 2.5V, 25°C		
D022B		PIC18C601/801	_	_	TBD	μΑ	$VDD = 4.2V, -40^{\circ}C \text{ to } +85^{\circ}C$		
		Low Voltage Detect	_	_	TBD	μA	$VDD = 4.2V, -40^{\circ}C \text{ to } +125^{\circ}C$		
			_	_	TBD	μΑ	VDD = 4.2V, 25°C		
D025	Δ loscb	PIC18LC801/601	_	_	3	μA	VDD = 2.5V		
		Timer1 Oscillator	_		TBD	μΑ	VDD = 2.5V, 25°C		
D025		PIC18C601/801	_	_	TBD	μΑ	$VDD = 4.2V, -40^{\circ}C \text{ to } +85^{\circ}C$		
		Timer1 Oscillator	_	_	TBD	μΑ	VDD = 4.2V, -40°C to +125°C		
			_		TBD	μΑ	VDD = 4.2V, 25°C		

Legend: Rows with industrial-extended data are shaded for improved readability.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode, or during a device RESET, without losing RAM data

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD MCLR = VDD; WDT enabled/disabled as specified.

all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, ...).

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or Vss, and
- **4:** For RC osc option, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.

22.2 DC Characteristics: PIC18C801 (Industrial, Extended) PIC18LC601/801 (Industrial)

	ARACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended					
Param Symbol Characteristic/ No. Device		Min	Max	Units	Conditions			
	VIL	Input Low Voltage						
		I/O ports:						
D030		with TTL buffer	Vss	0.15VDD	V	VDD < 4.5V		
D030A			_	0.8	ν	4.5V ≤ VDQ ≤ 5.5V		
D031		with Schmitt Trigger buffer	Vss	0.2 VDD	1/2			
		RC3 and RC4	Vss	0.3VRD	/ <i>/></i>			
D032		MCLR	Vss	0.2 VDD	\ \\	$\langle \rangle$		
D032A		OSC1 (in XT, HS and LP modes) and T1OSI	Vss	03ADB /	V			
D033		OSC1(in RC mode) ⁽¹⁾	Wss \	0.5 KDD	V			
	VIH	Input High Voltage						
		I/O ports:	1/////					
D040		with TTL buffer	Q.25VDD + 0.8V	VDD	V	VDD < 4.5V		
D040A			2.0	VDD	V	$4.5V \le VDD \le 5.5V$		
D041		with Schmitt Trigger buffer	√ 0.8VDD	VDD	V			
		RC3 and RC4	0.7Vdd	VDD	V			
D042		MCLR	0.8VDD	VDD	V			
D042A		OSC1 (in HS and LP modes) and	0.7Vdd	VDD	V			
D043 <		OSC1 (RC mode) ⁽¹⁾	0.9Vpd	VDD	V			
	VHY'S	Hysteresis of Schmitt Trigger Ir	puts					
D050			TBD	TBD	V			
	IIL V	Input Leakage Current ^(2,3)						
D060		I/O ports	_	±1	μΑ	$Vss \le Vpin \le Vdd$,		
						Pin at hi-impedance		
D061		MCLR	_	±5	μΑ	$Vss \le VPIN \le VDD$		
D063		OSC1	_	±5	μΑ	$Vss \le VPIN \le VDD$		
	IPU	Weak Pull-up Current						
D070	IPURB	PORTB weak pull-up current	50	400	μΑ	VDD = 5V, VPIN = VSS		

Note 1: In RC oscillator option, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PICmicro device be driven with an external clock while in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

22.2 DC Characteristics: PIC18C801 (Industrial, Extended) PIC18LC601/801 (Industrial) (Continued)

	ARACTE		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended							
Param No.	Symbol	Characteristic/ Device	Min	Max	Units	Conditions				
	Vol	Output Low Voltage								
D080		I/O ports	_	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C				
D080A			_	0.6	W	$10L = 7.0 \text{ mA}, \text{ VDD} = 4.5V,}$ -40°C to 125 °C				
D083		OSC2/CLKO (RC mode)	_	0.6	X	$ OL = 1.6 \text{ mA}, VDD = 4.5V,} +40^{\circ}C \text{ to } +85^{\circ}C$				
D083A				0.6	V	IOL = 1.2 mA , VDD = 4.5V , -40°C to $+125^{\circ}\text{C}$				
D084		System Bus mode		TBD	V	IOL = 1.6 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$				
D084A				TBD	V	IOL = 1.2 mA , VDD = 4.5V , -40°C to $+125^{\circ}\text{C}$				
D085		Control Signals		TBD	V	IOL = 1.6 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$				
D085A				TBD	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C				
	VoH /	Output High Voltage ⁽³⁾								
D090		I/O ports	VDD - 0.7	_	V	IOH = -3.0 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$				
D090A			VDD - 0.7	_	V	IOH = -2.5 mA, VDD = 4.5 V, -40 °C to $+125$ °C				
D092\		OSC2/CLKO (RC mode)	VDD - 0.7	_	V	IOH = -1.3 mA, VDD = 4.5 V, -40 °C to $+85$ °C				
D092A			VDD - 0.7	_	V	IOH = -1.0 mA, VDD = 4.5V, -40°C to +125°C				
D093		System Bus mode	TBD	_	V	IOH = -1.3 mA, VDD = 4.5 V, -40 °C to $+85$ °C				
D093A			TBD	_	V	IOH = -1.0 mA, VDD = 4.5 V, -40 °C to $+125$ °C				
D094		Control Signals	TBD	_	V	IOH = -1.3 mA, VDD = 4.5 V, -40 °C to $+85$ °C				
D094A			TBD	_	V	IOH = -1.0 mA, VDD = 4.5V, -40°C to +125°C				
	Vod	Open-drain High Voltage	drain High Voltage							
D150			_	7.5	V	RA4 pin				
Capacitive Loading Specs on Output Pins										
D101	Cio	All I/O pins and OSC2 (in RC mode)	_	50	pF	To meet the AC Timing Specifications				
D102	Св	SCL, SDA	_	400	рF	In I ² C mode				
	l .	scillator option, the OSC1/CLKI pir	· 0 · · · · · · ·							

Note 1: In RC oscillator option, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PICmicro device be driven with an external clock while in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

FIGURE 22-3: LOW-VOLTAGE DETECT CHARACTERISTICS

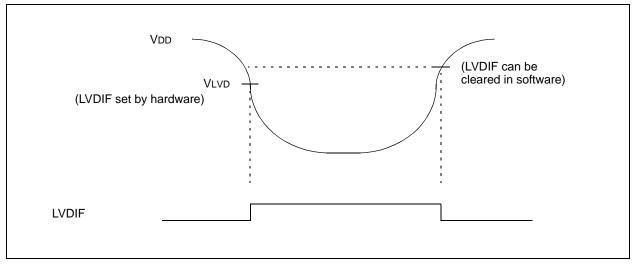


TABLE 22-1: LOW VOLTAGE DETECT CHARACTERISTICS

			VCC = 2.0V tc	5.5V					
			Commercial (Commercial (C): TAMB = 0°C to +70°C					
			Industrial (I):	TAM	в = -40°	C to +85	5°C		
Param No.	Characte	ristic	Symbol	Min	Тур†	Max	Units	Conditions	
D420	LVD Voltage on VDD	LVV = 0001	VLVD	2.0	2.06	2,12	\bigvee V		
	Transition High to	LVV = 0010		2.2	227	2:34>	V		
	Low	LVV = 0011		2,4	2.47	2.54	V		
		LVV = 0100		(Z.Z)	2,58	2.66	V		
		LVV = 0101	$\langle \rangle$	\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \	2.78	2.86	V		
		LVV = 0110	1/1/1/	\\2.8	2.89	2.98	V		
		LVV = 0111	U 110,	3.0	3.1	3.2	V		
		LVV = 1000		3.3	3.41	3.52	V		
		LVV = 1001)		3.5	3.61	3.72	V		
		LVV= 1010\		3.6	3.72	3.84	V		
		L\V ≠ 1041		3.8	3.92	4.04	V		
		LV 🕅 ≥ 1100		4.0	4.13	4.26	V		
		LVV = 1101			4.2	4.33	4.46	V	
		LVV = 1110		4.5	4.64	4.78	V		
D421	LVD Voltage Drift Tem Coefficient	perature	TCVout		15	50	ppm/°C		
D422	Bandgap Voltage Drift with respect to VDD Regulation		ΔVBG/ ΔVDD	_	_	50	μV/V		
D423	Bandgap Reference V	oltage Value	VBG	_	1.22		V		

Note: Production tested at TAMB = 25°C. Specifications over temperature limits guaranteed by characterization.

22.3 AC (Timing) Characteristics

22.3.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2pp	os	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercas	se letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data-in	t0	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercas	se letters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ²	² C specifications only)		
СС			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

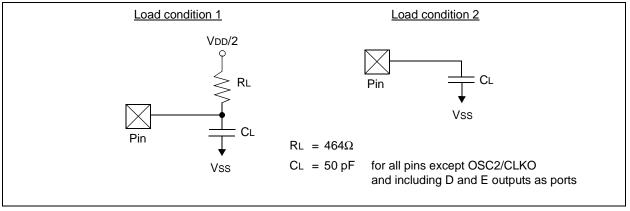
22.3.2 TIMING CONDITIONS

The temperature and voltages specified in Table 22-2 apply to all timing specifications, unless otherwise noted. Figure 22-4 specifies the load conditions for the timing specifications.

TABLE 22-2: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Standard Operating Conditions (unless otherwise stated)				
	Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
AC CHARACTERISTICS	-40°C ≤ TA ≤ +125°C for extended				
	Operating voltage VDD range as described in DC spec Section 22.1.				
	LC parts operate for industrial temperatures only.				

FIGURE 22-4: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



22.3.3 TIMING DIAGRAMS AND SPECIFICATIONS

FIGURE 22-5: EXTERNAL CLOCK TIMING

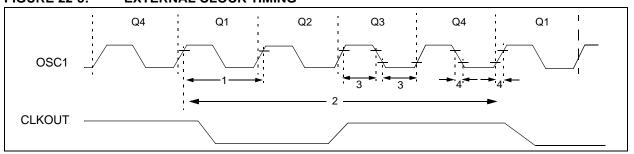


TABLE 22-3: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units
	Fosc	External CLKI Frequency	DC	_	4	MHz
		(Note 1)	DC	_	25	∕MHz
			4	_	6.25	MHz
			DC	_	25	MHz
			DC	_	200	k₩z
		Oscillator Frequency (Note 1)	DC	_	4) L MHz
			4		25	MHz
			4	1 +V	6.25	MHz
			5 <	$\langle + \rangle$	200 \	kHz
1	Tosc	External CLKI Period (Note 1)	250_\	$\langle \cdot \rangle + \langle \cdot \rangle$	\sim	ns
			√ ¥0 √	1/-	_	ns
			\\40\\\	<u></u>	_	ns
			\ \ 1\\ 60 \\ \	_	_	ns
			\\5\	_		μs
		Oscillator Period (Note 1)	250	_	_	ns
			40	_	100	ns
			160	_	100	ns
			5	_		μs
2	Tcy	Instruction Cycle Time (Note 1)	160	Tcy	DC	ns
3	Tost,	External Clock in (OSC1) High or	2.5	_	_	μs
	TosH	Low Time	10	_	_	ns
4	Tosk,	External Clock in (OSC1) Rise or	_	_	50	ns
	TosF	Fail Time	_	_	5	ns

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

TABLE 22-4: PLL CLOCK TIMING SPECIFICATION (VDD 7 4.2V - 5.5V)

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
7		PLL Start-up Time (Lock Time)		2	ms	
	ΔCLK	CLKOUT Stability (Jitter) Using PLL	-2	+2	%	

FIGURE 22-6: CLKOUT AND I/O TIMING

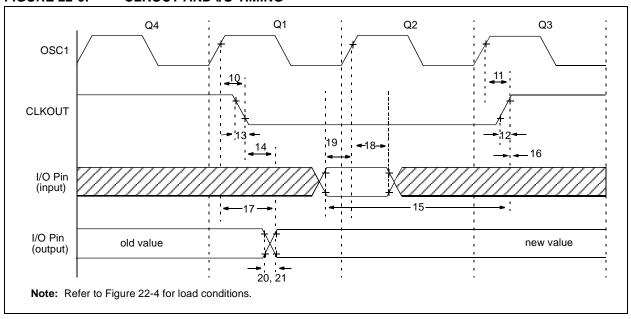
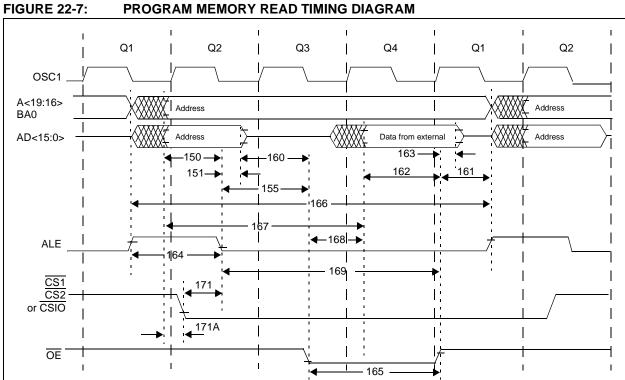


TABLE 22-5: CLKOUT AND I/O TIMING REQUIREMENTS

Param. No.	Symbol	Characte	eristic	Min	Тур	Max	Units	Conditions
10	TosH2ckL	OSC1 [↑] to CLKOUT√	,	_	75	200	ns	(1)
11	TosH2ckH	OSC1↑ to CLKOUT1	_	75	200	ns	(1)	
12	TckR	CLKOUT rise time		_	3 5	100	ns	(1)
13	TckF	CLKOUT fall time		_ \	135	100	ns	(1)
14	TckL2ioV	CLKOUT ↓ to Port or	ut valid	\leftarrow	12	0.5Tcy + 20	ns	(1)
15	TioV2ckH	Port in valid before C	0.25Tey + 25	1	_	ns	(1)	
16	TckH2ioI	Port in hold after CLI	KOUT↑		_	_	ns	(1)
17	TosH2ioV	OSC1↑ (Q1 cycle) to	Port out valid		50	150	ns	
18	TosH2iol		PIC18C601/801	100	_	_	ns	
18A		to Port input invalid (I/O in hold time)	PIC18LC604/801	200	_	_	ns	
19	TioV2osH	Port input valid to OS (I/O in setup time)	sch	0	_	_	ns	
20	TioR	Port output rise	PIC18C601/801	_	10	25	ns	
20A		time	PIC18 LC 601/801	_	_	60	ns	
21	TioF	Port output fall time	PIC18C601/801	_	10	25	ns	
21A /		\searrow	PIC18 LC 601/801	_	_	60	ns	
22†\$	T/N/P	INT pin high or low time		Tcy	_	_	ns	
23††	T RBP	RB7:RB4 change IN	T high or low time	Tcy	_	_	ns	

^{††} Thèse parameters are asynchronous events, not related to any internal clock edges.

Note 1: Measurements are taken in RC mode, where CLKO pin output is 4 x Tosc.



PROGRAM MEMORY READ TIMING DIAGRAM

Operating Conditions: 2.0V <Vcc <5.5V, -40°C <TA <125°C, unless otherwise stated.

TABLE 22-6: CLKOUT AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Characteristics	Min	Тур	Max	Units
150	TadV2alL	Address out valid to ALE↓ (address setup time)	0.25Tcy-10	_	_	ns
151	TalL2adl	ALE↓ to address out invalid (address hold time)	5	_	_	ns
155	TalL2oeL	ALE ↓ to OE ↓	C (SPD)	0.125TcY	_	ns
160	TadZ2oeL	AD high-Z to OE ↓ (bus release to OE)	D 29	_	_	ns
161	ToeH2adD	OE ↑ to AD driven	0.125Tcy-5	_	_	ns
162	TadV2oeH	LS data valid before OE ↑ (data setup time)	20	_	_	ns
163	ToeH2adl	OE ↑ to data in invalid (data hold time)	0	_	_	ns
164	TalH2alL	ALE pulse width	_	Tcy	_	ns
165	ToeL2oeH	OE pulse width	0.5Tcy-5	0.5TcY	_	ns
166	TalH2alH	ALE↑ to ALE↑ (cycle time)	_	0.25TcY	_	ns
167	Tacc	Address valid to data valid	0.75Tcy-25	_	_	ns
168	Toe	OE ↓ to data valid		_	0.5Tcy-25	ns
169	TalL2oeH	ALE ↓ to OE ↑	0.625TcY-10	_	0.625Tcy+10	ns
171	TalH2csL	Chip select active to ALE ↓	0.25Tcy-20	_	_	ns
171A	TubL2oeH	AD valid to chip select active		_	10	ns

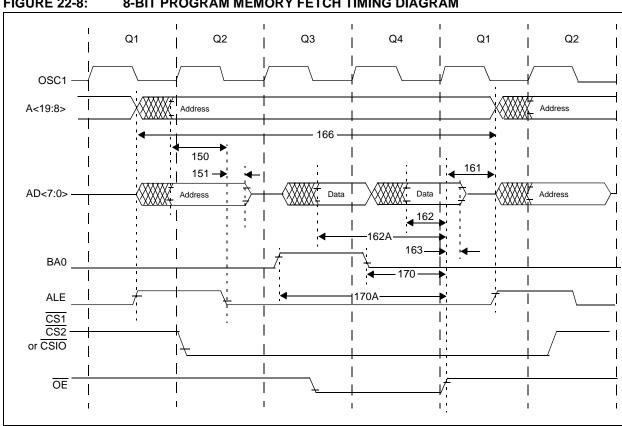
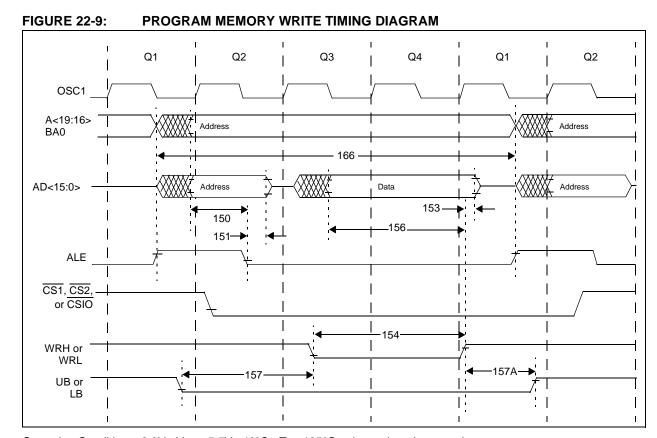


FIGURE 22-8: 8-BIT PROGRAM MEMORY FETCH TIMING DIAGRAM

Operating Conditions: 2.0V <Vcc <5.5V, -40°C <TA <125°C, Fosc max = 25MHz, unless otherwise stated.

TABLE 22-7: 8-BIT PROGRAM MEMORY FETCH TIMING REQUIREMENTS

Param No.	Symbol	Characteristics	Min	Тур	Max	Units
150	TadV2alL	Address out valid to ALE↓ (address setup time)	0.25Tcy-10	7	_	ns
151	TalL2adl	ALE↓ to address out invalid (address hold time)	5	_	_	ns
161	ToeH2adD	OE ↑ to AD driven	0.125Tcy-5	_	_	ns
162	TadV2oeH	LS data valid before OE ↑ (data setup time)	20	_	_	ns
162A	TadV2oeH	MS data valid before OE ↑ (data setup time)	0.25Tcy+20	_	_	ns
163	ToeH2adl	OE ↑ to data in invalid (data hold time)	0	_	_	ns
166	TalH2alH	ALET to ALET (cycle time)	_	0.25Tcy	_	ns
170	TubH2oeH	BAO = 0 valid before OE 1	0.25Tcy-10	_	_	ns
170A	TubL2oeH	BA0 = 1 valid before OE ↑	0.5TcY-10	_	_	ns



Operating Conditions: 2.0V <Vcc <5.5V, -40°C <TA <125°C unless otherwise stated.

TABLE 22-8: PROGRAM MEMORY WRITE TIMING REQUIREMENTS

Param No.	Symbol	Characteristics	Min	Тур	Max	Units
150	TadV2alL	Address out valid to ALE↓ (address setup time)	0.25Tcy-10	_	_	ns
151	TalL2adl	ALE↓ to address out invalid (address hold time)	5	_	_	ns
153	TwrH2adl	WRn ↑ to data out invalid (data hold time)	5	_	_	ns
154	TwrL	WRn pulse width	0.5Tcy-5	0.5TcY	_	ns
156	TadV2wrH	Data valid before WRn (Lodata setup time)	0.5Tcy-10	_	_	ns
157	TbsV2wrL	Byte select valid before WRn ↓ (byte select setup time)	0.25TcY	_	_	ns
157A	TwrH2bsI	WRn ↑ to byte select invalid (byte select hold time)	0.125Tcy-5	_	_	ns
166	TalH2alH	ALE↑ to ALE↑ (cycle time)	_	0.25TcY	_	ns
36	TIVRST	Time for Internal Reference Voltage to become stable	_	20	50	μs

FIGURE 22-10: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

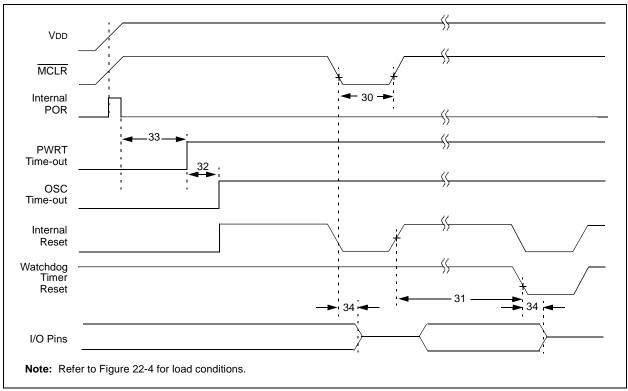


TABLE 22-9: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	18	177	_	μs	
31	TWDT	Watchdog Timer Time-out Period (No Prescaler)	Wilden.	18	33	ms	
32	Tost	Oscillation Start-up Timer Period	_	_	1024Tosc	l	Tosc = OSC1 period
33	TPWRT	Power up Timer Period	28	72	132	ms	
34	Tioz	I/O Hi-Impedance from MCLR Low or Watchdog Timer Reset	_	2	_	μs	

T0CKI T10S0/T1CKI TMR0 or TMR1 Note: Refer to Figure 22-4 for load conditions.

TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS **FIGURE 22-11:**

TABLE 22-10: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Symbol		Characteri	stic	Min	Max	Units	Conditions
40	Tt0H	T0CKI F	ligh Pulse Width	No Prescaler	0.5Tcy + 20		ns	
				With Prescaler	10	_	ns	
41	Tt0L	T0CKI Low Pulse Width		No Prescaler	0.5Tcy + 20	1	ns	
				With Prescaler	10 —		ns	
42	Tt0P	TOCKI F	Period	No Prescaler	Tcy + 10	_/ \	ns	
				With Prescaler	Greater of: 20 ns or Tcy + 40 N		ns	W≧ prescale value (1, 2, 4,, 256)
45	Tt1H	T1CKI	Synchronous, no	o prescaler	0.5Tey + 20	\	ns	
		High	Synchronous,	PIC18C601/801	/ / te / /		ns	
		Time	with prescaler	PIC18 LC 601/801	\ \ \ 25 ~		ns	
			Asynchronous	PIC18C601/801	\ \ 30	_	ns	
			<	PIC18LC601/801	50	_	ns	
46	Tt1L	T1CKI	Synchronous, no	o prescaler	0.5Tcy + 5	_	ns	
		Low	Synchronous,	PIC18C601/801	10	_	ns	
		Time	with prescaler	PIC18LC601/801	25	_	ns	
			Asynchronous	PIC18C601/801	30	_	ns	
				PIC18 LC 601/801	TBD	TBD	ns	
47	Tt1P	T1CKI input period	Synchronous		Greater of: 20 ns or <u>Tcy + 40</u> N	_	ns	N = prescale value (1, 2, 4, 8)
		\bigvee	Asynchronous		60		ns	
	\Ft ¹ \	T1CKI o	oscillator input frequency range		DC	50	kHz	
48	Toke2tmrl	Delay fro	om external T1Ch crement	KI clock edge to	2Tosc	7Tosc	_	

FIGURE 22-12: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

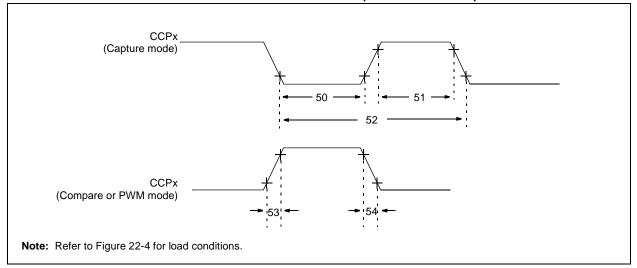


TABLE 22-11: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Param. No.	Symbol	(Characteristic		Min	Max	Units	Conditions
50	TccL	CCPx input low No Prescale		er	0.5Tcy + 20	_	ns	
		time With Prescale	With	PIC18 C 601/801	(10)	· —	ns	
			Prescaler	PIC18 LC 601/801	20	_	ns	
51	1 TccH CCPxinputhig		No Prescal	er (0.5Tcy + 20	_	ns	
		time	With	PIC18 C 601/801	10	_	ns	
			Prescaler	P(C18LC601/801	20	_	ns	
52	TccP	CCPx input perio	od \	1 1	3Tcy + 40	_	ns	N = prescale
		_ ()			N			value (1, 4 or 16)
53	TccR	CCPx output fat	time	PIC18 C 601/801		25	ns	
				PIC18 LC 601/801		45	ns	
54	TccF	CCPx output fall	time	PIC18 C 601/801		25	ns	
		·		PIC18 LC 601/801		45	ns	

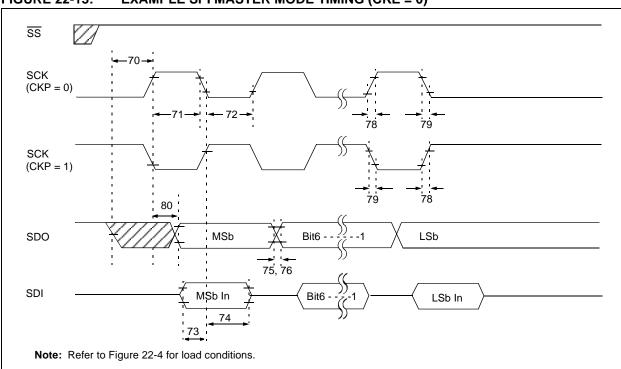


FIGURE 22-13: EXAMPLE SPI MASTER MODE TIMING (CKE = 0)

TABLE 22-12: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param. No.	Symbol	Characterist	tic	Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy		ns		
71	TscH	SCK input high time	1.25Tcy + 30		ns	\triangleright	
71A		(Slave mode)	Single Byte	40	7	ns	(Note 1)
72	TscL	SCK input low time	Continuous	1.25TcV + 30	$\sqrt{}$	ns	
72A		(Slave mode)	Single Byte	40	\searrow	ns	(Note 1)
73	TdiV2scH, TdiV2scL	Setup time of SDI data input t	100	_	ns		
73A	Тв2в	Last clock edge of Byte1 to the Byte2	√1.5Tcy + 40	_	ns	(Note 2)	
74	TscH2diL, TscL2diL	Hold time of SDI data input to	SCK edge	100	_	ns	
75	TdoR	SDO data output rise time	PIC18 C 601/801	_	25	ns	
			PIC18 LC 601/801	_	45	ns	
76	TdoF	SDO data output fall time		_	25	ns	
78	TseR	SCK output rise time	PIC18 C 601/801	_	25	ns	
<		(Master mode)	PIC18 LC 601/801		45	ns	
79	TŞCF	SCK output fall time (Master i	_	25	ns		
80	TscH2doV,	SDO data output valid after	PIC18 C 601/801		50	ns	
	TscL2doV	SCK edge	PIC18 LC 601/801	_	100	ns	

Note 1: Requires the use of parameter # 73A.

^{2:} Only if parameter #s 71A and 72A are used.

SS SCK (CKP = 0)SCK (CKP = 1)80 MSb LSb SDO 75, 76 SDI MSb In Bit6 LSb In 74 Note: Refer to Figure 22-4 for load conditions.

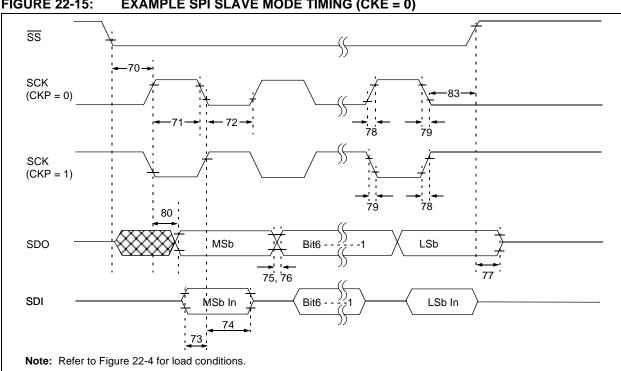
FIGURE 22-14: EXAMPLE SPI MASTER MODE TIMING (CKE = 1)

TABLE 22-13: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
71	TscH	SCK input high time	Continuous	1.25Tcy + 30	_	<ns \<="" td=""><td></td></ns>	
71A		(Slave mode)	Single Byte	40		ns	(Note 1)
72	TscL	SCK input low time	Continuous	1.25Tcy + 30		ns	
72A		(Slave mode)	Single Byte	40^	$\rangle $	ns	(Note 1)
73	TdiV2scH, TdiV2scL	Setup time of SDI data input	100	4	ns		
73A	Тв2в	Last clock edge of Byte1 to to f Byte2	1.5Tcy + 40		ns	(Note 2)	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100		ns	
75	TdoR	SDO data output rise time PIC 18 0 60 1/801		_	25	ns	
			RIC18 LC 601/801	_	45	ns	
76	TdoF	SDO data output fall time		_	25	ns	
78	TscR	SCK output rise time	PC18 C 601/801	_	25	ns	
		(Master mode)	PIC18 LC 601/801	_	45	ns	
79	TscF	SCK output fall time (Master mode)		_	25	ns	
80	TscH2doV,	SDO data output valid after	PIC18 C 601/801		50	ns	
	TscL2doV	SCK edge>	PIC18 LC 601/801	_	100	ns	
81	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge		Tcy		ns	

Note 1: Requires the use of parameter # 73A.

2: Only if parameter #s 71A and 72A are used.



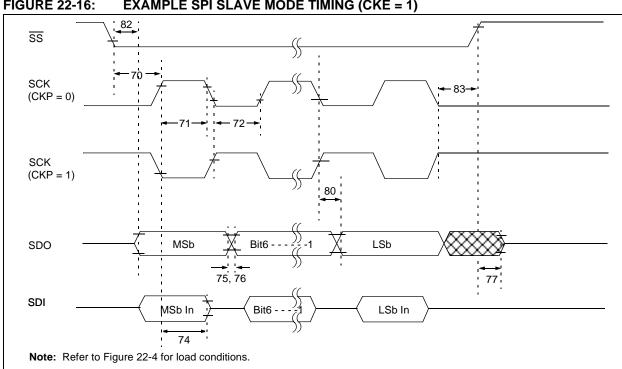
EXAMPLE SPI SLAVE MODE TIMING (CKE = 0) FIGURE 22-15:

TABLE 22-14: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING (CKE = 0))

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions	
70	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	ı	ns		
71	TscH	SCK input high time	Continuous	1.25Tcy + 30		ns	1
71A		(Slave mode)	Single Byte	40 '	$\langle \leftarrow \rangle$) ns	(Note 1)
72	TscL	SCK input low time	Continuous	1.25TçY+ 30	\bigvee	ns	\checkmark
72A		(Slave mode)	Single Byte	40	(A)	ns	(Note 1)
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to S	100	>	ns		
73A	Тв2в	Last clock edge of Byte1 to the 1st	1.5TcY+40	_	ns	(Note 2)	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SC	100	_	ns		
75	TdoR	SDO data output rise time PIC18C601/801		_	25	ns	
			RIC18LC601/801		45	ns	
76	TdoF	SDO data output fall time		_	25	ns	
77	TssH2doZ	SST to SDO output hi-impedance	\$	10	50	ns	
78	TscR	SCK output rise time	PIC18 C 601/801	_	25	ns	
		(Master mode) PIC18LC601/80			45	ns	
79	TseF	SCK output fall time (Master mod	_	25	ns		
80	Ts€H2doV,	SDO data output valid after SCK	PIC18 C 601/801	_	50	ns	
	TscL2doV	egge		100	ns		
83	TscH2ssH, TscL2ssH	SS ↑ after SCK edge	1.5Tcy + 40		ns		

Note 1: Requires the use of parameter # 73A.

^{2:} Only if parameter #s 71A and 72A are used.



EXAMPLE SPI SLAVE MODE TIMING (CKE = 1) FIGURE 22-16:

TABLE 22-15: EXAMPLE SPI SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions		
70	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input		Tcy	_	ns		
71	TscH	SCK input high time	Continuous	1.25Tcy + 30	_	ns		
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)	
72	TscL	SCK input low time	Continuous	1.25Tcy + 30	_	ns		
72A		(Slave mode)	Single Byte	₁ 40	— ns (Note 1)		(Note 1)	
73A	Тв2в	Last clock edge of Byte1 to the 1st cl	ock edge of Byte2	₹5Tc Y + 40	_	ns	(Note 2)	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK	\$00	_	ns			
75	TdoR	SDO data output rise time	PIC18C601/801	_	25	ns		
			PIC18LC601/801	_	45	ns		
76	TdoF	SDO data output fall time	11/1/11	_	25	ns		
77	TssH2doZ	SS↑ to SDO output hi-impedance		10	50	ns		
78	TscR	SCK output rise time	PIC18 C 601/801	_	25	ns		
		(Master mode)	PIC18 LC 601/801	_	45	ns		
79	TscF	SCK output fall time (Master mode)		_	25	ns		
80	TscH2doV,	SDO data output valid after SCK	PIC18 C 601/801	_	50	ns		
	TscL2doV	edge	PIC18 LC 601/801	_	100	ns		
82	TssL2doV	SDO data output valid after SS↓	PIC18 C 601/801	_	50	ns		
		edge	PIC18 LC 601/901	_	100	ns		
83	TscH2ssH, TscL2ssH	SS ↑ after SCK edge		1.5Tcy + 40	_	ns		

Note 1: Requires the use of parameter # 73A.

2: Only if parameter #s 71A and 72A are used.

FIGURE 22-17: I²C BUS START/STOP BITS TIMING

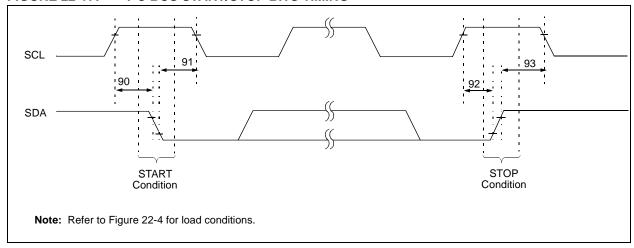


TABLE 22-16: I²C BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	START condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup time	400 kHz mode	600	—		START condition
91	THD:STA	START condition	100 kHz mode	³ 4000	_	ns	After this period, the first
		Hold time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	STOP condition	100 kHz mode	4700	_	ns	
		Setup time	400 kHz mode	600	_		
93	THD:STO	STOP condition	100 kHz mode	4000	_	ns	
		Hold time	400 kHz mode	600	_		



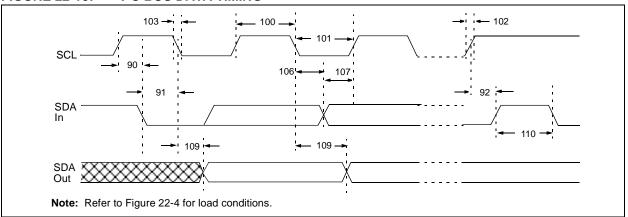


TABLE 22-17: I²C BUS DATA REQUIREMENTS (SLAVE MODE)

Param No.	Symbol	Characte	eristic	Min	Max	Units	Conditions
100	THIGH	Clock high time	100 kHz mode	4.0	_	μs	PIC18C601/801 must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μs	PIC18C601/801 must operate at a minimum of 10 MHz
			SSP Module	1.5TcY	_		
101	TLOW	Clock low time	100 kHz mode	4.7	_	μs	PIC18C601/801 must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	_	μs	PIC18C601/801 must operate at a minimum of 10 MHz
			SSP module	1.5TcY	_	ns \	
102	TR	SDA and SCL rise	100 kHz mode		1000 (ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10 to 400 pF
103	TF	SDA and SCL fall time	100 kHz mode		300	\ ns	
			400 kHz mode	20 + 0.10b	300	hs	Cb is specified to be from 10 to 400 pF
90	TSU:STA	START condition	100 kHz mode	\ \ 4.₹ \ \	$\langle \rangle$	μs	Only relevant for Repeated
		setup time	400 kHz mode	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		μs	START condition
91	THD:STA	START condition hold	100 kHz mode	1 \ 4.0	_	μs	After this period the first clock
		time	400 kHz/mode	0.6	_	μs	pulse is generated
106	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
	_	- ()	400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	(Note 2)
	_ <		400 kHz mode	100	_	ns	
92	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μs	
100		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	400 kHz mode	0.6	_	μs	(National)
109	TAA	Output valid from	100 kHz mode 400 kHz mode	_	3500	ns	(Note 1)
110	TBUF	Bus free time	100 kHz mode	4.7	_	ns	Time the bus must be free
110	IRAL	Dus free liffle	400 kHz mode	1.3	_	μs μs	before a new transmission can start
D102	Cb	Bus capacitive loading		_	400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast mode I²C bus device can be used in a standard mode I²C bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line. Before the SCL line is released, TR max. + tsu;DAT = 1000 + 250 = 1250 ns (according to the standard mode I²C bus specification).

FIGURE 22-19: MASTER SSP I²C BUS START/STOP BITS TIMING WAVEFORMS

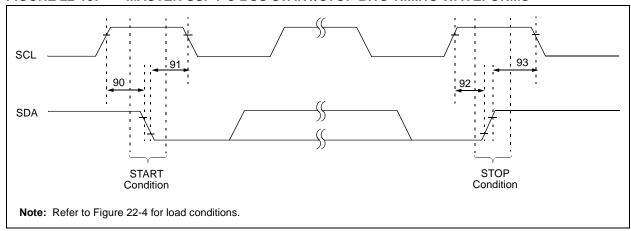


TABLE 22-18: MASTER SSP I²C BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions	
90	Tsu:sta	START condition	100 kHz mode	2(Tosc)(BRG + 1)	_		Only relevant for Repeated START	
		Setup time	400 kHz mode	2(Tosc)(BRG + 1)	1 —	ns		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG+1)	<u> </u>		condition	
91	THD:STA	START condition	100 kHz mode	2(Tosc)(BRG+4)	_		After this period, the first clock pulse is generated	
		Hold time	400 kHz mode	2(Tosc)(BRG + 1)	_	ns		
			1 MHz mode (1)	2(10sc)(BRG + 1)	_			
92	Tsu:sto	STOP condition	100 kHz mode	2(Tosc)(BRG + 1)	_			
		Setup time	400 kHz mode	2(Tosc)(BRG + 1)	_	ns		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_			
93	THD:STO	STOP condition	100 kHz mode	2(Tosc)(BRG + 1)	_			
		Hold time	400 kHz mode	2(Tosc)(BRG + 1)	_	ns		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)				

Note 1: Maximum pin capacitance = 10 pF for all $I^2\text{C}$ pins.

FIGURE 22-20: MASTER SSP I²C BUS DATA TIMING

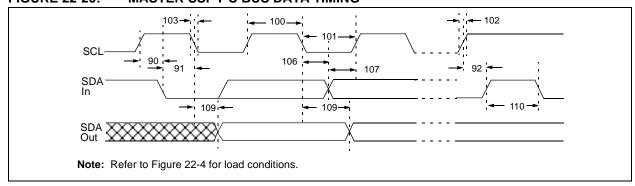


TABLE 22-19: MASTER SSP I²C BUS DATA REQUIREMENTS

Param No.	Symbol	Charac	teristic	Min	Max	Units	Conditions
100	THIGH	Clock high time	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
101	TLOW	Clock low time	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	<u> </u>
			400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
102	Tr	SDA and SCL	100 kHz mode		1000	ns 〈	Cb is specified to be
		rise time	400 kHz mode	20 + 0.1Cb	300	ns	from 10 to 400 pF
			1 MHz mode ⁽¹⁾	_	300	Ms	
103	TF	SDA and SCL	100 kHz mode	- <	300	ns	Cb is specified to be
		fall time	400 kHz mode	20 + 0.1¢b	/3/00	\ ns	from 10 to 400 pF
			1 MHz mode ⁽¹⁾		700	ns	
90	Tsu:sta	START condition	100 kHz mode	2(769¢)(BRG+1)		ms	Only relevant for
		setup time	400 kHz mode	\2(\to\sc)(BRG\+1)\	\ _	ms	Repeated START
			1 MHz mode ⁽¹⁾	\2\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		ms	condition
91	THD:STA	START condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	After this period, the first
		hold time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	clock pulse is generated
			1/MHz mode(V)	2(Tosc)(BRG + 1)	_	ms	
106	THD:DAT	Data input	100 kHz mode	0	_	ns	
		hold time	400 kHz mode	0	0.9	ms	
	_		1 MHz mode ⁽¹⁾	TBD	_	ns	
107	TSU:DAT	Data input	100 kHz mode	250	_	ns	(Note 2)
		setup time	400 kHz mode	100	_	ns	
\			1 MHz mode ⁽¹⁾	TBD	-	ns	
92	Tsu:sto	STOP condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
		setup time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
109	TAA	Output valid from	100 kHz mode	_	3500	ns	
		clock	400 kHz mode		1000	ns	
			1 MHz mode ⁽¹⁾	_	_	ns	
110	TBUF	Bus free time	100 kHz mode	4.7	_	ms	Time the bus must be
			400 kHz mode	1.3		ms	free before a new
			1 MHz mode ⁽¹⁾	TBD	_	ms	transmission can start
D102	Cb	Bus capacitive loa		_	400	pF	

Note 1: Maximum pin capacitance = 10 pF for all $I^2\text{C}$ pins.

^{2:} A fast mode I²C bus device can be used in a standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line. Before the SCL line is released, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode).

FIGURE 22-21: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

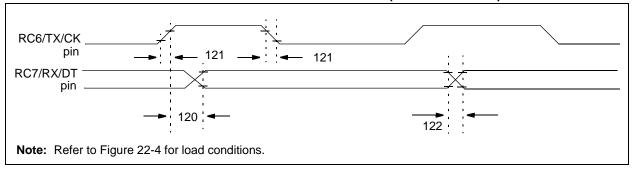


TABLE 22-20: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
120	TckH2dtV	SYNC XMIT (Master & Slave)					
		Clock high to data-out valid	RIG180601/801	_	40	ns	
			PIC18 LC 601/801	_	100	ns	
121	Tckrf	Clock out rise time and fall time	PIC18 C 601/801	_	20	ns	
		(Master mode)	PIC18 LC 601/801	_	50	ns	
122	Tdtrf	Data-out rise time and fall time	PIC18 C 601/801	_	20	ns	
			PIC18 LC 601/801	_	50	ns	

FIGURE 22-22: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

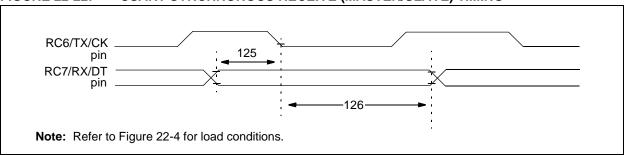


TABLE 22-21: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TdtV2ckl	SYNC RCV (Master & Slave)				
		Data-hold before CK (A) hold time)	10	_	ns	
126	TckL2dtl	Data-hold after CK (DT hold time)	15	_	ns	

TABLE 22-22: A/D CONVERTER CHARACTERISTICS: PIC18C601/801 (INDUSTRIAL, EXTENDED) PIC18LC601/801 (INDUSTRIAL)

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution	_	_	10	bit	VREF = VDD ≥ 3.0V
			_		TBD	bit	VREF = VDD < 3.0V
A03	EIL	Integral linearity error	_	_	<±1	LSb	VREF = VDD ≥ 3.0V
			_	_	TBD	LSb	VREF YDD < 3.0V
A04	EDL	Differential linearity error	_	_	<±1	LSb	VREF = VDQ ≥ 3.0V
	_			_	TBD	1 1	VREF = VDD < 3.0V
A05	EFS	Full scale error	_	_	<±1	LSb LSb	VREF = VDD ≥ 3.0V
100		0" 1	_		TBD		VREF = VDD < 3.0V
A06	EOFF	Offset error	_		√<±1 ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖ ∖	LSb LSb	$VREF = VDD \ge 3.0V$ VREF = VDD < 3.0V
A10		Monotonicity		-	L \ \ /	/L30/	$VSS \le VAIN \le VREF$
		<u>, </u>	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	arantee			VSS ≤ VAIN ≤ VREF
A20	VREF	Reference voltage (VREFH - VREFL)	0	/ + /		V	
A20A			3 \		\vee –	V	For 10-bit resolution
A21	VREFH	Reference voltage High	\ \\X\V\$\$ \\	$\overline{\ \ }$	AVDD + 0.3 V	V	
A22	VREFL	Reference voltage Low	AV\$s\0.3 V	<u></u>	AVDD	V	
A25	VAIN	Analog input voltage \	AVss\-, 0.3 V	_	VREF + 0.3 V	V	
A30	ZAIN	Recommended impedance of analog voltage source		_	10.0	kΩ	
A40	IAD	A/D conversion PtC18 6601/801	_	180		μА	Average current
7110	1, 10	eurrent (VDD) PtC18L C 601/801	_	90		μA	consumption when
		11002001/001		30		μπ	A/D is on ⁽¹⁾
A50 -	TREF	VREF input current ⁽²⁾	10	_	1000	μΑ	During VAIN acquisition. Based on differential of VHOLD to VAIN. To charge CHOLD, see Section 17.0.
			_	_	10	μΑ	During A/D conversion cycle.

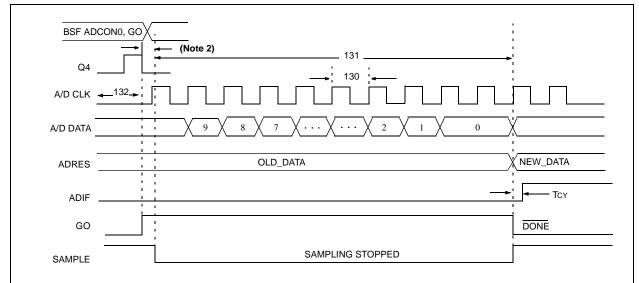
Note 1: When A/D is off, it will not consume any current other than minor leakage current. The power-down current spec includes any such leakage from the A/D module.

VREF current is from RA2/AN2/VREF- and RA3/AN3/VREF+ pins or AVDD and AVSS pins, whichever is selected as reference input.

^{2:} Vss ≤ VAIN ≤ VREF

^{3:} The A/D conversion result either increases or remains constant as the analog input increases.

FIGURE 22-23: A/D CONVERSION TIMING



- Note 1: If the A/D clock source is selected as RC, a time of TcY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
 - 2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

TABLE 22-23: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characte	Min	Max	Units	Conditions	
130	TAD	A/D clock period	PIC18 C 601/801	1.6	20 ⁽⁵⁾	μs	Tosc based, VREF ≥ 3.0V
			PIC18 LC 601/801	3.0	20(5)	μs	Tosc based, VREF full range
			PIC18 C 601/801	2.0	6.0	μs	A/D RC mode
			PIC18 LC 601/801	3.0	9.0	μs	A/D RC mode
131	TCNV	Conversion time (not including acquisition	on time) ⁽¹⁾		12	TAD	
132	TACQ	Acquisition time ⁽³⁾		15 10	_	μs μs	-40°C ≤ Temp ≤ 125°C 0°C ≤ Temp ≤ 125°C
135	Tswc	Switching time from eor	vert sample	_	(Note 4)		
136	Тамр	Amplifier settling time (2		1		μѕ	This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 5 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).

Note 1: ADRES register may be read on the following TcY cycle.

- 2: See Section 17.0 for minimum conditions, when input voltage has changed more than 1 LSb.
- 3: The time for the holding capacitor to acquire the "New" input voltage, when the voltage changes full scale after the conversion (AVDD to AVSS, or AVSS to AVDD). The source impedance (RS) on the input channels is 50Ω .
- 4: On the next Q4 cycle of the device clock.
- 5: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

NOTES:

23.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

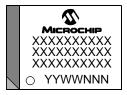
Graphs and Tables are not available at this time.

NOTES:

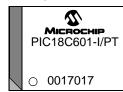
24.0 PACKAGING INFORMATION

24.1 Package Marking Information

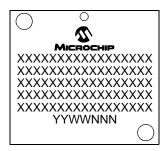
64-Lead TQFP



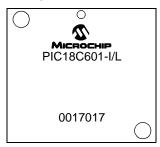
Example



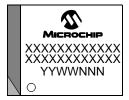
68-Lead PLCC



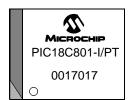
Example



80-Lead TQFP



Example



Legend: XX...X Customer specific information*

YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

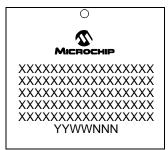
Note

In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)

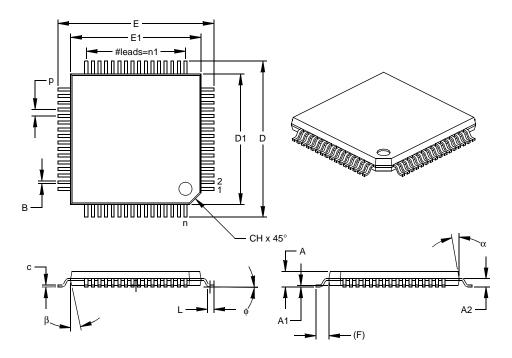
84-Lead PLCC







64-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)



	Units		INCHES		М	ILLIMETERS	*
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		64			64	
Pitch	р		.020			0.50	
Pins per Side	n1		16			16	
Overall Height	Α	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	ф	0	3.5	7	0	3.5	7
Overall Width	Е	.463	.472	.482	11.75	12.00	12.25
Overall Length	D	.463	.472	.482	11.75	12.00	12.25
Molded Package Width	E1	.390	.394	.398	9.90	10.00	10.10
Molded Package Length	D1	.390	.394	.398	9.90	10.00	10.10
Lead Thickness	С	.005	.007	.009	0.13	0.18	0.23
Lead Width	В	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

^{*} Controlling Parameter

Notes:

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

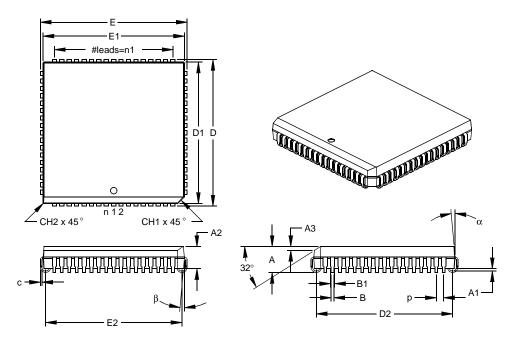
.010" (0.254mm) per side.

JEDEC Equivalent: MS-026

Drawing No. C04-085

[§] Significant Characteristic

68-Lead Plastic Leaded Chip Carrier (L) - Square (PLCC)



	Units	INCHES*		N	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		68			68	
Pitch	р		.050			1.27	
Pins per Side	n1		17			17	
Overall Height	Α	.165	.173	.180	4.19	4.39	4.57
Molded Package Thickness	A2	.145	.153	.160	3.68	3.87	4.06
Standoff §	A1	.020	.028	.035	0.51	0.71	0.89
Side 1 Chamfer Height	А3	.024	.029	.034	0.61	0.74	0.86
Corner Chamfer 1	CH1	.040	.045	.050	1.02	1.14	1.27
Corner Chamfer (others)	CH2	.000	.005	.010	0.00	0.13	0.25
Overall Width	Е	.985	.990	.995	25.02	25.15	25.27
Overall Length	D	.985	.990	.995	25.02	25.15	25.27
Molded Package Width	E1	.950	.954	.958	24.13	24.23	24.33
Molded Package Length	D1	.950	.954	.958	24.13	24.23	24.33
Footprint Width	E2	.890	.920	.930	22.61	23.37	23.62
Footprint Length	D2	.890	.920	.930	22.61	23.37	23.62
Lead Thickness	С	.008	.011	.013	0.20	0.27	0.33
Upper Lead Width	B1	.026	.029	.032	0.66	0.74	0.81
Lower Lead Width	В	.013	.020	.021	0.33	0.51	0.53
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

^{*} Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

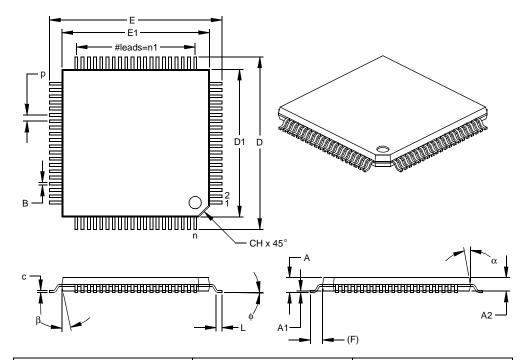
.010" (0.254mm) per side.

JEDEC Equivalent: MO-047

Drawing No. C04-049

[§] Significant Characteristic

80-Lead Plastic Thin Quad Flatpack (PT) 12x12x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)



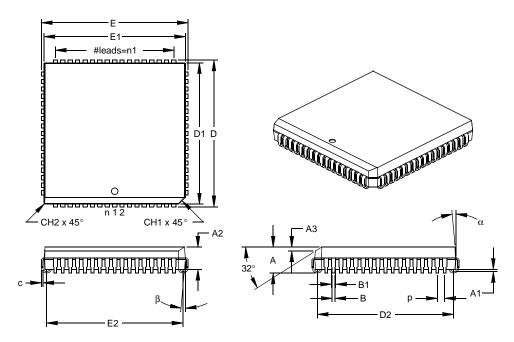
	Units	INCHES		MILLIMETERS*			
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		80			80	
Pitch	р		.020			0.50	
Pins per Side	n1		20			20	
Overall Height	Α	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff §	A1	.002	.004	.006	0.05	0.10	0.15
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	ф	0	3.5	7	0	3.5	7
Overall Width	Е	.541	.551	.561	13.75	14.00	14.25
Overall Length	D	.541	.551	.561	13.75	14.00	14.25
Molded Package Width	E1	.463	.472	.482	11.75	12.00	12.25
Molded Package Length	D1	.463	.472	.482	11.75	12.00	12.25
Lead Thickness	С	.004	.006	.008	0.09	0.15	0.20
Lead Width	В	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side.
JEDEC Equivalent: MS-026
Drawing No. C04-092

^{*} Controlling Parameter § Significant Characteristic

84-Lead Plastic Leaded Chip Carrier (L) - Square (PLCC)



	Units		INCHES*		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		68			68	
Pitch	р		.050			1.27	
Pins per Side	n1		17			17	
Overall Height	Α	.165	.173	.180	4.19	4.39	4.57
Molded Package Thickness	A2	.145	.153	.160	3.68	3.87	4.06
Standoff §	A1	.020	.028	.035	0.51	0.71	0.89
Side 1 Chamfer Height	A3	.024	.029	.034	0.61	0.74	0.86
Corner Chamfer 1	CH1	.040	.045	.050	1.02	1.14	1.27
Corner Chamfer (others)	CH2	.000	.005	.010	0.00	0.13	0.25
Overall Width	Е	.985	.990	.995	25.02	25.15	25.27
Overall Length	D	.985	.990	.995	25.02	25.15	25.27
Molded Package Width	E1	.950	.954	.958	24.13	24.23	24.33
Molded Package Length	D1	.950	.954	.958	24.13	24.23	24.33
Footprint Width	E2	.890	.920	.930	22.61	23.37	23.62
Footprint Length	D2	.890	.920	.930	22.61	23.37	23.62
Lead Thickness	С	.008	.011	.013	0.20	0.27	0.33
Upper Lead Width	B1	.026	.029	.032	0.66	0.74	0.81
Lower Lead Width	В	.013	.020	.021	0.33	0.51	0.53
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

^{*} Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MO-047

Drawing No. C04-093

[§] Significant Characteristic

APPENDIX A: DATA SHEET REVISION HISTORY

Revision A

This is a new data sheet.

APPENDIX B: DEVICE DIFFERENCES

The differences between the PIC18C601/801 devices listed in this data sheet are shown in Table B-1.

TABLE B-1: DEVICE DIFFERENCES

Fe	ature	PIC18C601	PIC18C801	
Progran	m External n Memory ytes)	256K	2M	
Data Mer	nory (Bytes)	1.5K	1.5K	
A/D C	hannels	8	12	
Package	TQFP	64-pin	80-pin	
Types	PLCC	68-pin	84-pin	

APPENDIX C: DEVICE MIGRATIONS

This section is intended to describe the functional and electrical specification differences when migrating between functionally similar devices (such as from a PIC16C74A to a PIC16C74B).

Not Applicable

APPENDIX D: MIGRATING FROM OTHER PICmicro DEVICES

This discusses some of the issues in migrating from other PICmicro devices to the PIC18CXXX family of devices.

D.1 PIC16CXXX to PIC18CXXX

See application note AN716.

D.2 PIC17CXXX to PIC18CXXX

See application note AN726.

APPENDIX E: DEVELOPMENT TOOL VERSION REQUIREMENTS

This lists the minimum requirements (software/ firmware) of the specified development tool to support the devices listed in this data sheet.

MPLAB® IDE: TBD
MPLAB® SIMULATOR: TBD

MPLAB® ICE 3000:

PIC18C601/801 Processor Module:

Part Number - TBD

PIC18C601/801 Device Adapter: Socket Part Number

64-pin TQFP TBD 68-pin PLCC TBD 80-pin TQFP TBD 84-pin PLCC TBD

MPLAB® ICD: TBD
PRO MATE® II: TBD
PICSTART® Plus: TBD
MPASM™ Assembler: TBD
MPLAB® C18 C Compiler: TBD

Note: Please read all associated README.TXT

files that are supplied with the development tools. These "read me" files will discuss product support and any known limitations.

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Device	VDD range, PIC18LC601/	01 ⁽¹⁾ , PIC18C6 4.2V to 5.5V 801 ⁽¹⁾ , PIC18L 2.5V to 5.5V					
Temperature Range		40°C to +70°C 40°C to +125°					
Package		QFP PLCC			Note 1:	LC =	
Pattern		irements. Blan	ctory specified) or k for OTP and		2:	T =	In TC

- a) PIC18LC601 I/L = Industrial temp., PLCC package, Extended VDD limits, 16-bit data bus.
- b) PIC18LC801 E/PT = Extended temp., TQFP package, Extended VDD limits, 16-bit data bus.

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